

# PIC24FJ256GA705 FAMILY

## 16-Bit General Purpose Microcontrollers with 256-Kbyte Flash and 16-Kbyte RAM in Low Pin Count Packages

#### **High-Performance CPU**

- Modified Harvard Architecture
- Up to 16 MIPS Operation @ 32 MHz
- 8 MHz Fast RC Internal Oscillator:
  - 96 MHz PLL option
  - Multiple clock divide options
  - Fast start-up
- 17-Bit x 17-Bit Single-Cycle Hardware Fractional/Integer Multiplier
- · 32-Bit by 16-Bit Hardware Divider
- 16-Bit x 16-Bit Working Register Array
- · C Compiler Optimized Instruction Set Architecture
- Two Address Generation Units for Separate Read and Write Addressing of Data Memory
- Six-Channel DMA Controller

#### **Analog Features**

- Up to 14-Channel, Software Selectable, 10/12-Bit Analog-to-Digital Converter:
  - 12-bit, 200K samples/second conversion rate (single Sample-and-Hold)
  - Sleep mode operation
  - Charge pump for operating at lower AVDD
  - Band gap reference input feature
  - Windowed threshold compare feature
  - Auto-scan feature
- · Three Analog Comparators with Input Multiplexing:
  - Programmable reference voltage for comparators
- LVD Interrupt Above/Below Programmable VLVD Level
- Charge Time Measurement Unit (CTMU):
  - Allows measurement of capacitance and time
  - Operational in Sleep

#### **Low-Power Features**

- Sleep and Idle modes Selectively Shut Down Peripherals and/or Core for Substantial Power Reduction and Fast Wake-up
- Doze mode allows CPU to Run at a Lower Clock Speed than Peripherals
- Alternate Clock modes allow On-the-Fly Switching to a Lower Clock Speed for Selective Power Reduction

#### **Special Microcontroller Features**

- Supply Voltage Range of 2.0V to 3.6V
- · Dual Voltage Regulators:
  - 1.8V core regulator
  - 1.2V regulator for Retention Sleep mode
- Operating Ambient Temperature Range of -40°C to +85°C
- ECC Flash Memory (256 Kbytes):
  - Single Error Correction (SEC)
  - Double Error Detection (DED)
  - 10,000 erase/write cycle endurance, typical
  - Data retention: 20 years minimum
  - Self-programmable under software control
- 16-Kbyte SRAM
- · Programmable Reference Clock Output
- In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>) and In-Circuit Emulation (ICE) via 2 Pins
- JTAG Boundary Scan Support
- Fail-Safe Clock Monitor Operation:
  - Detects clock failure and switches to on-chip, Low-Power RC (LPRC) Oscillator
- Power-on Reset (POR), Brown-out Reset (BOR) and Oscillator Start-up Timer (OST)
- Programmable Low-Voltage Detect (LVD)
- Flexible Watchdog Timer (WDT) with its Own RC Oscillator for Reliable Operation

#### **Peripheral Features**

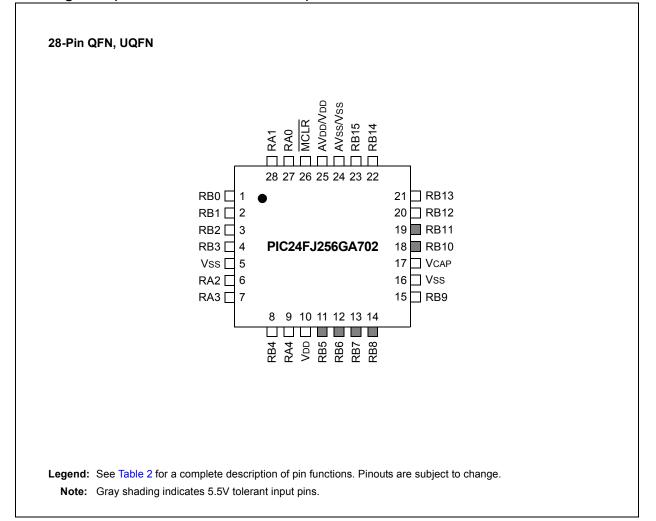
- High-Current Sink/Source 18 mA/18 mA on All I/O Pins
- Independent, Low-Power 32 kHz Timer Oscillator
- Timer1: 16-Bit Timer/Counter with External Crystal Oscillator; Timer1 can Provide an A/D Trigger
- Timer2,3: 16-Bit Timer/Counter, can Create 32-Bit Timer; Timer3 can Provide an A/D Trigger
- Three Input Capture modules, Each with a 16-Bit Timer
- Three Output Compare/PWM modules, Each with a 16-Bit Timer
- Four MCCP modules, Each with a Dedicated 16/32-Bit Timer:
  - One 6-output MCCP module
  - Three 2-output MCCP modules
- Three Variable Width, Synchronous Peripheral Interface (SPI) Ports on All Devices; 3 Operation modes:
  - 3-wire SPI (supports all 4 SPI modes)
  - 8 by 16-bit or 8 by 8-bit FIFO
  - I<sup>2</sup>S mode

#### TABLE 1:PIC24FJ256GA705 FAMILY DEVICES

- Two I<sup>2</sup>C Master and Slave w/Address Masking, and IPMI Support
- Two UART modules:
  - LIN/J2602 bus support (auto-wake-up, Auto-Baud Detect (ABD), Break character support)
  - RS-232 and RS-485 support
  - IrDA<sup>®</sup> mode (hardware encoder/decoder functions)
- Five External Interrupt Pins
- Parallel Master Port/Enhanced Parallel Slave Port (PMP/EPSP), 8-Bit Data with External Programmable Control (polarity and protocol)
- Enhanced CRC module
- Reference Clock Output with Programmable
   Divider
- Two Configurable Logic Cell (CLC) Blocks:
  - Two inputs and one output, all mappable to peripherals or I/O pins
  - AND/OR/XOR logic and D/JK flip-flop functions
- Peripheral Pin Select (PPS) with Independent I/O Mapping of Many Peripherals

	Men	nory				Peripherals													
Device	Program (bytes)	SRAM (bytes)	Pins	Old9	DMA Channels	10/12-Bit A/D Channels	Comparators	CRC	MCCP 6-Output/2-Output	IC/OC/PWM	16-Bit Timers	I <sup>2</sup> C	Variable Width SPI	LIN-USART/Irda <sup>®</sup>	<b>CTMU Channels</b>	EPMP (Address/Data Line)	CLC	RTCC	JTAG
PIC24FJ64GA705	64K	16K	48	40	6	14	3	Yes	1/3	3/3	3	2	3	2	13	10/8	2	Yes	Yes
PIC24FJ128GA705	128K	16K	48	40	6	14	3	Yes	1/3	3/3	3	2	3	2	13	10/8	2	Yes	Yes
PIC24FJ256GA705	256K	16K	48	40	6	14	3	Yes	1/3	3/3	3	2	3	2	13	10/8	2	Yes	Yes
PIC24FJ64GA704	64K	16K	44	36	6	14	3	Yes	1/3	3/3	3	2	3	2	13	10/8	2	Yes	Yes
PIC24FJ128GA704	128K	16K	44	36	6	14	3	Yes	1/3	3/3	3	2	3	2	13	10/8	2	Yes	Yes
PIC24FJ256GA704	256K	16K	44	36	6	14	3	Yes	1/3	3/3	3	2	3	2	13	10/8	2	Yes	Yes
PIC24FJ64GA702	64K	16K	28	22	6	10	3	Yes	1/3	3/3	3	2	3	2	12	No	2	Yes	Yes
PIC24FJ128GA702	128K	16K	28	22	6	10	3	Yes	1/3	3/3	3	2	3	2	12	No	2	Yes	Yes
PIC24FJ256GA702	256K	16K	28	22	6	10	3	Yes	1/3	3/3	3	2	3	2	12	No	2	Yes	Yes

#### Pin Diagrams (PIC24FJ256GA702 Devices)



#### TABLE 2: COMPLETE PIN FUNCTION DESCRIPTIONS (PIC24FJ256GA702 QFN, UQFN)

Pin	Function		Function
1	PGD1/AN2/CTCMP/C2INB/ <b>RP0</b> /RB0	15	TDO/C1INC/C2INC/C3INC/TMPRN/RP9/SDA1/T1CK/CTED4/RB9
2	PGC1/AN1-/AN3/C2INA/ <b>RP1</b> /CTED12/RB1	16	Vss
3	AN4/C1INB/ <b>RP2</b> /SDA2/CTED13/RB2	17	VCAP
4	AN5/C1INA/RP3/SCL2/CTED8/RB3	18	PGD2/TDI/ <b>RP10</b> /OCM1C/CTED11/RB10
5	Vss	19	PGC2/TMS/REFI1/RP11/CTED9/RB11
6	OSCI/CLKI/C1IND/RA2	20	AN8/LVDIN/ <b>RP12</b> /RB12
7	OSCO/CLKO/C2IND/RA3	21	AN7/C1INC/ <b>RP13</b> /OCM1D/CTPLS/RB13
8	SOSCI/ <b>RP4</b> /RB4	22	CVREF/AN6/C3INB/ <b>RP14</b> /CTED5/RB14
9	SOSCO/PWRLCLK/RA4	23	AN9/C3INA/ <b>RP15</b> /CTED6/RB15
10	Vdd	24	AVss/Vss
11	PGD3/ <b>RP5</b> /ASDA1/OCM1E/RB5	25	AVdd/Vdd
12	PGC3/ <b>RP6</b> /ASCL1/OCM1F/RB6	26	MCLR
13	RP7/OCM1A/CTED3/INT0/RB7	27	VREF+/CVREF+/AN0/C3INC/RP26/CTED1/RA0
14	TCK/ <b>RP8</b> /SCL1/OCM1B/CTED10/RB8	28	VREF-/CVREF-/AN1/C3IND/ <b>RP27</b> /CTED2/RA1

Legend: RPn represents remappable pins for Peripheral Pin Select (PPS) functions.

**Note:** Pinouts are subject to change.

#### Pin Diagrams (PIC24FJ256GA702 Devices)

28-Pin SOIC, SSOP, SPDIP

Legend: See Table 3 for a complete description of pin functions. Pinouts are subject to change.Note: Gray shading indicates 5.5V tolerant input pins.

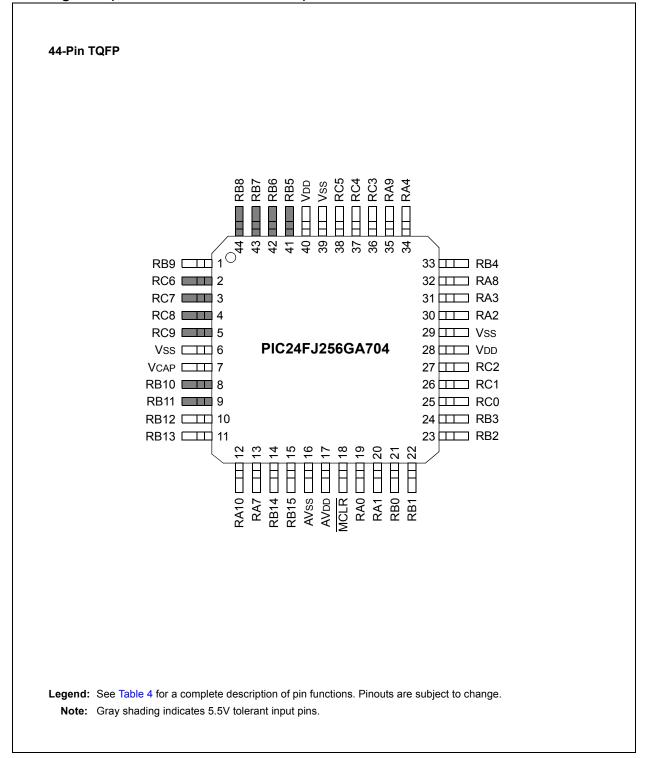
#### TABLE 3: COMPLETE PIN FUNCTION DESCRIPTIONS (PIC24FJ256GA702 SOIC, SSOP, SPDIP)

Pin	Function	Pin	Function
1	MCLR	15	PGC3/ <b>RP6</b> /ASCL1/OCM1F/RB6
2	VREF+/CVREF+/AN0/C3INC/RP26/CTED1/RA0	16	RP7/OCM1A/CTED3/INT0/RB7
3	VREF-/CVREF-/AN1/C3IND/ <b>RP27</b> /CTED2/RA1	17	TCK/RP8/SCL1/OCM1B/CTED10/RB8
4	PGD1/AN2/CTCMP/C2INB/ <b>RP0</b> /RB0	18	TDO/C1INC/C2INC/C3INC/TMPRN/RP9/SDA1/T1CK/CTED4/RB9
5	PGC1/AN1-/AN3/C2INA/ <b>RP1</b> /CTED12/RB1	19	Vss
6	AN4/C1INB/ <b>RP2</b> /SDA2/CTED13/RB2	20	VCAP
7	AN5/C1INA/RP3/SCL2/CTED8/RB3	21	PGD2/TDI/ <b>RP10</b> /OCM1C/CTED11/RB10
8	Vss	22	PGC2/TMS/REFI1/RP11/CTED9/RB11
9	OSCI/CLKI/C1IND/RA2	23	AN8/LVDIN/ <b>RP12</b> /RB12
10	OSCO/CLKO/C2IND/RA3	24	AN7/C1INC/RP13/OCM1D/CTPLS/RB13
11	SOSCI/ <b>RP4</b> /RB4	25	CVREF/AN6/C3INB/RP14/CTED5/RB14
12	SOSCO/PWRLCLK/RA4	26	AN9/C3INA/ <b>RP15</b> /CTED6/RB15
13	VDD	27	AVss/Vss
14	PGD3/ <b>RP5</b> /ASDA1/OCM1E/RB5	28	AVdd/Vdd

Legend: RPn represents remappable pins for Peripheral Pin Select (PPS) functions.

Note: Pinouts are subject to change.

#### Pin Diagrams (PIC24FJ256GA704 Devices)



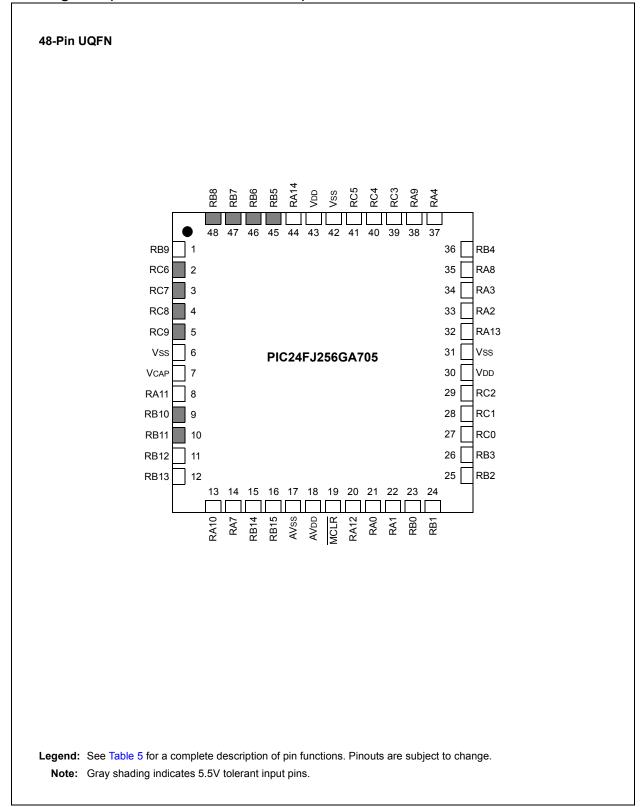
Pin	Function	Pin	Function
1	C1INC/C2INC/C3INC/TMPRN/RP9/SDA1/T1CK/CTED4/PMD3/RB9	23	AN4/C1INB/ <b>RP2</b> /SDA2/CTED13/RB2
2	RP22/PMA1/PMALH/RC6	24	AN5/C1INA/RP3/SCL2/CTED8/RB3
3	RP23/PMA0/PMALL/RC7	25	AN10/ <b>RP16</b> /PMBE1/RC0
4	RP24/PMA5/RC8	26	AN11/RP17/PMA15/PMCS2/RC1
5	RP25/CTED7/PMA6/RC9	27	AN12/RP18/PMACK1/RC2
6	Vss	28	Vdd
7	VCAP	29	Vss
8	PGD2/RP10/OCM1C/CTED11/PMD2/RB10	30	OSCI/CLKI/C1IND/RA2
9	PGC2/REFI1/RP11/CTED9/PMD1/RB11	31	OSCO/CLKO/C2IND/RA3
10	AN8/LVDIN/ <b>RP12</b> /PMD0/RB12	32	TDO/PMA8/RA8
11	AN7/C1INC/ <b>RP13</b> /OCM1D/CTPLS/PMRD/PMWR/RB13	33	SOSCI/ <b>RP4</b> /RB4
12	TMS/ <b>RP28</b> /PMA2/PMALU/RA10	34	SOSCO/PWRLCLK/RA4
13	TCK/PMA7/RA7	35	TDI/PMA9/RA9
14	CVREF/AN6/C3INB/ <b>RP14</b> /CTED5/PMWR/PMENB/RB14	36	AN13/ <b>RP19</b> /PMBE0/RC3
15	AN9/C3INA/ <b>RP15</b> /CTED6/PMA14/PMCS/PMCS1/RB15	37	RP20/PMA4/RC4
16	AVss	38	RP21/PMA3/RC5
17	AVDD	39	Vss
18	MCLR	40	Vdd
19	VREF+/CVREF+/AN0/C3INC/ <b>RP26</b> /CTED1/RA0	41	PGD3/ <b>RP5</b> /ASDA1/OCM1E/PMD7/RB5
20	VREF-/CVREF-/AN1/C3IND/ <b>RP27</b> /CTED2/RA1	42	PGC3/ <b>RP6</b> /ASCL1/OCM1F/PMD6/RB6
21	PGD1/AN2/CTCMP/C2INB/ <b>RP0</b> /RB0	43	RP7/OCM1A/CTED3/PMD5/INT0/RB7
22	PGC1/AN1-/AN3/C2INA/ <b>RP1</b> /CTED12/RB1	44	RP8/SCL1/OCM1B/CTED10/PMD4/RB8

### TABLE 4: COMPLETE PIN FUNCTION DESCRIPTIONS (PIC24FJ256GA704 TQFP)

Legend: RPn represents remappable pins for Peripheral Pin Select (PPS) functions.

**Note:** Pinouts are subject to change.

#### Pin Diagrams (PIC24FJ256GA705 Devices)



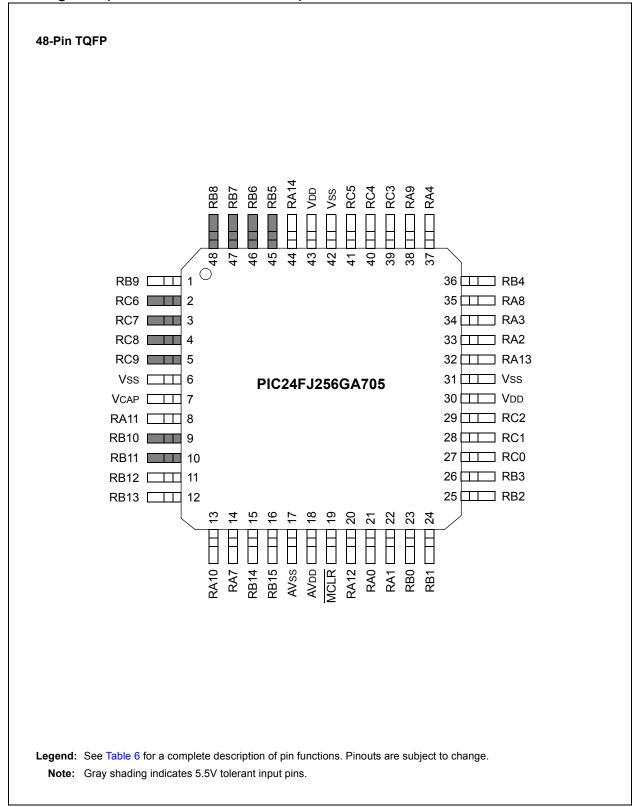
Pin	Function	Pin	Function		
1	C1INC/C2INC/C3INC/TMPRN/RP9/SDA1/T1CK/CTED4/PMD3/RB9	25	AN4/C1INB/RP2/SDA2/CTED13/RB2		
2	RP22/PMA1/PMALH/RC6	26	AN5/C1INA/RP3/SCL2/CTED8/RB3		
3	RP23/PMA0/PMALL/RC7	27	AN10/ <b>RP16</b> /PMBE1/RC0		
4	RP24/PMA5/RC8	28	AN11/RP17/PMA15/PMCS2/RC1		
5	RP25/CTED7/PMA6/RC9	29	AN12/RP18/PMACK1/RC2		
6	Vss	30	Vdd		
7	VCAP	31	Vss		
8	<b>RPI29</b> /RA11	32	RPI31/RA13		
9	PGD2/ <b>RP10</b> /OCM1C/CTED11/PMD2/RB10	33	OSCI/CLKI/C1IND/RA2		
10	PGC2/REFI1/ <b>RP11</b> /CTED9/PMD1/RB11	34	OSCO/CLKO/C2IND/RA3		
11	AN8/LVDIN/ <b>RP12</b> /PMD0/RB12	35	TDO/PMA8/RA8		
12	AN7/C1INC/ <b>RP13</b> /OCM1D/CTPLS/PMRD/PMWR/RB13	36	SOSCI/ <b>RP4</b> /RB4		
13	TMS/ <b>RP28</b> /PMA2/PMALU/RA10	37	SOSCO/PWRLCLK/RA4		
14	TCK/PMA7/RA7	38	TDI/PMA9/RA9		
15	CVREF/AN6/C3INB/RP14/CTED5/PMWR/PMENB/RB14	39	AN13/ <b>RP19</b> /PMBE0/RC3		
16	AN9/C3INA/ <b>RP15</b> /CTED6/PMA14/PMCS/PMCS1/RB15	40	RP20/PMA4/RC4		
17	AVss	41	RP21/PMA3/RC5		
18	AVDD	42	Vss		
19	MCLR	43	VDD		
20	RPI30/RA12	44	RPI32/RA14		
21	VREF+/CVREF+/AN0/C3INC/RP26/CTED1/RA0	45	PGD3/ <b>RP5</b> /ASDA1/OCM1E/PMD7/RB5		
22	Vref-/CVref-/AN1/C3IND/ <b>RP27</b> /CTED2/RA1	46	PGC3/ <b>RP6</b> /ASCL1/OCM1F/PMD6/RB6		
23	PGD1/AN2/CTCMP/C2INB/ <b>RP0</b> /RB0	47	RP7/OCM1A/CTED3/PMD5/INT0/RB7		
24	PGC1/AN1-/AN3/C2INA/ <b>RP1</b> /CTED12/RB1	48	RP8/SCL1/OCM1B/CTED10/PMD4/RB8		

### TABLE 5: COMPLETE PIN FUNCTION DESCRIPTIONS (PIC24FJ256GA705 UQFN)

Legend: RPn and RPIn represent remappable pins for Peripheral Pin Select (PPS) functions.

**Note:** Pinouts are subject to change.

#### Pin Diagrams (PIC24FJ256GA705 Devices)



Pin	Function	Pin	Function
1	C1INC/C2INC/C3INC/TMPRN/ <b>RP9</b> /SDA1/T1CK/CTED4/PMD3/RB9	25	AN4/C1INB/ <b>RP2</b> /SDA2/CTED13/RB2
2	RP22/PMA1/PMALH/RC6	26	AN5/C1INA/RP3/SCL2/CTED8/RB3
3	RP23/PMA0/PMALL/RC7	27	AN10/RP16/PMBE1/RC0
4	RP24/PMA5/RC8	28	AN11/RP17/PMA15/PMCS2/RC1
5	RP25/CTED7/PMA6/RC9	29	AN12/RP18/PMACK1/RC2
6	Vss	30	Vdd
7	VCAP	31	Vss
8	RPI29/RA11	32	RPI31/RA13
9	PGD2/RP10/OCM1C/CTED11/PMD2/RB10	33	OSCI/CLKI/C1IND/RA2
10	PGC2/REFI1/RP11/CTED9/PMD1/RB11	34	OSCO/CLKO/C2IND/RA3
11	AN8/LVDIN/ <b>RP12</b> /PMD0//RB12	35	TDO/PMA8/RA8
12	AN7/C1INC/RP13/OCM1D/CTPLS/PMRD/PMWR/RB13	36	SOSCI/ <b>RP4</b> /RB4
13	TMS/ <b>RP28</b> /PMA2/PMALU/RA10	37	SOSCO/PWRLCLK/RA4
14	TCK/PMA7/RA7	38	TDI/PMA9/RA9
15	CVREF/AN6/C3INB/RP14/CTED5/PMWR/PMENB/RB14	39	AN13/ <b>RP19</b> /PMBE0/RC3
16	AN9/C3INA/RP15/CTED6/PMA14/PMCS/PMCS1/RB15	40	RP20/PMA4/RC4
17	AVss	41	RP21/PMA3/RC5
18	AVDD	42	Vss
19	MCLR	43	VDD
20	RPI30/RA12	44	RPI32/RA14
21	VREF+/CVREF+/AN0/C3INC/RP26/CTED1/RA0	45	PGD3/ <b>RP5</b> /ASDA1/OCM1E/PMD7/RB5
22	Vref-/CVref-/AN1/C3IND/ <b>RP27</b> /CTED2/RA1	46	PGC3/RP6/ASCL1/OCM1F/PMD6/RB6
23	PGD1/AN2/CTCMP/C2INB/ <b>RP0</b> /RB0	47	RP7/OCM1A/CTED3/PMD5/INT0/RB7
24	PGC1/AN1-/AN3/C2INA/ <b>RP1</b> /CTED12/RB1	48	RP8/SCL1/OCM1B/CTED10/PMD4/RB8

## TABLE 6: COMPLETE PIN FUNCTION DESCRIPTIONS (PIC24FJ256GA705 TQFP)

Legend: RPn and RPIn represent remappable pins for Peripheral Pin Select (PPS) functions.

**Note:** Pinouts are subject to change.

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#### Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

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#### **Referenced Sources**

This device data sheet is based on the following individual chapters of the *"dsPIC33/PIC24 Family Reference Manual"*. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note 1: To access the documents listed below, browse to the documentation section of the PIC24FJ256GA705 product page of the Microchip web site (www.microchip.com) or select a family reference manual section from the following list.

> In addition to parameters, features and other documentation, the resulting page provides links to the related family reference manual sections.

- "CPU with Extended Data Space (EDS)" (DS39732)
- "Direct Memory Access Controller (DMA)" (DS39742)
- "PIC24F Flash Program Memory" (DS30009715)
- "Data Memory with Extended Data Space (EDS)" (DS39733)
- "Reset" (DS39712)
- "Interrupts" (DS70000600)
- "Oscillator" (DS39700)
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- "Universal Asynchronous Receiver Transmitter (UART)" (DS70000582)
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- "RTCC with Timestamp" (DS70005193)
- "32-Bit Programmable Cyclic Redundancy Check (CRC)" (DS30009729)
- "Configurable Logic Cell (CLC)" (DS70005298)
- "12-Bit A/D Converter with Threshold Detect" (DS39739)
- "Scalable Comparator Module" (DS39734)
- "Dual Comparator Module" (DS39710)
- "Charge Time Measurement Unit (CTMU) and CTMU Operation with Threshold Detect" (DS30009743)
- "High-Level Integration with Programmable High/Low-Voltage Detect (HLVD)" (DS39725)
- "Watchdog Timer (WDT)" (DS39697)
- "CodeGuard™ Intermediate Security" (DS70005182)
- "High-Level Device Integration" (DS39719)
- "Programming and Diagnostics" (DS39716)
- "Comparator Voltage Reference Module" (DS39709)

NOTES:

## 1.0 DEVICE OVERVIEW

This document contains device-specific information for the following devices:

- PIC24FJ64GA705 PIC24FJ256GA704
- PIC24FJ128GA705 PIC24FJ64GA702
- PIC24FJ256GA705
  - PIC24FJ256GA702

PIC24FJ128GA702

PIC24FJ64GA704PIC24FJ128GA704

The PIC24FJ256GA705 family introduces large Flash and SRAM memory in smaller package sizes. This is a 16-bit microcontroller family with a broad peripheral feature set and enhanced computational performance. This family also offers a new migration option for those high-performance applications which may be outgrowing their 8-bit platforms, but do not require the numerical processing power of a Digital Signal Processor (DSP).

 Table 1-3 lists the functions of the various pins shown in the pinout diagrams.

#### 1.1 Core Features

#### 1.1.1 16-BIT ARCHITECTURE

Central to all PIC24F devices is the 16-bit modified Harvard architecture, first introduced with Microchip's dsPIC<sup>®</sup> Digital Signal Controllers (DSCs). The PIC24F CPU core offers a wide range of enhancements, such as:

- 16-bit data and 24-bit address paths with the ability to move information between data and memory spaces
- Linear addressing of up to 12 Mbytes (program space) and 32 Kbytes (data)
- A 16-element Working register array with built-in software stack support
- A 17 x 17 hardware multiplier with support for integer math
- Hardware support for 32 by 16-bit division
- An instruction set that supports multiple addressing modes and is optimized for high-level languages, such as 'C'
- Operational performance up to 16 MIPS

#### 1.1.2 POWER-SAVING TECHNOLOGY

The PIC24FJ256GA705 family of devices includes Retention Sleep, a low-power mode with essential circuits being powered from a separate low-voltage regulator.

This new low-power mode also supports the continuous operation of the low-power, on-chip Real-Time Clock/ Calendar (RTCC), making it possible for an application to keep time while the device is otherwise asleep.

Aside from this new feature, PIC24FJ256GA705 family devices also include all of the legacy power-saving features of previous PIC24F microcontrollers, such as:

- On-the-Fly Clock Switching, allowing the selection of a lower power clock during run time
- Doze Mode Operation, for maintaining peripheral clock speed while slowing the CPU clock
- Instruction-Based Power-Saving Modes, for quick invocation of the Idle and Sleep modes

## 1.1.3 OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC24FJ256GA705 family offer six different oscillator options, allowing users a range of choices in developing application hardware. These include:

- · Two Crystal modes
- · External Clock (EC) mode
- A Phase-Locked Loop (PLL) frequency multiplier, which allows processor speeds up to 32 MHz
- An internal Fast RC Oscillator (FRC), a nominal 8 MHz output with multiple frequency divider options
- A separate internal Low-Power RC Oscillator (LPRC), 31 kHz nominal for low-power, timing-insensitive applications.

The internal oscillator block also provides a stable reference source for the Fail-Safe Clock Monitor (FSCM). This option constantly monitors the main clock source against a reference signal provided by the internal oscillator and enables the controller to switch to the internal oscillator, allowing for continued low-speed operation or a safe application shutdown.

#### 1.1.4 EASY MIGRATION

Regardless of the memory size, all devices share the same rich set of peripherals, allowing for a smooth migration path as applications grow and evolve. The consistent pinout scheme used throughout the entire family also aids in migrating from one device to the next larger device.

The PIC24F family is pin-compatible with devices in the dsPIC33 family, and shares some compatibility with the pinout schema for PIC18 and dsPIC30. This extends the ability of applications to grow from the relatively simple, to the powerful and complex, yet still selecting a Microchip device.

#### 1.2 DMA Controller

PIC24FJ256GA705 family devices have a Direct Memory Access (DMA) Controller. This module acts in concert with the CPU, allowing data to move between data memory and peripherals without the intervention of the CPU, increasing data throughput and decreasing execution time overhead. Six independently programmable channels make it possible to service multiple peripherals at virtually the same time, with each channel peripheral performing a different operation. Many types of data transfer operations are supported.

#### 1.3 Other Special Features

- Peripheral Pin Select: The Peripheral Pin Select (PPS) feature allows most digital peripherals to be mapped over a fixed set of digital I/O pins. Users may independently map the input and/or output of any one of the many digital peripherals to any one of the I/O pins.
- **Configurable Logic Cell:** The Configurable Logic Cell (CLC) module allows the user to specify combinations of signals as inputs to a logic function and to use the logic output to control other peripherals or I/O pins.
- **Timing Modules:** The PIC24FJ256GA705 family provides three independent, general purpose, 16-bit timers (two of which can be combined into a 32-bit timer). The devices also include 4 multiple output advanced Capture/Compare/PWM/Timer peripherals, and 3 independent legacy Input Capture and 3 independent legacy Output Compare modules.
- **Communications:** The PIC24FJ256GA705 family incorporates a range of serial communication peripherals to handle a range of application requirements. There are 2 independent I<sup>2</sup>C modules that support both Master and Slave modes of operation. Devices also have, through the PPS feature, 2 independent UARTs with built-in IrDA<sup>®</sup> encoders/decoders and 3 SPI modules.
- Analog Features: All members of the PIC24FJ256GA705 family include a 12-bit A/D Converter (A/D) module and a triple comparator module. The A/D module incorporates a range of new features that allow the converter to assess and make decisions on incoming data, reducing CPU overhead for routine A/D conversions. The comparator module includes three analog comparators that are configurable for a wide range of operations.
- CTMU Interface: In addition to their other analog features, members of the PIC24FJ256GA705 family include the CTMU interface module. This provides a convenient method for precision time measurement and pulse generation, and can serve as an interface for capacitive sensors.

- Enhanced Parallel Master/Parallel Slave Port: This module allows rapid and transparent access to the microcontroller data bus, and enables the CPU to directly address external data memory. The parallel port can function in Master or Slave mode, accommodating data widths of 4 or 8 bits and address widths of up to 10 bits in Master modes.
- Real-Time Clock and Calendar (RTCC): This module implements a full-featured clock and calendar with alarm functions in hardware, freeing up timer resources and program memory space for use of the core application.

#### 1.4 Details on Individual Family Members

Devices in the PIC24FJ256GA705 family are available in 28-pin, 44-pin and 48-pin packages. The general block diagram for all devices is shown in Figure 1-1.

The devices are differentiated from each other in five ways:

- Flash program memory (64 Kbytes for PIC24FJ64GA70X devices, 128 Kbytes for PIC24FJ128GA70X devices, 256 Kbytes for PIC24FJ256GA70X devices).
- 2. Available I/O pins and ports (22 pins on 2 ports for 28-pin devices, and 36 and 40 pins on 3 ports for 44-pin/48-pin devices).
- 3. Enhanced Parallel Master Port (EPMP) is only available on 44-pin/48-pin devices.
- 4. Analog input channels (10 channels for 28-pin devices and 14 channels for 44-pin/48-pin devices).
- CTMU input channels (12 channels for 28-pin devices and 13 channels for 44-pin/48-pin devices)

All other features for devices in this family are identical. These are summarized in Table 1-1 and Table 1-2.

A list of the pin features available on the PIC24FJ256GA705 family devices, sorted by function, is shown in Table 1-3. Note that this table shows the pin location of individual peripheral features and not how they are multiplexed on the same pin. This information is provided in the pinout diagrams in the beginning of this data sheet. Multiplexed features are sorted by the priority given to a feature, with the highest priority peripheral being listed first.

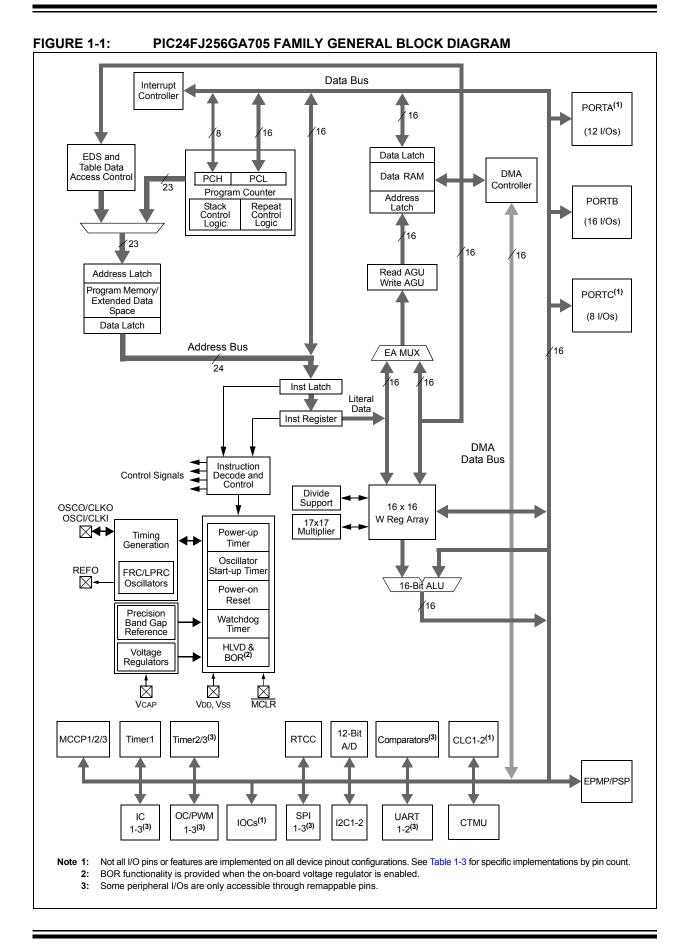
Features	PIC24FJ64GA702	PIC24FJ256GA702						
Operating Frequency	DC – 32 MHz							
Program Memory (bytes)	64K	128K	256K					
Program Memory (instruction words, 24 bits)	22,528	45,056	88,064					
Data Memory (bytes)		16K	•					
Interrupt Sources (soft vectors/NMI traps)		124						
I/O Ports		Ports A, B						
Total I/O Pins		22						
Remappable Pins		18 (18 I/Os, 0 input only)						
DMA		1 6-channel						
16-Bit Timers		3 <sup>(1)</sup>						
Real-Time Clock and Calendar (RTCC)		Yes						
Cyclic Redundancy Check (CRC)		Yes						
Input Capture Channels	3(1)							
Output Compare/PWM Channels	3(1)							
Input Change Notification Interrupt	21 (remappable pins)							
Serial Communications:								
UART	2 <sup>(1)</sup>							
SPI (3-wire/4-wire)		3(1)						
I <sup>2</sup> C		2						
Configurable Logic Cell (CLC)	2 <sup>(1)</sup>							
Parallel Communications (EPMP/PSP)		No						
Capture/Compare/PWM/Timer	4 Multiple CCPs							
Modules	1 (6-output), 3 (2-output)							
JTAG Boundary Scan	Yes							
10/12-Bit Analog-to-Digital Converter (A/D) Module (input channels)	10							
Analog Comparators	3							
CTMU Interface	Yes							
Universal Serial Bus Controller	No							
Resets (and Delays)	<u>Core</u> POR, VDD POR, BOR, RESET Instruction, MCLR, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (OST, PLL Lock)							
Instruction Set	76 Base Instructions, Multiple Addressing Mode Variations							
Packages	28-Pin QFN, UQFN, SOIC, SSOP and SPDIP							

#### TABLE 1-1: DEVICE FEATURES FOR THE PIC24FJXXXGA702: 28-PIN DEVICES

**Note 1:** Some peripherals are accessible through remappable pins.

Features	PIC24FJ64GA70X	PIC24FJ128GA70X	PIC24FJ256GA70X					
Operating Frequency	DC – 32 MHz							
Program Memory (bytes)	64K	128K	256K					
Program Memory (instruction words, 24 bits)	22,528	45,056	88,064					
Data Memory (bytes)		16K						
Interrupt Sources (soft vectors/NMI traps)		124						
I/O Ports		Ports A, B, C						
Total I/O Pins:								
44-pin	35	35	35					
48-pin	39	39	39					
Remappable Pins:								
44-pin		29 (29 I/Os, 0 input only)						
48-pin		33 (29 I/Os, 4 input only)						
DMA (6-channel)		1						
16-Bit Timers		3 <sup>(1)</sup>						
Real-Time Clock and Calendar (RTCC)	Yes							
Cyclic Redundancy Check (CRC)	Yes							
Input Capture Channels	3 <sup>(1)</sup>							
Output Compare/PWM Channels	3 <sup>(1)</sup>							
Input Change Notification Interrupt	25 (remappable pins)							
Serial Communications:								
UART		2 <sup>(1)</sup>						
SPI (3-wire/4-wire)		3 <sup>(1)</sup>						
l <sup>2</sup> C	2							
Configurable Logic Cell (CLC)	2 <sup>(1)</sup>							
Parallel Communications (EPMP/PSP)	Yes							
Capture/Compare/PWM/Timer Modules (MCCP)	4 Modules 1 (6-output), 3 (2-output)							
JTAG Boundary Scan	Yes							
10/12-Bit Analog-to-Digital Converter (A/D) Module (input channels)	14							
Analog Comparators		3						
CTMU Interface	Yes							
Universal Serial Bus Controller	No							
Resets (and delays)	Core POR, VDD POR, BOR, RESET Instruction, MCLR, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (OST, PLL Lock)							
Instruction Set	76 Base Instru	ctions, Multiple Addressing N	Mode Variations					
Packages	44-P	in TQFP, 48-Pin TQFP and L	JQFN					

**Note 1:** Some peripherals are accessible through remappable pins.



Dia	1	Pin Number/G	rid Locato			Input	
Pin Function	28-Pin SOIC, SSOP, SPDIP	28-Pin QFN, UQFN	44-Pin TQFP	48-Pin UQFN/TQFP	I/O	Buffer	Description
AN0	2	27	19	21	I	ANA	A/D Analog Inputs
AN1	3	28	20	22	I	ANA	
AN2	4	1	21	23	I	ANA	
AN3	5	2	22	24	I	ANA	
AN4	6	3	23	25	I	ANA	
AN5	7	4	24	26	I	ANA	]
AN6	25	22	14	15	I	ANA	
AN7	24	21	11	12	I	ANA	
AN8	23	20	10	11	Ι	ANA	
AN9	26	23	15	16	I	ANA	
AN10	—	_	25	27	I	ANA	
AN11	—	_	26	28	I	ANA	
AN12	—	_	27	29	I	ANA	
AN13	—	_	36	39	I	ANA	
AVDD	28	25	17	18	Р	—	Positive Supply for Analog modules
AVss	27	24	16	17	Р	—	Ground Reference for Analog modules
C1INA	7	4	24	26	Ι	ANA	Comparator 1 Input A
C1INB	6	3	23	25	Ι	ANA	Comparator 1 Input B
C1INC	18, 24	15, 21	1, 11	1, 12	Ι	ANA	Comparator 1 Input C
C1IND	9	6	30	33	Ι	ANA	Comparator 1 Input D
C2INA	5	2	22	24	I	ANA	Comparator 2 Input A
C2INB	4	1	21	23	Ι	ANA	Comparator 2 Input B
C2INC	18	15	1	1	Ι	ANA	Comparator 2 Input C
C2IND	10	7	31	34	Ι	ANA	Comparator 2 Input D
C3INA	26	23	15	16	I	ANA	Comparator 3 Input A
C3INB	25	22	14	15	I	ANA	Comparator 3 Input B
C3INC	2, 18	15, 27	1, 19	1, 21	I	ANA	Comparator 3 Input C
C3IND	3	28	20	22	I	ANA	Comparator 3 Input D
CLKI	9	6	30	33	_	—	Main Clock Input Connection
CLKO	10	7	31	34	0	DIG	System Clock Output
CTCMP	4	1	21	23	0	ANA	CTMU Comparator 2 Input (Pulse mode)

#### TABLE 1-3: PIC24FJ256GA705 FAMILY PINOUT DESCRIPTIONS

Legend: TTL = TTL input buffer ANA = Analog level input/output DIG = Digital input/output

ST = Schmitt Trigger input buffer

 $I^2C = I^2C/SMBus$  input buffer

Dim	F	Pin Number/G	rid Locator			Immunt	
Pin Function	28-Pin SOIC, SSOP, SPDIP	28-Pin QFN, UQFN	44-Pin TQFP	48-Pin UQFN/TQFP	I/O	Input Buffer	Description
CTED1	2	27	19	21	Ι	ST	CTMU External Edge Inputs
CTED2	3	28	20	22	Ι	ST	
CTED3	16	13	43	47	Ι	ST	
CTED4	18	15	1	1	Ι	ST	
CTED5	25	22	14	15	Ι	ST	
CTED6	26	23	15	16	Ι	ST	
CTED7	—	—	5	5	Ι	ST	
CTED8	7	4	24	26	Ι	ST	
CTED9	22	19	9	10	Ι	ST	
CTED10	17	14	44	48	Ι	ST	
CTED11	21	18	8	9	Ι	ST	
CTED12	5	2	22	24	Ι	ST	
CTED13	6	3	23	25	Ι	ST	
CTPLS	24	21	11	12	0	DIG	CTMU Pulse Output
CVREF	25	22	14	15	0	ANA	Comparator Voltage Reference Output
CVREF+	2	27	19	21	Ι	ANA	Comparator Voltage Reference (high) Input
CVREF-	3	28	20	22	Ι	ANA	Comparator Voltage Reference (low) Input
INT0	16	13	43	47	Ι	ST	External Interrupt Input 0
IOCA0	2	27	19	21	Ι	ST	PORTA Interrupt-on-Change
IOCA1	3	28	20	22	Ι	ST	
IOCA2	9	6	30	33	Ι	ST	
IOCA3	10	7	31	34	-	ST	
IOCA4	12	9	34	37	Ι	ST	
IOCA7	—	—	13	14	Ι	ST	
IOCA8	—	—	32	35	Ι	ST	
IOCA9	—	—	35	38	-	ST	
IOCA10	—	—	12	13	Ι	ST	]
IOCA11	—	—	_	8	Ι	ST	]
IOCA12	_	_	_	20	Ι	ST	]
IOCA13	_	_	_	32	I	ST	]
IOCA14		_	_	44	I	ST	]

Legend: TTL = TTL input buffer ANA = Analog level input/output DIG = Digital input/output ST = Schmitt Trigger input buffer  $I^2C = I^2C/SMBus$  input buffer

D:-	1	Pin Number/G	rid Locato	r			
Pin Function	28-Pin SOIC, SSOP, SPDIP	28-Pin QFN, UQFN	44-Pin TQFP	48-Pin UQFN/TQFP	I/O	Input Buffer	Description
IOCB0	4	1	21	23	I	ST	PORTB Interrupt-on-Change
IOCB1	5	2	22	24	Ι	ST	
IOCB2	6	3	23	25	Ι	ST	
IOCB3	7	4	24	26	Ι	ST	
IOCB4	11	8	33	36	Ι	ST	
IOCB5	14	11	41	45	I	ST	
IOCB6	15	12	42	46	I	ST	
IOCB7	16	13	43	47	I	ST	
IOCB8	17	14	44	48	I	ST	
IOCB9	18	15	1	1	I	ST	
IOCB10	21	18	8	9	I	ST	
IOCB11	22	19	9	10	Ι	ST	
IOCB12	23	20	10	11	Ι	ST	
IOCB13	24	21	11	12	Ι	ST	
IOCB14	25	22	14	15	Ι	ST	
IOCB15	26	23	15	16	Ι	ST	
IOCC1	_	—	26	28	Ι	ST	PORTC Interrupt-on-Change
IOCC2	_		27	29	Ι	ST	
IOCC3	_	—	36	39	Ι	ST	
IOCC4	_	_	37	40	I	ST	
IOCC5	_	_	38	41	I	ST	
IOCC6	_	—	2	2	I	ST	
IOCC7	—	_	3	3	I	ST	
IOCC8	_	_	4	4	Ι	ST	
IOCC9	_	—	5	5	I	ST	
MCLR	1	26	18	19	Ι	ST	Master Clear (device Reset) Input. This line is brought low to cause a Reset.
OCM1A	16	13	43	47	0	DIG	MCCP1 Outputs
OCM1B	17	14	44	48	0	DIG	
OCM1C	21	18	8	9	0	DIG	1
OCM1D	24	21	11	12	0	DIG	1
OCM1E	14	11	41	45	0	DIG	1
OCM1F	15	12	42	46	0	DIG	1
OSCI	9	6	30	33	I	ANA/ST	Main Oscillator Input Connection
OSCO	10	7	31	34	0	ANA	Main Oscillator Output Connection

Legend: TTL = TTL input buffer ANA = Analog level input ST = Schmitt Trigger input buffer

ANA = Analog level input/output DIG = Digital input/output  $I^2C = I^2C/SMBus$  input buffer

Pin	F	Pin Number/G	rid Locator	•		Innut	
Function		Input Buffer	Description				
PGC1	5	2	22	24	I	ST	ICSP™ Programming Clock
PGC2	22	19	9	10	Ι	ST	
PGC3	15	12	42	46	Ι	ST	
PGD1	4	1	21	23	I/O	DIG/ST	ICSP Programming Data
PGD2	21	18	8	9	I/O	DIG/ST	
PGD3	14	11	41	45	I/O	DIG/ST	
PMA0	—	—	3	3	I/O	DIG/ST/ TTL	Parallel Master Port Address<0>/ Address Latch Low
PMA1	—	—	2	2	I/O	DIG/ST/ TTL	Parallel Master Port Address<1>/ Address Latch High
PMA2	—	—	12	13	I/O	DIG/ST/ TTL	Parallel Master Port Address<2>
PMA3	—	_	38	41	I/O	DIG/ST/ TTL	Parallel Master Port Address<3>
PMA4	—	_	37	40	I/O	DIG/ST/ TTL	Parallel Master Port Address<4>
PMA5	—	_	4	4	I/O	DIG/ST/ TTL	Parallel Master Port Address<5>
PMA6	—	_	5	5	I/O	DIG/ST/ TTL	Parallel Master Port Address<6>
PMA7	—	—	13	14	I/O	DIG/ST/ TTL	Parallel Master Port Address<7>
PMA8	—	—	32	35	I/O	DIG/ST/ TTL	Parallel Master Port Address<8>
PMA9	-	—	35	38	I/O	DIG/ST/ TTL	Parallel Master Port Address<9>
PMA14/PMCS/ PMCS1	-	—	15	16	I/O	DIG/ST/ TTL	Parallel Master Port Address<14>/ Slave Chip Select/Chip Select 1 Strobe

Legend: TTL = TTL input buffer ANA = Analog level input/output DIG = Digital input/output ST = Schmitt Trigger input buffer  $I^2C = I^2C/SMBus$  input buffer

XCVR = Dedicated Transceiver

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Pin	F	Pin Number/G	rid Locator			Innut	
Function	28-Pin SOIC, SSOP, SPDIP	28-Pin QFN, UQFN	44-Pin TQFP	48-Pin UQFN/TQFP	I/O	Input Buffer	Description
PMD0	_	_	10	11	I/O	DIG/ST/ TTL	Parallel Master Port Data (Demultiplexed Master mode) or Address/Data
PMD1	—	—	9	10	I/O	DIG/ST/ TTL	(Multiplexed Master modes)
PMD2	—	Ι	8	9	I/O	DIG/ST/ TTL	
PMD3	—	—	1	1	I/O	DIG/ST/ TTL	
PMD4	—	—	44	48	I/O	DIG/ST/ TTL	
PMD5	—	Ι	43	47	I/O	DIG/ST/ TTL	
PMD6	—	—	42	46	I/O	DIG/ST/ TTL	
PMD7	—	—	41	45	I/O	DIG/ST/ TTL	
PMRD/PMWR	_	_	11	12	I/O	DIG/ST/ TTL	Parallel Master Port Read Strobe/ Write Strobe
PMWR/PMENB	—	—	14	15	I/O	DIG/ST/ TTL	Parallel Master Port Write Strobe/ Enable Strobe
PWRGT	—	_	_	—	0	DIG	Real-Time Clock Power Control Output
PWRLCLK	12	9	34	37	I	ST	Real-Time Clock 50/60 Hz Clock Input

**Legend:** TTL = TTL input buffer

ANA = Analog level input/output DIG = Digital input/output ST = Schmitt Trigger input buffer

 $I^2C = I^2C/SMBus$  input buffer

Dim	F	Pin Number/G	rid Locator				
Pin Function	28-Pin SOIC, SSOP, SPDIP	28-Pin QFN, UQFN	44-Pin TQFP	48-Pin UQFN/TQFP	I/O	Input Buffer	Description
RA0	2	27	19	21	I/O	DIG/ST	PORTA Digital I/Os
RA1	3	28	20	22	I/O	DIG/ST	
RA2	9	6	30	33	I/O	DIG/ST	
RA3	10	7	31	34	I/O	DIG/ST	
RA4	12	9	34	37	I/O	DIG/ST	
RA7	—	_	13	14	I/O	DIG/ST	
RA8	—	_	32	35	I/O	DIG/ST	
RA9	—	_	35	38	I/O	DIG/ST	
RA10	—	_	12	13	I/O	DIG/ST	
RA11	—	_	_	8	I/O	DIG/ST	
RA12	—	_	_	20	I/O	DIG/ST	
RA13	—	_	_	32	I/O	DIG/ST	
RA14	—	_	_	44	I/O	DIG/ST	
RB0	4	1	21	23	I/O	DIG/ST	PORTB Digital I/Os
RB1	5	2	22	24	I/O	DIG/ST	
RB2	6	3	23	25	I/O	DIG/ST	
RB3	7	4	24	26	I/O	DIG/ST	
RB4	11	8	33	36	I/O	DIG/ST	
RB5	14	11	41	45	I/O	DIG/ST	
RB6	15	12	42	46	I/O	DIG/ST	
RB7	16	13	43	47	I/O	DIG/ST	
RB8	17	14	44	48	I/O	DIG/ST	
RB9	18	15	1	1	I/O	DIG/ST	
RB10	21	18	8	9	I/O	DIG/ST	
RB11	22	19	9	10	I/O	DIG/ST	
RB12	23	20	10	11	I/O	DIG/ST	
RB13	24	21	11	12	I/O	DIG/ST	
RB14	25	22	14	15	I/O	DIG/ST	
RB15	26	23	15	16	I/O	DIG/ST	
RC0	—	_	25	27	I/O	DIG/ST	PORTC Digital I/Os
RC1	—	—	26	28	I/O	DIG/ST	]
RC2	_	_	27	29	I/O	DIG/ST	
RC3	_	_	36	39	I/O	DIG/ST	]
RC4	—	_	37	40	I/O	DIG/ST	]
RC5	_	_	38	41	I/O	DIG/ST	
RC6	_	—	2	2	I/O	DIG/ST	]
RC7	_	_	3	3	I/O	DIG/ST	]
RC8	_	_	4	4	I/O	DIG/ST	
RC9	_	_	5	5	I/O	DIG/ST	

Legend: TTL = TTL input buffer ANA = Analog level input/output DIG = Digital input/output ST = Schmitt Trigger input buffer  $I^2C = I^2C/SMBus$  input buffer XCVR = Dedicated Transceiver

Din	1	Pin Number/G	rid Locator				
Pin Functior	28-Pin SOIC, SSOP, SPDIP	28-Pin QFN, UQFN	44-Pin TQFP	48-Pin UQFN/TQFP	I/O	Input Buffer	Description
RP0	4	1	21	23	I/O	DIG/ST	Remappable Peripherals
RP1	5	2	22	24	I/O	DIG/ST	(input or output)
RP2	6	3	23	25	I/O	DIG/ST	
RP3	7	4	24	26	I/O	DIG/ST	
RP4	11	8	33	36	I/O	DIG/ST	
RP5	14	11	41	45	I/O	DIG/ST	
RP6	15	12	42	46	I/O	DIG/ST	
RP7	16	13	43	47	I/O	DIG/ST	
RP8	17	14	44	48	I/O	DIG/ST	
RP9	18	15	1	1	I/O	DIG/ST	
RP10	21	18	8	9	I/O	DIG/ST	
RP11	22	19	9	10	I/O	DIG/ST	
RP12	23	20	10	11	I/O	DIG/ST	-
RP13	24	21	11	12	I/O	DIG/ST	
RP14	25	22	14	15	I/O	DIG/ST	-
RP15	26	23	15	16	I/O	DIG/ST	-
RP16	_	_	25	27	I/O	DIG/ST	
RP17	_	_	26	28	I/O	DIG/ST	
RP18	_	_	27	29	I/O	DIG/ST	
RP19	_	_	36	39	I/O	DIG/ST	
RP20	_	—	37	40	I/O	DIG/ST	
RP21	_	_	38	41	I/O	DIG/ST	-
RP22	_	—	2	2	I/O	DIG/ST	
RP23	_	—	3	3	I/O	DIG/ST	
RP24	_	_	4	4	I/O	DIG/ST	-
RP25	_	_	5	5	I/O	DIG/ST	1
RP26	2	27	19	21	I/O	DIG/ST	1
RP27	3	28	20	22	I/O	DIG/ST	1
RP28	_	_	12	13	I/O	DIG/ST	1
RPI29	—		_	8	Ι	DIG/ST	Remappable Peripherals
RPI30	_	—	_	20	Ι	DIG/ST	(input only)
RPI31	_	_	_	32	Ι	DIG/ST	1
RPI32		_	_	44	Ι	DIG/ST	1

Legend: TTL = TTL input buffer ANA = Analog level input/output DIG = Digital input/output ST = Schmitt Trigger input buffer

 $I^2C = I^2C/SMBus input buffer$ 

Dia	i	Pin Number/G	rid Locator					
Pin Function	28-Pin SOIC, SSOP, SPDIP	28-Pin QFN, UQFN	44-Pin TQFP	48-Pin UQFN/TQFP	I/O	Input Buffer	Description	
SCL1	17	14	44	48	I/O	l <sup>2</sup> C	I2C1 Synchronous Serial Clock Input/Output	
SCL2	7	4	24	26	I/O	l <sup>2</sup> C	I2C2 Synchronous Serial Clock Input/Output	
SDA1	18	15	1	1	I/O	l <sup>2</sup> C	I2C1 Data Input/Output	
SDA2	6	3	23	25	I/O	l <sup>2</sup> C	I2C2 Data Input/Output	
SOSCI	11	8	33	36	Ι	ANA/ST	Secondary Oscillator/Timer1 Clock Input	
SOSCO	12	9	34	37	0	ANA	Secondary Oscillator/Timer1 Clock Output	
T1CK	18	15	1	1	-	ST	Timer1 Clock	
ТСК	17	14	13	14		ST	JTAG Test Clock/Programming Clock Input	
TDI	21	18	35	38	-	ST	JTAG Test Data/Programming Data Input	
TDO	18	15	32	35	0	DIG	JTAG Test Data Output	
TMPRN	18	15	1	1	-	ST	Tamper Detect Input	
TMS	22	19	12	13	Ι	ST	JTAG Test Mode Select Input	
VCAP	20	17	7	7	Р	—	External Filter Capacitor Connection (regulator enabled)	
Vdd	13, 28	10, 25	28, 40	30, 43	Ρ	—	Positive Supply for Peripheral Digital Logic and I/O Pins	
VREF+	2	27	19	21	Ι	ANA	Comparator and A/D Reference Voltage (high) Input	
VREF-	3	28	20	22	I	ANA	Comparator and A/D Reference Voltage (low) Input	
Vss	8, 19, 27	5, 16, 24	6, 29, 39	6, 31, 42	Р	—	Ground Reference for Peripheral Digital Logic and I/O Pins	

TTL = TTL input buffer Legend: ANA = Analog level input/output DIG = Digital input/output

ST = Schmitt Trigger input buffer  $I^2C = I^2C/SMBus$  input buffer

NOTES:

### 2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT MICROCONTROLLERS

#### 2.1 Basic Connection Requirements

Getting started with the PIC24FJ256GA705 family of 16-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and VSS pins (see Section 2.2 "Power Supply Pins")
- All AVDD and AVss pins, regardless of whether or not the analog device features are used (see Section 2.2 "Power Supply Pins")
- MCLR pin (see Section 2.3 "Master Clear (MCLR) Pin")

 VCAP pin (see Section 2.4 "Voltage Regulator Pin (VCAP)")

These pins must also be connected if they are being used in the end application:

- PGCx/PGDx pins used for In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>) and debugging purposes (see Section 2.5 "ICSP Pins")
- OSCI and OSCO pins when an external oscillator source is used

(see Section 2.6 "External Oscillator Pins")

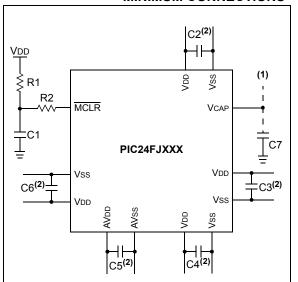
Additionally, the following pins may be required:

• VREF+/VREF- pins used when external voltage reference for analog modules is implemented

**Note:** The AVDD and AVss pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

#### FIGURE 2-1: RECOMMENDED MINIMUM CONNECTIONS



#### Key (all values are recommendations):

C1 through C6: 0.1 µF, 50V ceramic

C7: 10 µF, 16V or greater, ceramic

R1: 10 kΩ

R2: 100Ω to 470Ω

- Note 1: See Section 2.4 "Voltage Regulator Pin (VCAP)" for an explanation of voltage regulator pin connections.
  - 2: The example shown is for a PIC24F device with five VDD/VSs and AVDD/AVSs pairs. Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

#### 2.2 Power Supply Pins

#### 2.2.1 DECOUPLING CAPACITORS

The use of decoupling capacitors on every pair of power supply pins, such as VDD, VSS, AVDD and AVSS, is required.

Consider the following criteria when using decoupling capacitors:

- Value and type of capacitor: A 0.1  $\mu$ F (100 nF), 25V-50V capacitor is recommended. The capacitor should be a low-ESR device with a self-resonance frequency in the range of 200 MHz and higher. Ceramic capacitors are recommended.
- Placement on the printed circuit board: The decoupling capacitors should be placed as close to the pins as possible. It is recommended to place the capacitors on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is no greater than 0.25 inch (6 mm).
- Handling high-frequency noise: If the board is experiencing high-frequency noise (upward of tens of MHz), add a second ceramic type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01  $\mu$ F to 0.001  $\mu$ F. Place this second capacitor next to each primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible (e.g., 0.1  $\mu$ F in parallel with 0.001  $\mu$ F).
- Maximizing performance: On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum, thereby reducing PCB trace inductance.

#### 2.2.2 BULK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a bulk capacitance of 10  $\mu$ F or greater located near the MCU. The value of the capacitor should be determined based on the trace resistance that connects the power supply source to the device, and the maximum current drawn by the device in the application. Typical values range from 10  $\mu$ F to 47  $\mu$ F. The capacitor should be ceramic and have a voltage rating of 25V or more to reduce DC bias effects (see Section 2.4.1 "Considerations for Ceramic Capacitors").

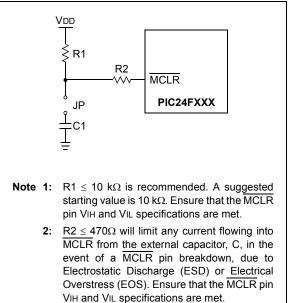
### 2.3 Master Clear (MCLR) Pin

The MCLR pin provides two specific device functions: device Reset, and device programming and debugging. If programming and debugging are not required in the end application, a direct connection to VDD may be all that is required. The addition of other components, to help increase the application's resistance to spurious Resets from voltage sags, may be beneficial. A typical configuration is shown in Figure 2-1. Other circuit designs may be implemented depending on the application's requirements.

During programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R1 and C1 will need to be adjusted based on the application and PCB requirements. For example, it is recommended that the capacitor, C1, be isolated from the MCLR pin during programming and debugging operations by using a jumper (Figure 2-2). The jumper is replaced for normal run-time operations.

Any components associated with the  $\overline{\text{MCLR}}$  pin should be placed within 0.25 inch (6 mm) of the pin.

#### FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS



#### 2.4 Voltage Regulator Pin (VCAP)

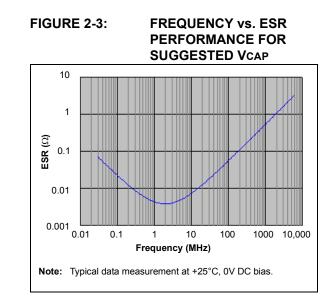
**Note:** This section applies only to PIC24FJ devices with an on-chip voltage regulator.

Refer to **Section 29.3 "On-Chip Voltage Regulator"** for details on connecting and using the on-chip regulator.

A low-ESR (< 5 $\Omega$ ) capacitor is required on the VCAP pin to stabilize the voltage regulator output voltage. The VCAP pin must not be connected to VDD and must use a capacitor of 10  $\mu$ F connected to ground. The type can be ceramic or tantalum. Suitable examples of capacitors are shown in Table 2-1. Capacitors with equivalent specifications can be used.

Designers may use Figure 2-3 to evaluate the ESR equivalence of candidate devices.

The placement of this capacitor should be close to VCAP. It is recommended that the trace length not exceed 0.25 inch (6 mm). Refer to **Section 32.0** "**Electrical Characteristics**" for additional information.



#### TABLE 2-1: SUITABLE CAPACITOR EQUIVALENTS (0805 CASE SIZE)

Make	Part #	Nominal Capacitance	Base Tolerance	Rated Voltage
TDK	C2012X5R1E106K085AC	10 µF	±10%	25V
TDK	C2012X5R1C106K085AC	10 µF	±10%	16V
Kemet	C0805C106M4PACTU	10 µF	±10%	16V
Murata	GRM21BR61E106KA3L	10 µF	±10%	25V
Murata	GRM21BR61C106KE15	10 µF	±10%	16V

#### 2.4.1 CONSIDERATIONS FOR CERAMIC CAPACITORS

In recent years, large value, low-voltage, surface-mount ceramic capacitors have become very cost effective in sizes up to a few tens of microfarad. The low-ESR, small physical size and other properties make ceramic capacitors very attractive in many types of applications.

Ceramic capacitors are suitable for use with the internal voltage regulator of this microcontroller. However, some care is needed in selecting the capacitor to ensure that it maintains sufficient capacitance over the intended operating range of the application.

Typical low-cost, 10 µF ceramic capacitors are available in X5R, X7R and Y5V dielectric ratings (other types are also available, but are less common). The initial tolerance specifications for these types of capacitors are often specified as ±10% to ±20% (X5R and X7R) or -20%/ +80% (Y5V). However, the effective capacitance that these capacitors provide in an application circuit will also vary based on additional factors, such as the applied DC bias voltage and the temperature. The total in-circuit tolerance is, therefore, much wider than the initial tolerance specification.

The X5R and X7R capacitors typically exhibit satisfactory temperature stability (ex: ±15% over a wide temperature range, but consult the manufacturer's data sheets for exact specifications). However, Y5V capacitors typically have extreme temperature tolerance specifications of +22%/-82%. Due to the extreme temperature tolerance, a 10 µF nominal rated Y5V type capacitor may not deliver enough total capacitance to meet minimum internal voltage regulator stability and transient response requirements. Therefore, Y5V capacitors are not recommended for use with the internal regulator if the application must operate over a wide temperature range.

In addition to temperature tolerance, the effective capacitance of large value ceramic capacitors can vary substantially, based on the amount of DC voltage applied to the capacitor. This effect can be very significant, but is often overlooked or is not always documented.

A typical DC bias voltage vs. capacitance graph for X7R type capacitors is shown in Figure 2-4.

#### FIGURE 2-4: DC BIAS VOLTAGE vs. CAPACITANCE **CHARACTERISTICS** Change (%) 0 -10 -20 -30 Capacitance -40 -50 -60 -70 6.3V Capacitor

When selecting a ceramic capacitor to be used with the internal voltage regulator, it is suggested to select a high-voltage rating so that the operating voltage is a small percentage of the maximum rated capacitor voltage. For example, choose a ceramic capacitor rated at a minimum of 16V for the 1.8V core voltage. Suggested capacitors are shown in Table 2-1.

DC Bias Voltage (VDC)

10 11 12

#### 2.5 **ICSP** Pins

-80

2 3

The PGCx and PGDx pins are used for In-Circuit Serial Programming (ICSP) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed  $100\Omega$ .

Pull-up resistors, series diodes and capacitors on the PGCx and PGDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin Voltage Input High (VIH) and Voltage Input Low (VIL) requirements.

For device emulation, ensure that the "Communication Channel Select" pins (i.e., PGCx/PGDx) programmed into the device match the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to Section 30.0 "Development Support".

#### 2.6 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency Primary Oscillator and a low-frequency Secondary Oscillator (refer to Section 9.0 "Oscillator Configuration" for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-5. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

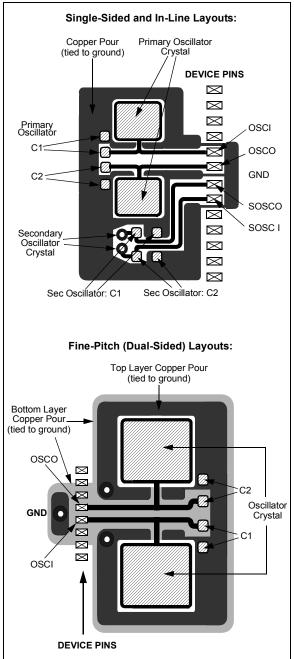
In planning the application's routing and I/O assignments, ensure that adjacent port pins, and other signals in close proximity to the oscillator, are benign (i.e., free of high frequencies, short rise and fall times and other similar noise).

For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- AN943, "Practical PICmicro<sup>®</sup> Oscillator Analysis and Design"
- AN949, "Making Your Oscillator Work"
- AN1798, "Crystal Selection for Low-Power Secondary Oscillator"

## FIGURE 2-5: SUGGESTED

#### PLACEMENT OF THE OSCILLATOR CIRCUIT



#### 2.7 Configuration of Analog and Digital Pins During ICSP Operations

If an ICSP compliant emulator is selected as a debugger, it automatically initializes all of the A/D input pins (ANx) as "digital" pins. This is done by clearing all bits in the ANSx registers. Refer to **Section 11.2** "**Configuring Analog Port Pins (ANSx)**" for more specific information.

The bits in these registers that correspond to the A/D pins that initialized the emulator must not be changed by the user application firmware; otherwise, communication errors will result between the debugger and the device.

If your application needs to use certain A/D pins as analog input pins during the debug session, the user application must modify the appropriate bits during initialization of the A/D module, as follows:

 Set the bits corresponding to the pin(s) to be configured as analog. Do not change any other bits, particularly those corresponding to the PGCx/PGDx pair, at any time. When a Microchip debugger/emulator is used as a programmer, the user application firmware must correctly configure the ANSx registers. Automatic initialization of these registers is only done during debugger operation. Failure to correctly configure the register(s) will result in all A/D pins being recognized as analog input pins, resulting in the port value being read as a logic '0', which may affect user application functionality.

#### 2.8 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 k $\Omega$  to 10 k $\Omega$  resistor to Vss on unused pins and drive the output to logic low.

#### 3.0 CPU

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the CPU, refer to the "dsPIC33/PIC24 Family Reference Manual", "CPU with Extended Data Space (EDS)" (DS39732), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The PIC24F CPU has a 16-bit (data) modified Harvard architecture with an enhanced instruction set and a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M instructions of user program memory space. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double-word move (MOV.D) instruction and the table instructions. Overhead-free program loop constructs are supported using the REPEAT instructions, which are interruptible at any point.

PIC24F devices have sixteen, 16-bit Working registers in the programmer's model. Each of the Working registers can act as a Data, Address or Address Offset register. The 16<sup>th</sup> Working register (W15) operates as a Software Stack Pointer (SSP) for interrupts and calls.

The lower 32 Kbytes of the Data Space (DS) can be accessed linearly. The upper 32 Kbytes of the Data Space are referred to as Extended Data Space (EDS), to which the extended data RAM, EPMP memory space or program memory can be mapped.

The Instruction Set Architecture (ISA) has been significantly enhanced beyond that of the PIC18, but maintains an acceptable level of backward compatibility. All PIC18 instructions and addressing modes are supported, either directly, or through simple macros. Many of the ISA enhancements have been driven by compiler efficiency needs.

The core supports Inherent (no operand), Relative, Literal, Memory Direct Addressing modes along with three groups of addressing modes. All modes support Register Direct and various Register Indirect modes. Each group offers up to seven addressing modes. Instructions are associated with predefined addressing modes depending upon their functional requirements.

For most instructions, the core is capable of executing a data (or program data) memory read, a Working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing trinary operations (for example, A + B = C) to be executed in a single cycle.

A high-speed, 17-bit x 17-bit multiplier has been included to significantly enhance the core arithmetic capability and throughput. The multiplier supports Signed, Unsigned and Mixed mode, 16-bit x 16-bit or 8-bit x 8-bit, integer multiplication. All multiply instructions execute in a single cycle.

The 16-bit ALU has been enhanced with integer divide assist hardware that supports an iterative non-restoring divide algorithm. It operates in conjunction with the REPEAT instruction looping mechanism and a selection of iterative divide instructions to support 32-bit (or 16-bit), divided by 16-bit, integer signed and unsigned division. All divide operations require 19 cycles to complete but are interruptible at any cycle boundary.

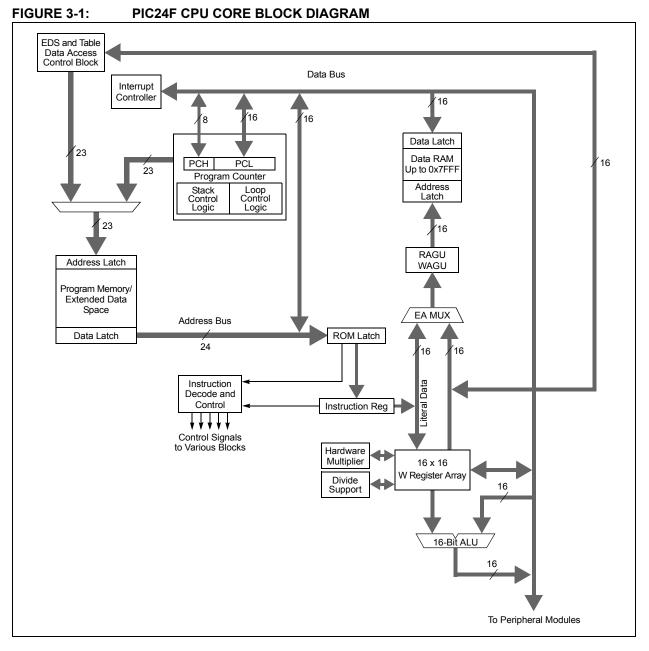
The PIC24F has a vectored exception scheme with up to 8 sources of non-maskable traps and up to 118 interrupt sources. Each interrupt source can be assigned to one of seven priority levels.

A block diagram of the CPU is shown in Figure 3-1.

#### 3.1 Programmer's Model

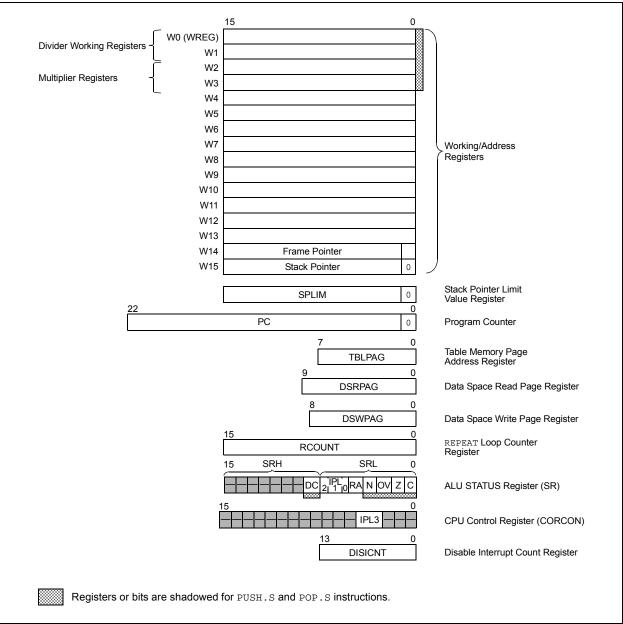
The programmer's model for the PIC24F is shown in Figure 3-2. All registers in the programmer's model are memory-mapped and can be manipulated directly by instructions.

A description of each register is provided in Table 3-1. All registers associated with the programmer's model are memory-mapped.



Register(s) Name	Description	
W0 through W15	Working Register Array	
PC	23-Bit Program Counter	
SR	ALU STATUS Register	
SPLIM	Stack Pointer Limit Value Register	
TBLPAG	Table Memory Page Address Register	
RCOUNT	REPEAT Loop Counter Register	
CORCON	CPU Control Register	
DISICNT	Disable Interrupt Count Register	
DSRPAG	Data Space Read Page Register	
DSWPAG	Data Space Write Page Register	





# 3.2 CPU Control Registers

### REGISTER 3-1: SR: ALU STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0			
_	_	_	_	_	—	—	DC			
bit 15							bit			
R/W-0 <sup>(1)</sup>	R/W-0 <sup>(1)</sup>	R/W-0 <sup>(1)</sup>	R-0	R/W-0	R/W-0	R/W-0	R/W-0			
IPL2 <sup>(2)</sup>	IPL1 <sup>(2)</sup>	IPL0 <sup>(2)</sup>	RA	N	OV	Z	С			
bit 7							bit			
Legend:										
R = Readable b	oit	W = Writable b	it	U = Unimpler	nented bit, read	l as '0'				
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	nown			
bit 15-9	Unimplemen	ted: Read as '0'								
bit 8 l	DC: ALU Half	f Carry/Borrow b	it							
	1 = A carry o	ut from the 4 <sup>th</sup> lo	w-order bit (	for byte-sized da	ata) or 8 <sup>th</sup> low-o	order bit (for wo	ord-sized data			
	of the res	sult occurred		-	·					
	0 = No carry	out from the 4 <sup>th</sup>	or 8 <sup>th</sup> low-or	der bit of the res	sult has occurre	ed				
bit 7-5 I	IPL<2:0>: CF	PU Interrupt Prior	rity Level Sta	tus bits <sup>(1,2)</sup>						
	111 = CPU lr	nterrupt Priority I	evel is 7 (15	;); user interrupt	s are disabled					
	110 = CPU Interrupt Priority Level is 6 (14)									
	101 = CPU Interrupt Priority Level is 5 (13)									
	100 = CPU Interrupt Priority Level is 4 (12)									
		nterrupt Priority I								
		nterrupt Priority I								
	001 = CPU lr	nterrupt Priority I	Level is 1 (9)							
		nterrupt Priority I Loop Active bit								
		•								
		oop is in progres								
	N: ALU Nega		-							
	1 = Result wa	Ų								
		as not negative (	zero or posit	ve)						
	OV: ALU Ove									
		occurred for sigr	ned (2's com	plement) arithm	etic in this arith	metic operatio	n			
bit 1	<b>z:</b> ALU Zero I	oit								
	1 = An operat	tion, which affect	s the Z bit, h	as set it at some	e time in the pa	ist				
		recent operation	n, which affe	cts the Z bit, has	cleared it (i.e.	, a non-zero re	sult)			
	C: ALU Carry									
		ut from the Most								
	0 = No carry (	out from the Mos	st Significant	bit of the result	occurred					
Note 1: The	IPLx Status h	oits are read-only	when NSTI	DIS (INTCON1<	15>) = 1					
		oits are concater				) to form the C				

2: The IPLx Status bits are concatenated with the IPL3 Status bit (CORCON<3>) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL when IPL3 = 1.

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	R/C-0	R/W-1	U-0	U-0
	—	—	—	IPL3 <sup>(1)</sup>	PSV <sup>(2)</sup>	—	—
bit 7				•			bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-4	Unimplemented: Read as '0'
bit 3	IPL3: CPU Interrupt Priority Level Status bit <sup>(1)</sup>
	<ul> <li>1 = CPU Interrupt Priority Level is greater than 7</li> <li>0 = CPU Interrupt Priority Level is 7 or less</li> </ul>
bit 2	<b>PSV:</b> Program Space Visibility (PSV) in Data Space Enable <sup>(2)</sup>
	<ul><li>1 = Program space is visible in Data Space</li><li>0 = Program space is not visible in Data Space</li></ul>
bit 1-0	Unimplemented: Read as '0'

Note 1: The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level; see Register 3-1 for bit description.

2: If PSV = 0, any reads from data memory at 0x8000 and above will cause an address trap error instead of reading from the PSV section of program memory. This bit is not individually addressable.

# 3.3 Arithmetic Logic Unit (ALU)

The PIC24F ALU is 16 bits wide and is capable of addition, subtraction, bit shifts and logic operations. Unless otherwise mentioned, arithmetic operations are 2's complement in nature. Depending on the operation, the ALU may affect the values of the Carry (C), Zero (Z), Negative (N), Overflow (OV) and Digit Carry (DC) Status bits in the SR register. The C and DC Status bits operate as Borrow and Digit Borrow bits, respectively, for subtraction operations.

The ALU can perform 8-bit or 16-bit operations, depending on the mode of the instruction that is used. Data for the ALU operation can come from the W register array, or data memory, depending on the addressing mode of the instruction. Likewise, output data from the ALU can be written to the W register array or a data memory location.

The PIC24F CPU incorporates hardware support for both multiplication and division. This includes a dedicated hardware multiplier and support hardware for 16-bit divisor division.

## 3.3.1 MULTIPLIER

The ALU contains a high-speed, 17-bit x 17-bit multiplier. It supports unsigned, signed or mixed sign operation in several multiplication modes:

- 16-bit x 16-bit signed
- 16-bit x 16-bit unsigned
- 16-bit signed x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit unsigned
- 16-bit unsigned x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit signed
- · 8-bit unsigned x 8-bit unsigned

# 3.3.2 DIVIDER

The divide block supports 32-bit/16-bit and 16-bit/16-bit signed and unsigned integer divide operations with the following data sizes:

- 1. 32-bit signed/16-bit signed divide
- 2. 32-bit unsigned/16-bit unsigned divide
- 3. 16-bit signed/16-bit signed divide
- 4. 16-bit unsigned/16-bit unsigned divide

The quotient for all divide instructions ends up in W0 and the remainder in W1. The 16-bit signed and unsigned DIV instructions can specify any W register for both the 16-bit divisor (Wn), and any W register (aligned) pair (W(m + 1):Wm) for the 32-bit dividend. The divide algorithm takes one cycle per bit of divisor, so both 32-bit/16-bit and 16-bit/16-bit instructions take the same number of cycles to execute.

## 3.3.3 MULTI-BIT SHIFT SUPPORT

The PIC24F ALU supports both single bit and singlecycle, multi-bit arithmetic and logic shifts. Multi-bit shifts are implemented using a shifter block, capable of performing up to a 15-bit arithmetic right shift, or up to a 15-bit left shift, in a single cycle. All multi-bit shift instructions only support Register Direct Addressing for both the operand source and result destination.

A full summary of instructions that use the shift operation is provided in Table 3-2.

#### TABLE 3-2: INSTRUCTIONS THAT USE THE SINGLE BIT AND MULTI-BIT SHIFT OPERATION

Instruction Description	
ASR	Arithmetic Shift Right Source register by one or more bits.
SL	Shift Left Source register by one or more bits.
LSR	Logical Shift Right Source register by one or more bits.

# 4.0 MEMORY ORGANIZATION

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "PIC24F Flash Program Memory" (DS30009715), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

As Harvard architecture devices, PIC24F microcontrollers feature separate program and data memory spaces and buses. This architecture also allows direct access of program memory from the Data Space during code execution.

# 4.1 Program Memory Space

The program address memory space of the PIC24FJ256GA705 family devices is 4M instructions. The space is addressable by a 24-bit value derived from either the 23-bit Program Counter (PC) during program execution, or from table operation or Data Space remapping, as described in Section 4.3 "Interfacing Program and Data Memory Spaces".

User access to the program memory space is restricted to the lower half of the address range (000000h to 7FFFFFh). The exception is the use of TBLRD/TBLWT operations, which use TBLPAG<7> to permit access to the Configuration bits and customer OTP sections of the configuration memory space.

The memory map for the PIC24FJ256GA705 family of devices is shown in Figure 4-1.

# PIC24FJ256GA705 FAMILY

#### FIGURE 4-1: PROGRAM SPACE MEMORY MAP FOR PIC24FJ256GA705 DEVICES

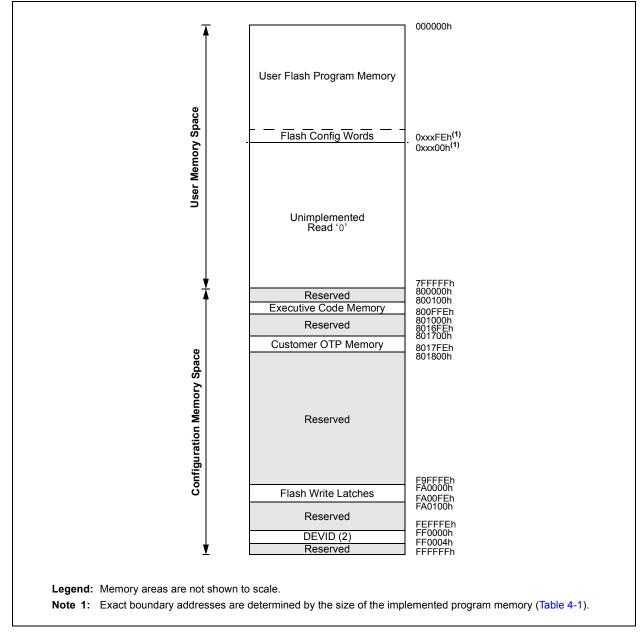


TABLE 4-1:	PROGRAM MEMORY SIZES AND BOUNDARIES <sup>(2)</sup>

Device	Program Memory Upper Boundary (Instruction Words)	Write Blocks <sup>(1)</sup>	Erase Blocks <sup>(1)</sup>
PIC24FJ256GA70X	02AFFEh (88,064 x 24)	1376	172
PIC24FJ128GA70X	015FFEh (45,056 x 24)	704	88
PIC24FJ64GA70X	00AFFEh (22,528 x 24)	352	44

Note 1: 1 Write Block = 128 Instruction Words; 1 Erase Block (Page) = 1024 Instruction Words.

2: To maintain integer page sizes, the memory sizes are not exactly half of each other.

## 4.1.1 PROGRAM MEMORY ORGANIZATION

The program memory space is organized in wordaddressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address (Figure 4-2).

Program memory addresses are always word-aligned on the lower word and addresses are incremented or decremented by two during code execution. This arrangement also provides compatibility with data memory space addressing and makes it possible to access data in the program memory space.

## 4.1.2 HARD MEMORY VECTORS

All PIC24F devices reserve the addresses between 000000h and 000200h for hard-coded program execution vectors. A hardware Reset vector is provided to redirect code execution from the default value of the PC on a device Reset to the actual start of code. A GOTO instruction is programmed by the user at 000000h, with the actual address for the start of code at 000002h.

The PIC24FJ256GA705 devices can have up to two Interrupt Vector Tables (IVT). The first is located from addresses, 00004h to 0000FFh. The Alternate Interrupt Vector Table (AIVT), which can be enabled by the AIVTDIS Configuration bit, is located from 000104h to 0001FFh if no Boot Segment (BS) is present. If the user has configured a Boot Segment, the AIVT will be located at the address, (BSLIM<12:0> x 1024) – 508. These vector tables allow each of the many device interrupt sources to be handled by separate Interrupt Service Routines (ISRs). A more detailed discussion of the Interrupt Vector Tables is provided in Section 8.1 "Interrupt Vector Table".

# 4.1.3 CONFIGURATION BITS OVERVIEW

The Configuration bits are stored in the last page location of implemented program memory. These bits can be set or cleared to select various device configurations. There are two types of Configuration bits: system operation bits and code-protect bits. The system operation bits determine the power-on settings for system-level components, such as the oscillator and the Watchdog Timer. The code-protect bits prevent program memory from being read and written.

Table 4-2 lists all of the Configuration registers as wellas their Configuration register locations. Refer toSection 29.0 "Special Features" for the fullConfiguration register description for each specificdevice.

Configuration Registers	PIC24FJ256GA70X	PIC24FJ128GA70X	PIC24FJ64GA70X
FSEC	02AF00h	015F00h	00AF00h
FBSLIM	02AF10h	015F10h	00AF10h
FSIGN	02AF14h	015F14h	00AF14h
FOSCSEL	02AF18h	015F18h	00AF18h
FOSC	02AF1Ch	015F1Ch	00AF1Ch
FWDT	02AF20h	015F20h	00AF20h
FPOR	02AF24h	015F24h	00AF24h
FICD	02AF28h	015F28h	00AF28h
FDEVOPT1	02AF2Ch	015F2Ch	00AF2Ch

TABLE 4-2: CONFIGURATION WORD ADDRESSES

#### 4.1.4 CODE-PROTECT CONFIGURATION BITS

The device implements intermediate security features defined by the FSEC register. The Boot Segment (BS) is the higher privileged segment and the General Segment (GS) is the lower privileged segment. The total user code memory can be split into BS or GS. The size of the segments is determined by the BSLIM<12:0> bits. The relative location of the segments within user space does not change, such that BS (if present) occupies the memory area just after the Interrupt Vector Table (IVT) and the GS occupies the space just after the BS (or if the Alternate IVT is enabled, just after it).

The Configuration Segment (CS) is a small segment (less than a page, typically just one row) within user Flash address space. It contains all user configuration data that is loaded by the NVM Controller during the Reset sequence.

# 4.1.5 CUSTOMER OTP MEMORY

PIC24FJ256GA705 family devices provide 256 bytes of One-Time-Programmable (OTP) memory, located at addresses, 801700h through 8017FEh. This memory can be used for persistent storage of application-specific information that will not be erased by reprogramming the device. This includes many types of information, such as (but not limited to):

- Application Checksums
- Code Revision Information
- Product Information
- Serial Numbers
- System Manufacturing Dates
- · Manufacturing Lot Numbers

Customer OTP memory may be programmed in any mode, including user RTSP mode, but it cannot be erased. Data is not cleared by a chip erase.

Note: Do not write the OTP memory more than one time. Writing to the OTP memory more than once may result in a permanent ECC Double-Bit Error (ECCDBE) trap.

# 4.2 Data Memory Space

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"Data Memory with Extended Data Space (EDS)**" (DS39733). The information in this data sheet supersedes the information in the FRM.

The PIC24F core has a 16-bit wide data memory space, addressable as a single linear range. The Data Space is accessed using two Address Generation Units (AGUs), one each for read and write operations. The Data Space memory map is shown in Figure 4-2.

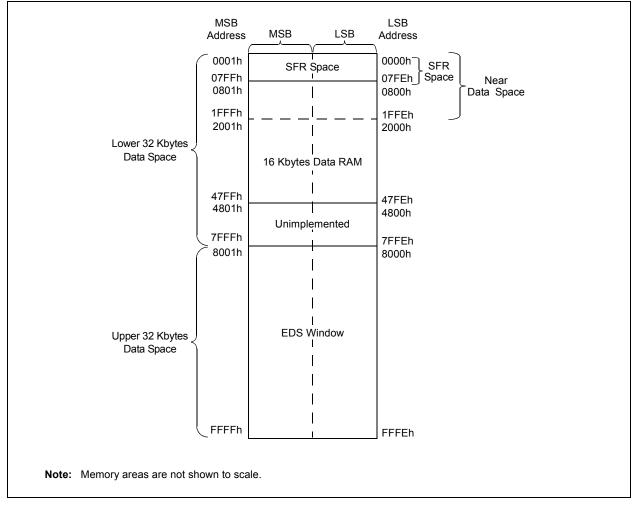
The 16-bit wide data addresses in the data memory space point to bytes within the Data Space (DS). This gives a DS address range of 16 Kbytes or 8K words. The lower half (0000h to 7FFFh) is used for implemented (on-chip) memory addresses.

The upper half of data memory address space (8000h to FFFFh) is used as a window into the Extended Data Space (EDS). This allows the microcontroller to directly access a greater range of data beyond the standard 16-bit address range. EDS is discussed in detail in **Section 4.2.5 "Extended Data Space (EDS)**".

# 4.2.1 DATA SPACE WIDTH

The data memory space is organized in byteaddressable, 16-bit wide blocks. Data is aligned in data memory and registers as 16-bit words, but all Data Space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

# FIGURE 4-2: DATA SPACE MEMORY MAP FOR PIC24FJ256GA705 DEVICES



### 4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC<sup>®</sup> MCUs and improve Data Space memory usage efficiency, the PIC24F instruction set supports both word and byte operations. As a consequence of byte accessibility, all EA calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode, [Ws++], will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word, which contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel, byte-wide entities with shared (word) address decode, but separate write lines. Data byte writes only write to the corresponding side of the array or register which matches the byte address.

All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations or translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap will be generated. If the error occurred on a read, the instruction underway is completed; if it occurred on a write, the instruction will be executed but the write will not occur. In either case, a trap is then executed, allowing the system and/or user to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the LSB. The Most Significant Byte (MSB) is not modified.

A Sign-Extend (SE) instruction is provided to allow users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, users can clear the MSB of any W register by executing a Zero-Extend (ZE) instruction on the appropriate address.

Although most instructions are capable of operating on word or byte data sizes, it should be noted that some instructions operate only on words.

# 4.2.3 NEAR DATA SPACE

The 8-Kbyte area between 0000h and 1FFFh is referred to as the Near Data Space. Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. The remainder of the Data Space is addressable indirectly. Additionally, the whole Data Space is addressable using MOV instructions, which support Memory Direct Addressing with a 16-bit address field.

# 4.2.4 SPECIAL FUNCTION REGISTER (SFR) SPACE

The first 2 Kbytes of the Near Data Space, from 0000h to 07FFh, are primarily occupied with Special Function Registers (SFRs). These are used by the PIC24F core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'. A diagram of the SFR space, showing where the SFRs are actually implemented, is shown in Table 4-3. Each implemented area indicates a 32-byte region where at least one address is implemented as an SFR. A complete list of implemented SFRs, including their addresses, is shown in Table 4-4 through 4-11.

							SFR	Space A	ddress								
	xx00	xx10	xx20	xx30	xx40	xx50	xx60	xx70	xx80	xx90	xxA0	xxB0	xxC0	xxD0	xxE0	ххF	0
000h	000h Core																
100h	OSC	Reset <sup>(1)</sup>		EPMP		CRC	REFO	PN	ΛD	Tim	ners	-	CTMU		RTCC		
200h		Capture			Compar	e				M	CCP				Comp	ANCF	-G
300h		MC	CP			_	—				UA	RT		—	—		SPI
400h			SPI			_	CL	.C	_	—		l <sup>2</sup> C			DMA		
500h	DMA					_	—			—	—	-	—	—	—		
600h	—	_	_	_						1/0	0						
700h	—			A/D			NVM	_	_				PPS				

# TABLE 4-3: IMPLEMENTED REGIONS OF SFR DATA SPACE<sup>(2)</sup>

Legend: — = No implemented SFRs in this block

Note 1: Includes HLVD control.

2: Regions shown are approximate. Refer to Table 4-4 through Table 4-11 for exact addresses.

File Name	Address	All Resets	File Name	Address	All Resets		
CPU CORE			INTERRUPT CONTROLLER (CONTINUED)				
WREG0	0000	0000	IEC1	009A	0000		
WREG1	0002	0000	IEC2	009C	0000		
WREG2	0004	0000	IEC3	009E	0000		
WREG3	0006	0000	IEC4	00A0	0000		
WREG4	0008	0000	IEC5	00A2	0000		
WREG5	000A	0000	IEC6	00A4	0000		
WREG6	000C	0000	IEC7	00A6	0000		
WREG7	000E	0000	IPC0	00A8	4444		
WREG8	0010	0000	IPC1	00AA	4444		
WREG9	0012	0000	IPC2	00AC	4444		
WREG10	0014	0000	IPC3	00AE	4444		
WREG11	0016	0000	IPC4	00B0	4444		
WREG12	0018	0000	IPC5	00B2	4404		
WREG13	001A	0000	IPC6	00B4	4444		
WREG14	001C	0000	IPC7	00B6	4444		
WREG15	001E	0800	IPC8	00B8	0044		
SPLIM	0020	xxxx	IPC9	00BA	4444		
PCL	002E	0000	IPC10	00BC	4444		
PCH	0030	0000	IPC11	00BE	4444		
DSRPAG	0032	0000	IPC12	00C0	4444		
DSWPAG	0034	0000	IPC13	00C2	0440		
RCOUNT	0036	xxxx	IPC14	00C4	4400		
SR	0042	0000	IPC15	00C6	4444		
CORCON	0044	0004	IPC16	00C8	4444		
DISICNT	0052	xxxx	IPC17	00CA	4444		
TBLPAG	0054	0000	IPC18	00CC	0044		
INTERRUPT CON	TROLLER	•	IPC19	00CE	0040		
INTCON1	0080	0000	IPC20	00D0	4440		
INTCON2	0082	8000	IPC21	00D2	4444		
INTCON4	0086	0000	IPC22	00D4	4444		
IFS0	0088	0000	IPC23	00D6	4400		
IFS1	008A	0000	IPC24	00D8	4444		
IFS2	008C	0000	IPC25	00DA	0440		
IFS3	008E	0000	IPC26	00DC	0400		
IFS4	0090	0000	IPC27	00DE	4440		
IFS5	0092	0000	IPC28	00E0	4444		
IFS6	0094	0000	IPC29	00E2	0044		
IFS7	0096	0000	INTTREG	00E4	0000		
IEC0	0098	0000			•		

TABLE 4-4: SFR MAP: 0000h BLOCK

Legend: x = undefined. Reset values are shown in hexadecimal.

File Name	Address	All Resets	File Name	Address	All Resets		
OSCILLATOR		·	PMD (CONTINUED)				
OSCCON	0100	xxx0	PMD3	017C	0000		
CLKDIV	0102	30x0	PMD4	017E	0000		
OSCTUN	0108	0000	PMD5	0180	0000		
OSCDIV	010C	0001	PMD6	0182	0000		
OSCFDIV	010E	0000	PMD7	0184	0000		
RESET		•	PMD8	0186	0000		
RCON	0110	0003	TIMER				
HLVD			TMR1	0190	0000		
HLVDCON	0114	0000	PR1	0192	FFFF		
PMP			T1CON	0194	0000		
PMCON1	0128	0000	TMR2	0196	0000		
PMCON2	012A	0000	TMR3HLD	0198	0000		
PMCON3	012C	0000	TMR3	019A	0000		
PMCON4	012E	0000	PR2	019C	FFFF		
PMCS1CF	0130	0000	PR3	019E	FFFF		
PMCS1BS	0132	0000	T2CON	01A0	0x00		
PMCS1MD	0134	0000	T3CON	01A2	0x00		
PMCS2CF	0136	0000	СТМИ				
PMCS2BS	0138	0000	CTMUCON1L	01C0	0000		
PMCS2MD	013A	0000	CTMUCON1H	01C2	0000		
PMDOUT1	013C	xxxx	CTMUCON2L	01C4	0000		
PMDOUT2	013E	xxxx	REAL-TIME CLOCK AND CALENDAR (RTCC)				
PMDIN1	0140	xxxx	RTCCON1L	01CC	xxxx		
PMDIN2	0142	xxxx	RTCCON1H	01CE	xxxx		
PMSTAT	0144	008F	RTCCON2L	01D0	xxxx		
CRC			RTCCON2H	01D2	xxxx		
CRCCON1	0158	00x0	RTCCON3L	01D4	xxxx		
CRCCON2	015A	0000	RTCSTATL	01D8	00xx		
CRCXORL	015C	0000	TIMEL	01DC	xx00		
CRCXORH	015E	0000	TIMEH	01DE	xxxx		
CRCDATL	0160	xxxx	DATEL	01E0	xx0x		
CRCDATH	0162	xxxx	DATEH	01E2	xxxx		
CRCWDATL	0164	xxxx	ALMTIMEL	01E4	xx00		
CRCWDATH	0166	xxxx	ALMTIMEH	01E6	xxxx		
REFO			ALMDATEL	01E8	xx0x		
REFOCONL	0168	0000	ALMDATEH	01EA	xxxx		
REFOCONH	016A	0000	TSATIMEL	01EC	xx00		
REFOTRIML	016C	0000	TSATIMEH	01EE	xxxx		
PMD			TSADATEL	01F0	xx0x		
PMD1	0178	0000	TSADATEH	01F2	xxxx		
PMD2	017A	0000					

# TABLE 4-5: SFR MAP: 0100h BLOCK

 $\label{eq:legend: set values are shown in hexadecimal.} \ensuremath{\text{Legend: }} x \ensuremath{\text{ = undefined. Reset values are shown in hexadecimal.}}$ 

File Name	Address	All Resets	File Name	Address	All Resets
INPUT CAPTURE			MULTIPLE OUTPUT	CAPTURE/COMPARI	E/PWM (CONTINUED)
IC1CON1	0200	0000	CCP1RAH	0286	0000
IC1CON2	0202	000D	CCP1RBL	0288	0000
IC1BUF	0204	0000	CCP1RBH	028A	0000
IC1TMR	0206	0000	CCP1BUFL	028C	0000
IC2CON1	0208	0000	CCP1BUFH	028E	0000
IC2CON2	020A	000D	CCP2CON1L	0290	0000
IC2BUF	020C	0000	CCP2CON1H	0292	0000
IC2TMR	020E	0000	CCP2CON2L	0294	0000
IC3CON1	0210	0000	CCP2CON2H	0296	0100
IC3CON2	0212	000D	CCP2CON3L	0298	0000
IC3BUF	0214	0000	CCP2CON3H	029A	0000
IC3TMR	0216	0000	CCP2STATL	029C	00x0
OUTPUT COMPAR	RE		CCP2STATH	029E	0000
OC1CON1	0230	0000	CCP2TMRL	02A0	0000
OC1CON2	0232	000C	CCP2TMRH	02A2	0000
OC1RS	0234	xxxx	CCP2PRL	02A4	FFFF
OC1R	0236	xxxx	CCP2PRH	02A6	FFFF
OC1TMR	0238	xxxx	CCP2RAL	02A8	0000
OC2CON1	023A	0000	CCP2RAH	02AA	0000
OC2CON2	023C	000C	CCP2RBL	02AC	0000
OC2RS	023E	xxxx	CCP2RBH	02AE	0000
OC2R	0240	xxxx	CCP2BUFL	02B0	0000
OC2TMR	0242	xxxx	CCP2BUFH	02B2	0000
OC3CON1	0244	0000	CCP3CON1L	02B4	0000
OC3CON2	0246	000C	CCP3CON1H	02B6	0000
OC3RS	0248	xxxx	CCP3CON2L	02B8	0000
OC3R	024A	xxxx	CCP3CON2H	02BA	0100
OC3TMR	024C	xxxx	CCP3CON3L	02BC	0000
MULTIPLE OUTPU	T CAPTURE/COMPARE		CCP3CON3H	02BE	0000
CCP1CON1L	026C	0000	CCP3STATL	02C0	00x0
CCP1CON1H	026E	0000	CCP3STATH	02C2	0000
CCP1CON2L	0270	0000	CCP3TMRL	02C4	0000
CCP1CON2H	0272	0100	CCP3TMRH	02C6	0000
CCP1CON3L	0274	0000	CCP3PRL	02C8	FFFF
CCP1CON3H	0276	0000	CCP3PRH	02CA	FFFF
CCP1STATL	0278	00x0	CCP3RAL	02CC	0000
CCP1STATH	027A	0000	CCP3RAH	02CE	0000
CCP1TMRL	027C	0000	CCP3RBL	02D0	0000
CCP1TMRH	027E	0000	CCP3RBH	02D2	0000
CCP1PRL	0280	FFFF	CCP3BUFL	02D4	0000
CCP1PRH	0282	FFFF	CCP3BUFH	02D6	0000
CCP1RAL	0284	0000		1	1

TABLE 4-6: SFR MAP: 0200h BLOCK

**Legend:** x = undefined. Reset values are shown in hexadecimal.

File Name	Address	All Resets	File Name	Address	All Resets		
COMPARATORS		COMPARATORS (CONTINUED)					
CMSTAT	02E6	0000	CM3CON	02EE	0000		
CVRCON	02E8	00xx	ANALOG CONFIGURATION				
CM1CON	02EA	0000	ANCFG	02F4	0000		
CM2CON	02EC	0000					

# TABLE 4-6: SFR MAP: 0200h BLOCK (CONTINUED)

 $\label{eq:Legend: Legend: Legend: Legend: Legend: x = undefined. Reset values are shown in hexadecimal.$ 

# TABLE 4-7: SFR MAP: 0300h BLOCK

File Name	Address	All Resets	File Name	Address	All Resets
MULTIPLE OUTPUT	CAPTURE/COMPAR	E/PWM	UART		•
CCP4CON1L	0300	0000	U1MODE	0398	0000
CCP4CON1H	0302	0000	U1STA	039A	0110
CCP4CON2L	0304	0000	U1TXREG	039C	x0xx
CCP4CON2H	0306	0100	U1RXREG	039E	0000
CCP4CON3L	0308	0000	U1BRG	03A0	0000
CCP4CON3H	030A	0000	U1ADMD	03A2	0000
CCP4STATL	030C	00x0	U2MODE	03AE	0000
CCP4STATH	030E	0000	U2STA	03B0	0110
CCP4TMRL	0310	0000	U2TXREG	03B2	xxxx
CCP4TMRH	0312	0000	U2RXREG	03B4	0000
CCP4PRL	0314	FFFF	U2BRG	03B6	0000
CCP4PRH	0316	FFFF	U2ADMD	03B8	0000
CCP4RAL	0318	0000	SPI		
CCP4RAH	031A	0000	SPI1CON1L	03F4	0x00
CCP4RBL	031C	0000	SPI1CON1H	03F6	0000
CCP4RBH	031E	0000	SPI1CON2L	03F8	0000
CCP4BUFL	0320	0000	SPI1STATL	03FC	0028
CCP4BUFH	0322	0000	SPI1CON2H	03F8	0000
		·	SPI1STATH	03FE	0000

**Legend:** x = undefined. Reset values are shown in hexadecimal.

File Name	Address	All Resets	File Name	Address	All Resets
SPI (CONTINUED	))		I <sup>2</sup> C (CONTINUED)	0498	0000
SPI1BUFL	0400	0000	I2C1BRG	0498	0000
SPI1BUFH	0402	0000	I2C1CONL	049A	1000
SPI1BRGL	0404	xxxx	I2C1CONH	049C	0000
SPI1IMSKL	0408	0000	I2C1STAT	049E	0000
SPI1IMSKH	040A	0000	I2C1ADD	04A0	0000
SPI1URDTL	040C	0000	I2C1MSK	04A2	0000
SPI1URDTH	040E	0000	I2C2RCV	04A4	0000
SPI2CON1L	0410	0x00	I2C2TRN	04A6	00FF
SPI2CON1H	0412	0000	I2C2BRG	04A8	0000
SPI2CON2L	0414	0000	I2C2CONL	04AA	1000
SPI2STATL	0418	0028	I2C2CONH	04AC	0000
SPI2STATH	041A	0000	I2C2STAT	04AE	0000
SPI2BUFL	041C	0000	I2C2ADD	04B0	0000
SPI2BUFH	041E	0000	I2C2MSK	04B2	0000
SPI2BRGL	0420	xxxx	DMA		•
SPI2IMSKL	0424	0000	DMACON	04C4	0000
SPI2IMSKH	0426	0000	DMABUF	04C6	0000
SPI2URDTL	0428	0000	DMAL	04C8	0000
SPI2URDTH	042A	0000	DMAH	04CA	0000
SPI3CON1L	042C	0x00	DMACH0	04CC	0000
SPI3CON1H	042E	0000	DMAINT0	04CE	0000
SPI3CON2L	0430	0000	DMASRC0	04D0	0000
SPI3STATL	0434	0028	DMADST0	04D2	0000
SPI3STATH	0436	0000	DMACNT0	04D4	0001
SPI3BUFL	0438	0000	DMACH1	04D6	0000
SPI3BUFH	043A	0000	DMAINT1	04D8	0000
SPI3BRGL	043C	xxxx	DMASRC1	04DA	0000
SPI3IMSKL	0440	0000	DMADST1	04DC	0000
SPI3IMSKH	0442	0000	DMACNT1	04DE	0001
SPI3URDTL	0444	0000	DMACH2	04E0	0000
SPI3URDTH	0446	0000	DMAINT2	04E2	0000
CONFIGURABLE	LOGIC CELL (CLC)		DMASRC2	04E4	0000
CLC1CONL	0464	0000	DMADST2	04E6	0000
CLC1CONH	0466	0000	DMACNT2	04E8	0001
CLC1SEL	0468	0000	DMACH3	04EA	0000
CLC1GLSL	046C	0000	DMAINT3	04EC	0000
CLC1GLSH	046E	0000	DMASRC3	04EE	0000
CLC2CONL	0470	0000	DMADST3	04F0	0000
CLC2CONH	0472	0000	DMACNT3	04F2	0001
CLC2SEL	0474	0000	DMACH4	04F4	0000
CLC2GLSL	0478	0000	DMAINT4	04F6	0000
CLC2GLSH	047A	0000	DMASRC4	04F8	0000
l <sup>2</sup> C			DMADST4	04FA	0000
2C1RCV	0494	0000	DMACNT4	04FC	0001
I2C1TRN	0496	00FF	DMACH5	04FE	0000

TABLE 4-8: SFR MAP: 0400h BLOCK

File Name	Address	All Resets	File Name	Address	All Resets	
DMA (CONTINUED)		DMA (CONTINUED)				
DMAINT5	0500	0000	DMADST5	0504	0000	
DMASRC5	0502	0000	DMACNT5	0506	0001	

# TABLE 4-9: SFR MAP: 0500h BLOCK

Legend: x = undefined. Reset values are shown in hexadecimal.

#### TABLE 4-10: SFR MAP: 0600h BLOCK

File Name	Address	All Resets	File Name	Address	All Resets	
I/O			PORTB (CONTINUE	PORTB (CONTINUED)		
PADCON	065E	0000	ANSB	067E	FFFF	
IOCSTAT	0660	0000	IOCPB	0680	0000	
PORTA			IOCNB	0682	0000	
TRISA	0662	FFFF	IOCFB	0684	0000	
PORTA	0664	0000	IOCPUB	0686	0000	
LATA	0666	0000	IOCPDB	0688	0000	
ODCA	0668	0000	PORTC			
ANSA	066A	FFFF	TRISC	068A	FFFF	
IOCPA	066C	0000	PORTC	068C	0000	
IOCNA	066E	0000	LATC	068E	0000	
IOCFA	0670	0000	ODCC	0690	0000	
IOCPUA	0672	0000	ANSC	0692	FFFF	
IOCPDA	0674	0000	IOCPC	0694	0000	
PORTB		·	IOCNC	0696	0000	
TRISB	0676	FFFF	IOCFC	0698	0000	
PORTB	0678	0000	IOCPUC	069A	0000	
LATB	067A	0000	IOCPDC	069C	0000	
ODCB	067C	0000		•	-	

**Legend:** x = undefined. Reset values are shown in hexadecimal.

File Name	Address	All Resets	File Name	Address	All Resets
A/D			PERIPHERAL PIN S	ELECT	
ADC1BUF0	0712	xxxx	RPINR0	0790	3F3F
ADC1BUF1	0714	xxxx	RPINR1	0792	3F3F
ADC1BUF2	0716	xxxx	RPINR2	0794	3F3F
ADC1BUF3	0718	xxxx	RPINR3	0796	3F3F
ADC1BUF4	071A	xxxx	RPINR5	079A	3F3F
ADC1BUF5	071C	xxxx	RPINR6	079C	3F3F
ADC1BUF6	071E	xxxx	RPINR7	079E	3F3F
ADC1BUF7	0720	xxxx	RPINR8	07A0	003F
ADC1BUF8	0722	xxxx	RPINR11	07A6	3F3F
ADC1BUF9	0724	xxxx	RPINR12	07A8	3F3F
ADC1BUF10	0726	xxxx	RPINR18	07B4	3F3F
ADC1BUF11	0728	xxxx	RPINR19	07B6	3F3F
ADC1BUF12	072A	xxxx	RPINR20	07B8	3F3F
ADC1BUF13	072C	xxxx	RPINR21	07BA	3F3F
ADC1BUF14	072E	xxxx	RPINR22	07BC	3F3F
ADC1BUF15	0730	xxxx	RPINR23	07BE	3F3F
AD1CON1	0746	xxxx	RPINR25	07C2	3F3F
AD1CON2	0748	xxxx	RPINR28	07C8	3F3F
AD1CON3	074A	xxxx	RPINR29	07CA	003F
AD1CHS	074C	xxxx	RPOR0	07D4	0000
AD1CSSH	074E	xxxx	RPOR1	07D6	0000
AD1CSSL	0750	xxxx	RPOR2	07D8	0000
AD1CON4	0752	xxxx	RPOR3	07DA	0000
AD1CON5	0754	xxxx	RPOR4	07DC	0000
AD1CHITL	0758	xxxx	RPOR5	07DE	0000
AD1CTMENH	075A	0000	RPOR6	07E0	0000
AD1CTMENL	075C	0000	RPOR7	07E2	0000
AD1RESDMA	075E	0000	RPOR8	07E4	0000
NVM			RPOR9	07E6	0000
NVMCON	0760	0000	RPOR10	07E8	0000
NVMADR	0762	xxxx	RPOR11	07EA	0000
NVMADRU	0764	00xx	RPOR12	07EC	0000
NVMKEY	0766	0000	RPOR13	07EE	0000
	·		RPOR14	07F0	0000

TABLE 4-11: SFR MAP: 0700h BLOCK

**Legend:** x = undefined. Reset values are shown in hexadecimal.

#### 4.2.5 EXTENDED DATA SPACE (EDS)

The Extended Data Space (EDS) allows PIC24F devices to address a much larger range of data than would otherwise be possible with a 16-bit address range. EDS includes any additional internal data memory not directly accessible by the lower 32-Kbyte data address space and any external memory through EPMP.

In addition, EDS also allows read access to the program memory space. This feature is called Program Space Visibility (PSV) and is discussed in detail in Section 4.3.3 "Reading Data from Program Memory Using EDS".

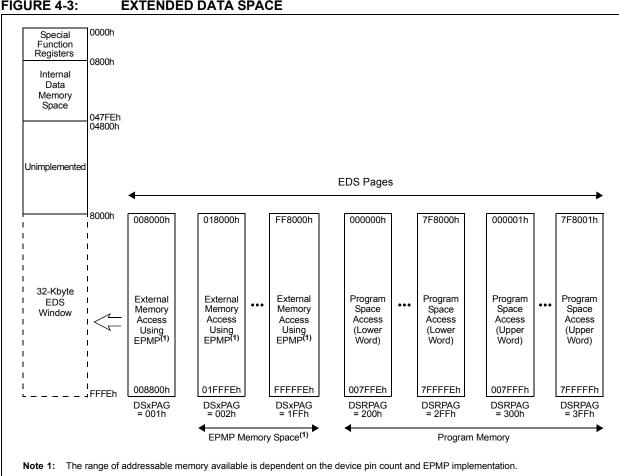
Figure 4-3 displays the entire EDS space. The EDS is organized as pages, called EDS pages, with one page equal to the size of the EDS window (32 Kbytes). A particular EDS page is selected through the Data Space Read Page register (DSRPAG) or the Data Space Write Page register (DSWPAG). For PSV, only the DSRPAG register is used. The combination of the DSRPAG register value and the 16-bit wide data address forms a 24-bit Effective Address (EA).

The data addressing range of the PIC24FJ256GA705 family devices depends on the version of the Enhanced Parallel Master Port implemented on a particular device; this is, in turn, a function of device pin count. Table 4-12 lists the total memory accessible by each of the devices in this family. For more details on accessing external memory using EPMP, refer to the "dsPIC33/PIC24 Family Reference Manual', "Enhanced Parallel Master Port (EPMP)" (DS39730).

<b>TABLE 4-12:</b>	TOTAL ACCESSIBLE DATA
	MEMORY

Family	Internal RAM	External RAM Access Using EPMP
PIC24FJXXXGA70X	16K	1K

Accessing Page 0 in the EDS window will Note: generate an address error trap as Page 0 is the base data memory (data locations, 0800h to 7FFFh, in the lower Data Space).



#### FIGURE 4-3: **EXTENDED DATA SPACE**

## 4.2.5.1 Data Read from EDS

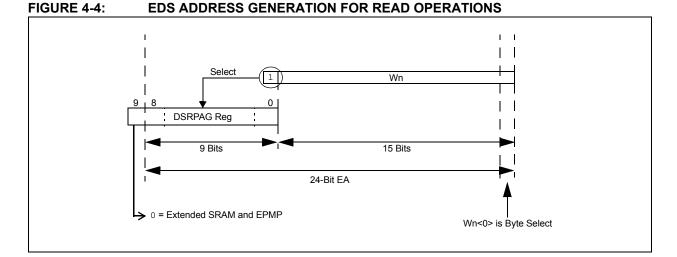
In order to read the data from the EDS space, first, an Address Pointer is set up by loading the required EDS page number into the DSRPAG register and assigning the offset address to one of the W registers. Once the above assignment is done, the EDS window is enabled by setting bit 15 of the Working register which is assigned with the offset address; then, the contents of the pointed EDS location can be read.

Figure 4-4 illustrates how the EDS space address is generated for read operations.

When the Most Significant bit (MSb) of EA is '1' and DSRPAG<9> = 0, the lower 9 bits of DSRPAG are concatenated to the lower 15 bits of EA to form a 24-bit EDS space address for read operations.

Example 4-1 shows how to read a byte, word and double word from EDS.

Note: All read operations from EDS space have an overhead of one instruction cycle. Therefore, a minimum of two instruction cycles are required to complete an EDS read. EDS reads under the REPEAT instruction; the first two accesses take three cycles and the subsequent accesses take one cycle.



# EXAMPLE 4-1: EDS READ CODE IN ASSEMBLY

; Set the EDS page from where the data to be read mov #0x0002, w0 w0, DSRPAG ;page 2 is selected for read mov #0x0800, w1 ;select the location (0x800) to be read mov bset wl, #15 ;set the MSB of the base address, enable EDS mode ;Read a byte from the selected location mov.b [w1++], w2 ;read Low byte mov.b [w1++], w3 ;read High byte ;Read a word from the selected location mov [w1], w2 ; ;Read Double - word from the selected location mov.d [w1], w2 ;two word read, stored in w2 and w3

# 4.2.5.2 Data Write into EDS

In order to write data to EDS, such as in EDS reads, an Address Pointer is set up by loading the required EDS page number into the DSWPAG register, and assigning the offset address to one of the W registers. Once the above assignment is done, then the EDS window is enabled by setting bit 15 of the Working register, assigned with the offset address, and the accessed location can be written.

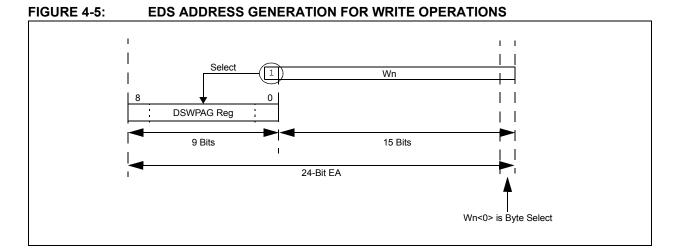
Figure 4-5 illustrates how the EDS address is generated for write operations.

When the MSbs of EA are '1', the lower 9 bits of DSWPAG are concatenated to the lower 15 bits of EA to form a 24-bit EDS address for write operations. Example 4-2 shows how to write a byte, word and double word to EDS.

The Data Space Page registers (DSRPAG/DSWPAG) do not update automatically while crossing a page boundary when the rollover happens from 0xFFFF to

0x8000. While developing code in assembly, care must be taken to update the Data Space Page registers when an Address Pointer crosses the page boundary. The 'C' compiler keeps track of the addressing, and increments or decrements the Page registers accordingly, while accessing contiguous data memory locations.

- **Note 1:** All write operations to EDS are executed in a single cycle.
  - 2: Use of Read/Modify/Write operation on any EDS location under a REPEAT instruction is not supported. For example: BCLR, BSW, BTG, RLC f, RLNC f, RRC f, RRNC f, ADD f, SUB f, SUBR f, AND f, IOR f, XOR f, ASR f, ASL f.
  - Use the DSRPAG register while performing Read/Modify/Write operations.



#### EXAMPLE 4-2: EDS WRITE CODE IN ASSEMBLY

```
; Set the EDS page where the data to be written
          #0x0002, w0
   mov
          w0, DSWPAG
                         ;page 2 is selected for write
   mov
          #0x0800, w1
                         ;select the location (0x800) to be written
   mov
          w1, #15
                         ;set the MSB of the base address, enable EDS mode
   bset
;Write a byte to the selected location
  mov #0x00A5, w2
   mov
          #0x003C, w3
   mov.b w2, [w1++]
                        ;write Low byte
   mov.b w3, [w1++]
                        ;write High byte
;Write a word to the selected location
          #0x1234, w2
   mov
                         ;
          w2, [w1]
   mov
                         ;
;Write a Double - word to the selected location
          #0x1122, w2
   mov
   mov
          #0x4455, w3
   mov.d w2, [w1]
                         ;2 EDS writes
```

DSRPAG (Data Space Read Register)	DSWPAG (Data Space Write Register)	Source/Destination Address while Indirect Addressing	24-Bit EA Pointing to EDS	Comment
x <sup>(1)</sup>	x <sup>(1)</sup>	0000h to 1FFFh	000000h to 001FFFh	Near Data Space <sup>(2)</sup>
		2000h to 7FFFh	002000h to 007FFFh	
001h	001h		008000h to 00FFFEh	
002h	002h		010000h to 017FFEh	
003h •	003h •	8000h to FFFFh	018000h to 0187FEh	EPMP Memory Space
•	•	800011 10 FFF11	•	
•	•		•	
1FFh	1FFh		FF8000h to FFFFFEh	
000h	000h		Invalid Address	Address Error Trap <sup>(3)</sup>

#### TABLE 4-13: EDS MEMORY ADDRESS WITH DIFFERENT PAGES AND ADDRESSES

Note 1: If the source/destination address is below 8000h, the DSRPAG and DSWPAG registers are not considered.
2: This Data Space can also be accessed by Direct Addressing.

**3:** When the source/destination address is above 8000h and DSRPAG/DSWPAG are '0', an address error trap will occur.

#### 4.2.6 SOFTWARE STACK

Apart from its use as a Working register, the W15 register in PIC24F devices is also used as a Software Stack Pointer (SSP). The pointer always points to the first available free word and grows from lower to higher addresses. It pre-decrements for stack pops and post-increments for stack pushes, as shown in Figure 4-6. Note that for a PC push during any CALL instruction, the MSB of the PC is zero-extended before the push, ensuring that the MSB is always clear.

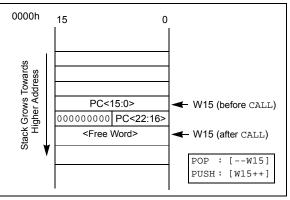
Note:	A PC push during exception processing
	will concatenate the SRL register to the
	MSB of the PC prior to the push.

The Stack Pointer Limit Value register (SPLIM), associated with the Stack Pointer, sets an upper address boundary for the stack. SPLIM is uninitialized at Reset. As is the case for the Stack Pointer, SPLIM<0> is forced to '0' as all stack operations must be wordaligned. Whenever an EA is generated using W15 as a source or destination pointer, the resulting address is compared with the value in SPLIM. If the contents of the Stack Pointer (W15) and the SPLIM register are equal, and a push operation is performed, a stack error trap will not occur. The stack error trap will occur on a subsequent push operation. Thus, for example, if it is desirable to cause a stack error trap when the stack grows beyond address 2000h in RAM, initialize the SPLIM with the value, 1FFEh.

Similarly, a Stack Pointer underflow (stack error) trap is generated when the Stack Pointer address is found to be less than 0800h. This prevents the stack from interfering with the SFR space.

A write to the SPLIM register should not be immediately followed by an indirect read operation using W15.

#### FIGURE 4-6: CALL STACK FRAME



# 4.3 Interfacing Program and Data Memory Spaces

The PIC24F architecture uses a 24-bit wide program space and 16-bit wide Data Space. The architecture is also a modified Harvard scheme, meaning that data can also be present in the program space. To use this data successfully, it must be accessed in a way that preserves the alignment of information in both spaces.

Aside from normal execution, the PIC24F architecture provides two methods by which program space can be accessed during operation:

- Using table instructions to access individual bytes or words anywhere in the program space
- Remapping a portion of the program space into the Data Space (Program Space Visibility)

Table instructions allow an application to read or write to small areas of the program memory. This makes the method ideal for accessing data tables that need to be updated from time to time. It also allows access to all bytes of the program word. The remapping method allows an application to access a large block of data on a read-only basis, which is ideal for look-ups from a large table of static data. It can only access the least significant word of the program word.

# 4.3.1 ADDRESSING PROGRAM SPACE

Since the address ranges for the data and program spaces are 16 and 24 bits, respectively, a method is needed to create a 23-bit or 24-bit program address from 16-bit data registers. The solution depends on the interface method to be used.

For table operations, the 8-bit Table Memory Page Address register (TBLPAG) is used to define a 32K word region within the program space. This is concatenated with a 16-bit EA to arrive at a full 24-bit program space address. In this format, the MSBs of TBLPAG are used to determine if the operation occurs in the user memory (TBLPAG<7> = 0) or the configuration memory (TBLPAG<7> = 1).

For remapping operations, the 10-bit Extended Data Space Read register (DSRPAG) is used to define a 16K word page in the program space. When the Most Significant bit (MSb) of the EA is '1', and the MSb (bit 9) of DSRPAG is '1', the lower 8 bits of DSRPAG are concatenated with the lower 15 bits of the EA to form a 23-bit program space address. The DSRPAG<8> bit decides whether the lower word (when the bit is '0') or the higher word (when the bit is '1') of program memory is mapped. Unlike table operations, this strictly limits remapping operations to the user memory area.

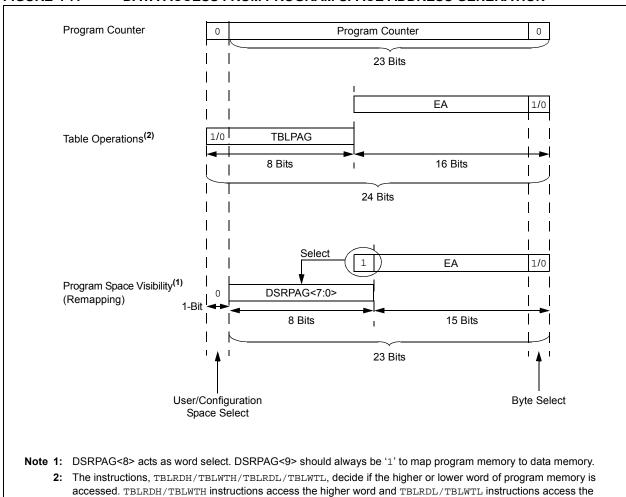
Table 4-14 and Figure 4-7 show how the program EA is created for table operations and remapping accesses from the data EA. Here, P<23:0> refers to a program space word, whereas D<15:0> refers to a Data Space word.

Access Type	Access	Program Space Address					
	Space	<23>	<22:16>	<15>	<14:1>	<0>	
Instruction Access	User	0		PC<22:1>		0	
(Code Execution)		0xx xxxx xxxx xxxx xxxx xxx0					
TBLRD/TBLWT	User	TBLPAG<7:0>		Data EA<15:0>			
(Byte/Word Read/Write)		0xxx xxxx		XXX	xxxx xxxx xxxx xxxx		
	Configuration	TBLPAG<7:0>		Data EA<15:0>			
		1xxx xxxx		xxxx xxxx xxxx xxxx		xxx	
Program Space Visibility	User	0 DSRP		:0> <sup>(2)</sup> Data EA<14:0> <sup>(1)</sup>		l:0>( <b>1</b> )	
(Block Remap/Read)		0	XXXX XXX	xx	xxx xxxx xx	xx xxxx	

# TABLE 4-14: PROGRAM SPACE ADDRESS CONSTRUCTION

**Note 1:** Data EA<15> is always '1' in this case, but is not used in calculating the program space address. Bit 15 of the address is DSRPAG<0>.

2: DSRPAG<9> is always '1' in this case. DSRPAG<8> decides whether the lower word or higher word of program memory is read. When DSRPAG<8> is '0', the lower word is read, and when it is '1', the higher word is read.



lower word. Table Read operations are permitted in the configuration memory space.

# FIGURE 4-7: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION

#### 4.3.2 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the program space without going through Data Space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a program space word as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to Data Space addresses. Program memory can thus be regarded as two, 16-bit word-wide address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space which contains the least significant data word, and TBLRDH and TBLWTH access the space which contains the upper data byte.

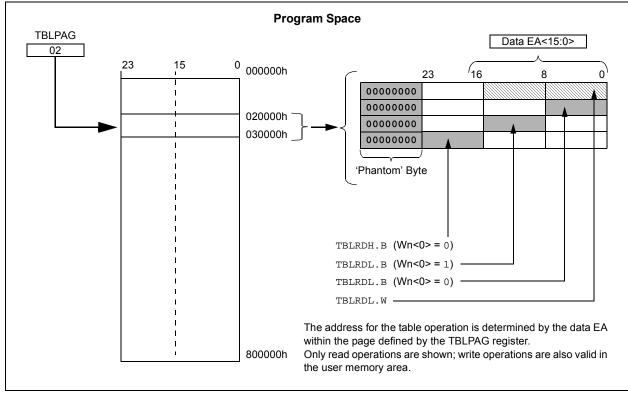
Two table instructions are provided to move byte or word-sized (16-bit) data to and from program space. Both function as either byte or word operations.

 TBLRDL (Table Read Low): In Word mode, it maps the lower word of the program space location (P<15:0>) to a data address (D<15:0>). In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when byte select is '1'; the lower byte is selected when it is '0'. TBLRDH (Table Read High): In Word mode, it maps the entire upper word of a program address (P<23:16>) to a data address. Note that D<15:8>, the 'phantom' byte, will always be '0'. In Byte mode, it maps the upper or lower byte of the program word to D<7:0> of the data address, as above. Note that the data will always be '0' when the upper 'phantom' byte is selected (byte select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are described in Section 6.0 "Flash Program Memory".

For all table operations, the area of program memory space to be accessed is determined by the Table Memory Page Address register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.

Note: Only Table Read operations will execute in the configuration memory space where Device IDs are located. Table Write operations are not allowed.



# FIGURE 4-8: ACCESS PROGRAM MEMORY WITH TABLE INSTRUCTIONS

# 4.3.3 READING DATA FROM PROGRAM MEMORY USING EDS

The upper 32 Kbytes of Data Space may optionally be mapped into any 16K word page of the program space. This provides transparent access of stored constant data from the Data Space without the need to use special instructions (i.e., TBLRDL/H).

Program space access through the Data Space occurs when the MSb of EA is '1' and the DSRPAG<9> bit is also '1'. The lower 8 bits of DSRPAG are concatenated to the Wn<14:0> bits to form a 23-bit EA to access program memory. The DSRPAG<8> decides which word should be addressed; when the bit is '0', the lower word, and when '1', the upper word of the program memory is accessed.

The entire program memory is divided into 512 EDS pages, from 200h to 3FFh, each consisting of 16K words of data. Pages, 200h to 2FFh, correspond to the lower words of the program memory, while 300h to 3FFh correspond to the upper words of the program memory.

Using this EDS technique, the entire program memory can be accessed. Previously, the access to the upper word of the program memory was not supported. Table 4-15 provides the corresponding 23-bit EDS address for program memory with EDS page and source addresses.

For operations that use PSV and are executed outside a REPEAT loop, the MOV and MOV. D instructions will require one instruction cycle in addition to the specified execution time. All other instructions will require two instruction cycles in addition to the specified execution time.

For operations that use PSV, which are executed inside a REPEAT loop, there will be some instances that require two instruction cycles in addition to the specified execution time of the instruction:

- · Execution in the first iteration
- · Execution in the last iteration
- Execution prior to exiting the loop due to an interrupt
- Execution upon re-entering the loop after an interrupt is serviced

Any other iteration of the REPEAT loop will allow the instruction accessing data, using PSV, to execute in a single cycle.

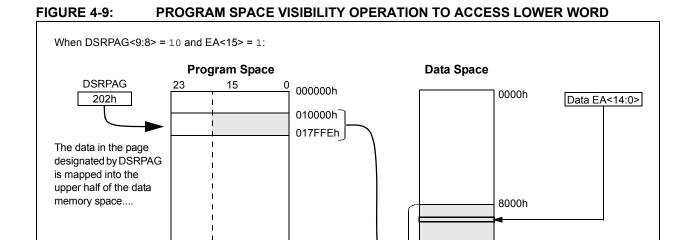
DSRPAG (Data Space Read Register)	Source Address while Indirect Addressing	23-Bit EA Pointing to EDS	Comment	
200h		000000h to 007FFEh	Lower words of 4M program	
•		•	instructions (8 Mbytes) for	
•		•	read operations only.	
•		•		
2FFh		7F8000h to 7FFFFEh		
300h	8000h to FFFFh	000001h to 007FFFh	Upper words of 4M program	
•		•	instructions (4 Mbytes remaining;	
•		•	4 Mbytes are phantom bytes) for	
•		•	read operations only.	
3FFh		7F8001h to 7FFFFFh		
000h		Invalid Address	Address error trap. <sup>(1)</sup>	

# TABLE 4-15: EDS PROGRAM ADDRESS WITH DIFFERENT PAGES AND ADDRESSES

**Note 1:** When the source/destination address is above 8000h and DSRPAG/DSWPAG is '0', an address error trap will occur.

# EXAMPLE 4-3: EDS READ CODE FROM PROGRAM MEMORY IN ASSEMBLY

; Set the	EDS page from where the dat	a to be read
mov	#0x0202, w0	
mov	w0, DSRPAG	;page 0x202, consisting lower words, is selected for read
mov	#0x000A, w1	;select the location (0x0A) to be read
bset	w1, #15	;set the MSB of the base address, enable EDS mode
;Read a by	te from the selected locati	on
mov.b	[w1++], w2	;read Low byte
mov.b	[w1++], w3	;read High byte
;Read a wo	rd from the selected locati	on
mov	[w1], w2	i
;Read Doub	le - word from the selected	llocation
mov.d	[w1], w2	;two word read, stored in w2 and w3



EDS Window

FFFFh

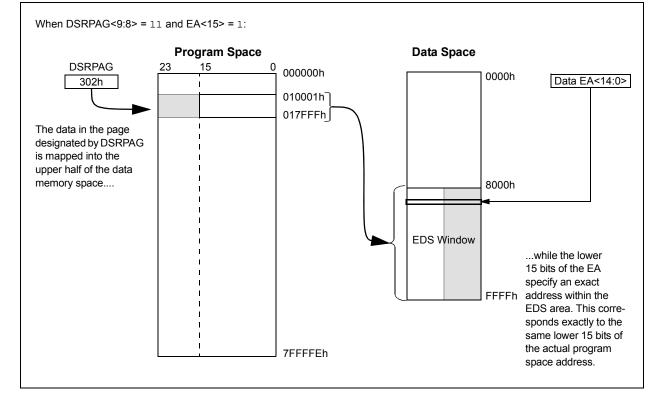
...while the lower 15 bits of the EA specify an exact address within the

space address.

EDS area. This corresponds exactly to the same lower 15 bits of the actual program

#### FIGURE 4-10: PROGRAM SPACE VISIBILITY OPERATION TO ACCESS UPPER WORD

7FFFFEh



# 5.0 DIRECT MEMORY ACCESS CONTROLLER (DMA)

Note: This data sheet summarizes the features of the PIC24FJ256GA705 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the "dsPIC33/PIC24 Family Reference Manual", "Direct Memory Access Controller (DMA)" (DS39742), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Direct Memory Access (DMA) Controller is designed to service high throughput data peripherals operating on the SFR bus, allowing them to access data memory directly and alleviating the need for CPU intensive management. By allowing these data intensive peripherals to share their own data path, the main data bus is also deloaded, resulting in additional power savings.

The DMA Controller functions both as a peripheral and a direct extension of the CPU. It is located on the microcontroller data bus between the CPU and DMA-enabled peripherals, with direct access to SRAM. This partitions the SFR bus into two buses, allowing the DMA Controller access to the DMA capable peripherals located on the new DMA SFR bus. The controller serves as a master device on the DMA SFR bus, controlling data flow from DMA capable peripherals.

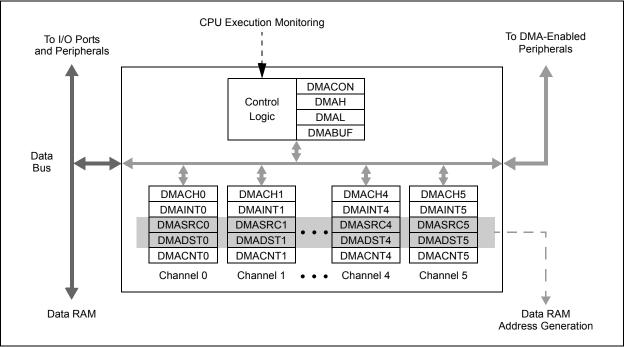
The controller also monitors CPU instruction processing directly, allowing it to be aware of when the CPU requires access to peripherals on the DMA bus and automatically relinquishing control to the CPU as needed. This increases the effective bandwidth for handling data without DMA operations causing a processor stall. This makes the controller essentially transparent to the user.

The DMA Controller has these features:

- Six Independent and Independently
   Programmable Channels
- Concurrent Operation with the CPU (no DMA caused Wait states)
- DMA Bus Arbitration
- · Five Programmable Address modes
- Four Programmable Transfer modes
- Four Flexible Internal Data Transfer modes
- · Byte or Word Support for Data Transfer
- 16-Bit Source and Destination Address Register for Each Channel, Dynamically Updated and Reloadable
- 16-Bit Transaction Count Register, Dynamically Updated and Reloadable
- · Upper and Lower Address Limit Registers
- Counter Half-Full Level Interrupt
- · Software Triggered Transfer
- Null Write mode for Symmetric Buffer Operations

A simplified block diagram of the DMA Controller is shown in Figure 5-1.





# 5.1 Summary of DMA Operations

The DMA Controller is capable of moving data between addresses according to a number of different parameters. Each of these parameters can be independently configured for any transaction; in addition, any or all of the DMA channels can independently perform a different transaction at the same time. Transactions are classified by these parameters:

- Source and destination (SFRs and data RAM)
- · Data size (byte or word)
- Trigger source
- Transfer mode (One-Shot, Repeated or Continuous)
- Addressing modes (Fixed Address or Address Blocks, with or without Address Increment/ Decrement)

In addition, the DMA Controller provides channel priority arbitration for all channels.

#### 5.1.1 SOURCE AND DESTINATION

Using the DMA Controller, data may be moved between any two addresses in the Data Space. The SFR space (0000h to 07FFh), or the data RAM space (0800h to FFFFh), can serve as either the source or the destination. Data can be moved between these areas in either direction or between addresses in either area. The four different combinations are shown in Figure 5-2.

If it is necessary to protect areas of data RAM, the DMA Controller allows the user to set upper and lower address boundaries for operations in the Data Space above the SFR space. The boundaries are set by the DMAH and DMAL Limit registers. If a DMA channel attempts an operation outside of the address boundaries, the transaction is terminated and an interrupt is generated.

# 5.1.2 DATA SIZE

The DMA Controller can handle both 8-bit and 16-bit transactions. Size is user-selectable using the SIZE bit (DMACHn<1>). By default, each channel is configured for word-sized transactions. When byte-sized transactions are chosen, the LSb of the source and/or destination address determines if the data represents the upper or lower byte of the data RAM location.

#### 5.1.3 TRIGGER SOURCE

The DMA Controller can use any one of the device's interrupt sources to initiate a transaction. The DMA Trigger sources are listed in reverse order of their natural interrupt priority and are shown in Table 5-1.

Since the source and destination addresses for any transaction can be programmed independently of the trigger source, the DMA Controller can use any trigger to perform an operation on any peripheral. This also allows DMA channels to be cascaded to perform more complex transfer operations.

# 5.1.4 TRANSFER MODE

The DMA Controller supports four types of data transfers, based on the volume of data to be moved for each trigger.

- One-Shot: A single transaction occurs for each trigger.
- Continuous: A series of back-to-back transactions occur for each trigger; the number of transactions is determined by the DMACNTn transaction counter.
- Repeated One-Shot: A single transaction is performed repeatedly, once per trigger, until the DMA channel is disabled.
- Repeated Continuous: A series of transactions are performed repeatedly, one cycle per trigger, until the DMA channel is disabled.

All transfer modes allow the option to have the source and destination addresses, and counter value automatically reloaded after the completion of a transaction. Repeated mode transfers do this automatically.

## 5.1.5 ADDRESSING MODES

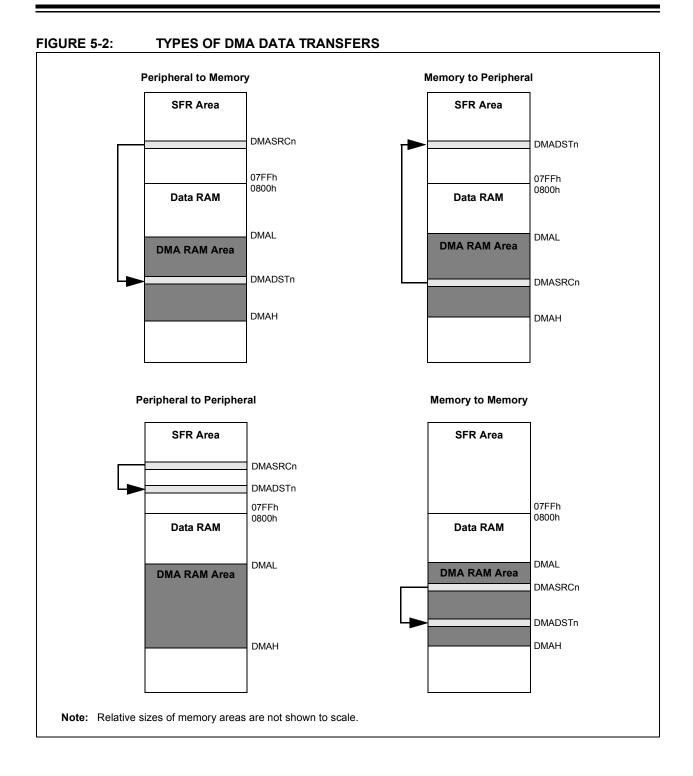
The DMA Controller also supports transfers between single addresses or address ranges. The four basic options are:

- Fixed-to-Fixed: Between two constant addresses
- Fixed-to-Block: From a constant source address to a range of destination addresses
- Block-to-Fixed: From a range of source addresses to a single, constant destination address
- Block-to-Block: From a range to source addresses to a range of destination addresses

The option to select auto-increment or auto-decrement of source and/or destination addresses is available for Block Addressing modes.

In addition to the four basic modes, the DMA Controller also supports Peripheral Indirect Addressing (PIA) mode, where the source or destination address is generated jointly by the DMA Controller and a PIA capable peripheral. When enabled, the DMA channel provides a base source and/or destination address, while the peripheral provides a fixed range offset address.

For PIC24FJ256GA705 family devices, the 12-bit A/D Converter module is the only PIA capable peripheral. Details for its use in PIA mode are provided in Section 24.0 "12-Bit A/D Converter with Threshold Detect".



# 5.1.6 CHANNEL PRIORITY

Each DMA channel functions independently of the others, but also competes with the others for access to the data and DMA buses. When access collisions occur, the DMA Controller arbitrates between the channels using a user-selectable priority scheme. Two schemes are available:

- Round-Robin: When two or more channels collide, the lower numbered channel receives priority on the first collision. On subsequent collisions, the higher numbered channels each receive priority, based on their channel number.
- Fixed: When two or more channels collide, the lowest numbered channel always receives priority, regardless of past history; however, any channel being actively processed is not available for an immediate retrigger. If a higher priority channel is continually requesting service, it will be scheduled for service after the next lower priority channel with a pending request.

# 5.2 Typical Setup

To set up a DMA channel for a basic data transfer:

- Enable the DMA Controller (DMAEN = 1) and select an appropriate channel priority scheme by setting or clearing PRSSEL.
- 2. Program DMAH and DMAL with the appropriate upper and lower address boundaries for data RAM operations.
- 3. Select the DMA channel to be used and disable its operation (CHEN = 0).
- Program the appropriate source and destination addresses for the transaction into the channel's DMASRCn and DMADSTn registers. For PIA mode addressing, use the base address value.
- 5. Program the DMACNTn register for the number of triggers per transfer (One-Shot or Continuous modes) or the number of words (bytes) to be transferred (Repeated modes).
- 6. Set or clear the SIZE bit to select the data size.
- 7. Program the TRMODE<1:0> bits to select the Data Transfer mode.
- 8. Program the SAMODE<1:0> and DAMODE<1:0> bits to select the addressing mode.
- 9. Enable the DMA channel by setting CHEN.
- 10. Enable the trigger source interrupt.

# 5.3 Peripheral Module Disable

Unlike other peripheral modules, the channels of the DMA Controller cannot be individually powered down using the Peripheral Module Disable (PMD) registers. Instead, the channels are controlled as two groups. The DMA0MD bit (PMD7<4>) selectively controls DMACH0 through DMACH3. The DMA1MD bit (PMD7<5>) controls DMACH4 and DMACH5. Setting both bits effectively disables the DMA Controller.

# 5.4 DMA Registers

The DMA Controller uses a number of registers to control its operation. The number of registers depends on the number of channels implemented for a particular device.

There are always four module-level registers (one control and three buffer/address):

- DMACON: DMA Engine Control Register (Register 5-1)
- DMAH and DMAL: DMA High and Low Address Limit Registers
- DMABUF: DMA Data Buffer

Each of the DMA channels implements five registers (two control and three buffer/address):

- DMACHn: DMA Channel n Control Register (Register 5-2)
- DMAINTn: DMA Channel n Interrupt Register (Register 5-3)
- DMASRCn: DMA Data Source Address Pointer for Channel n
- DMADSTn: DMA Data Destination Address Pointer for Channel n
- DMACNTn: DMA Transaction Counter for Channel n

For PIC24FJ256GA705 family devices, there are a total of 34 registers.

R/W-0	U-0						
DMAEN	—	—	—	_	—	—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	_	—	—	PRSSEL
bit 7							bit 0

# REGISTER 5-1: DMACON: DMA ENGINE CONTROL REGISTER

# Legend:

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 DMAEN: DMA Module Enable bit

1 = Enables module

0 = Disables module and terminates all active DMA operation(s)

bit 14-1 Unimplemented: Read as '0'

bit 0 PRSSEL: Channel Priority Scheme Selection bit

1 = Round-robin scheme

0 = Fixed priority scheme

U-0	U-0	U-0	r-0	U-0	R/W-0	R/W-0	R/W-0
_	_	_	_		NULLW	RELOAD <sup>(1)</sup>	CHREQ <sup>(3)</sup>
bit 15			•	•	•	•	bit
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SAMODE1	SAMODE0	DAMODE1	DAMODE0	TRMODE1	TRMODE0	SIZE	CHEN
bit 7							bit
Legend:		r = Reserved	bit				
R = Readable	e bit	W = Writable	bit	U = Unimplen	nented bit, read	l as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own
bit 15-13	Unimplemen	ted: Read as '	)'				
bit 12	Reserved: Ma	aintain as '0'					
bit 11	Unimplemen	ted: Read as '	י)				
bit 10	NULLW: Null	Write Mode bit					
		/ write is initiate		n for every writ	e to DMADSTr	ı	
		ny write is initia					
bit 9		Idress and Cou					
		on, DMADSTn ne next operatio		n registers are	reloaded to th	eir previous va	lues upon th
				n are not reload	led on the start	of the next ope	eration <sup>(2)</sup>
bit 8		A Channel Soft					
	1 = A DMA re		ed by software;		cleared upon c	ompletion of a	DMA transfe
bit 7-6		0>: Source Add	•	lection bits			
		Cn is used in F			and remains u	nchanged	
	10 = DMASR	Cn is decreme	nted based on	the SIZE bit aff	ter a transfer co	ompletion	
		Cn is incremen				mpletion	
		Cn remains un					
bit 5-4		0>: Destination				nahanaad	
		Tn is used in P Tn is decreme					
		Tn is incremen					
	00 = DMADS	Tn remains un	changed after a	a transfer comp	oletion		
bit 3-2		0>: Transfer Mo		oits			
		ed Continuous i	node				
	10 = Continue	ed One-Shot m	ode				
	00 = One-Sho		Juc				
bit 1	SIZE: Data Si	ize Selection bi	t				
	1 = Byte (8-bi	t)					
	0 = Word (16-	,					
bit 0		Channel Enabl					
		sponding chan					
	u – The corre	sponding chan					
	nly the original [		-		-		DMADSTn.
2: DN	MASPCn DMA	DSTn and DM/	ACNITh are alw	ave releaded in	n Reneated mo	da transfore	

- DMASRCn, DMADSTn and DMACNTn are always reloaded in Repeated mode transfers (DMACHn<2> = 1), regardless of the state of the RELOAD bit.
- 3: The number of transfers executed while CHREQ is set depends on the configuration of TRMODE<1:0>.

# REGISTER 5-3: DMAINTn: DMA CHANNEL n INTERRUPT REGISTER

R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
DBUFWF <sup>(1)</sup>	CHSEL6	CHSEL5	CHSEL4	CHSEL3	CHSEL2	CHSEL1	CHSEL0		
bit 15				1 1		1	bit 8		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0		
HIGHIF <sup>(1,2)</sup>	LOWIF <sup>(1,2)</sup>	DONEIF <sup>(1)</sup>	HALFIF <sup>(1)</sup>	OVRUNIF <sup>(1)</sup>	_	_	HALFEN		
bit 7							bit		
Legend:									
R = Readable		W = Writable		U = Unimplem					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown		
bit 15	1 = The cont DMASRO	Cn in Null Write ent of the DMA	A buffer has r mode	bit <sup>(1)</sup> not been written n written to the lo		·			
bit 14-8	CHSEL<6:0>	: DMA Channe	I Trigger Selec	ction bits					
		for a complete							
bit 7	<b>HIGHIF:</b> DMA High Address Limit Interrupt Flag bit <sup>(1,2)</sup> 1 = The DMA channel has attempted to access an address higher than DMAH or the upper limit of the								
	1 = The DMA data RAN		ttempted to ac	cess an address	s higher than I	DMAH or the up	per limit of th		
			ot invoked the	high address li	mit interrupt				
bit 6	<ul> <li>0 = The DMA channel has not invoked the high address limit interrupt</li> <li>LOWIF: DMA Low Address Limit Interrupt Flag bit<sup>(1,2)</sup></li> </ul>								
	the SFR	range (07FFh)		ccess the DMA		lower than DM	AL, but abov		
L:1 F				low address lin	nit interrupt				
bit 5	If CHEN = 1:	A Complete Op	eration interru	Ipt Flag bit					
		ious DMA sess	ion has ended	with completior	ı				
		ent DMA sessio							
	If CHEN = 0:								
	-			with completion					
h:+ 4	•			without comple	tion				
bit 4		A 50% Waterma In has reached							
		In has not reac							
bit 3	OVRUNIF: DMA Channel Overrun Flag bit <sup>(1)</sup>								
		channel is trig		s still completing	the operation	based on the p	revious trigge		
bit 2-1		ted: Read as '		a					
bit 0	-	Ifway Completi		bit					
		s are invoked w	hen DMACNT	n has reached i		nt and at compl	etion		
		upi is invokeu c	ing at the com	piecion of the tra					
Note 1: Se	tting these flag	-	-	ate an interrupt.					

DMAL) is NOT done before the actual access.

CHSEL<6:0>	Trigger (Interrupt)	CHSEL<6:0>	Trigger (Interrupt)	
0000000	Off	1000001	UART2 TX Interrupt	
0001001	MCCP4 IC/OC Interrupt	1000010	UART2 RX Interrupt	
0001010	MCCP4 Timer Interrupt	1000011	UART2 Error Interrupt	
0001011	MCCP3 IC/OC Interrupt	1000100	UART1 TX Interrupt	
0001100	MCCP3 Timer Interrupt	1000101	UART1 RX Interrupt	
0001101	MCCP2 IC/OC Interrupt	1000110	UART1 Error Interrupt	
0001110	MCCP2 Timer Interrupt	1001011	DMA Channel 5 Interrupt	
0001111	MCCP1 IC/OC Interrupt	1001100	DMA Channel 4 Interrupt	
0010000	MCCP1 Timer Interrupt	1001101	DMA Channel 3 Interrupt	
0010100	OC3 Interrupt	1001110	DMA Channel 2 Interrupt	
0010101	OC2 Interrupt	1001111	DMA Channel 1 Interrupt	
0010110	OC1 Interrupt	1010000	DMA Channel 0 Interrupt	
0011010	IC3 Interrupt	1010001	A/D Interrupt	
0011011	IC2 Interrupt	1010011	PMP Interrupt	
0011100	IC1 Interrupt	1010100	HLVD Interrupt	
0100000	SPI3 Receive Interrupt	1010101	CRC Interrupt	
0100001	SPI3 Transmit Interrupt	1011011	CLC2 Out	
0100010	SPI3 General Interrupt	1011100	CLC1 Out	
0100011	SPI2 Receive Interrupt	1011110	RTCC Alarm Interrupt	
0100100	SPI2 Transmit Interrupt	1100001	TMR3 Interrupt	
0100101	SPI2 General Interrupt	1100010	TMR2 Interrupt	
0100110	SPI1 Receive Interrupt	1100011	TMR1 Interrupt	
0100111	SPI1 Transmit Interrupt	1100110	CTMU Trigger	
0101000	SPI1 General Interrupt	1100111	Comparator Interrupt	
0101111	I2C2 Slave Interrupt	1101000	INT4 Interrupt	
0110000	I2C2 Master Interrupt	1101001	INT3 Interrupt	
0110001	I2C2 Bus Collision Interrupt	1101010	INT2 Interrupt	
0110010	I2C1 Slave Interrupt	1101011	INT1 Interrupt	
0110011	I2C1 Master Interrupt	1101100	INT0 Interrupt	
0110100	I2C1 Bus Collision Interrupt	1101101	Interrupt-on-Change (IOC) Interrupt	

# TABLE 5-1: DMA TRIGGER SOURCES

# 6.0 FLASH PROGRAM MEMORY

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "PIC24F Flash Program Memory" (DS30009715), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The PIC24FJ256GA705 family of devices contains internal Flash program memory for storing and executing application code. The program memory is readable, writable and erasable. The Flash memory can be programmed in four ways:

- In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>)
- Run-Time Self-Programming (RTSP)
- JTAG
- Enhanced In-Circuit Serial Programming (Enhanced ICSP)

ICSP allows a PIC24FJ256GA705 family device to be serially programmed while in the end application circuit. This is simply done with two lines for the programming clock and programming data (named PGCx and PGDx, respectively), and three other lines for power (VDD), ground (Vss) and Master Clear (MCLR). This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed. RTSP is accomplished using TBLRD (Table Read) and TBLWT (Table Write) instructions. With RTSP, the user may write program memory data in blocks of 128 instructions (384 bytes) at a time and erase program memory in blocks of 1024 instructions (3072 bytes) at a time.

The device implements a 7-bit Error Correcting Code (ECC). The NVM block contains a logic to write and read ECC bits to and from the Flash memory. The Flash is programmed at the same time as the corresponding ECC parity bits. The ECC provides improved resistance to Flash errors. ECC single bit errors can be transparently corrected; ECC double-bit errors result in a trap.

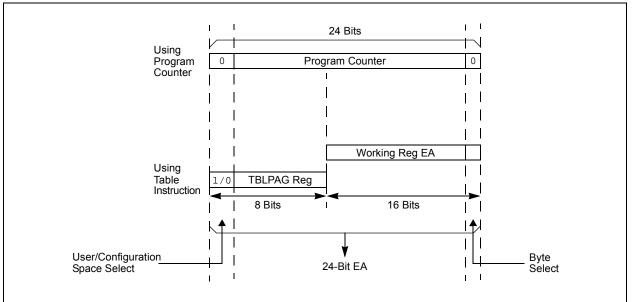
# 6.1 Table Instructions and Flash Programming

Regardless of the method used, all programming of Flash memory is done with the Table Read and Table Write instructions. These allow direct read and write access to the program memory space from the data memory while the device is in normal operating mode. The 24-bit target address in the program memory is formed using the TBLPAG<7:0> bits and the Effective Address (EA) from a W register, specified in the table instruction, as shown in Figure 6-1.

The TBLRDL and the TBLWTL instructions are used to read or write to bits<15:0> of program memory. TBLRDL and TBLWTL can access program memory in both Word and Byte modes.

The TBLRDH and TBLWTH instructions are used to read or write to bits<23:16> of program memory. TBLRDH and TBLWTH can also access program memory in Word or Byte mode.

#### FIGURE 6-1: ADDRESSING FOR TABLE REGISTERS



# 6.2 RTSP Operation

The PIC24F Flash program memory array is organized into rows of 128 instructions or 384 bytes. RTSP allows the user to erase blocks of eight rows (1024 instructions) at a time and to program one row at a time. It is also possible to program two instruction word blocks.

The 8-row erase blocks and single row write blocks are edge-aligned, from the beginning of program memory, on boundaries of 3072 bytes and 384 bytes, respectively.

When data is written to program memory using TBLWT instructions, the data is not written directly to memory. Instead, data written using Table Writes is stored in holding latches until the programming sequence is executed.

Any number of TBLWT instructions can be executed and a write will be successfully performed. However, 128 TBLWT instructions are required to write the full row of memory.

To ensure that no data is corrupted during a write, any unused address should be programmed with FFFFFFh. This is because the holding latches reset to an unknown state, so if the addresses are left in the Reset state, they may overwrite the locations on rows which were not rewritten.

The basic sequence for RTSP programming is to set the Table Pointer to point to the programming latches, do a series of TBLWT instructions to load the buffers and set the NVMADRU/NVMADR registers to point to the destination. Programming is performed by setting the control bits in the NVMCON register.

Data can be loaded in any order and the holding registers can be written to multiple times before performing a write operation. Subsequent writes, however, will wipe out any previous writes.

**Note:** Writing to a location multiple times without erasing is *not* recommended.

All of the Table Write operations are single-word writes (2 instruction cycles), because only the buffers are written. A programming cycle is required for programming each row.

# 6.3 JTAG Operation

The PIC24F family supports JTAG boundary scan. Boundary scan can improve the manufacturing process by verifying pin to PCB connectivity.

# 6.4 Enhanced In-Circuit Serial Programming

Enhanced In-Circuit Serial Programming uses an onboard bootloader, known as the Program Executive (PE), to manage the programming process. Using an SPI data frame format, the Program Executive can erase, program and verify program memory. For more information on Enhanced ICSP, see the device programming specification.

# 6.5 Control Registers

There are four SFRs used to read and write the program Flash memory: NVMCON, NVMADRU, NVMADR and NVMKEY.

The NVMCON register (Register 6-1) controls which blocks are to be erased, which memory type is to be programmed and when the programming cycle starts.

NVMKEY is a write-only register that is used for write protection. To start a programming or erase sequence, the user must consecutively write 55h and AAh to the NVMKEY register. Refer to **Section 6.6 "Programming Operations"** for further details.

The NVMADRU/NVMADR registers contain the upper byte and lower word of the destination of the NVM write or erase operation. Some operations (chip erase) operate on fixed locations and do not require an address value.

# 6.6 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. During a programming or erase operation, the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON<15>) starts the operation and the WR bit is automatically cleared when the operation is finished.

REGISTER	6-1: NV	MCON: FLAS	SH MEMOR	Y CONTROL F	REGISTER			
R/S-0, HC <sup>(1)</sup>	R/W-0 <sup>(1)</sup>	R-0, HSC <sup>(1)</sup>	R/W-0	r-0	r-0	U-0	U-0	
WR	WREN	WRERR	NVMSIDL	—	—	—	—	
bit 15							bit	
U-0	U-0	U-0	U-0	R/W-0 <sup>(1)</sup>	R/W-0 <sup>(1)</sup>	R/W-0 <sup>(1)</sup>	R/W-0 <sup>(1)</sup>	
_	_		_	NVMOP3 <sup>(2)</sup>	NVMOP2 <sup>(2)</sup>	NVMOP1 <sup>(2)</sup>	NVMOP0 <sup>(2)</sup>	
bit 7							bit	
Legend:		S = Settable	hit	HC = Hardware	Clearable bit	r = Reserved b	nit	
R = Readable	a hit	W = Writable		'0' = Bit is clear		x = Bit is unkn		
-n = Value at		'1' = Bit is se					Own	
		e/Clearable bit	ι	0 – Unimpierne	ented bit, read as	5 0		
bit 15	cleared	s a Flash merr I by hardware c	once the oper	or erase operat ation is complete plete and inactive		on is self-timed	and the bit	
bit 14	-	te Enable bit <sup>(1)</sup>						
	1 = Enable	s Flash progra	m/erase operation	ations				
	0 = Inhibits	Flash program	/erase opera	tions				
bit 13	WRERR: Write Sequence Error Flag bit <sup>(1)</sup>							
	automa	atically on any s	set attempt of	sequence attem the WR bit) mpleted normally	-	ion has occurr	ed (bit is s	
bit 12	•	NVM Stop in Id	•	inplotod normally				
511 12	1 = Remov	es power from	the program	memory when de				
bit 11-10		Maintain as '0'	,	,				
bit 9-4		ented: Read as	; 'O'					
bit 3-0	•	0>: NVM Operation		oits <sup>(1,2)</sup>				
	1110 = Chi 0100 = Unu 0011 = Era 0010 = Rov	p erases user r ısed	nemory (does program or ex operation	s not erase Devic ecutive memory	e ID, customer (	OTP or executiv	ve memory)	
	iese bits can	only be reset of	on a Power-o	n Reset.				
2: Al	l other comb	other combinations of NVMOP<3:0> are unimplemented						

# REGISTER 6-1: NVMCON: FLASH MEMORY CONTROL REGISTER

**2:** All other combinations of NVMOP<3:0> are unimplemented.

#### 6.6.1 PROGRAMMING ALGORITHM FOR FLASH PROGRAM MEMORY

The user can program one row of Flash program memory at a time. To do this, it is necessary to erase the 8-row erase block containing the desired row. The general process is:

- 1. Read eight rows of program memory (1024 instructions) and store in data RAM.
- 2. Update the program data in RAM with the desired new data.
- 3. Erase the block (see Example 6-1):
  - a) Set the NVMOP<3:0> bits (NVMCON<3:0>) to '0011' to configure for block erase. Set the WREN (NVMCON<14>) bit.
  - b) Write the starting address of the block to be erased into the NVMADRU/NVMADR registers.
  - c) Write 55h to NVMKEY.
  - d) Write AAh to NVMKEY.
  - e) Set the WR bit (NVMCON<15>). The erase cycle begins and the CPU stalls for the duration of the erase cycle. When the erase is done, the WR bit is cleared automatically.
- 4. Update the TBLPAG register to point to the programming latches on the device. Update the NVMADRU/NVMADR registers to point to the destination in the program memory.

#### TABLE 6-1: EXAMPLE PAGE ERASE

- 5. Write the first 128 instructions from data RAM into the program memory buffers (see Table 6-1).
- 6. Write the program block to Flash memory:
  - a) Set the NVMOPx bits to '0010' to configure for row programming. Set the WREN bit.
  - b) Write 55h to NVMKEY.
  - c) Write AAh to NVMKEY.
  - d) Set the WR bit. The programming cycle begins and the CPU stalls for the duration of the write cycle. When the write to Flash memory is done, the WR bit is cleared automatically.
- Repeat Steps 4 through 6, using the next available 128 instructions from the block in data RAM, by incrementing the value in NVMADRU/ NVMADR until all 1024 instructions are written back to Flash memory.

For protection against accidental operations, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPS, as shown in Example 6-2.

Step 1:	Set the NVMCON register to erase a page.
MOV	#0x4003, W0
MOV	W0, NVMCON
Step 2:	Load the address of the page to be erased into the NVMADR register pair.
MOV	<pre>#PAGE_ADDR_LO, W0</pre>
MOV	W0, NVMADR
MOV	<pre>#PAGE_ADDR_HI, W0</pre>
MOV	W0, NVMADRU
Step 3:	Set the WR bit.
MOV	#0x55, W0
MOV	W0, NVMKEY
MOV	#OxAA, WO
MOV	W0, NVMKEY
BSET	NVMCON, #WR
NOP	
NOP	
NOP	

# EXAMPLE 6-1: ERASING A PROGRAM MEMORY BLOCK ('C' LANGUAGE CODE)

<pre>// C example using MPLAB XC16     unsigned long progAddr = 0xXXXXXX;     unsigned int offset;</pre>	// Address of row to write
//Set up pointer to the first memory location	to be written
NVMADRU = progAddr>>16;	// Initialize PM Page Boundary SFR
NVMADR = progAddr & 0xFFFF;	<pre>// Initialize lower word of address</pre>
$NVMCON = 0 \times 4003;$	// Initialize NVMCON
asm("DISI #5");	<pre>// Block all interrupts with priority &lt;7</pre>
	// for next 5 instructions
builtin_write_NVM();	// check function to perform unlock
	// sequence and set WR

#### TABLE 6-2: CODE MEMORY PROGRAMMING EXAMPLE: ROW WRITES

Step 1: Set	t the NVMCON register to program 128 instruction words.
MOV	#0x4002, W0
MOV	W0, NVMCON
	ialize the TBLPAG register for writing to the latches.
MOV	#0xFA, W12
MOV	W12, TBLPAG
	ad W0:W5 with the next 4 instruction words to program.
MOV	# <lsw0>, W0</lsw0>
MOV	# <msb1:msb0>, W1</msb1:msb0>
MOV	# <lsw1>, W2</lsw1>
MOV	# <lsw2>, W3</lsw2>
MOV	# <msb3:msb2>, W4</msb3:msb2>
MOV	# <lsw3>, W5</lsw3>
Step 4: Set	t the Read Pointer (W6) and load the (next set of) write latches.
CLR	W6
CLR	W7
TBLWTL	[W6++], [W7]
TBLWTH.B	[W6++], [W7++]
TBLWTH.B	[W6++], [++W7]
TBLWTL	[W6++], [W7++]
TBLWTL	[W6++], [W7]
TBLWTH.B	[W6++], [W7++]
TBLWTH.B	[W6++], [++W7]
TBLWTL	[W6++], [W7++]
Step 5: Re	peat Steps 4 and 5, for a total of 32 times, to load the write latches with 128 instructions.
Step 6: Set	t the NVMADRU/NVMADR register pair to point to the correct address.
MOV	<pre>#DestinationAddress&lt;15:0&gt;, W3</pre>
MOV	#DestinationAddress<23:16>, W4
MOV	W3, NVMADR
MOV	W4, NVMADRU
Step 7: Exe	ecute the WR bit unlock sequence and initiate the write cycle.
MOV	#0x55, W0
MOV	W0, NVMKEY
MOV	#0xAA, WO
MOV	W0, NVMKEY
BSET	NVMCON, #WR
NOP	
NOP	
NOP	

DISI	#5	; Block all interrupts with priority <7 ; for next 5 instructions
MOV.B MOV MOV.B MOV	#0x55, W0 W0, NVMKEY #0xAA, W1 W1, NVMKEY	<pre>/ Hor next 5 instructions / Write the 0x55 key / Write the 0xAA key</pre>
BSET NOP NOP	NVMCON, #WR	; Start the programming sequence ; Required delays
BTSC BRA	NVMCON, #15 \$-2	; and wait for it to be ; completed

#### EXAMPLE 6-2: INITIATING A PROGRAMMING SEQUENCE

#### 6.6.2 PROGRAMMING A DOUBLE WORD OF FLASH PROGRAM MEMORY

If a Flash location has been erased, it can be programmed using Table Write instructions to write two instruction words (2 x 24-bit) into the write latch. The TBLPAG register is loaded with the address of the write latches and the NVMADRU/NVMADR registers are loaded with the address of the first of the two instruction words to be programmed. The TBLWTL and TBLWTH instructions write the desired data into the write latches. To configure the NVMCON register for a two-word write, set the NVMOPx bits (NVMCON<3:0>) to '0001'. The write is performed by executing the unlock sequence and setting the WR bit. An equivalent procedure in 'C', using the MPLAB<sup>®</sup> XC16 compiler and built-in hardware functions, is shown in Example 6-3.

#### TABLE 6-3: PROGRAMMING A DOUBLE WORD OF FLASH PROGRAM MEMORY

Step 1: Init	ialize the TBLPAG register for writing to the latches.
MOV	#0xFA, W12
MOV	W12, TBLPAG
Step 2: Loa	ad W0:W2 with the next two packed instruction words to program.
MOV	# <lsw0>, W0</lsw0>
MOV	# <msb1:msb0>, W1</msb1:msb0>
MOV	# <lsw1>, W2</lsw1>
Step 3: Se	t the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches.
CLR	W6
CLR	W7
TBLWTL	[W6++], [W7]
	[W6++], [W7++]
	[W6++], [++W7]
TBLWTL.W	[W6++], [W7++]
Step 4: Se	t the NVMADRU/NVMADR register pair to point to the correct address.
MOV	<pre>#DestinationAddress&lt;15:0&gt;, W3</pre>
MOV	#DestinationAddress<23:16>, W4
MOV	W3, NVMADR
MOV	W4, NVMADRU
Step 5: Se	t the NVMCON register to program two instruction words.
MOV	#0x4001, W10
MOV	W10, NVMCON
NOP	
Step 6: Init	iate the write cycle.
MOV	#0x55, W1
MOV	W1, NVMKEY
MOV	#0xAA, W1
MOV	W1, NVMKEY
BSET	NVMCON, #WR
NOP	
NOP	
NOP	

#### EXAMPLE 6-3: PROGRAMMING A DOUBLE WORD OF FLASH PROGRAM MEMORY ('C' LANGUAGE CODE)

// C example using MPLAB XC16	
unsigned long progAddr = 0xXXXXXX;	// Address of word to program
unsigned int progDatalL = 0xXXXX;	// Data to program lower word of word 1
unsigned char progDatalH = 0xXX;	// Data to program upper byte of word 1
unsigned int progData2L = 0xXXXX;	// Data to program lower word of word 2
unsigned char progData2H = 0xXX;	// Data to program upper byte of word 2
//Set up NVMCON for word programming	
$NVMCON = 0 \times 4001;$	// Initialize NVMCON
TBLPAG = 0xFA;	// Point TBLPAG to the write latches
//Set up pointer to the first memory locati	on to be written
NVMADRU = progAddr>>16;	// Initialize PM Page Boundary SFR
NVMADR = progAddr & 0xFFFF;	// Initialize lower word of address
//Perform TBLWT instructions to write latch	es
builtin_tblwtl(0, progDatalL);	// Write word 1 to address low word
builtin_tblwth(0, progData2H);	// Write word 1 to upper byte
builtin_tblwtl(1, progData2L);	// Write word 2 to address low word
builtin_tblwth(1, progData2H);	// Write word 2 to upper byte
<pre>asm("DISI #5");</pre>	// Block interrupts with priority <7 for next 5 $$
	// instructions
builtin_write_NVM();	// XC16 function to perform unlock sequence and set WR

# 7.0 RESETS

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Reset" (DS39712), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Reset module combines all Reset <u>sources</u> and controls the device Master Reset Signal, <u>SYSRST</u>. The following is a list of device Reset sources:

- POR: Power-on Reset
- MCLR: Master Clear Pin Reset
- SWR: RESET Instruction
- WDT: Watchdog Timer Reset
- · BOR: Brown-out Reset
- CM: Configuration Mismatch Reset
- TRAPR: Trap Conflict Reset
- · IOPUWR: Illegal Opcode Reset
- UWR: Uninitialized W Register Reset

A simplified block diagram of the Reset module is shown in Figure 7-1.

Any active source of Reset will make the SYSRST signal active. Many registers associated with the CPU and peripherals are forced to a known Reset state. Most registers are unaffected by a Reset; their status is unknown on POR and unchanged by all other Resets.

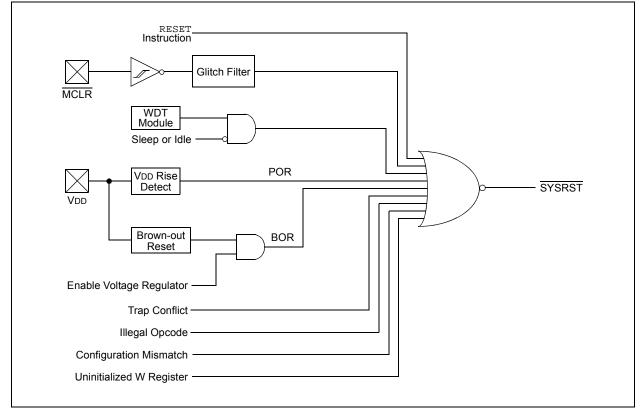
Note: Refer to the specific peripheral or CPU section of this manual for register Reset states.

All types of device Reset will set a corresponding status bit in the RCON register to indicate the type of Reset (see Register 7-1). A POR will clear all bits, except for the BOR and POR (RCON<1:0>) bits, which are set. The user may set or clear any bit at any time during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software will not cause a device Reset to occur.

The RCON register also has other bits associated with the Watchdog Timer and device power-saving states. The function of these bits is discussed in other sections of this data sheet.

Note: The status bits in the RCON register should be cleared after they are read so that the next RCON register values after a device Reset will be meaningful.

#### FIGURE 7-1: RESET SYSTEM BLOCK DIAGRAM



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**RCON: RESET CONTROL REGISTER** 

**REGISTER 7-1:** 

R/W-0	R/W-0	R/W-1	R/W-0	U-0	U-0	R/W-0	R/W-0
TRAPR <sup>(1)</sup>		SBOREN <sup>(5)</sup>	RETEN <sup>(2)</sup>		_	CM <sup>(1)</sup>	VREGS <sup>(3)</sup>
bit 15		OBOILEN				OW	bit 8
							bit 0
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1
EXTR <sup>(1)</sup>	SWR <sup>(1)</sup>	SWDTEN <sup>(4)</sup>	WDTO <sup>(1)</sup>	SLEEP <sup>(1)</sup>	IDLE <sup>(1)</sup>	BOR <sup>(1)</sup>	POR <sup>(1)</sup>
bit 7							bit 0
Legend:	la hit		.:.		anted hit read		
R = Readab		W = Writable k	DIT	-	ented bit, read		
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	IOWN
bit 15	TRAPR: Tran	Reset Flag bit <sup>(</sup>	1)				
	•	onflict Reset has					
		onflict Reset has					
bit 14	IOPUWR: Illeg	gal Opcode or l	Jninitialized W	/ Register Acce	ss Reset Flag	bit <sup>(1)</sup>	
				I address mode	e or Uninitializ	ed W register	is used as an
		Pointer and cau					
L:1 4 0	-	-		gister Reset has	s not occurred		
bit 13	1 = BOR is er	ftware Control (	Jver the BOR	Function Dit			
	0 = BOR is dis						
bit 12		ntion Mode Ena	able bit <sup>(2)</sup>				
				e is in Sleep mo tage levels are		ator supplies to	o the core)
bit 11-10		ted: Read as '0			present		
bit 9	-	ation Word Misi		lag bit <sup>(1)</sup>			
Sit 0	•	ration Word Mis		•			
				has not occurre	ed		
bit 8	VREGS: Fast	Wake-up from	Sleep bit <sup>(3)</sup>				
		e-up is disabled e-up is enabled	· · · ·				
bit 7		al Reset (MCLI		,			
		Clear (pin) Res	-	d			
		Clear (pin) Res					
bit 6	SWR: Softwar	re reset (Instr	uction) Flag bi	t <sup>(1)</sup>			
		instruction has l					
	0 <b>= A</b> reset i	instruction has	not been exec	uted			
	Il of the Reset sta ause a device Re	-	e set or cleare	d in software. S	etting one of th	nese bits in soft	ware does not
	the LPCFG Con		'1' (unprograr	nmed), the rete	ntion regulator	is disabled an	d the RETEN
	it has no effect. I						
<b>3</b> : R	Re-enabling the re	gulator after it e	nters Standby	mode will add a	delay, TVREG,	when waking u	• •
	pplications that d				-	-	-
	the FWDTEN<1	•	on bits are '11	' (unprogramm	ed), the WDT is	s always enabl	ed, regardless
	f the SWDTEN b he BOREN<1.0>	•	Configuration h	vite must be set t	o (01 <sup>°</sup> in order f	for SBODEN to	have an affact

#### 5: The BOREN<1:0> (FPOR<1:0>) Configuration bits must be set to '01' in order for SBOREN to have an effect.

#### REGISTER 7-1: RCON: RESET CONTROL REGISTER (CONTINUED)

bit 5	:	SWDTEN: Software Enable/Disable of WDT bit <sup>(4)</sup>
		1 = WDT is enabled
		0 = WDT is disabled
bit 4		WDTO: Watchdog Timer Time-out Flag bit <sup>(1)</sup>
		1 = WDT time-out has occurred
		0 = WDT time-out has not occurred
bit 3	:	SLEEP: Wake from Sleep Flag bit <sup>(1)</sup>
		1 = Device has been in Sleep mode
		0 = Device has not been in Sleep mode
bit 2		IDLE: Wake-up from Idle Flag bit <sup>(1)</sup>
		1 = Device has been in Idle mode
		0 = Device has not been in Idle mode
bit 1		BOR: Brown-out Reset Flag bit <sup>(1)</sup>
		1 = A Brown-out Reset has occurred (also set after a Power-on Reset)
		0 = A Brown-out Reset has not occurred
bit 0		POR: Power-on Reset Flag bit <sup>(1)</sup>
		1 = A Power-on Reset has occurred
		0 = A Power-on Reset has not occurred
Noto	<b>1</b> • All c	of the Reset status hits may be set or cleared in software. Setting one of

- 2: If the LPCFG Configuration bit is '1' (unprogrammed), the retention regulator is disabled and the RETEN bit has no effect. Retention mode preserves the SRAM contents during Sleep.
- **3:** Re-enabling the regulator after it enters Standby mode will add a delay, TVREG, when waking up from Sleep. Applications that do not use the voltage regulator should set this bit to prevent this delay from occurring.
- 4: If the FWDTEN<1:0> Configuration bits are '11' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.
- 5: The BOREN<1:0> (FPOR<1:0>) Configuration bits must be set to '01' in order for SBOREN to have an effect.

Flag Bit	Setting Event	Clearing Event
TRAPR (RCON<15>)	Trap Conflict Event	POR
IOPUWR (RCON<14>)	Illegal Opcode or Uninitialized W Register Access	POR
CM (RCON<9>)	Configuration Mismatch Reset	POR
EXTR (RCON<7>)	MCLR Reset	POR
SWR (RCON<6>)	RESET Instruction	POR
WDTO (RCON<4>)	WDT Time-out	CLRWDT, PWRSAV Instruction, POR
SLEEP (RCON<3>)	PWRSAV #0 Instruction	POR
IDLE (RCON<2>)	PWRSAV #1 Instruction	POR
BOR (RCON<1>)	POR, BOR	—
POR (RCON<0>)	POR	—

#### TABLE 7-1: RESET FLAG BIT OPERATION

Note: All Reset flag bits may be set or cleared by the user software.

**Note 1:** All of the Reset status bits may be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

#### 7.1 Special Function Register Reset States

Most of the Special Function Registers (SFRs) associated with the PIC24F CPU and peripherals are reset to a particular value at a device Reset. The SFRs are grouped by their peripheral or CPU function and their Reset values are specified in each section of this manual.

The Reset value for each SFR does not depend on the type of Reset, with the exception of four registers. The Reset value for the Reset Control register, RCON, will depend on the type of device Reset. The Reset value for the Oscillator Control register, OSCCON, will depend on the type of Reset and the programmed values of the FNOSC<2:0> bits in the FOSCSEL Flash Configuration Word (see Table 7-2). The RCFGCAL and NVMCON registers are only affected by a POR.

# 7.2 Device Reset Times

The Reset times for various types of device Reset are summarized in Table 7-3. Note that the Master Reset Signal, SYSRST, is released after the POR delay time expires.

The time at which the device actually begins to execute code will also depend on the system oscillator delays, which include the Oscillator Start-up Timer (OST) and the PLL lock time. The OST and PLL lock times occur in parallel with the applicable SYSRST delay times.

The Fail-Safe Clock Monitor (FSCM) delay determines the time at which the FSCM begins to monitor the system clock source after the SYSRST signal is released.

# 7.3 Brown-out Reset (BOR)

PIC24FJ256GA705 family devices implement a BOR circuit that provides the user with several configuration and power-saving options. The BOR is controlled by the BOREN<1:0> (FPOR<1:0>) Configuration bits.

When BOR is enabled, any drop of VDD below the BOR threshold results in a device BOR. Threshold levels are described in **Section 32.1 "DC Characteristics"**.

# 7.4 Clock Source Selection at Reset

If clock switching is enabled, the system clock source at device Reset is chosen, as shown in Table 7-2. If clock switching is disabled, the system clock source is always selected according to the Oscillator Configuration bits. For more information, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"Oscillator"** (DS39700).

# TABLE 7-2:OSCILLATOR SELECTION vs.TYPE OF RESET (CLOCK<br/>SWITCHING ENABLED)

Reset Type	Clock Source Determinant		
POR	FNOSC<2:0> Configuration bits		
BOR	(FOSCSEL<2:0>)		
MCLR			
WDTO	COSC<2:0> Control bits (OSCCON<14:12>)		
SWR			

Reset Type	Clock Source	SYSRST Delay	System Clock Delay	Notes
POR	EC	TPOR + TSTARTUP + TRST		1, 2, 3
	ECPLL	TPOR + TSTARTUP + TRST	Тьоск	1, 2, 3, 5
	XT, HS, SOSC	TPOR + TSTARTUP + TRST	Тоѕт	1, 2, 3, 4
	XTPLL, HSPLL	TPOR + TSTARTUP + TRST	TOST + TLOCK	1, 2, 3, 4, 5
	FRC, OSCFDIV	TPOR + TSTARTUP + TRST	TFRC	1, 2, 3, 6, 7
	FRCPLL	TPOR + TSTARTUP + TRST	TFRC + TLOCK	1, 2, 3, 5, 6
	LPRC	TPOR + TSTARTUP + TRST	TLPRC	1, 2, 3, 6
BOR	EC	TSTARTUP + TRST	_	2, 3
	ECPLL	TSTARTUP + TRST	Тьоск	2, 3, 5
	XT, HS, SOSC	TSTARTUP + TRST	Тоѕт	2, 3, 4
	XTPLL, HSPLL	TSTARTUP + TRST	TOST + TLOCK	2, 3, 4, 5
	FRC, OSCFDIV	TSTARTUP + TRST	TFRC	2, 3, 6, 7
	FRCPLL	TSTARTUP + TRST	TFRC + TLOCK	2, 3, 5, 6
	LPRC	TSTARTUP + TRST	TLPRC	2, 3, 6
MCLR	Any Clock	Trst	_	3
WDT	Any Clock	Trst	_	3
Software	Any clock	Trst	_	3
Illegal Opcode	Any Clock	Trst	_	3
Uninitialized W	Any Clock	Trst	_	3
Trap Conflict	Any Clock	Trst		3

TABLE 7-3: RESET DELAY TIMES FOR VARIOUS DEVICE RESETS

**Note 1:** TPOR = Power-on Reset delay (10  $\mu$ s nominal).

- **2**: TSTARTUP = TVREG.
- **3**: TRST = Internal State Reset Time (2 μs nominal).
- **4:** TOST = Oscillator Start-up Timer (OST). A 10-bit counter counts 1024 oscillator periods before releasing the oscillator clock to the system.
- **5**: TLOCK = PLL Lock Time.
- **6**: TFRC and TLPRC = RC Oscillator Start-up Times.
- 7: If Two-Speed Start-up is enabled, regardless of the Primary Oscillator selected, the device starts with FRC so the system clock delay is just TFRC, and in such cases, FRC start-up time is valid; it switches to the Primary Oscillator after its respective clock delay.

#### 7.4.1 POR AND LONG OSCILLATOR START-UP TIMES

The oscillator start-up circuitry and its associated delay timers are not linked to the device Reset delays that occur at power-up. Some crystal circuits (especially low-frequency crystals) will have a relatively long start-up time. Therefore, <u>one or more of the following conditions</u> is possible after SYSRST is released:

- The oscillator circuit has not begun to oscillate.
- The Oscillator Start-up Timer has not expired (if a crystal oscillator is used).
- The PLL has not achieved a lock (if PLL is used).

The device will not begin to execute code until a valid clock source has been released to the system. Therefore, the oscillator and PLL start-up delays must be considered when the Reset delay time must be known.

#### 7.4.2 FAIL-SAFE CLOCK MONITOR (FSCM) AND DEVICE RESETS

If the FSCM is enabled, it will begin to monitor the system clock source when SYSRST is released. If a valid clock source is not available at this time, the device will automatically switch to the FRC Oscillator and the user can switch to the desired crystal oscillator in the Trap Service Routine (TSR).

# 8.0 INTERRUPT CONTROLLER

- Note 1: This data sheet summarizes the features of the PIC24FJ256GA705 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Interrupts" (DS70000600) in the "dsPIC33/PIC24 Family Reference Manual", which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.
  - Some registers and associated bits described in this section may not be available on all devices. Refer to Section 4.0 "Memory Organization" in this data sheet for device-specific register and bit information.

The PIC24FJ256GA705 family interrupt controller reduces the numerous peripheral interrupt request signals to a single interrupt request signal to the PIC24FJ256GA705 family CPU.

The interrupt controller has the following features:

- Up to Eight Processor Exceptions and Software Traps
- Seven User-Selectable Priority Levels
- Interrupt Vector Table (IVT) with a Unique Vector for Each Interrupt or Exception Source
- Fixed Priority within a Specified User Priority Level
- Fixed Interrupt Entry and Return Latencies

# 8.1 Interrupt Vector Table

The PIC24FJ256GA705 family Interrupt Vector Table (IVT), shown in Figure 8-1, resides in program memory starting at location, 000004h. The IVT contains 6 non-maskable trap vectors and up to 118 sources of interrupt. In general, each interrupt source has its own vector. Each interrupt vector contains a 24-bit wide address. The value programmed into each interrupt vector location is the starting address of the associated Interrupt Service Routine (ISR).

Interrupt vectors are prioritized in terms of their natural priority. This priority is linked to their position in the vector table. Lower addresses generally have a higher natural priority. For example, the interrupt associated with Vector 0 takes priority over interrupts at any other vector address.

#### 8.1.1 ALTERNATE INTERRUPT VECTOR TABLE

The Alternate Interrupt Vector Table (AIVT) is located after the IVT, as shown in Figure 8-1. The AIVTEN (INTCON2<8>) control bit provides access to the AIVT. If the AIVTEN bit is set, all interrupt and exception processes will use the alternate vectors instead of the default vectors. The alternate vectors are organized in the same manner as the default vectors.

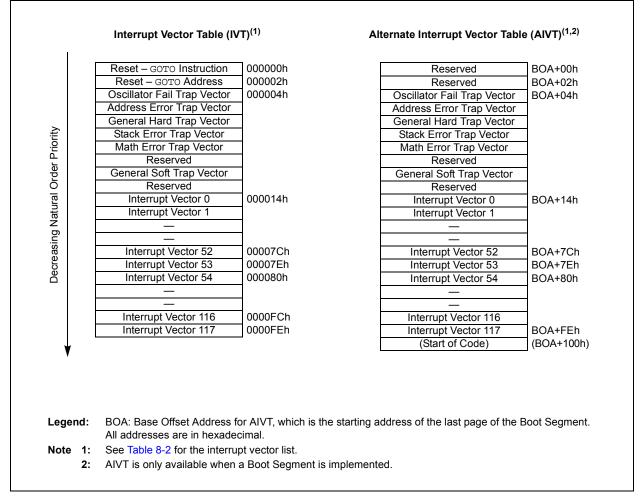
The AIVT supports emulation and debugging efforts by providing a means to switch between an application, and a support environment, without requiring the interrupt vectors to be reprogrammed. This feature also enables switching between applications for evaluation of different software algorithms at run time. If the AIVT is not needed, the AIVT should be programmed with the same addresses used in the IVT.

#### 8.2 Reset Sequence

A device Reset is not a true exception because the interrupt controller is not involved in the Reset process. The PIC24FJ256GA705 family devices clear their registers in response to a Reset, which forces the PC to zero. The device then begins program execution at location, 0x000000. A GOTO instruction at the Reset address can redirect program execution to the appropriate start-up routine.

**Note:** Any unimplemented or unused vector locations in the IVT should be programmed with the address of a default interrupt handler routine that contains a RESET instruction.

#### FIGURE 8-1: PIC24F INTERRUPT VECTOR TABLES



#### TABLE 8-1: TRAP VECTOR DETAILS

Vector Number	IVT Address	AIVT Address	Trap Source
0	000004h	BOA+04h	Oscillator Failure
1	000006h	BOA+06h	Address Error
2	000008h	BOA+08h	General Hardware Error
3	00000Ah	BOA+0Ah	Stack Error
4	00000Ch	BOA+0Ch	Math Error
5	00000Eh	BOA+0Eh	Reserved
6	000010h	000010h BOA+10h General Software Error	
7	000012h	BOA+12h	Reserved

**Legend:** BOA = Base Offset Address for AIVT segment, which is the starting address of the last page of the Boot Segment.

#### TABLE 8-2: INTERRUPT VECTOR DETAILS

	IRQ	IVT Address	In	terrupt Bit Lo	ocation
Interrupt Source	#	IVI Address	Flag	Enable	Priority
	Highest N	atural Order Pric	ority		
INT0 – External Interrupt 0	0	000014h	IFS0<0>	IEC0<0>	IPC0<2:0>
IC1 – Input Capture 1	1	000016h	IFS0<1>	IEC0<1>	IPC0<6:4>
OC1 – Output Compare 1	2	000018h	IFS0<2>	IEC0<2>	IPC0<10:8>
T1 – Timer1	3	00001Ah	IFS0<3>	IEC0<3>	IPC0<14:12>
DMA0 – Direct Memory Access 0	4	00001Ch	IFS0<4>	IEC0<4>	IPC1<2:0>
IC2 – Input Capture 2	5	00001Eh	IFS0<5>	IEC0<5>	IPC1<6:4>
OC2 – Output Compare 2	6	000020h	IFS0<6>	IEC0<6>	IPC1<10:8>
T2 – Timer2	7	000022h	IFS0<7>	IEC0<7>	IPC1<14:12>
T3 – Timer3	8	000024h	IFS0<8>	IEC0<8>	IPC2<2:0>
SPI1 – SPI1 General	9	000026h	IFS0<9>	IEC0<9>	IPC2<6:4>
SPI1TX – SPI1 Transfer Done	10	000028h	IFS0<10>	IEC0<10>	IPC2<10:8>
U1RX – UART1 Receiver	11	00002Ah	IFS0<11>	IEC0<11>	IPC2<14:12>
U1TX – UART1 Transmitter	12	00002Ch	IFS0<12>	IEC0<12>	IPC3<2:0>
ADC1 – A/D Converter 1	13	00002Eh	IFS0<13>	IEC0<13>	IPC3<6:4>
DMA1 – Direct Memory Access 1	14	000030h	IFS0<14>	IEC0<14>	IPC3<10:8>
NVM – NVM Program/Erase Complete	15	000032h	IFS0<15>	IEC0<15>	IPC3<14:12>
SI2C1 – I2C1 Slave Events	16	000034h	IFS1<0>	IEC1<0>	IPC4<2:0>
MI2C1 – I2C1 Master Events	17	000036h	IFS1<1>	IEC1<1>	IPC4<6:4>
Comp – Comparator	18	000038h	IFS1<2>	IEC1<2>	IPC4<10:8>
IOC – Interrupt-on-Change Interrupt	10	00003Ah	IFS1<3>	IEC1<3>	IPC4<14:12>
INT1 – External Interrupt 1	20	00003Ch	IFS1<4>	IEC1<4>	IPC5<2:0>
	20				
	21				
	22				
DMA2 – Direct Memory Access 2	23	000044h	IFS1<8>	IEC1<8>	IPC6<2:0>
OC3 – Output Compare 3	25	000044h	IFS1<9>	IEC1<0>	IPC6<6:4>
005 – Output Compare 5	26	00004011	11 01 - 92		11 00 0.42
	20				
INT2 – External Interrupt 2	28				
U2RX – UART2 Receiver	29	00004Eh	IFS1<13> IFS1<14>	IEC1<13>	IPC7<6:4>
	30	000050h		IEC1<14>	IPC7<10:8>
U2TX – UART2 Transmitter	31	000052h	IFS1<15>	IEC1<15>	IPC7<14:12>
SPI2 – SPI2 General	32	000054h	IFS2<0>	IEC2<0>	IPC8<2:0>
SPI2TX – SPI2 Transfer Done	33	000056h	IFS2<1>	IEC2<1>	IPC8<6:4>
—	34				
	35	-			
DMA3 – Direct Memory Access 3	36	00005Ch	IFS2<4>	IEC2<4>	IPC9<2:0>
IC3 – Input Capture 3	37	00005Eh	IFS2<5>	IEC2<5>	IPC9<6:4>
	38	—	—	—	
	39	—	—	—	
	40	—	—	—	
CCT3 – Capture/Compare Timer3	43	00006Ah	IFS2<11>	IEC2<11>	IPC10<14:12

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<b>TABLE 8-2:</b>	INTERRUPT VECTOR DETAILS (CONTINUED)
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Interment Course	IRQ		In	terrupt Bit Lo	ocation
Interrupt Source	#	IVT Address	Flag	Enable	Priority
CCT4 – Capture/Compare Timer	44	00006Ch	IFS2<12>	IEC2<12>	IPC11<2:0>
PMP – Parallel Master Port	45	00006Eh	IFS2<13>	IEC2<13>	IPC11<6:4>
DMA4 – Direct Memory Access 4	46	000070h	IFS2<14>	IEC2<14>	IPC11<10:8>
	47		_	—	
	48			—	
SI2C2 – I2C2 Slave Events	49	000076h	IFS3<1>	IEC3<1>	IPC12<6:4>
MI2C2 – I2C2 Master Events	50	000078h	IFS3<2>	IEC3<2>	IPC12<10:8>
	51			—	
_	52			_	_
INT3 – External Interrupt 3	53	00007Eh	IFS3<5>	IEC3<5>	IPC13<6:4>
INT4 – External Interrupt 4	54	000080h	IFS3<6>	IEC3<6>	IPC13<10:8>
_	55	_	_	_	
_	56	—	_	—	
	57			—	
SPI1RX – SPI1 Receive Done	58	000088h	IFS3<10>	IEC3<10>	IPC14<10:8>
SPI2RX – SPI2 Receive Done	59	00008Ah	IFS3<11>	IEC3<11>	IPC14<14:12>
SPI3RX – SPI3 Receive Done	60	00008Ch	IFS3<12>	IEC3<12>	IPC15<2:0>
DMA5 – Direct Memory Access 5	61	00008Eh	IFS3<13>	IEC3<13>	IPC15<6:4>
RTCC – Real-Time Clock and Calendar	62	000090h	IFS3<14>	IEC3<14>	IPC15<10:8>
CCP1 – Capture/Compare 1	63	000092h	IFS3<15>	IEC3<15>	IPC15<14:12>
CCP2 – Capture/Compare 2	64	000094h	IFS4<0>	IEC4<0>	IPC16<2:0>
U1E – UART1 Error	65	000096h	IFS4<1>	IEC4<1>	IPC16<6:4>
U2E – UART2 Error	66	000098h	IFS4<2>	IEC4<2>	IPC16<10:8>
CRC – Cyclic Redundancy Check	67	00009Ah	IFS4<3>	IEC4<3>	IPC16<14:12>
_	68	—		—	_
_	69	—	_	_	
_	70	—		—	_
—	71	—	—	—	—
HLVD – High/Low-Voltage Detect	72	0000A4h	IFS4<8>	IEC4<8>	IPC18<2:0>
—	73	—	—	—	—
—	74	—	—	—	—
—	75	—	_	—	
—	76	—	—	—	—
CTMU – Interrupt	77	0000AEh	IFS4<13>	IEC4<13>	IPC19<6:4>
	78		_	—	
_	79	—		_	
	80				
_	81	_	_	_	
	82	—			
_	83			_	

	IRQ		In	terrupt Bit Lo	ocation
Interrupt Source	#	IVT Address	Flag	Enable	Priority
I2C1BC – I2C1 Bus Collision	84	0000BCh	IFS5<4>	IEC5<4>	IPC21<2:0>
I2C2BC – I2C2 Bus Collision	85	0000BEh	IFS5<5>	IEC5<5>	IPC21<6:4>
_	86	_	_		_
_	87		_	_	_
_	88	—			
_	89	_	_		_
SPI3 – SPI3 General	90	0000C8h	IFS5<10>	IEC5<10>	IPC22<10:8>
SPI3TX – SPI3 Transfer Done	91	0000CAh	IFS5<11>	IEC5<11>	IPC22<14:12>
_	92	92	_		_
_	93	93	_		_
CCP3 – Capture/Compare 3	94	0000D0h	IFS5<14>	IEC5<14>	IPC23<10:8>
CCP4 – Capture/Compare 4	95	0000D2h	IFS5<15>	IEC5<15>	IPC23<14:12>
CLC1 – Configurable Logic Cell 1	96	0000D4h	IFS6<0>	IEC6<0>	IPC24<2:0>
CLC2 – Configurable Logic Cell 2	97	0000D6h	IFS6<1>	IEC6<1>	IPC24<6:4>
_	98		_	_	
_	99	_			
_	100	_			
CCT1 – Capture/Compare Timer1	101	0000DEh	IFS6<5>	IEC6<5>	IPC25<6:4>
CCT2 – Capture/Compare Timer2	102	0000E0h	IFS6<6>	IEC6<6>	IPC25<10:8>
	103	—			
_	104		_	_	_
_	105	_			
FST – FRC Self-Tuning Interrupt	106	0000E8h	IFS6<10>	IEC6<10>	IPC26<10:8>
_	107	_	_		_
ECCIE – ECC Single Bit Error	108	0000ECh	IFS6<12>	IEC6<12>	IPC27<2:0>
	109	_	_	_	
RTCCTS – Real-Time Clock Timestamp	110	0000F0h	IFS6<14>	IEC6<14>	IPC27<10:8>
_	111	_			
_	112	—			
_	113	_	_	—	
_	114	_	_	—	
	115	_	—	—	_
_	116	—	_	—	
JTAG – JTAG	117	0000FEh	IFS7<5>	IEC7<5>	IPC29<6:4>

 TABLE 8-2:
 INTERRUPT VECTOR DETAILS (CONTINUED)

# 8.3 Interrupt Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

Note:	In the event you are not able to access the product page using the link above, enter this URL in your browser:
	http://www.microchip.com/wwwproducts/ Devices.aspx?dDocName=en555464

#### 8.3.1 KEY RESOURCES

- "Interrupts" (DS70000600) in the "dsPIC33/PIC24 Family Reference Manual"
- Code Samples
- Application Notes
- · Software Libraries
- Webinars
- All Related *"dsPIC33/PIC24 Family Reference Manual"* Sections
- Development Tools

# 8.4 Interrupt Control and Status Registers

PIC24FJ256GA705 family devices implement the following registers for the interrupt controller:

- INTCON1
- INTCON2
- INTCON4
- IFS0 through IFS7
- IEC0 through IEC7
- IPC0 through ICP29
- INTTREG

#### 8.4.1 INTCON1-INTCON4

Global interrupt control functions are controlled from INTCON1 and INTCON2. INTCON1 contains the Interrupt Nesting Disable (NSTDIS) bit, as well as the control and status flags for the processor trap sources.

The INTCON2 register controls global interrupt generation, the external interrupt request signal behavior and the use of the Alternate Interrupt Vector Table (AIVT).

The INTCON4 register contains the Software Generated Hard Trap bit (SGHT) and ECC Double-Bit Error (ECCDBE) trap.

#### 8.4.2 IFSx

The IFSx registers maintain all of the interrupt request flags. Each source of interrupt has a status bit, which is set by the respective peripherals or external signal, and is cleared via software.

#### 8.4.3 IECx

The IECx registers maintain all of the interrupt enable bits. These control bits are used to individually enable interrupts from the peripherals or external signals.

#### 8.4.4 IPCx

The IPCx registers are used to set the Interrupt Priority Level (IPL) for each source of interrupt. Each user interrupt source can be assigned to one of eight priority levels.

#### 8.4.5 INTTREG

The INTTREG register contains the associated interrupt vector number and the new CPU Interrupt Priority Level, which are latched into the Vector Number bits (VECNUM<7:0>) and Interrupt Priority Level bits (ILR<3:0>) fields in the INTTREG register. The new Interrupt Priority Level is the priority of the pending interrupt.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the same sequence as they are listed in Table 8-2. For example, the INT0 (External Interrupt 0) is shown as having Vector Number 8 and a natural order priority of 0. Thus, the INT0IF bit is found in IFS0<0>, the INT0IE bit in IEC0<0> and the INT0IPx bits in the first position of IPC0 (IPC0<2:0>).

#### 8.4.6 STATUS/CONTROL REGISTERS

Although these registers are not specifically part of the interrupt control hardware, two of the CPU Control registers contain bits that control interrupt functionality. For more information on these registers, refer to "CPU with Extended Data Space (EDS)" (DS39732) in the "dsPIC33/PIC24 Family Reference Manual".

- The CPU STATUS Register, SR, contains the IPL<2:0> bits (SR<7:5>). These bits indicate the current CPU Interrupt Priority Level. The user software can change the current CPU Interrupt Priority Level by writing to the IPLx bits.
- The CORCON register contains the IPL3 bit, which together with the IPL<2:0> bits, also indicates the current CPU Interrupt Priority Level. IPL3 is a read-only bit so that trap events cannot be masked by the user software.

All Interrupt registers are described in Register 8-3 through Register 8-6 in the following pages.

REGISTER 8-1:	SR: ALU STATUS REGISTER <sup>(1)</sup>
---------------	--

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	DC
bit 15							bit 8

R/W-0 <sup>(3)</sup>	R/W-0 <sup>(3)</sup>	R/W-0 <sup>(3)</sup>	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2 <sup>(2)</sup>	IPL1 <sup>(2)</sup>	IPL0 <sup>(2)</sup>	RA	Ν	OV	Z	C
bit 7							bit 0

Legend:					
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'					
-n = Value at POR	'1'= Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7-5	IPL<2:0>: CPU Interrupt Priority Level Status bits <sup>(2,3)</sup> 111 = CPU Interrupt Priority Level is 7 (15); user interrupts are disabled 110 = CPU Interrupt Priority Level is 6 (14) 101 = CPU Interrupt Priority Level is 5 (13) 100 = CPU Interrupt Priority Level is 4 (12) 011 = CPU Interrupt Priority Level is 3 (11) 010 = CPU Interrupt Priority Level is 2 (10) 001 = CPU Interrupt Priority Level is 1 (9)
	001 = CPU Interrupt Priority Level is 1 (9) 000 = CPU Interrupt Priority Level is 0 (8)

**Note 1:** For complete register details, see Register 3-1.

- 2: The IPL<2:0> Status bits are concatenated with the IPL3 Status bit (CORCON<3>) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL when IPL3 = 1. User interrupts are disabled when IPL3 = 1.
- 3: The IPL<2:0> Status bits are read-only when the NSTDIS bit (INTCON1<15>) = 1.

# REGISTER 8-2: CORCON: CPU CORE CONTROL REGISTER<sup>(1)</sup>

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—			—	—		—
bit 15							bit 8

U-0	U-0	U-0	U-0	R/C-0	R/W-1	U-0	U-0
—	—	—	—	IPL3 <sup>(2)</sup>	PSV	—	—
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1'= Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-4 Unimplemented: Read as '0'

bit 3 IPL3: CPU Interrupt Priority Level Status bit<sup>(2)</sup> 1 = CPU Interrupt Priority Level is greater than 7 0 = CPU Interrupt Priority Level is 7 or less

bit 2 **PSV:** Not used as part of the interrupt module

bit 1-0 Unimplemented: Read as '0'

**Note 1:** For complete register details, see Register 3-2.

2: The IPL<2:0> Status bits are concatenated with the IPL3 Status bit (CORCON<3>) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL when IPL3 = 1. User interrupts are disabled when IPL3 = 1.

R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
NSTDIS		_	—	_		—	—				
bit 15							bit				
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0				
—	—		MATHERR	ADDRERR	STKERR	OSCFAIL	—				
bit 7							bit				
<u> </u>											
Legend:	- 1-14		- 1-:4			(0)					
R = Readable		W = Writable			ented bit, read						
-n = Value at	POR	'1' = Bit is se	et	'0' = Bit is cleared		x = Bit is unknown					
bit 15 bit 14-5	1 = Interrupt 0 = Interrupt	errupt Nesting nesting is dis nesting is en	abled abled								
bit 4	-	Unimplemented: Read as '0' MATHERR: Math Error Status bit									
511 4	1 = Math err	or trap has or or trap has no	curred								
bit 3	1 = Address	error trap has	r Trap Status bit s occurred s not occurred								
bit 2	STKERR: Si 1 = Stack en	tack Error Tra ror trap has o ror trap has n	p Status bit ccurred								
bit 1	<b>OSCFAIL:</b> O 1 = Oscillato	Scillator Failu r failure trap l	ire Trap Status bi	it							
bit 0	Unimpleme	nted: Read a	<b>s</b> '0'								

#### REGISTER 8-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-1	R-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0				
GIE	DISI	SWTRAP		_			AIVTEN				
bit 15	•						bit				
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
		—	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP				
bit 7							bit				
Legend:											
R = Readable	e bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'					
-n = Value at	Value at POR '1' = Bit is set				ared	x = Bit is unkr	nown				
bit 15	GIE: Global	Interrupt Enable	e bit								
	•	ts and associate	•		abled						
	•	ts are disabled, I	•	still enabled							
bit 14	DISI: DISI Instruction Status bit 1 = DISI instruction is active										
		struction is active struction is not a									
bit 13		Software Trap St									
		e trap is enabled									
	0 = Software	e trap is disabled	ł								
bit 12-9	Unimpleme	nted: Read as '	0'								
bit 8	AIVTEN: Alternate Interrupt Vector Table Enable bit										
		ernate Interrupt \ ndard Interrupt \			onfiguration bits	)					
bit 7-5	Unimpleme	nted: Read as '	0'								
bit 4	INT4EP: External Interrupt 4 Edge Detect Polarity Select bit										
	1 = Interrupt on negative edge										
	<ul> <li>0 = Interrupt on positive edge</li> <li>INT3EP: External Interrupt 3 Edge Detect Polarity Select bit</li> </ul>										
bit 3				Polarity Select	bit						
	1 = Interrupt on negative edge 0 = Interrupt on positive edge										
bit 2		ternal Interrupt 2		Polarity Select	bit						
		t on negative ed	-	,							
	0 = Interrupt	t on positive edg	е								
bit 1		ternal Interrupt 1	-	Polarity Select	bit						
		t on negative ed t on positive edg									
bit 0	•	ternal Interrupt (		Polaritv Select	t bit						
		t on negative ed									
		t on positive edg									

#### REGISTER 8-4: INTCON2: INTERRUPT CONTROL REGISTER 2

#### REGISTER 8-5: INTCON4: INTERRUPT CONTROL REGISTER 4

	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
bit 15	—	—	—	—	—	—	—	—
	bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	R/C-0	R/C-0
—	—		—	—	—	ECCDBE	SGHT
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-2 Unimplemented: Read as '0'

bit 1 ECCDBE: ECC Double-Bit Error Trap bit 1 = ECC Double-Bit Error trap has occurred 0 = ECC Double-Bit Error trap has not occurred

bit 0 SGHT: Software Generated Hard Trap Status bit

1 = Software generated hard trap has occurred

0 = Software generated hard trap has not occurred

R-0	U-0	R/W-0	U-0	R-0	R-0	R-0	R-0				
CPUIRQ		VHOLD		ILR3	ILR2	ILR1	ILR0				
bit 15							bit 8				
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0				
VECNUM7	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUMO				
bit 7	VECKOMO	VECHOING	VEONOMI	VEONO	VEONOMIZ	VEORO	bit (				
Legend:											
R = Readable	e bit	W = Writable	bit	U = Unimplen	nented bit, read	1 as '0'					
-n = Value at		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	nown				
bit 15	CPUIRQ: Inte	errupt Request	from Interrupt	Controller to C	PU bit						
						jed by the CPU	; this happens				
		e CPU priority is			ority						
bit 14		upt request is u i <b>ted:</b> Read as 'i	-	eu							
bit 13	-			ation hit							
DIT 13	<ul> <li>VHOLD: Vector Number Capture Configuration bit</li> <li>1 = The VECNUMx bits contain the value of the highest priority pending interrupt</li> </ul>										
	0 = The VEC	NUMx bits cor	ntain the value	of the last Ac	knowledged in	terrupt (i.e., the terrupts are per					
bit 12	Unimplemen	ted: Read as '	D'				-				
bit 11-8	ILR<3:0>: New CPU Interrupt Priority Level bits										
	1111 = CPU Interrupt Priority Level is 15										
	•										
	• 0001 = CPU Interrupt Priority Level is 1										
	0000 = CPU Interrupt Priority Level is 0										
bit 7-0	VECNUM<7:	0>: Vector Num	ber of Pendin	g Interrupt bits							
	11111111 =	VECNUM<7:0>: Vector Number of Pending Interrupt bits 11111111 = 255, Reserved; do not use									
	•										
	•		, 40 1101 400								
	• •										
	• • 00001001 =	9, IC1 – Input (									
	00001000 =	8, INT0 – Exter	Capture 1 rnal Interrupt C	)							
	00001000 = 00000111 =	8, INT0 – Exter 7, Reserved; d	Capture 1 nal Interrupt C o not use	)							
	00001000 = 00000111 = 00000110 =	8, INT0 – Exter 7, Reserved; d 6, Generic soft	Capture 1 mal Interrupt C o not use error trap	)							
	00001000 = 00000111 = 00000110 = 00000101 =	8, INT0 – Exter 7, Reserved; d	Capture 1 mal Interrupt C o not use error trap o not use	)							
	00001000 = 00000111 = 00000110 = 00000101 = 00000100 = 00000011 =	8, INT0 – Exter 7, Reserved; d 6, Generic soft 5, Reserved; d 4, Math error tr 3, Stack error t	Capture 1 rnal Interrupt C o not use error trap o not use ap rap	)							
	00001000 = 00000111 = 00000110 = 00000101 = 00000100 = 00000011 = 00000010 =	8, INT0 – Exter 7, Reserved; d 6, Generic soft 5, Reserved; d 4, Math error tr	Capture 1 rnal Interrupt C o not use error trap o not use ap rap t trap	)							

# REGISTER 8-6: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER

# 9.0 OSCILLATOR CONFIGURATION

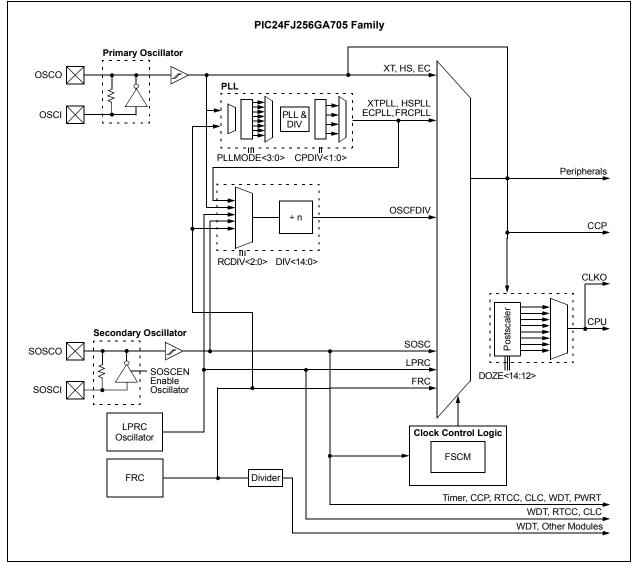
Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Oscillator" (DS39700), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The oscillator system for the PIC24FJ256GA705 family devices has the following features:

 An On-Chip PLL Block to provide a Range of Frequency Options for the System Clock

- Software-Controllable Switching between Various Clock Sources
- Software-Controllable Postscaler for Selective Clocking of CPU for System Power Savings
- A Fail-Safe Clock Monitor (FSCM) that Detects Clock Failure and Permits Safe Application Recovery or Shutdown
- A Separate and Independently Configurable System Clock Output for Synchronizing External Hardware

A simplified diagram of the oscillator system is shown in Figure 9-1.



#### FIGURE 9-1: PIC24FJ256GA705 FAMILY CLOCK DIAGRAM

# 9.1 CPU Clocking Scheme

The system clock source can be provided by one of four sources:

- Primary Oscillator (POSC) on the OSCI and OSCO pins
- Secondary Oscillator (SOSC) on the SOSCI and SOSCO pins
- Fast Internal RC (FRC) Oscillator
- · Low-Power Internal RC (LPRC) Oscillator

The Primary Oscillator and FRC sources have the option of using the internal PLL block, which can generate a 4x, 6x or 8x PLL clock. If the PLL is used, the PLL clocks can then be postscaled, if necessary, and used as the system clock. Refer to **Section 9.5 "Oscillator Modes"** for additional information. The internal FRC provides an 8 MHz clock source.

Each clock source (PRIPLL, FRCPLL, PRI, FRC, LPRC and SOSC) can be used as an input to an additional divider, which can then be used to produce a divided clock source for use as a system clock (OSCFDIV).

The selected clock source generates the processor and peripheral clock sources. The processor clock source is divided by two to produce the internal instruction cycle clock, FCY. In this document, the instruction cycle clock is also denoted by FOSC/2. The internal instruction cycle clock, FOSC/2, can be provided on the OSCO I/O pin for some operating modes of the Primary Oscillator.

# 9.2 Initial Configuration on POR

The oscillator source (and operating mode) that is used at a device Power-on Reset event is selected using Configuration bit settings. The Oscillator Configuration bit settings are located in the Configuration registers in the program memory (refer to Section 29.1 "Configuration Bits" for further details). The Primary Oscillator Configuration bits, POSCMD<1:0> (FOSC<1:0>), and the Oscillator Select Configuration bits, FNOSC<2:0> (FOSCSEL<2:0>), select the oscillator source that is used at a Power-on Reset. The OSCFDIV clock source is the default (unprogrammed) selection; the default input source to the OSCFDIV divider is the FRC clock source. Other oscillators may be chosen by programming these bit locations.

The Configuration bits allow users to choose between the various Clock modes shown in Table 9-1.

#### 9.2.1 CLOCK SWITCHING MODE CONFIGURATION BITS

The FCKSM<1:0> Configuration bits (FOSC<7:6>) are used to jointly configure device clock switching and the Fail-Safe Clock Monitor (FSCM). Clock switching is enabled only when FCKSM1 is programmed ('0'). The FSCM is enabled only when FCKSM<1:0> are both programmed ('00').

Oscillator Mode	Oscillator Source	POSCMD<1:0>	FNOSC<2:0>	Notes
Oscillator with Frequency Division (OSCFDIV)	Internal/External	11	111	1, 2, 3
Low-Power RC Oscillator (LPRC)	Internal	11	101	3
Secondary (Timer1) Oscillator (SOSC)	Secondary	11	100	3
Primary Oscillator (XT) with PLL Module (XTPLL)	Primary	01	011	
Primary Oscillator (EC) with PLL Module (ECPLL)	Primary	00	011	
Primary Oscillator (HS)	Primary	10	010	
Primary Oscillator (XT)	Primary	01	010	
Primary Oscillator (EC)	Primary	00	010	
Fast RC Oscillator with PLL Module (FRCPLL)	Internal	11	001	3
Fast RC Oscillator (FRC)	Internal	11	000	3

#### TABLE 9-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION

**Note 1:** The input oscillator to the OSCFDIV Clock mode is determined by the RCDIV<2:0> (CLKDIV<10:8) bits. At POR, the default value selects the FRC module.

- 2: This is the default Oscillator mode for an unprogrammed (erased) device.
- 3: OSCO pin function is determined by the OSCIOFCN Configuration bit.

### 9.3 Control Registers

The operation of the oscillator is controlled by five Special Function Registers:

- OSCCON
- CLKDIV
- OSCTUN
- OSCDIV
- OSCFDIV

The OSCCON register (Register 9-1) is the main control register for the oscillator. It controls clock source switching and allows the monitoring of clock sources. OSCCON is protected by a write lock to prevent inadvertent clock switches. See Section 9.4 "Clock Switching Operation" for more information. The CLKDIV register (Register 9-2) controls the features associated with Doze mode, as well as the postscalers for the OSCFDIV Clock mode and the PLL module.

The OSCTUN register (Register 9-3) allows the user to fine-tune the FRC Oscillator over a range of approximately  $\pm 1.5\%$ .

The OSCDIV and OSCFDIV registers provide control for the system oscillator frequency divider.

U-0	R-x <sup>(2)</sup>	R-x <sup>(2)</sup>	R-x <sup>(2)</sup>	U-0	R/W-x <sup>(2)</sup>	R/W-x <sup>(2)</sup>	R/W-x <sup>(2)</sup>				
_	COSC2	COSC1	COSC0		NOSC2	NOSC1	NOSC0				
bit 15							bit 8				
		(1)									
R/W-0	R/W-0	R-0 <sup>(4)</sup>	U-0	R/CO-0	R/W-0	R/W-0	R/W-0				
CLKLOCK	IOLOCK <sup>(3)</sup>	LOCK	—	CF	POSCEN	SOSCEN	OSWEN				
bit 7							bit (				
		00 01.000									
Legend: R = Readat	ala hit	CO = Clearal W = Writable	-		nented bit, read						
				'0' = Bit is cle							
-n = Value a	al POR	'1' = Bit is se			areu	x = Bit is unkn	OWN				
bit 15	Unimplemen	ted: Read as '	٥'								
bit 14-12			e ator Selection b	oits <sup>(2)</sup>							
511112			ency Divider (O								
	110 = Reserv	/ed		,							
		ower RC Oscill									
		dary Oscillator		(XTPLL, ECPL							
		y Oscillator (X			L)						
			th PLL module	(FRCPLL)							
		C Oscillator (F	-								
bit 11		ted: Read as '									
bit 10-8		NOSC<2:0>: New Oscillator Selection bits <sup>(2)</sup>									
		11 = Oscillator with Frequency Divider (OSCFDIV)									
	110 = Reserv	ower RC Oscill	ator (LPRC)								
		dary Oscillator									
				(XTPLL, ECPL	L)						
		y Oscillator (X									
		C Oscillator wi	th PLL module RC)	(FRGPLL)							
bit 7			Lock Enable b	bit							
		nabled (FCKSN									
	1 = Clock an	d PLL selection	ns are locked								
				ed and may be	modified by se	tting the OSWE	N bit				
		sabled (FCKS		and may be m	odified by setti	ng the OSWEN	hit				
bit 6		Lock Enable b		and may be m		ig the cover	Dit.				
	1 = I/O lock is										
	0 = I/O lock is	s not active									
bit 5	LOCK: PLL L	ock Status bit <sup>(</sup>	4)								
				start-up timer is							
	0 = PLL mod	lule is out of lo	ck, PLL start-up	o timer is runnir	ng or PLL is dis	abled					
	OSCCON is prote Switching Opera			nt inadvertent c	lock switches.	See Section 9.	4 "Clock				
	Reset values for t			the FNOSCx C	onfiguration bits	5.					
3: 1	The state of the loaddition, if the IO	OLOCK bit car	only be chang	jed once an un	locking sequen	ce has been ex					
	This hit also rese	-									

# REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER<sup>(1)</sup>

4: This bit also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.

# **REGISTER 9-1:** OSCCON: OSCILLATOR CONTROL REGISTER<sup>(1)</sup> (CONTINUED)

- bit 4 Unimplemented: Read as '0'
- bit 3 **CF:** Clock Fail Detect bit
  - 1 = FSCM has detected a clock failure
  - 0 = No clock failure has been detected
- bit 2 **POSCEN:** Primary Oscillator Sleep Enable bit
  - 1 = Primary Oscillator continues to operate during Sleep mode
    - 0 = Primary Oscillator is disabled during Sleep mode
- bit 1 SOSCEN: 32 kHz Secondary Oscillator (SOSC) Enable bit
  - 1 = Enables Secondary Oscillator
  - 0 = Disables Secondary Oscillator
- bit 0 OSWEN: Oscillator Switch Enable bit
  - 1 = Initiates an oscillator switch to a clock source specified by the NOSC<2:0> bits
  - 0 = Oscillator switch is complete
- Note 1: OSCCON is protected by a write lock to prevent inadvertent clock switches. See Section 9.4 "Clock Switching Operation" for more information.
  - 2: Reset values for these bits are determined by the FNOSCx Configuration bits.
  - **3:** The state of the IOLOCK bit can only be changed once an unlocking sequence has been executed. In addition, if the IOL1WAY Configuration bit is '1', once the IOLOCK bit is set, it cannot be cleared.
  - 4: This bit also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.

ROI	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0				
	DOZE2	DOZE1	DOZE0	DOZEN <sup>(1)</sup>	RCDIV2	RCDIV1	RCDIV0				
bit 15							bit				
R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0				
CPDIV1	CPDIV0	PLLEN	_		_						
bit 7							bit				
Legend:	L:4										
R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknow											
-n = value at F	POR	'1' = Bit is set		0 = Bit is clea	ared	x = Bit is unkn	IOWN				
bit 15	ROI: Recover	on Interrupt bi	ŀ								
bit 10		pheral clock ra	tio to 1:1								
		have no effect									
bit 14-12	DOZE<2:0>:	CPU Periphera	I Clock Ratio	Select bits							
	111 <b>= 1:128</b>										
	110 = 1:64										
	101 = 1:32 100 = 1:16										
	011 = 1:8 (de	fault)									
	010 = 1:4	laany									
	001 = 1:2										
	000 = 1:1										
bit 11	DOZEN: Doze Enable bit <sup>(1)</sup>										
				oheral clock ratio	0						
	<ul> <li>0 = CPU peripheral clock ratio is set to 1:1</li> <li>RCDIV&lt;2:0&gt;: System Frequency Divider Clock Source Select bits</li> </ul>										
bit 10-8	•	System Frequ	ency Divider C	lock Source Se	lect bits						
bit 10-8	RCDIV<2:0>:	System Freque ed; do not use	ency Divider C	Clock Source Se	lect bits						
bit 10-8	RCDIV<2:0>: 111 = Reserv 110 = Reserv	ed; do not use	-	Clock Source Se	lect bits						
bit 10-8	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Pc	ed; do not use ed ower RC Oscilla	ator (LPRC)	Clock Source Se	lect bits						
bit 10-8	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second	ed; do not use ed ower RC Oscilla dary Oscillator	ator (LPRC) (SOSC)			ECPLL)					
bit 10-8	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Pc 100 = Second 011 = Primary	ed; do not use ed ower RC Oscilla dary Oscillator y Oscillator (XT	ator (LPRC) (SOSC) , HS, EC) with	Clock Source Se		ECPLL)					
bit 10-8	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary	ed; do not use ed ower RC Oscilla dary Oscillator y Oscillator (XT y Oscillator (XT	ator (LPRC) (SOSC) , HS, EC) with , HS, EC)	PLL module (X	TPLL, HSPLL	ECPLL)					
bit 10-8	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 001 = Fast R	ed; do not use ed ower RC Oscilla dary Oscillator y Oscillator (XT y Oscillator (XT	ator (LPRC) (SOSC) ; HS, EC) with ; HS, EC) RC) with PLL r		TPLL, HSPLL	ECPLL)					
bit 10-8 bit 7-6	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>:	ed; do not use ed ower RC Oscillator y Oscillator (XT y Oscillator (XT C Oscillator (Ff C Oscillator (Ff System Clock	ator (LPRC) (SOSC) , HS, EC) with , HS, EC) RC) with PLL r RC)	PLL module (X	TPLL, HSPLL L)		ch)				
	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>: 11 = 4 MHz (c	ed; do not use ed ower RC Oscillator y Oscillator (XT y Oscillator (XT C Oscillator (Ff C Oscillator (Ff System Clock divide-by-8)	ator (LPRC) (SOSC) , HS, EC) with , HS, EC) RC) with PLL r RC)	PLL module (X nodule (FRCPLI	TPLL, HSPLL L)		ch)				
	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>: 11 = 4 MHz (c 10 = 8 MHz (c)	ed; do not use ed ower RC Oscilla- dary Oscillator (XT y Oscillator (XT C Oscillator (Ff C Oscillator (Ff System Clock divide-by-8) divide-by-4)	ator (LPRC) (SOSC) , HS, EC) with , HS, EC) RC) with PLL r RC)	PLL module (X nodule (FRCPLI	TPLL, HSPLL L)		ch)				
	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>: 11 = 4 MHz (c 10 = 8 MHz (c 01 = 16 MHz	ed; do not use ed ower RC Oscilla- dary Oscillator (XT y Oscillator (XT C Oscillator (Ff C Oscillator (Ff System Clock divide-by-8) divide-by-4) (divide-by-2)	ator (LPRC) (SOSC) , HS, EC) with , HS, EC) RC) with PLL r RC)	PLL module (X nodule (FRCPLI	TPLL, HSPLL L)		ch)				
bit 7-6	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>: 11 = 4 MHz (c 10 = 8 MHz (c 01 = 16 MHz 00 = 32 MHz	ed; do not use ed ower RC Oscillator y Oscillator (XT y Oscillator (XT C Oscillator (Ff C Oscillator (Ff System Clock divide-by-8) divide-by-4) (divide-by-2) (divide-by-1)	ator (LPRC) (SOSC) , HS, EC) with , HS, EC) RC) with PLL r RC)	PLL module (X nodule (FRCPLI	TPLL, HSPLL L)		ch)				
	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>: 11 = 4 MHz (c 10 = 8 MHz (c 01 = 16 MHz 00 = 32 MHz PLLEN: PLL	ed; do not use ed ower RC Oscillator y Oscillator (XT y Oscillator (XT C Oscillator (FF C Oscillator (FF System Clock divide-by-8) divide-by-4) (divide-by-2) (divide-by-1) Enable bit	ator (LPRC) (SOSC) , HS, EC) with , HS, EC) RC) with PLL r RC)	PLL module (X nodule (FRCPLI	TPLL, HSPLL L)		ch)				
bit 7-6	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>: 11 = 4 MHz (c 10 = 8 MHz (c 01 = 16 MHz 00 = 32 MHz PLLEN: PLL I 1 = PLL is alw	ed; do not use ed ower RC Oscilla- dary Oscillator (XT y Oscillator (XT c Oscillator (FF C Oscillator (FF System Clock divide-by-8) divide-by-4) (divide-by-2) (divide-by-1) Enable bit vays active	ator (LPRC) (SOSC) , HS, EC) with , HS, EC) RC) with PLL r RC) Select bits (pc	PLL module (X nodule (FRCPLI	TPLL, HSPLL L) from PLL, 32 N	IHz clock brand					
bit 7-6	RCDIV<2:0>: 111 = Reserv 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 010 = Fast RC 000 = Fast RC CPDIV<1:0>: 11 = 4 MHz (c 10 = 8 MHz (c 01 = 16 MHz 00 = 32 MHz PLLEN: PLL I 1 = PLL is alw 0 = PLL is onl	ed; do not use ed ower RC Oscilla- dary Oscillator (XT y Oscillator (XT c Oscillator (FF C Oscillator (FF System Clock divide-by-8) divide-by-4) (divide-by-2) (divide-by-1) Enable bit vays active	ator (LPRC) (SOSC) ; HS, EC) with ; HS, EC) RC) with PLL r RC) Select bits (po Select bits (po	PLL module (X nodule (FRCPLI ostscaler select f	TPLL, HSPLL L) from PLL, 32 N	IHz clock brand					

# REGISTER 9-2: CLKDIV: CLOCK DIVIDER REGISTER

#### REGISTER 9-3: OSCTUN: FRC OSCILLATOR TUNE REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
	—	—	—	—		—	—		
bit 15	-						bit 8		
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
_	—		TUN<5:0>						
bit 7							bit 0		
Legend:									
R = Readabl	le bit	W = Writable I	oit	U = Unimplemented bit, read as '0'					
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown			nown		
bit 15-6	Unimpleme	nted: Read as '0	)'						
bit 5-0	TUN<5:0>: F	RC Oscillator T	uning bits						
	011111 <b>= M</b>	aximum frequen	cy deviation						
	011110								

011110 = 000001 = 000000 = Center frequency, oscillator is running at factory calibrated frequency 11111 = 100001 = 100000 = Minimum frequency deviation

	54440	544/0	5444 6	<b>D</b> 444 0	<b>D</b> 444 0	5444	5444.0		
U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
—				DIV<14:8>					
bit 15							bit		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1		
			DIV	<7:0>					
bit 7							bit		
Legend:									
R = Readable bit		W = Writable bi	t	U = Unimplemented bit, read		d as '0'			
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown			
bit 15	Unimpleme	nted: Read as '0'							
bit 14-0	DIV<14:0>: Reference Clock Divider bits								
	Specifies the 1/2 period of the reference clock in the source clocks								
	(ex: Period of ref_clk_output = [Reference Source * 2] * DIV<14:0>).								
	11111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2)								
	11111111111111 = Oscillator frequency divided by 65,532 (32,766 * 2)								
			or noquonoy		002 (02,700 2	-/			
	•		or noquonoy	alvided by 03,	552 (52,700 2	-,			
	· · ·		or nequency	divided by 05,	552 (52,700 2	-,			
					•	- ,			
	• • • 0000000000	000011 = Oscillat	or frequency	v divided by 6 (3	* 2)	7			
	• • 0000000000000000000000000000000000	000011 <b>= Oscillat</b>	or frequency or frequency	v divided by 6 (3 v divided by 4 (2	* 2) * 2)	,			

#### REGISTER 9-4: OSCDIV: OSCILLATOR DIVISOR REGISTER

# REGISTER 9-5: OSCFDIV: OSCILLATOR FRACTIONAL DIVISOR REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			TRIM	1<0:7>			
bit 15							bit 8
							/
R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
TRIM8	—	—	_	—	—	—	—
bit 7						•	bit 0
Legend:							
R = Readable	e bit	W = Writable b	oit	U = Unimplemented bit, read as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	
<pre>bit 15-7 TRIM&lt;0:8&gt; Trim bits Provides fractional additive to the DIV&lt;14:0&gt; bits value for the 1/2 period of the oscillator clock. 0000_0000_0 = 0/512 (0.0) divisor added to DIVx value 0000_0000_1 = 1/512 (0.001953125) divisor added to DIVx value 0000_0001_0 = 2/512 (0.00390625) divisor added to DIVx value</pre>						or clock.	
bit 6-0		ted: Read as '0					

**Note 1:** TRIMx values greater than zero are ONLY valid when DIVx values are greater than zero.

# 9.4 Clock Switching Operation

With few limitations, applications are free to switch between any of the four clock sources (POSC, SOSC, FRC and LPRC) under software control and at any time. To limit the possible side effects that could result from this flexibility, PIC24F devices have a safeguard lock built into the switching process.

Note: The Primary Oscillator mode has three different submodes (XT, HS and EC), which are determined by the POSCMDx Configuration bits. While an application can switch to and from Primary Oscillator mode in software, it cannot switch between the different primary submodes without reprogramming the device.

#### 9.4.1 ENABLING CLOCK SWITCHING

To enable clock switching, the FCKSM1 Configuration bit in FOSC must be programmed to '0'. (Refer to **Section 29.1 "Configuration Bits"** for further details.) If the FCKSM1 Configuration bit is unprogrammed ('1'), the clock switching function and Fail-Safe Clock Monitor function are disabled; this is the default setting.

The NOSCx control bits (OSCCON<10:8>) do not control the clock selection when clock switching is disabled. However, the COSC<2:0> bits (OSCCON<14:12>) will reflect the clock source selected by the FNOSCx Configuration bits.

The OSWEN control bit (OSCCON<0>) has no effect when clock switching is disabled; it is held at '0' at all times.

#### 9.4.2 OSCILLATOR SWITCHING SEQUENCE

At a minimum, performing a clock switch requires this basic sequence:

- 1. If desired, read the COSCx bits (OSCCON<14:12>) to determine the current oscillator source.
- 2. Perform the unlock sequence to allow a write to the OSCCON register high byte.
- 3. Write the appropriate value to the NOSCx bits (OSCCON<10:8>) for the new oscillator source.
- 4. Perform the unlock sequence to allow a write to the OSCCON register low byte.
- 5. Set the OSWEN bit to initiate the oscillator switch.

Once the basic sequence is completed, the system clock hardware responds automatically as follows:

- 1. The clock switching hardware compares the COSCx bits with the new value of the NOSCx bits. If they are the same, then the clock switch is a redundant operation. In this case, the OSWEN bit is cleared automatically and the clock switch is aborted.
- If a valid clock switch has been initiated, the LOCK (OSCCON<5>) and CF (OSCCON<3>) bits are cleared.
- The new oscillator is turned on by the hardware if it is not currently running. If a crystal oscillator must be turned on, the hardware will wait until the OST expires. If the new source is using the PLL, then the hardware waits until a PLL lock is detected (LOCK = 1).
- 4. The hardware waits for 10 clock cycles from the new clock source and then performs the clock switch.
- 5. The hardware clears the OSWEN bit to indicate a successful clock transition. In addition, the NOSCx bits value is transferred to the COSCx bits.
- 6. The old clock source is turned off at this time, with the exception of LPRC (if WDT or FSCM is enabled) or SOSC (if SOSCEN remains set).
  - Note 1: The processor will continue to execute code throughout the clock switching sequence. Timing-sensitive code should not be executed during this time.
    - 2: Direct clock switches between any Primary Oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transitional clock source between the two PLL modes.

A recommended code sequence for a clock switch includes the following:

- 1. Disable interrupts during the OSCCON register unlock and write sequence.
- Execute the unlock sequence for the OSCCON high byte by writing 78h and 9Ah to OSCCON<15:8> in two back-to-back instructions.
- 3. Write the new oscillator source to the NOSCx bits in the instruction immediately following the unlock sequence.
- 4. Execute the unlock sequence for the OSCCON low byte by writing 46h and 57h to OSCCON<7:0> in two back-to-back instructions.
- 5. Set the OSWEN bit in the instruction immediately following the unlock sequence.
- 6. Continue to execute code that is not clock-sensitive (optional).
- 7. Invoke an appropriate amount of software delay (cycle counting) to allow the selected oscillator and/or PLL to start and stabilize.
- 8. Check to see if OSWEN is '0'. If it is, the switch was successful. If OSWEN is still set, then check the LOCK bit to determine the cause of the failure.

The core sequence for unlocking the OSCCON register and initiating a clock switch is shown in Example 9-1.

#### EXAMPLE 9-1: BASIC CODE SEQUENCE FOR CLOCK SWITCHING

;Place the new oscillator selection in WO
;OSCCONH (high byte) Unlock Sequence
MOV #OSCCONH, w1
MOV #0x78, w2
MOV #0x9A, w3
MOV.b w2, [w1]
MOV.b w3, [w1]
;Set new oscillator selection
MOV.b WREG, OSCCONH
;OSCCONL (low byte) unlock sequence
MOV #OSCCONL, w1
MOV #0x46, w2
MOV #0x57, w3
MOV.b w2, [w1]
MOV.b w3, [w1]
;Start oscillator switch operation
BSET OSCCON, #0

# 9.5 Oscillator Modes

The PLL block is shown in Figure 9-2. In this system, the input from the Primary Oscillator is divided down by a PLL prescaler to generate a 4 MHz output. This is used to drive an on-chip, 96 MHz PLL frequency multiplier to drive the fixed, divide-by-3 frequency divider and configurable PLL prescaler/divider to generate a range of system clock frequencies. The CPDIV<1:0> bits select the system clock speed. Available clock options are listed in Table 9-2.

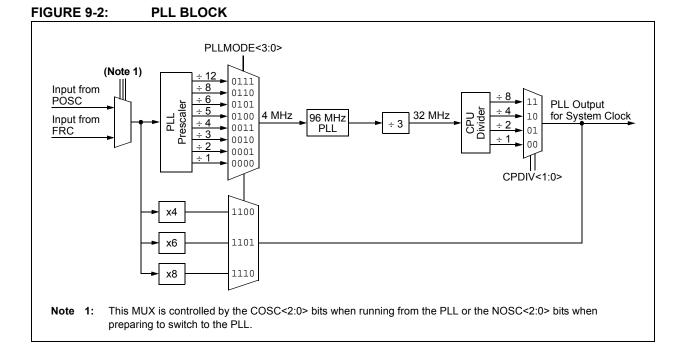
The user must manually configure the PLL divider to generate the required 4 MHz output using the PLLMODE<3:0> Configuration bits. This limits the choices for Primary Oscillator frequency to a total of eight possibilities, as shown in Table 9-3.

TABLE 9-2: SYSTEI	<b>M CLOCK OPTIONS</b>
-------------------	------------------------

MCU Clock Division (CPDIV<1:0>)	Microcontroller Clock Frequency
None (00)	32 MHz
÷2(01)	16 MHz
÷4 (10)	8 MHz
÷8 (11)	4 MHz

# TABLE 9-3:VALID PRIMARY OSCILLATOR<br/>CONFIGURATIONS

Input Oscillator Frequency	Clock Mode	PLL Mode (PLLMODE<3:0>)
48 MHz	ECPLL	÷ <b>12 (</b> 0111 <b>)</b>
32 MHz	HSPLL, ECPLL	÷8(0110)
24 MHz	HSPLL, ECPLL	÷6(0101)
20 MHz	HSPLL, ECPLL	÷5 (0100)
16 MHz	HSPLL, ECPLL	÷4 (0011)
12 MHz	HSPLL, ECPLL	÷3(0010)
8 MHz	ECPLL, XTPLL, FRCPLL	÷2(0001)
4 MHz	ECPLL, XTPLL, FRCPLL	÷1 (0000)



# 9.6 Reference Clock Output

In addition to the CLKO output (Fosc/2) available in certain Oscillator modes, the device clock in the PIC24FJ256GA705 family devices can also be configured to provide a reference clock output signal to a port pin. This feature is available in all oscillator configurations and allows the user to select a greater range of clock submultiples to drive external devices in the application. CLKO is enabled by Configuration bit, OSCIOFCN, and is independent of the REFO reference clock. REFO is mappable to any I/O pin that has mapped output capability. Refer to Table 11-7 for more information.

This reference clock output is controlled by the REFOCONL, REFOCONH and REFOTRIML registers. Setting the ROEN bit (REFOCONL<15>) makes the clock signal available on the REFO pin. The RODIV<14:0> bits (REFOCONH<14:0>) enable the selection of different clock divider options. The ROTRIM<0:8> bits (REFOTRIML<7:15>) allow the user to provide a fractional addition to the RODIVx value. The ROSWEN bit (REFOCONL<9>) indicates that the clock divider or trim the REFO frequency, the user should wait until this bit has been cleared. Write the updated values to ROTRIMx and RODIVx, set the ROSWEN bit and then wait until it is cleared before assuming that the REFO clock is valid.

The ROSEL<3:0> bits (REFOCONL<3:0>) determine which clock source is used for the reference clock output. The ROSLP bit (REFOCONL<11>) determines if the reference source is available on REFO when the device is in Sleep mode.

To use the reference clock output in Sleep mode, both the ROSLP bit must be set and the clock selected by the ROSELx bits must be enabled for operation during Sleep mode, if possible. Clearing the ROSELx bits allows the reference output frequency to change as the system clock changes during any clock switches. The ROOUT bit enables/disables the reference clock output on the REFO pin.

The ROACTIVE bit (REFOCONL<8>) indicates that the module is active; it can be cleared by disabling the module (setting ROEN to '0'). The user must not change the reference clock source or adjust the trim or divider when the ROACTIVE bit indicates that the module is active. To avoid glitches, the user should not disable the module until the ROACTIVE bit is '1'.

The PLLSS Configuration bit (FOSC<4>), when cleared, can be used to generate a REFO clock with the PLL that is independent of the system clock. The PLL cannot be used in the primary clock chain. For example, if the system clock is using FRC at 8 MHz, the PLL can use the FRC as the input and generate 32 MHz (PLL4x mode) out of REFO.

# 9.7 Secondary Oscillator

#### 9.7.1 BASIC SOSC OPERATION

PIC24FJ256GA705 family devices do not have to set the SOSCEN bit to use the Secondary Oscillator. Any module requiring the SOSC (such as the RTCC or Timer1) will automatically turn on the SOSC when the clock signal is needed. The SOSC, however, has a long start-up time (as long as 1 second). To avoid delays for peripheral start-up, the SOSC can be manually started using the SOSCEN bit.

To use the Secondary Oscillator, the SOSCSEL bit (FOSC<3>) must be set to '1'. Programming the SOSCSEL bit to '0' configures the SOSC pins for Digital mode, enabling digital I/O functionality on the pins.

# 9.7.2 CRYSTAL SELECTION

The 32.768 kHz crystal used for the SOSC must have the following specifications in order to properly start up and run at the correct frequency when the SOSC is in High-Power mode (default):

- 12.5 pF loading capacitance
- 1.0 pF shunt capacitance
- A typical ESR of 35k-50k; 70k maximum

In addition, the two external crystal loading capacitors should be in the range of 18-22 pF, which will be based on the PC board layout. The capacitors should be COG, 5% tolerance and rated 25V or greater.

The accuracy and duty cycle of the SOSC can be measured on the REFO pin, and is recommended to be in the range of 40-60% and accurate to  $\pm 0.65$  Hz.

## 9.7.3 LOW-POWER SOSC OPERATION

The Secondary Oscillator can operate in two distinct levels of power consumption based on device configuration. In Low-Power mode, the oscillator operates in a low drive strength, low-power state. By default, the oscillator uses a higher drive strength, and therefore, requires more power. Low-Power mode is selected by Configuration bit, SOSCHP (FDEVOPT1<3>). The lower drive strength of this mode makes the SOSC more sensitive to noise and requires a longer start-up time. This mode can be used with lower load capacitance crystals (6 pF-9 pF) to reduce Sleep current in the RTCC. When Low-Power mode is used, care must be taken in the design and layout of the SOSC circuit to ensure that the oscillator starts up and oscillates properly. PC board layout issues, stray capacitance and other factors will need to be carefully controlled in order for the crystal to operate.

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-0
ROEN		ROSIDL	ROOUT	ROSLP		ROSWEN	ROACTIVE
bit 15							bit
U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
			_	ROSEL3	ROSEL2	ROSEL1	ROSEL0
bit 7							bit
Legend:							
R = Readab		W = Writable		-	ented bit, read		
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15		onoo Oooillatoi	Output Enchl	a hit			
DIL 15		ence Oscillator e Oscillator mo	•				
		e Oscillator is o		J			
bit 14	Unimplemen	ted: Read as '	0'				
bit 13	•	FO Stop in Idle					
		•		levice enters Idl	e mode		
	0 = Continues	s module opera	ition in Idle mo	de			
bit 12	ROOUT: Refe	erence Clock C	utput Enable b	bit			
		e clock is drive e clock is not d					
bit 11	ROSLP: Refe	erence Oscillato	or Output Stop	in Sleep bit			
		e Oscillator cor					
	0 = Reference	e Oscillator is c	lisabled in Slee	ер			
bit 10	Unimplemen	ted: Read as '	0'				
bit 9	ROSWEN: Re	eference Clock	RODIVx/ROT	RIMx Switch Er	able bit		
		ock divider; clo der switch has		ching is currently ed	/ in progress		
bit 8	ROACTIVE: F	Reference Cloo	k Request Sta	tus bit			
				not change the pdate the REFC	•	5)	
bit 7-4	Unimplemen	ted: Read as '	0'				
bit 3-0	ROSEL<3:0>	: Reference Cl	ock Source Se	elect bits			
	1111-1001 =	Reserved					
	1000 = REFI	•					
	0111 = Reser	rved					
	0110 = PLL 0101 = SOSC	2					
	0100 = LPRC						
	0011 <b>= FRC</b>						
	0010 = POSC	2					
		m clock (Fosc	(0)				

# REGISTER 9-6: REFOCONL: REFERENCE OSCILLATOR CONTROL REGISTER LOW

## REGISTER 9-7: REFOCONH: REFERENCE OSCILLATOR CONTROL REGISTER HIGH

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—				RODIV<14:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			ROD	IV<7:0>			
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable I	oit	U = Unimplem	nented bit, rea	ad as '0'	
-n = Value a	It POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15 bit 14-0	RODIV<14:	nted: Read as 'c 0>: Reference Cl	ock Divider b				
	(ex: Period of RODIV<14:0 111111111	2 period of the re of Output = [Refe D> = 0). 111111 = REFC 111110 = REFC	rence Source clock is the I	e * 2] * RODIV<1 base clock frequ	4:0>; this equ	by 65,534 (32,7)	67 * 2)

.

0000000000011 = REFO clock is the base clock frequency divided by 6 (3 \* 2) 00000000000010 = REFO clock is the base clock frequency divided by 4 (2 \* 2) 00000000000001 = REFO clock is the base clock frequency divided by 2 (1 \* 2) 000000000000000 = REFO clock is the same frequency as the base clock (no divider)

# REGISTER 9-8: REFOTRIML: REFERENCE OSCILLATOR TRIM REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			ROTE	RIM<0:7>			
bit 15							bit 8
R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
ROTRIM8	_	—		_	—	—	_
bit 7							bit (
Legend:							
R = Readable bit W = Writable bit				U = Unimplem	nented bit, read	l as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	iown
bit 15-7	These bits p 000000000 000000001	8>: REFO Trim I rovide a fraction: = 0/512 (0.0 div = 1/512 (0.0019 = 2/512 (0.0039	al additive to t isor added to 53125 divisor	the RODIVx value added to the RO	ue) ODIVx value)	eriod of the RE	FO clock.

111111110 = 510/512 (0.99609375 divisor added to the RODIVx value) 111111111 = 511/512 (0.998046875 divisor added to the RODIVx value)

bit 6-0 Unimplemented: Read as '0'

# 10.0 POWER-SAVING FEATURES

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Power-Saving Features with Deep Sleep" (DS39727), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The PIC24FJ256GA705 family of devices provides the ability to manage power consumption by selectively managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. All PIC24F devices manage power consumption in four different ways:

- Clock Frequency
- Instruction-Based Sleep and Idle modes
- · Software Controlled Doze mode
- · Selective Peripheral Control in Software

Combinations of these methods can be used to selectively tailor an application's power consumption, while still maintaining critical application features, such as timing-sensitive communications.

## 10.1 Clock Frequency and Clock Switching

PIC24F devices allow for a wide range of clock frequencies to be selected under application control. If the system clock configuration is not locked, users can choose low-power or high-precision oscillators by simply changing the NOSC<2:0> bits. The process of changing a system clock during operation, as well as limitations to the process, are discussed in more detail in Section 9.0 "Oscillator Configuration".

#### 10.2 Instruction-Based Power-Saving Modes

PIC24F devices have two special power-saving modes that are entered through the execution of a special PWRSAV instruction. Sleep mode stops clock operation and halts all code execution; Idle mode halts the CPU and code execution, but allows peripheral modules to continue operation. The assembly syntax of the PWRSAV instruction is shown in Example 10-1.

The MPLAB<sup>®</sup> XC16 C compiler offers "built-in" functions for the power-saving modes as follows:

Idle(); // places part in Idle
Sleep(); // places part in Sleep

Sleep and Idle modes can be exited as a result of an enabled interrupt, WDT time-out or a device Reset. When the device exits these modes, it is said to "wake-up".

**Note:** SLEEP\_MODE and IDLE\_MODE are constants defined in the assembler include file for the selected device.

#### 10.2.1 SLEEP MODE

Sleep mode has these features:

- The system clock source is shut down. If an on-chip oscillator is used, it is turned off.
- The device current consumption will be reduced to a minimum provided that no I/O pin is sourcing current.
- The Fail-Safe Clock Monitor does not operate during Sleep mode since the system clock source is disabled.
- The LPRC clock will continue to run in Sleep mode if the WDT is enabled.
- The WDT, if enabled, is automatically cleared prior to entering Sleep mode.
- Some device features or peripherals may continue to operate in Sleep mode. This includes items, such as the Input Change Notification (ICN) on the I/O ports or peripherals that use an external clock input. Any peripheral that requires the system clock source for its operation will be disabled in Sleep mode.

The device will wake-up from Sleep mode on any of the these events:

- On any interrupt source that is individually enabled
- On any form of device Reset
- · On a WDT time-out

On wake-up from Sleep, the processor will restart with the same clock source that was active when Sleep mode was entered.

#### EXAMPLE 10-1: PWRSAV INSTRUCTION SYNTAX

PWRSAV	#SLEEP_MODE	;	Put	the	device	into	SLEEP mode
PWRSAV	#IDLE_MODE	;	Put	the	device	into	IDLE mode

# 10.2.2 IDLE MODE

Idle mode has these features:

- The CPU will stop executing instructions.
- The WDT is automatically cleared.
- The system clock source remains active. By default, all peripheral modules continue to operate normally from the system clock source, but can also be selectively disabled (see Section 10.4 "Selective Peripheral Module Control").
- If the WDT or FSCM is enabled, the LPRC will also remain active.

The device will wake from Idle mode on any of these events:

- Any interrupt that is individually enabled.
- · Any device Reset.
- · A WDT time-out.

On wake-up from Idle, the clock is reapplied to the CPU and instruction execution begins immediately, starting with the instruction following the PWRSAV instruction or the first instruction in the ISR.

#### 10.2.3 INTERRUPTS COINCIDENT WITH POWER SAVE INSTRUCTIONS

Any interrupt that coincides with the execution of a PWRSAV instruction will be held off until entry into Sleep or Idle mode has completed. The device will then wake-up from Sleep or Idle mode.

#### 10.2.4 LOW-VOLTAGE RETENTION REGULATOR

PIC24FJ256GA705 family devices incorporate a second on-chip voltage regulator, designed to provide power to select microcontroller features at 1.2V nominal. This regulator allows features, such as data RAM and the WDT, to be maintained in power-saving modes where they would otherwise be inactive, or maintain them at a lower power than would otherwise be the case.

Retention Sleep uses less power than standard Sleep mode, but takes more time to recover and begin execution. An additional 10-15  $\mu$ s (typical) is required to charge VCAP from 1.2V to 1.8V and start to execute instructions when exiting Retention Sleep.

The VREGS bit allows control of speed to exit from the Sleep modes (regular and Retention) at the cost of more power. The regulator band gaps are enabled, which increases the current but reduces time to recover from Sleep by ~10  $\mu$ s.

The low-voltage retention regulator is only available when Sleep mode is invoked. It is controlled by the LPCFG Configuration bit (FPOR<2>) and in firmware by the RETEN bit (RCON<12>). LPCFG must be programmed (= 0) and the RETEN bit must be set (= 1) for the regulator to be enabled.

# 10.2.5 EXITING FROM LOW-VOLTAGE RETENTION SLEEP

All of the methods for exiting from standard Sleep also apply to Retention Sleep (MCLR, INT0, etc.). However, in order to allow the regulator to switch from 1.8V (operating) to Retention mode (1.2V), there is a hardware 'lockout timer' from the execution of Retention Sleep until Retention Sleep can be exited.

During the 'lockout time', the only method to exit Retention Sleep is a POR or MCLR. Interrupts that are asserted (such as INT0) during the 'lockout time' are masked. The lockout timer then sets a minimum interval from when the part enters Retention Sleep until it can exit from Retention Sleep. Interrupts are not 'held pending' during lockout; they are masked and in order to exit after the lockout expires, the exiting source must assert after the lockout time.

The lockout timer is derived from the LPRC clock, which has a wide (untrimmed) frequency tolerance.

The lockout time will be one of the following two cases:

- If the LPRC was not running at the time of Retention Sleep, the lockout time is 2 LPRC periods + LPRC wake-up time
- If the LPRC was running at the time of Retention Sleep, the lockout time is 1 LPRC period

Refer to Table 32-20 and Table 32-21 in the AC Electrical Specifications for the LPRC timing.

#### 10.2.6 SUMMARY OF LOW-POWER SLEEP MODES

The RETEN bit and the VREGS bit (RCON<12,8>) allow for four different Sleep modes, which will vary by wake-up time and power consumption. Refer to Table 10-1 for a summary of these modes. Specific information about the current consumption and wake times can be found in Section 32.0 "Electrical Characteristics".

#### TABLE 10-1: LOW-POWER SLEEP MODES

RETEN	VREGS	MODE	Relative Power
0	1	Sleep	A Few µA Range
0	0	Fast Wake-up	100 µA Range
1	1	Retention Sleep	Less than 1 µA
1	0	Fast Retention	A Few µA Range

# 10.3 Doze Mode

Generally, changing clock speed and invoking one of the power-saving modes are the preferred strategies for reducing power consumption. There may be circumstances, however, where this is not practical. For example, it may be necessary for an application to maintain uninterrupted synchronous communication, even while it is doing nothing else. Reducing system clock speed may introduce communication errors, while using a power-saving mode may stop communications completely.

Doze mode is a simple and effective alternative method to reduce power consumption while the device is still executing code. In this mode, the system clock continues to operate from the same source and at the same speed. Peripheral modules continue to be clocked at the same speed while the CPU clock speed is reduced. Synchronization between the two clock domains is maintained, allowing the peripherals to access the SFRs while the CPU executes code at a slower rate.

Doze mode is enabled by setting the DOZEN bit (CLKDIV<11>). The ratio between peripheral and core clock speed is determined by the DOZE<2:0> bits (CLKDIV<14:12>). There are eight possible configurations, from 1:1 to 1:256, with 1:1 being the default.

It is also possible to use Doze mode to selectively reduce power consumption in event driven applications. This allows clock-sensitive functions, such as synchronous communications, to continue without interruption while the CPU Idles, waiting for something to invoke an interrupt routine. Enabling the automatic return to full-speed CPU operation on interrupts is enabled by setting the ROI bit (CLKDIV<15>). By default, interrupt events have no effect on Doze mode operation.

## 10.4 Selective Peripheral Module Control

Idle and Doze modes allow users to substantially reduce power consumption by slowing or stopping the CPU clock. Even so, peripheral modules still remain clocked, and thus, consume power. There may be cases where the application needs what these modes do not provide: the allocation of power resources to CPU processing with minimal power consumption from the peripherals.

PIC24F devices address this requirement by allowing peripheral modules to be selectively disabled, reducing or eliminating their power consumption. This can be done with two control bits:

- The Peripheral Enable bit, generically named, "XXXEN", located in the module's main control SFR.
- The Peripheral Module Disable (PMD) bit, generically named, "XXXMD", located in one of the PMD Control registers.

Both bits have similar functions in enabling or disabling their associated module. Setting the PMD bit for a module disables all clock sources to that module, reducing its power consumption to an absolute minimum. In this state, the control and status registers associated with the peripheral will also be disabled, so writes to those registers will have no effect and read values will be invalid. Many peripheral modules have a corresponding PMD bit.

In contrast, disabling a module by clearing its XXXEN bit disables its functionality, but leaves its registers available to be read and written to. This reduces power consumption, but not by as much as setting the PMD bit does. Most peripheral modules have an enable bit; exceptions include input capture, output compare and RTCC.

To achieve more selective power savings, peripheral modules can also be selectively disabled when the device enters Idle mode. This is done through the control bit of the generic name format, "XXXIDL". By default, all modules that can operate during Idle mode will do so. Using the disable on Idle feature allows further reduction of power consumption during Idle mode, enhancing power savings for extremely critical power applications.

# TABLE 10-2: PERIPHERAL MODULE DISABLE REGISTER SUMMARY

Register	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1		_	T3MD	T2MD	T1MD		_		I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD	_	_	ADCMD	0000
PMD2		_	_		_	IC3MD	IC2MD	IC1MD	_	—	_	_	_	OC3MD	OC2MD	OC1MD	0000
PMD3		_	_		_	CMPMD	RTCCMD	PMPMD	CRCMD	—	—	_	_		I2C2MD		0000
PMD4		_	_		_	_	_	_	_	—	_	_	REFOMD	CTMUMD	LVDMD		0000
PMD5		_	_		_	_	_	_	_	—	_	_	CCP4MD	CCP3MD	CCP2MD	CCP1MD	0000
PMD6		_	_		_	_	_	_	_	—	_	_	_	-	_	SPI3MD	0000
PMD7		_	_		_	_	_		_	—	DMA1MD	DMA0MD	_		_		0000
PMD8		_	_	_	_	_	_	_	—		—	_	CLC2MD	CLC1MD	_		0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

U-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
	_	T3MD	T2MD	T1MD	—	_	_
bit 15			•	-		4	bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD	—		ADC1MD
bit 7							bit (
Legend:							
R = Readab	le bit	W = Writable	bit	U = Unimplem	nented bit, re	ad as 'O'	
-n = Value a	It POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unk	nown
bit 15-14	Unimplemer	nted: Read as '	ר'				
bit 13	-	3 Module Disat					
	1 = Module						
		power and clock	sources are	enabled			
bit 12	T2MD: Time	r2 Module Disat	ole bit				
	1 = Module	is disabled					
	0 = Module	power and clock	sources are	enabled			
bit 11	T1MD: Time	r1 Module Disat	ole bit				
	1 = Module						
		power and clock		enabled			
bit 10-8	-	nted: Read as '					
bit 7	-	1 Module Disat	ole bit				
	1 = Module			nablad			
L:1 0		power and clock		enableu			
bit 6		T2 Module Disa	DIE DIT				
	1 = Module i	power and clock	sources are e	enabled			
bit 5		T1 Module Disa					
	1 = Module i						
		power and clock	sources are	enabled			
bit 4		I2 Module Disal					
	1 = Module						
	0 = Module	power and clock	sources are	enabled			
bit 3	SPI1MD: SP	I1 Module Disal	ole bit				
	1 = Module	is disabled					
	0 = Module	power and clock	sources are	enabled			
bit 2-1	Unimplemer	nted: Read as '	כ'				
bit 0	ADC1MD: A	/D Converter Me	odule Disable	bit			
	1 = Module	is disabled					
		power and clock					

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	_	_	_		IC3MD	IC2MD	IC1MD
oit 15							bit
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
		_			OC3MD	OC2MD	OC1MD
bit 7							bit
Legend:							
R = Readal	ole bit	W = Writable	bit	U = Unimple	mented bit, read	d as '0'	
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cle	eared	x = Bit is unkr	nown
bit 15-11	Unimplemen	ted: Read as '	0'				
oit 10	IC3MD: Input	Capture 3 Mo	dule Disable b	oit			
	1 = Module is	s disabled					
	0 = Module p	ower and cloc	k sources are	enabled			
bit 9	IC2MD: Input	Capture 2 Mo	dule Disable b	it			
	1 = Module is						
	•	ower and cloc					
bit 8	•	Capture 1 Mo	dule Disable b	bit			
	1 = Module is			a sa a la la al			
L:1 7 0	•	ower and cloc		enabled			
bit 7-3	•	ted: Read as '		. 1 . 1. 1			
bit 2	•	out Compare 3	Module Disat	DIE DIT			
	1 = Module is 0 = Module p	s disabled	k sources are	enabled			
bit 1	•	put Compare 2					
	1 = Module is	•	Noutle Disa				
		ower and cloc	k sources are	enabled			
bit 0	-	out Compare 1					
	1 = Module is	•					

#### REGISTER 10-2: PMD2: PERIPHERAL MODULE DISABLE REGISTER 2

## REGISTER 10-3: PMD3: PERIPHERAL MODULE DISABLE REGISTER 3

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
	—	—		—	CMPMD	RTCCMD	PMPMD
bit 15							bit 8
R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	U-0
CRCMD				—		I2C2MD	_
bit 7							bit C
Legend: R = Readabl	lo hit	W = Writable b	\i+		contod hit roo	d aa '0'	
			אנ	0 = Onimpien	nented bit, rea		
-n = Value at	IPOR	'1' = Bit is set		0 = Bit is clear	areo	x = Bit is unkn	OWN
bit 15-11	Unimpleme	nted: Read as '0	,				
bit 10	-	ple Comparator I		le hit			
	1 = Module	•					
		power and clock	sources are	enabled			
bit 9	RTCCMD: R	TCC Module Dis	able bit				
	1 = Module	is disabled					
	0 = Module	power and clock	sources are	enabled			
bit 8	PMPMD: En	hanced Parallel	Master Port D	isable bit			
	1 = Module						
		power and clock		enabled			
bit 7		C Module Disab	le bit				
	1 = Module						
		power and clock		enabled			
	Unimpleme	nted: Read as '0					
	1000MD. 100	Madula Dia-L					
		2 Module Disab	le bit				
bit 6-2 bit 1	1 = Module			enabled			

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	—	—	—	—	_	—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	U-0
		<u> </u>	<u> </u>	REFOMD	CTMUMD	LVDMD	
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	x = Bit is unkn	iown	
bit 15-4	Unimplemen	ted: Read as '	0'				
bit 3	REFOMD: Re	eference Outpu	t Clock Disable	e bit			
	1 = Module is						
	0 = Module p	ower and clock	k sources are e	nabled			
bit 2	CTMUMD: CT	TMU Module D	isable bit				
	1 = Module is						
	0 = Module p	ower and clock	sources are e	nabled			
bit 1	LVDMD: High	/Low-Voltage	Detect Module	Disable bit			
	1 = Module is						
			sources are e	enabled			
bit 0	Unimplemen	ted: Read as '	0'				

# REGISTER 10-4: PMD4: PERIPHERAL MODULE DISABLE REGISTER 4

#### REGISTER 10-5: PMD5: PERIPHERAL MODULE DISABLE REGISTER 5

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—		—	—			—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	CCP4MD	CCP3MD	CCP2MD	CCP1MD
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-4	Unimplemented: Read as '0'
bit 3	CCP4MD: MCCP4 Module Disable bit
	1 = Module is disabled
	0 = Module power and clock sources are enabled
bit 2	CCP3MD: MCCP3 Module Disable bit
	1 = Module is disabled
	0 = Module power and clock sources are enabled
bit 1	CCP2MD: MCCP2 Module Disable bit
	1 = Module is disabled
	0 = Module power and clock sources are enabled
bit 0	CCP1MD: MCCP1 Module Disable bit
	1 = Module is disabled

0 = Module power and clock sources are enabled

#### REGISTER 10-6: PMD6: PERIPHERAL MODULE DISABLE REGISTER 6

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
	—	—	—	—	_	—	SPI3MD

JI3MD
1.1.0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-1 Unimplemented: Read as '0'

bit 7

bit 0 SPI3MD: SPI3 Module Disable bit

1 = Module is disabled

0 = Module power and clock sources are enabled

#### REGISTER 10-7: PMD7: PERIPHERAL MODULE DISABLE REGISTER 7

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	—	DMA1MD	DMA0MD	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6	Unimplemented: Read as '0'
bit 5	DMA1MD: DMA1 Controller (Channels 4 through 7) Disable bit
	1 = Controller is disabled
	0 = Controller power and clock sources are enabled
bit 4	DMA0MD: DMA0 Controller (Channels 0 through 3) Disable bit
	1 = Controller is disabled
	0 = Controller power and clock sources are enabled
h:+ 0 0	University and and an (a)

bit 3-0 Unimplemented: Read as '0'

## REGISTER 10-8: PMD8: PERIPHERAL MODULE DISABLE REGISTER 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	_	—
bit 15							bit 8
U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0
_	—	—	—	CLC2MD	CLC1MD	—	—
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable I	oit	U = Unimplem	nented bit, read	1 as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown			nown
bit 15-4	Unimplemen	ted: Read as '0	)'				
bit 3	CLC2MD: CLC2 Module Disable bit						
	1 = Module is disabled						
	0 = Module power and clock sources are enabled						
bit 2	CLC1MD: CLC1 Module Disable bit						

0 = Module power and clock sources are enabled

1 = Module is disabled

bit 1-0 Unimplemented: Read as '0'

NOTES:

# 11.0 I/O PORTS

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "I/O Ports with Peripheral Pin Select (PPS)" (DS39711), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

All of the device pins (except VDD, VSS, MCLR and OSCI/CLKI) are shared between the peripherals and the Parallel I/O (PIO) ports. All I/O input ports feature Schmitt Trigger (ST) inputs for improved noise immunity.

# 11.1 Parallel I/O (PIO) Ports

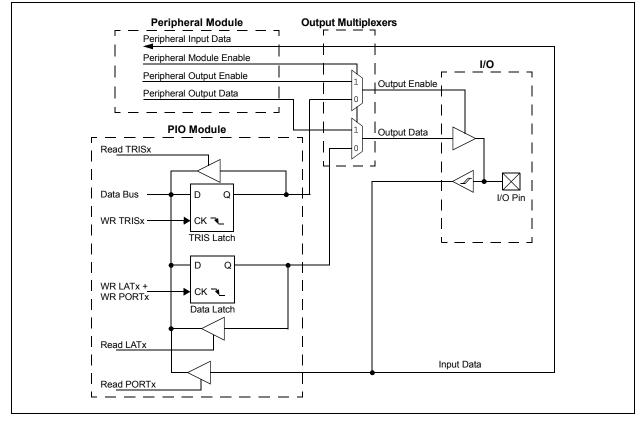
A Parallel I/O port that shares a pin with a peripheral is, in general, subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of the I/O pin. The logic also prevents "loop through", in which a port's digital output can drive the input of a peripheral that shares the same pin. Figure 11-1 shows how ports are shared with other peripherals and the associated I/O pin to which they are connected.

When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin may be read, but the output driver for the parallel port bit will be disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin may be driven by a port.

All port pins have three registers directly associated with their operation as digital I/Os and one register associated with their operation as analog inputs. The Data Direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the Output Latch register (LATx), read the latch; writes to the latch, write the latch. Reads from the PORTx register, read the port pins; writes to the port pins, write the latch.

Any bit and its associated data and control registers that are not valid for a particular device will be disabled. That means the corresponding LATx and TRISx registers, and the port pin, will read as zeros. Table 11-3 through Table 11-5 show ANSELx bits and ports availability for device variants. When a pin is shared with another peripheral or function that is defined as an input only, it is regarded as a dedicated port because there is no other competing source of inputs.

## FIGURE 11-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE



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## 11.1.1 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically, this instruction would be a NOP.

#### 11.1.2 OPEN-DRAIN CONFIGURATION

In addition to the PORTx, LATx and TRISx registers for data control, each port pin can also be individually configured for either a digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The open-drain feature allows the generation of outputs higher than VDD (e.g., 5V) on any desired digital only pins by using external pull-up resistors. The maximum open-drain voltage allowed is the same as the maximum VIH specification.

# 11.2 Configuring Analog Port Pins (ANSx)

The ANSx and TRISx registers control the operation of the pins with analog function. Each port pin with analog function is associated with one of the ANSx bits, which decide if the pin function should be analog or digital. Refer to Table 11-1 for detailed behavior of the pin for different ANSx and TRISx bit settings.

When reading the PORTx register, all pins configured as analog input channels will read as cleared (a low level).

# 11.2.1 ANALOG INPUT PINS AND VOLTAGE CONSIDERATIONS

The voltage tolerance of pins used as device inputs is dependent on the pin's input function. Most input pins are able to handle DC voltages of up to 5.5V, a level typical for digital logic circuits. However, several pins can only tolerate voltages up to VDD. Voltage excursions beyond VDD on these pins should always be avoided.

Table 11-2 summarizes the different voltage tolerances. For more information, refer to **Section 32.0 "Electrical Characteristics"** for more details.

TABLE 11-1:	CONFIGURING ANALOG/DIGITAL FUNCTION OF AN I/O PIN

Pin Function	Function ANSx Setting TRISx Setting		Comments
Analog Input	1	1	It is recommended to keep ANSx = 1.
Analog Output	1	1	It is recommended to keep ANSx = 1.
Digital Input	0	1	Firmware must wait at least one instruction cycle after configuring a pin as a digital input before a valid input value can be read.
Digital Output	0	0	Make sure to disable the analog output function on the pin if any is present.

#### TABLE 11-2: INPUT VOLTAGE LEVELS FOR PORT OR PIN TOLERATED DESCRIPTION INPUT

Port or Pin	Tolerated Input	Description
PORTB<11:10,8:5>	5.5V	Tolerates input levels above VDD; useful
PORTC<9:6>	- 5.5V	for most standard logic.
PORTA<14:7,4:0>		
PORTB<15:12,9,4:0>	VDD	Only VDD input levels are tolerated.
PORTC<5:0>	7	

Device	PORTA I/O Pins															
Device	RA15	RA14	RA13	RA12	RA11	RA10	RA9	RA8	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0
PIC24FJXXXGA705	_	Х	Х	Х	Х	Х	Х	Х	Х	_	_	Х	Х	Х	Х	Х
PIC24FJXXXGA704	_	_	_	_	_	Х	Х	Х	Х	_	_	Х	Х	Х	Х	Х
PIC24FJXXXGA702	_	_	_	_	_	_	_	_	_	_	_	Х	Х	Х	Х	Х
ANSELA bit present	—	_	_	_			_		_		_		Х	Х	Х	Х

# TABLE 11-3: PORTA PIN AND ANSELx AVAILABILITY

# TABLE 11-4: PORTB PIN AND ANSELx AVAILABILITY

PORTB I/O Pins						\$			_							
Device	RB15	RB14	RB13	RB12	RB11	RB10	RB9	RB8	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0
PIC24FJXXXGA705	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х
PIC24FJXXXGA704	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х
PIC24FJXXXGA702	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х
ANSELB bit present	Х	Х	Х	Х			Х					_	Х	Х	Х	Х

TABLE 11-5:	PORTC PIN AND ANSELX AVAILABILITY

Device							PO	RTC I/	O Pins	8						
Device	RC15	RC14	RC13	RC12	RC11	RC10	RC9	RC8	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0
PIC24FJXXXGA705	—	_	_		—		Х	Х	Х	Х	Х	Х	Х	Х	Х	Х
PIC24FJXXXGA704	—	_	_	_		_	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х
PIC24FJXXXGA702	_	_	_	_		_	_	_	_	_	_	_	_	_	_	—
ANSELC bit present	_	_	_			_				_		_	Х	Х	Х	Х

# 11.3 Interrupt-on-Change (IOC)

The Interrupt-on-Change function of the I/O ports allows the PIC24FJ256GA705 family of devices to generate interrupt requests to the processor in response to a Change-of-State (COS) on selected input pins. This feature is capable of detecting input Change-of-States, even in Sleep mode, when the clocks are disabled.

Interrupt-on-Change functionality is enabled on a pin by setting the IOCPx and/or IOCNx register bit for that pin. For example, PORTC has register names, IOCPC and IOCNC, for these functions. Setting a value of '1' in the IOCPx register enables interrupts for low-to-high transitions, while setting a value of '1' in the IOCNx register enables interrupts for high-to-low transitions. Setting a value of '1' in both register bits will enable interrupts for either case (e.g., a pulse on the pin will generate two interrupts). In order for any IOC to be detected, the global IOC Interrupt Enable bit (IEC1<3>) must be set, the PADCON<15> bit set (IOCON) and the associated ISFx flag cleared.

When an interrupt request is generated for a pin, the corresponding status flag (IOCFx register bit) will be set, indicating that a Change-of-State occurred on that pin. The IOCFx register bit will remain set until cleared by writing a zero to it. When any IOCFx flag bit in a given port is set, the corresponding IOCPxF bit in the IOCSTAT register will be set. This flag indicates that a change was detected on one of the bits on the given port. The IOCPxF flag will be cleared when all IOCFx<15:0> bits are cleared.

Multiple individual status flags can be cleared by writing a zero to one or more bits using a Read-Modify-Write operation. If another edge is detected on a pin whose status bit is being cleared during the Read-Modify-Write sequence, the associated change flag will still be set at the end of the Read-Modify-Write sequence. The user should use the instruction sequence (or equivalent) shown in Example 11-1 to clear the Interrupt-on-Change Status registers.

At the end of this sequence, the W0 register will contain a zero for each bit for which the port pin had a change detected. In this way, any indication of a pin changing will not be lost.

Due to the asynchronous and real-time nature of the Interrupt-on-Change, the value read on the port pins may not indicate the state of the port when the change was detected, as a second change can occur during the interval between clearing the flag and reading the port. It is up to the user code to handle this case if it is a possibility in their application. To keep this interval to a minimum, it is recommended that any code modifying the IOCFx registers be run either in the interrupt handler or with interrupts disabled.

Each Interrupt-on-Change (IOC) pin has both a weak pull-up and a weak pull-down connected to it. The pullups act as a current source connected to the pin, while the pull-downs act as a current sink connected to the pin. These eliminate the need for external resistors when push button or keypad devices are connected.

The pull-ups and pull-downs are separately enabled using the IOCPUx registers (for pull-ups) and the IOCPDx registers (for pull-downs). Each IOC pin has individual control bits for its pull-up and pull-down. Setting a control bit enables the weak pull-up or pull-down for the corresponding pin.

**Note:** Pull-ups and pull-downs on pins should always be disabled whenever the pin is configured as a digital output.

#### EXAMPLE 11-1: IOC STATUS READ/CLEAR IN ASSEMBLY

MOV0xFFFF, W0; Initial mask value 0xFFFF -> W0XORIOCFx, W0; W0 has 'l' for each bit set in IOCFxANDIOCFx; IOCFx & W0 ->IOCFx

#### EXAMPLE 11-2: PORT READ/WRITE IN ASSEMBLY

MOV W0, TRISB ; and PORTB<7:0> as outputs NOP ; Delay 1 cycle BTSS PORTB, #13 ; Next Instruction	MOV	0xFF00, W0	; Configure PORTB<15:8> as inputs
	MOV	WO, TRISB	; and PORTB<7:0> as outputs
BTSS PORTB, #13 ; Next Instruction	NOF		; Delay 1 cycle
	BTS	SS PORTB, #13	; Next Instruction

#### EXAMPLE 11-3: PORT READ/WRITE IN 'C'

TRISB = 0xFF00;	// Configure PORTB<15:8> as inputs and PORTB<7:0> as outputs
Nop();	// Delay 1 cycle
<pre>If (PORTBbits.RB13){ };</pre>	// Next Instruction

# 11.4 I/O Port Control Registers

| U-0    |
|-----|-----|-----|-----|-----|-----|--------|
| —   | _   | _   |     | _   |     | —      |
|     |     |     |     |     |     | bit 8  |
|     |     |     |     |     |     |        |
| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0  |
| —   |     | —   | _   |     | —   | PMPTTL |
|     |     |     |     |     |     | bit 0  |
|     | _   |     |     |     |     |        |

#### REGISTER 11-1: PADCON: PORT CONFIGURATION REGISTER

# Legend:

Logena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	IOCON: Interrupt-on-Change Enable bit
	<ul> <li>1 = Interrupt-on-Change functionality is enabled</li> <li>0 = Interrupt-on-Change functionality is disabled</li> </ul>
bit 14-1	Unimplemented: Read as '0'
bit 0	PMPTTL: PMP Port Type bit
	1 = TTL levels on PMP port pins
	0 = Schmitt Triggers on PMP port pins

# REGISTER 11-2: IOCSTAT: INTERRUPT-ON-CHANGE STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0
—	—	—	—	—	IOCPCF	IOCPBF	IOCPAF
bit 7							bit 0

Legend:	HS = Hardware Settable bit	Hardware Clearable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-3	Unimplemented: Read as '0'
bit 2	IOCPCF: Interrupt-on-Change PORTC Flag bit
	<ul> <li>1 = A change was detected on an IOC-enabled pin on PORTC</li> <li>0 = No change was detected or the user has cleared all detected changes</li> </ul>
bit 1	IOCPBF: Interrupt-on-Change PORTB Flag bit
	<ul> <li>1 = A change was detected on an IOC-enabled pin on PORTB</li> <li>0 = No change was detected or the user has cleared all detected changes</li> </ul>
bit 0	IOCPAF: Interrupt-on-Change PORTA Flag bit
	<ul> <li>1 = A change was detected on an IOC-enabled pin on PORTA</li> <li>0 = No change was detected, or the user has cleared all detected change</li> </ul>

# REGISTER 11-3: TRISX: OUTPUT ENABLE FOR PORTX REGISTER<sup>(1)</sup>

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			TRIS	x<15:8>			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			TRIS	Sx<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		it	U = Unimplemented bit, read as '0'				
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown

bit 15-0 **TRISx<15:0>:** Output Enable for PORTx bits 1 = LATx[n] is not driven on the PORTx[n] pin 0 = LATx[n] is driven on the PORTx[n] pin

Note 1: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

# **REGISTER 11-4: PORTX: INPUT DATA FOR PORTX REGISTER<sup>(1)</sup>**

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			PORTx	<15:8>			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			PORT	x<7:0>			
bit 7							bit 0
Legend:							
R = Readable I	bit	W = Writable bit		U = Unimplen	nented bit, read	d as '0'	

'0' = Bit is cleared

bit 15-0 **PORTx<15:0>:** PORTx Data Input Value bits

'1' = Bit is set

Note 1: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

-n = Value at POR

x = Bit is unknown

# REGISTER 11-5: LATX: OUTPUT DATA FOR PORTX REGISTER<sup>(1)</sup>

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
			LATX	<15:8>			
bit 15							bit 8
R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
			LAT	x<7:0>			
bit 7	bit 7						bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-0 LATx<15:0>: PORTx Data Output Value bits

Note 1: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

#### REGISTER 11-6: ODCx: OPEN-DRAIN ENABLE FOR PORTx REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			ODCx	<15:8>			
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
|       |       |       | ODCx  | <7:0> |       |       |       |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 ODCx<15:0>: PORTx Open-Drain Enable bits

1 = Open-drain is enabled on the PORTx pin

0 = Open-drain is disabled on the PORTx pin

Note 1: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

# REGISTER 11-7: ANSELX: ANALOG SELECT FOR PORTX REGISTER<sup>(1)</sup>

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			ANSE	Lx<15:8>			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			ANSE	Lx<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at P	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unki	nown

bit 15-0 ANSELx<15:0>: Analog Select for PORTx bits

1 = Analog input is enabled and digital input is disabled on the PORTx[n] pin

0 = Analog input is disabled and digital input is enabled on the PORTx[n] pin

**Note 1:** See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

x = Bit is unknown

# **REGISTER 11-8:** IOCPx: INTERRUPT-ON-CHANGE POSITIVE EDGE x REGISTER<sup>(1,2,3)</sup>

Legend:					nented bit, read		
bit 7							bit 0
			IOCP	°x<7:0>			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
bit 15							bit 8
			IOCP:	x<15:8>			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0

bit 15-0 **IOCPx<15:0>:** Interrupt-on-Change Positive Edge x Enable bits

'1' = Bit is set

-n = Value at POR

1 = Interrupt-on-Change is enabled on the IOCx pin for a positive going edge; the associated status bit and interrupt flag will be set upon detecting an edge

'0' = Bit is cleared

- 0 = Interrupt-on-Change is disabled on the IOCx pin for a positive going edge
- **Note 1:** Setting both IOCPx and IOCNx will enable the IOCx pin for both edges, while clearing both registers will disable the functionality.
  - 2: Changing the value of this register while the module is enabled (IOCON = 1) may cause a spurious IOC event. The corresponding interrupt must be ignored, cleared (using IOCFx) or masked (within the interrupt controller), or this module must be enabled (IOCON = 0) when changing this register.
  - 3: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

# REGISTER 11-9: IOCNX: INTERRUPT-ON-CHANGE NEGATIVE EDGE x REGISTER<sup>(1,2,3)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
		IOCNx	<15:8>			
						bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
		IOCN	x<7:0>			
						bit 0
			IOCN× R/W-0 R/W-0 R/W-0	IOCNx<15:8>	IOCNx<15:8> R/W-0 R/W-0 R/W-0 R/W-0	IOCNx<15:8> R/W-0 R/W-0 R/W-0 R/W-0 R/W-0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **IOCNx<15:0>:** Interrupt-on-Change Negative Edge x Enable bits

- 1 = Interrupt-on-Change is enabled on the IOCx pin for a negative going edge; the associated status bit and interrupt flag will be set upon detecting an edge
- 0 = Interrupt-on-Change is disabled on the IOCx pin for a negative going edge
- **Note 1:** Setting both IOCPx and IOCNx will enable the IOCx pin for both edges, while clearing both registers will disable the functionality.
  - 2: Changing the value of this register while the module is enabled (IOCON = 1) may cause a spurious IOC event. The corresponding interrupt must be ignored, cleared (using IOCFx) or masked (within the interrupt controller), or this module must be enabled (IOCON = 0) when changing this register.
  - 3: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

# REGISTER 11-10: IOCFx: INTERRUPT-ON-CHANGE FLAG x REGISTER<sup>(1,2)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			IOCE	<sup>-</sup> x<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			IOC	Fx<7:0>			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable bit		U = Unimplem	ented bit, rea	ad as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ired	x = Bit is unkr	nown

bit 15-0 **IOCFx<15:0>:** Interrupt-on-Change Flag x bits

- 1 = An enabled change was detected on the associated pin; set when IOCPx = 1 and a positive edge was detected on the IOCx pin, or when IOCNx = 1 and a negative edge was detected on the IOCx pin
   0 = No change was detected or the user cleared the detected change
- **Note 1:** It is not possible to set the IOCFx register bits with software writes (as this would require the addition of significant logic). To test IOC interrupts, it is recommended to enable the IOC functionality on one or more GPIO pins and then use the corresponding LATx register bit(s) to trigger an IOC interrupt.
  - 2: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

#### REGISTER 11-11: IOCPUx: INTERRUPT-ON-CHANGE PULL-UP ENABLE x REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			IOCPU	x<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			IOCPL	Jx<7:0>			
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 IOCPUx<15:0>: Interrupt-on-Change Pull-up Enable x bits

1 = Pull-up is enabled

0 = Pull-up is disabled

Note 1: See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

# REGISTER 11-12: IOCPDx: INTERRUPT-ON-CHANGE PULL-DOWN ENABLE x REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			IOCP	Dx<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			IOCF	PDx<7:0>			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable bit		U = Unimplem	nented bit, rea	ad as 'O'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown

bit 15-0 IOCPDx<15:0>: Interrupt-on-Change Pull-Down Enable x bits

1 = Pull-down is enabled

0 = Pull-down is disabled

**Note 1:** See Table 11-3, Table 11-4 and Table 11-5 for individual bit availability in this register.

# 11.5 Peripheral Pin Select (PPS)

A major challenge in general purpose devices is providing the largest possible set of peripheral features while minimizing the conflict of features on I/O pins. In an application that needs to use more than one peripheral multiplexed on a single pin, inconvenient work arounds in application code, or a complete redesign, may be the only option.

The Peripheral Pin Select (PPS) feature provides an alternative to these choices by enabling the user's peripheral set selection and its placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, users can better tailor the microcontroller to their entire application, rather than trimming the application to fit the device.

The Peripheral Pin Select feature operates over a fixed subset of digital I/O pins. Users may independently map the input and/or output of any one of many digital peripherals to any one of these I/O pins. PPS is performed in software and generally does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping once it has been established.

#### 11.5.1 AVAILABLE PINS

The PPS feature is used with a range of up to 44 pins, depending on the particular device and its pin count. Pins that support the Peripheral Pin Select feature include the designation, "RPn" or "RPIn", in their full pin designation, where "n" is the remappable pin number. "RP" is used to designate pins that support both remappable input and output functions, while "RPI" indicates pins that support remappable input functions only.

PIC24FJ256GA705 family devices support a larger number of remappable input/output pins than remappable input only pins. In this device family, there are up to 33 remappable input/output pins, depending on the pin count of the particular device selected. These pins are numbered, RP0 through RP28 and RPI29 through RPI32.

See Table 1-1 for a summary of pinout options in each package offering.

## 11.5.2 AVAILABLE PERIPHERALS

The peripherals managed by the PPS are all digital only peripherals. These include general serial communications (UART and SPI), general purpose timer clock inputs, timer related peripherals (input capture and output compare) and external interrupt inputs. Also included are the outputs of the comparator module, since these are discrete digital signals. PPS is not available for these peripherals:

- I<sup>2</sup>C (input and output)
- Input Change Notifications
- EPMP Signals (input and output)
- · Analog (inputs and outputs)
- INT0

A key difference between pin select and non-pin select peripherals is that pin select peripherals are not associated with a default I/O pin. The peripheral must always be assigned to a specific I/O pin before it can be used. In contrast, non-pin select peripherals are always available on a default pin, assuming that the peripheral is active and not conflicting with another peripheral.

#### 11.5.2.1 Peripheral Pin Select Function Priority

Pin-selectable peripheral outputs (e.g., output compare, UART transmit) will take priority over general purpose digital functions on a pin, such as EPMP and port I/O. Specialized digital outputs will take priority over PPS outputs on the same pin. The pin diagrams list peripheral outputs in the order of priority. Refer to them for priority concerns on a particular pin.

Unlike PIC24F devices with fixed peripherals, pinselectable peripheral inputs will never take ownership of a pin. The pin's output buffer will be controlled by the TRISx setting or by a fixed peripheral on the pin. If the pin is configured in Digital mode, then the PPS input will operate correctly. If an analog function is enabled on the pin, the PPS input will be disabled.

#### 11.5.3 CONTROLLING PERIPHERAL PIN SELECT

PPS features are controlled through two sets of Special Function Registers (SFRs): one to map peripheral inputs and one to map outputs. Because they are separately controlled, a particular peripheral's input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

The association of a peripheral to a peripheral-selectable pin is handled in two different ways, depending on if an input or an output is being mapped.

#### 11.5.3.1 Input Mapping

The inputs of the Peripheral Pin Select options are mapped on the basis of the peripheral; that is, a control register associated with a peripheral dictates the pin it will be mapped to. The RPINRx registers are used to configure peripheral input mapping (see Register 11-13 through Register 11-31).

Each register contains one or two sets of 6-bit fields, with each set associated with one of the pin-selectable peripherals. Programming a given peripheral's bit field with an appropriate 6-bit value maps the RPn/RPIn pin with that value to that peripheral. For any given device, the valid range of values for any of the bit fields corresponds to the maximum number of Peripheral Pin Selections supported by the device.

TARI E 11-6.	SELECTABLE INPUT SOURCES	(MAPS INPUT TO FUNCTION) <sup>(1)</sup>
IADLL II-0.	SELECTABLE INFOT SOURCES	

Input Name	Function Name	Register	Function Mapping Bits
Output Compare Trigger 1	OCTRIG1	RPINR0<5:0>	OCTRIG1R<5:0>
External Interrupt 1	INT1	RPINR0<13:8>	INT1R<5:0>
External Interrupt 2	INT2	RPINR1<5:0>	INT2R<5:0>
External Interrupt 3	INT3	RPINR1<13:8>	INT3R<5:0>
External Interrupt 4	INT4	RPINR2<5:0>	INT4R<5:0>
Output Compare Trigger 2	OCTRIG2	RPINR2<13:8>	OCTRIG2R<5:0>
Timer2 External Clock	T2CK	RPINR3<5:0>	T2CKR<5:0>
Timer3 External Clock	T3CK	RPINR3<13:8>	T3CKR<5:0>
Input Capture 1	ICM1	RPINR5<5:0>	ICM1R<5:0>
Input Capture 2	ICM2	RPINR5<13:8>	ICM2R<5:0>
Input Capture 3	ICM3	RPINR6<5:0>	ICM3R<5:0>
Input Capture 4	ICM4	RPINR6<13:8>	ICM4R<5:0>
Input Capture 1	IC1	RPINR7<5:0>	IC1R<5:0>
Input Capture 2	IC2	RPINR7<13:8>	IC2R<5:0>
Input Capture 3	IC3	RPINR8<5:0>	IC3R<5:0>
Output Compare Fault A	OCFA	RPINR11<5:0>	OCFAR<5:0>
Output Compare Fault B	OCFB	RPINR11<13:8>	OCFBR<5:0>
CCP Clock Input A	TCKIA	RPINR12<5:0>	TCKIAR<5:0>
CCP Clock Input B	TCKIB	RPINR12<13:8>	TCKIBR<5:0>
UART1 Receive	U1RX	RPINR18<5:0>	U1RXR<5:0>
UART1 Clear-to-Send	U1CTS	RPINR18<13:8>	U1CTSR<5:0>
UART2 Receive	U2RX	RPINR19<5:0>	U2RXR<5:0>
UART2 Clear-to-Send	U2CTS	RPINR19<13:8>	U2CTSR<5:0>
SPI1 Data Input	SDI1	RPINR20<5:0>	SDI1R<5:0>
SPI1 Clock Input	SCK1IN	RPINR20<13:8>	SCK1R<5:0>
SPI1 Slave Select Input	SS1IN	RPINR21<5:0>	SS1R<5:0>
SPI2 Data Input	SDI2	RPINR22<5:0>	SDI2R<5:0>
SPI2 Clock Input	SCK2IN	RPINR22<13:8>	SCK2R<5:0>
SPI2 Slave Select Input	SS2IN	RPINR23<5:0>	SS2R<5:0>
Generic Timer External Clock	TxCK	RPINR23<13:8>	TXCKR<5:0>
CLC Input A	CLCINA	RPINR25<5:0>	CLCINAR<5:0>
CLC Input B	CLCINB	RPINR25<13:8>	CLCINBR<5:0>
SPI3 Data Input	SDI3	RPINR28<5:0>	SDI3R<5:0>
SPI3 Clock Input	SCK3IN	RPINR28<13:8>	SCK3R<5:0>
SPI3 Slave Select Input	SS3IN	RPINR29<5:0>	SS3R<5:0>

Note 1: Unless otherwise noted, all inputs use the Schmitt Trigger (ST) input buffers.

# 11.5.3.2 Output Mapping

In contrast to inputs, the outputs of the Peripheral Pin Select options are mapped on the basis of the pin. In this case, a control register associated with a particular pin dictates the peripheral output to be mapped. The RPORx registers are used to control output mapping. Each register contains two 6-bit fields, with each field being associated with one RPn pin (see Register 11-32 through Register 11-46). The value of the bit field corresponds to one of the peripherals and that peripheral's output is mapped to the pin (see Table 11-7).

Because of the mapping technique, the list of peripherals for output mapping also includes a null value of '000000'. This permits any given pin to remain disconnected from the output of any of the pin-selectable peripherals.

<b>TABLE 11-7</b> :	SELECTABLE OUTPUT SOURCES	(MAPS FUNCTION TO OUTPUT)

Output Function Number	Function	Output Name
0	None (Pin Disabled)	_
1	C1OUT	Comparator 1 Output
2	C2OUT	Comparator 2 Output
3	U1TX	UART1 Transmit
4	U1RTS	UART1 Request-to-Send
5	U2TX	UART2 Transmit
6	U2RTS	UART2 Request-to-Send
7	SDO1	SPI1 Data Output
8	SCK1OUT	SPI1 Clock Output
9	SS10UT	SPI1 Slave Select Output
10	SDO2	SPI2 Data Output
11	SCK2OUT	SPI2 Clock Output
12	SS2OUT	SPI2 Slave Select Output
13	OC1	Output Compare 1
14	OC2	Output Compare 2
15	OC3	Output Compare 3
16	OCM2A	CCP2A Output Compare
17	OCM2B	CCP2B Output Compare
18	OCM3A	CCP3A Output Compare
19	OCM3B	CCP3B Output Compare
20	OCM4A	CCP4A Output Compare
21	OCM4B	CCP4B Output Compare
22	Reserved	_
23	SDO3	SPI3 Data Output
24	SCK3OUT	SPI3 Clock Output
25	SS3OUT	SPI3 Slave Select Output
26	C3OUT	Comparator 3 Output
27	PWRGT	RTCC Power Control
28	REFO	Reference Clock Output
29	CLC10UT	CLC1 Output
30	CLC2OUT	CLC2 Output
31	RTCC	RTCC Clock Output

## 11.5.3.3 Mapping Limitations

The control schema of the Peripheral Pin Select is extremely flexible. Other than systematic blocks that prevent signal contention, caused by two physical pins being configured as the same functional input or two functional outputs configured as the same pin, there are no hardware enforced lockouts. The flexibility extends to the point of allowing a single input to drive multiple peripherals or a single functional output to drive multiple output pins.

# 11.5.3.4 Mapping Exceptions for Family Devices

The differences in available remappable pins are summarized in Table 11-8.

When developing applications that use remappable pins, users should also keep these things in mind:

- For the RPINRx registers, bit combinations corresponding to an unimplemented pin for a particular device are treated as invalid; the corresponding module will not have an input mapped to it.
- For RPORx registers, the bit fields corresponding to an unimplemented pin will also be unimplemented; writing to these fields will have no effect.

# 11.5.4 CONTROLLING CONFIGURATION CHANGES

Because peripheral remapping can be changed during run time, some restrictions on peripheral remapping are needed to prevent accidental configuration changes. PIC24F devices include three features to prevent alterations to the peripheral map:

- · Control register lock sequence
- · Continuous state monitoring
- Configuration bit remapping lock

#### 11.5.4.1 Control Register Lock

Under normal operation, writes to the RPINRx and RPORx registers are not allowed. Attempted writes will appear to execute normally, but the contents of the

registers will remain unchanged. To change these registers, they must be unlocked in hardware. The register lock is controlled by the IOLOCK bit (OSCCON<6>). Setting IOLOCK prevents writes to the control registers; clearing IOLOCK allows writes.

To set or clear IOLOCK, a specific command sequence must be executed:

- 1. Write 46h to OSCCON<7:0>.
- 2. Write 57h to OSCCON<7:0>.
- 3. Clear (or set) IOLOCK as a single operation.

Unlike the similar sequence with the oscillator's LOCK bit, IOLOCK remains in one state until changed. This allows all of the Peripheral Pin Selects to be configured with a single unlock sequence, followed by an update to all control registers, then locked with a second lock sequence.

#### 11.5.4.2 Continuous State Monitoring

In addition to being protected from direct writes, the contents of the RPINRx and RPORx registers are constantly monitored in hardware by shadow registers. If an unexpected change in any of the registers occurs (such as cell disturbances caused by ESD or other external events), a Configuration Mismatch Reset will be triggered.

## 11.5.4.3 Configuration Bit Pin Select Lock

As an additional level of safety, the device can be configured to prevent more than one write session to the RPINRx and RPORx registers. The IOL1WAY (FOSC<5>) Configuration bit blocks the IOLOCK bit from being cleared after it has been set once. If IOLOCK remains set, the register unlock procedure will not execute and the Peripheral Pin Select Control registers cannot be written to. The only way to clear the bit and re-enable peripheral remapping is to perform a device Reset.

In the default (unprogrammed) state, IOL1WAY is set, restricting users to one write session. Programming IOL1WAY allows users unlimited access (with the proper use of the unlock sequence) to the Peripheral Pin Select registers.

Device		RPn Pins (I/O)	RPIn Pins		
Device	Total	Unimplemented	Total	Unimplemented	
PIC24FJXXXGA705	29	_	4	_	
PIC24FJXXXGA704	29	—	0	RPI29-32	
PIC24FJXXXGA702	18	RP16-25	0	RPI29-32	

#### TABLE 11-8: REMAPPABLE PIN EXCEPTIONS FOR PIC24FJ256GA705 FAMILY DEVICES

## 11.5.5 CONSIDERATIONS FOR PERIPHERAL PIN SELECTION

The ability to control Peripheral Pin Selection introduces several considerations into application design that could be overlooked. This is particularly true for several common peripherals that are available only as remappable peripherals.

The main consideration is that the Peripheral Pin Selects are not available on default pins in the device's default (Reset) state. Since all RPINRx registers reset to '111111' and all RPORx registers reset to '000000', all Peripheral Pin Select inputs are tied to Vss, and all Peripheral Pin Select outputs are disconnected.

This situation requires the user to initialize the device with the proper peripheral configuration before any other application code is executed. Since the IOLOCK bit resets in the unlocked state, it is not necessary to execute the unlock sequence after the device has come out of Reset. For application safety, however, it is best to set IOLOCK and lock the configuration after writing to the control registers.

Because the unlock sequence is timing-critical, it must be executed as an assembly language routine in the same manner as changes to the oscillator configuration. If the bulk of the application is written in 'C', or another high-level language, the unlock sequence should be performed by writing in-line assembly.

Choosing the configuration requires the review of all Peripheral Pin Selects and their pin assignments, especially those that will not be used in the application. In all cases, unused pin-selectable peripherals should be disabled completely. Unused peripherals should have their inputs assigned to an unused RPn/RPIn pin function. I/O pins with unused RPn functions should be configured with the null peripheral output.

The assignment of a peripheral to a particular pin does not automatically perform any other configuration of the pin's I/O circuitry. In theory, this means adding a pinselectable output to a pin may mean inadvertently driving an existing peripheral input when the output is driven. Users must be familiar with the behavior of other fixed peripherals that share a remappable pin and know when to enable or disable them. To be safe, fixed digital peripherals that share the same pin should be disabled when not in use. Along these lines, configuring a remappable pin for a specific peripheral does not automatically turn that feature on. The peripheral must be specifically configured for operation and enabled as if it were tied to a fixed pin. Where this happens in the application code (immediately following a device Reset and peripheral configuration or inside the main application routine) depends on the peripheral and its use in the application.

A final consideration is that Peripheral Pin Select functions neither override analog inputs nor reconfigure pins with analog functions for digital I/Os. If a pin is configured as an analog input on a device Reset, it must be explicitly reconfigured as a digital I/O when used with a Peripheral Pin Select.

Example 11-4 shows a configuration for bidirectional communication with flow control using UART1. The following input and output functions are used:

- Input Functions: U1RX, U1CTS
- Output Functions: U1TX, U1RTS

EXAMPLE 11-4:	CONFIGURING UART1
	INPUT AND OUTPUT
	FUNCTIONS

		1 01		
	Unlock Regi			
asm	volatile	("MOV	#OSCCON, w1	\n"
		"MOV	#0x46, w2	\n"
		"MOV	#0x57, w3	\n"
		"MOV.b	w2, [w1]	\n"
		"MOV.b	w3, [w1]	\n"
		"BCLR	OSCCON, #6")	;
//	or use XC16	5 built-	in macro:	
//	builtin_v	vrite_OS	CCONL(OSCCON &	0xbf)
//	Configure 1	Input Fu	nctions (Table	11-6)
	// Assign U	J1RX To	Pin RPO	
	RPINR18bits	s.UlRXR	= 0;	
	// Assign U	J1CTS To	Pin RP1	
	RPINR18bits			
, ,	Configura	Network II	unctions (Table	11 <b>7</b> )
	// Assign U	-		; 11-7)
	RPOR1bits.			
	RI ORIDICS.I	(1 21( - )	,	
	// Assign (	IIRTS TO	Pin RP3	
	RPOR1bits.H			
11	Lock Regist	ers		
asm	volatile	("MOV	#OSCCON, w1	\n"
		"MOV	#0x46, w2	\n"
		"MOV	#0x57, w3	\n"
		"MOV.b	w2, [w1]	\n"
				\n"
		"BSET	OSCCON, #6")	;
//	or use XC16	5 built-	in macro:	
11	builtin v	mita ng	CCONT. (OSCCON	0 - 40

```
// __builtin_write_OSCCONL(OSCCON | 0x40);
```

#### 11.5.6 PERIPHERAL PIN SELECT REGISTERS

The PIC24FJ256GA705 family of devices implements a total of 34 registers for remappable peripheral configuration:

- Input Remappable Peripheral Registers (19)
- Output Remappable Peripheral Registers (15)

Note: Input and Output register values can only be changed if IOLOCK (OSCCON<6>) = 0. See Section 11.5.4.1 "Control Register Lock" for a specific command sequence.

#### REGISTER 11-13: RPINR0: PERIPHERAL PIN SELECT INPUT REGISTER 0

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	INT1R5	INT1R4	INT1R3	INT1R2	INT1R1	INT1R0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	OCTRIG1R5	OCTRIG1R4	OCTRIG1R3	OCTRIG1R2	OCTRIG1R1	OCTRIG1R0
bit 7							bit 0

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	INT1R<5:0>: Assign External Interrupt 1 (INT1) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	<b>OCTRIG1R&lt;5:0&gt;:</b> Assign Output Compare Trigger 1 to Corresponding RPn or RPIn Pin bits

# REGISTER 11-14: RPINR1: PERIPHERAL PIN SELECT INPUT REGISTER 1

Legend: R = Readable bit W = Writable bit		U = Unimpler		( <b>a</b> )			
bit 7							bit 0
—	_	INT2R5	INT2R4	INT2R3	INT2R2	INT2R1	INT2R0
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
bit 15							bit 8
—	_	INT3R5	INT3R4	INT3R3	INT3R2	INT3R1	INT3R0
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-14	Unimplemented: Read as '0'
bit 13-8	INT3R<5:0>: Assign External Interrupt 3 (INT3) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	INT2R<5:0>: Assign External Interrupt 2 (INT2) to Corresponding RPn or RPIn Pin bits

## REGISTER 11-15: RPINR2: PERIPHERAL PIN SELECT INPUT REGISTER 2

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	OCTRIG2R5	OCTRIG2R4	OCTRIG2R3	OCTRIG2R2	OCTRIG2R1	OCTRIG2R0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	INT4R5	INT4R4	INT4R3	INT4R2	INT4R1	INT4R0
bit 7							bit 0
Logond							

Legend:			
R = Readable bit W = Writable bit		U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	OCTRIG2R<5:0>: Assign Output Compare Trigger 2 to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	INT4R<5:0>: Assign External Interrupt 4 (INT4) to Corresponding RPn or RPIn Pin bits

#### REGISTER 11-16: RPINR3: PERIPHERAL PIN SELECT INPUT REGISTER 3

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	T3CKR5	T3CKR4	T3CKR3	T3CKR2	T3CKR1	T3CKR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	T2CKR5	T2CKR4	T2CKR3	T2CKR2	T2CKR1	T2CKR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 T3CKR<5:0>: Assign Timer3 Clock to Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 T2CKR<5:0>: Assign Timer2 Clock to Corresponding RPn or RPIn Pin bits

Legend: R = Readable bit W = Writable bit							
bit 7							bit 0
—	—	ICM1R5	ICM1R4	ICM1R3	ICM1R2	ICM1R1	ICM1R0
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
bit 15							bit 8
_	—	ICM2R5	ICM2R4	ICM2R3	ICM2R2	ICM2R1	ICM2R0
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1

## REGISTER 11-17: RPINR5: PERIPHERAL PIN SELECT INPUT REGISTER 5

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit,	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-14	Unimplemented: Read as '0'
bit 13-8	ICM2R<5:0>: Input Capture Mode 2 bits
bit 7-6	Unimplemented: Read as '0'

bit 5-0 ICM1R<5:0>: Input Capture Mode 1 bits

#### **REGISTER 11-18: RPINR6: PERIPHERAL PIN SELECT INPUT REGISTER 6**

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	ICM4R5	ICM4R4	ICM4R3	ICM4R2	ICM4R1	ICM4R0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	ICM3R5	ICM3R4	ICM3R3	ICM3R2	ICM3R1	ICM3R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 ICM4R<5:0>: Input Capture Mode 4 bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 ICM3R<5:0>: Input Capture Mode 3 bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
	_	IC2R5	IC2R4	IC2R3	IC2R2	IC2R1	IC2R0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	IC1R5	IC1R4	IC1R3	IC1R2	IC1R1	IC1R0
bit 7	bit 7						bit 0
Legend:							
R = Readable bit W = Writable bit U = Unimplemented b		ented bit, read	l as '0'				
-n = Value at	POR	'1' = Bit is set '0' = Bit is cleared x = Bit is unl		x = Bit is unkr	nown		

#### REGISTER 11-19: RPINR7: PERIPHERAL PIN SELECT INPUT REGISTER 7

bit 15-14	Unimplemented: Read as '0'
bit 13-8	IC2R<5:0>: Assign Input Capture 2 (IC2) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	IC1R<5:0>: Assign Input Capture 1 (IC1) to Corresponding RPn or RPIn Pin bits

#### REGISTER 11-20: RPINR8: PERIPHERAL PIN SELECT INPUT REGISTER 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	IC3R5	IC3R4	IC3R3	IC3R2	IC3R1	IC3R0
bit 7 bit 0							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5-0 IC3R<5:0>: Assign Input Capture 3 (IC3) to Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	OCFBR5	OCFBR4	OCFBR3	OCFBR2	OCFBR1	OCFBR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
	—	OCFAR5	OCFAR4	OCFAR3	OCFAR2	OCFAR1	OCFAR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	OCFBR<5:0>: Assign Output Compare Fault B (OCFB) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	OCFAR<5:0>: Assign Output Compare Fault A (OCFA) to Corresponding RPn or RPIn Pin bits

# REGISTER 11-22: RPINR12: PERIPHERAL PIN SELECT INPUT REGISTER 12

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	TCKIBR5	TCKIBR4	TCKIBR3	TCKIBR2	TCKIBR1	TCKIBR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	TCKIAR5	TCKIAR4	TCKIAR3	TCKIAR2	TCKIAR1	TCKIAR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 TCKIBR<5:0>: Assign MCCP/SCCP Clock Input B to Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 TCKIAR<5:0>: Assign MCCP/SCCP Clock Input A to Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U1CTSR5	U1CTSR4	U1CTSR3	U1CTSR2	U1CTSR1	U1CTSR0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1

## REGISTER 11-23: RPINR18: PERIPHERAL PIN SELECT INPUT REGISTER 18

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U1RXR5	U1RXR4	U1RXR3	U1RXR2	U1RXR1	U1RXR0
bit 7		-					bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	U1CTSR<5:0>: Assign UART1 Clear-to-Send (U1CTS) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	U1RXR<5:0>: Assign UART1 Receive (U1RX) to Corresponding RPn or RPIn Pin bits

# REGISTER 11-24: RPINR19: PERIPHERAL PIN SELECT INPUT REGISTER 19

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U2CTSR5	U2CTSR4	U2CTSR3	U2CTSR2	U2CTSR1	U2CTSR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U2RXR5	U2RXR4	U2RXR3	U2RXR2	U2RXR1	U2RXR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 U2CTSR<5:0>: Assign UART2 Clear-to-Send (U2CTS) to Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 U2RXR<5:0>: Assign UART2 Receive (U2RX) to Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SCK1R5	SCK1R4	SCK1R3	SCK1R2	SCK1R1	SCK1R0
bit 15		-					bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SDI1R5	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0
bit 7							bit 0
Legend:							
R = Readable bit W = Writ		W = Writable	bit	U = Unimplen	nented bit, read	1 as '0'	
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	SCK1R<5:0>: Assign SPI1 Clock Input (SCK1IN) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	SDI1R<5:0>: Assign SPI1 Data Input (SDI1) to Corresponding RPn or RPIn Pin bits

## REGISTER 11-26: RPINR21: PERIPHERAL PIN SELECT INPUT REGISTER 21

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SS1R5	SS1R4	SS1R3	SS1R2	SS1R1	SS1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5-0 SS1R<5:0>: Assign SPI1 Slave Select Input (SS1IN) to Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	_	SCK2R5	SCK2R4	SCK2R3	SCK2R2	SCK2R1	SCK2R0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SDI2R5	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0
bit 7							bit 0
Legend:							

# REGISTER 11-27: RPINR22: PERIPHERAL PIN SELECT INPUT REGISTER 22

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	SCK2R<5:0>: Assign SPI2 Clock Input (SCK2IN) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	SDI2R<5:0>: Assign SPI2 Data Input (SDI2) to Corresponding RPn or RPIn Pin bits

# REGISTER 11-28: RPINR23: PERIPHERAL PIN SELECT INPUT REGISTER 23

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	TXCKR5	TXCKR4	TXCKR3	TXCKR2	TXCKR1	TXCKR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SS2R5	SS2R4	SS2R3	SS2R2	SS2R1	SS2R0
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **TXCKR<5:0>:** Assign General Timer External Input (TxCK) to Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 SS2R<5:0>: Assign SPI2 Slave Select Input (SS2IN) to Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	CLCINBR5	CLCINBR4	CLCINBR3	CLCINBR2	CLCINBR1	CLCINBR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	CLCINAR5	CLCINAR4	CLCINAR3	CLCINAR2	CLCINAR1	CLCINAR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	CLCINBR<5:0>: Assign CLC Input B to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	CLCINAR<5:0>: Assign CLC Input A to Corresponding RPn or RPIn Pin bits

# REGISTER 11-30: RPINR28: PERIPHERAL PIN SELECT INPUT REGISTER 28

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	SCK3R5	SCK3R4	SCK3R3	SCK3R2	SCK3R1	SCK3R0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SDI3R5	SDI3R4	SDI3R3	SDI3R2	SDI3R1	SDI3R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as 'O'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 SCK3R<5:0>: Assign SPI3 Clock Input (SCK3IN) to Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 SDI3R<5:0>: Assign SPI3 Data Input (SDI3) to Corresponding RPn or RPIn Pin bits

# REGISTER 11-31: RPINR29: PERIPHERAL PIN SELECT INPUT REGISTER 29

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	_	—	—	_	—	_	
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	SS3R5	SS3R4	SS3R3	SS3R2	SS3R1	SS3R0
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable I	bit	U = Unimplemented bit, read as '0'			
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unkno		nown		

bit 15-6 Unimplemented: Read as '0'

bit 5-0 SS3R<5:0>: Assign SPI3 Slave Select Input (SS3IN) to Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
_	—	RP1R5	RP1R4	RP1R3	RP1R2	RP1R1	RP1R0	
bit 15				-			bit 8	
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	—	RP0R5	RP0R4	RP0R3	RP0R2	RP0R1	RP0R0	
bit 7							bit 0	
Legend:								
R = Readable bit W = Writable		W = Writable	bit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		
bit 15-14	Unimplemen	ted: Read as '	כי					
bit 13-8	RP1R<5:0>:	RP1 Output Pir	n Mapping bits	;				
	Peripheral Ou	utput Number n	is assigned to	pin, RP1 (see	Table 11-7 for	peripheral func	tion numbers).	
bit 7-6	Unimplemented: Read as '0'							

bit 5-0 **RP0R<5:0>:** RP0 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP0 (see Table 11-7 for peripheral function numbers).

## REGISTER 11-33: RPOR1: PERIPHERAL PIN SELECT OUTPUT REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	_	RP3R5	RP3R4	RP3R3	RP3R2	RP3R1	RP3R0	
bit 15							bit 8	
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
_	_	RP2R5	RP2R4	RP2R3	RP2R2	RP2R1	RP2R0	
bit 7							bit 0	
Legend:								
R = Readable bit W = Writable bit			bit	U = Unimplemented bit, read as '0'				

-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RP3R<5:0>:** RP3 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP3 (see Table 11-7 for peripheral function numbers).

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **RP2R<5:0>:** RP2 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP2 (see Table 11-7 for peripheral function numbers).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP5R5	RP5R4	RP5R3	RP5R2	RP5R1	RP5R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP4R5	RP4R4	RP4R3	RP4R2	RP4R1	RP4R0
bit 7 bit							bit 0
Legend:							
R = Readable bit W = Writable bit		oit	U = Unimplemented bit, read as '0'				
-n = Value at POR (1' = Bit is set			'0' = Bit is cleared x = Bit is unknown				

# REGISTER 11-34: RPOR2: PERIPHERAL PIN SELECT OUTPUT REGISTER 2

bit 15-14	Unimplemented: Read as '0'
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- bit 13-8**RP5R<5:0>:** RP5 Output Pin Mapping bits<br/>Peripheral Output Number n is assigned to pin, RP5 (see Table 11-7 for peripheral function numbers).bit 7-6**Unimplemented:** Read as '0'
- bit 5-0 **RP4R<5:0>:** RP4 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP4 (see Table 11-7 for peripheral function numbers).

REGISTER 11-35: RPOR3: PERIPHERAL PIN SELECT OUTPUT REGISTE	EGISTER 11-35:	RIPHERAL PIN SELECT OUTPUT REGISTER 3
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U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	RP7R5	RP7R4	RP7R3	RP7R2	RP7R1	RP7R0
bit 15		-					bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP6R5	RP6R4	RP6R3	RP6R2	RP6R1	RP6R0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			oit	U = Unimplemented bit, read as '0'			
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			nown	

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RP7R<5:0>:** RP7 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP7 (see Table 11-7 for peripheral function numbers).

- bit 7-6 Unimplemented: Read as '0'
- bit 5-0 **RP6R<5:0>:** RP6 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP6 (see Table 11-7 for peripheral function numbers).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP9R5	RP9R4	RP9R3	RP9R2	RP9R1	RP9R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP8R5	RP8R4	RP8R3	RP8R2	RP8R1	RP8R0
bit 7							bit 0

# REGISTER 11-36: RPOR4: PERIPHERAL PIN SELECT OUTPUT REGISTER 4

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	RP9R<5:0>: RP9 Output Pin Mapping bits
	Peripheral Output Number n is assigned to pin, RP9 (see Table 11-7 for peripheral function numbers).
bit 7-6	Unimplemented: Read as '0'
bit 5-0	RP8R<5:0>: RP8 Output Pin Mapping bits
	Peripheral Output Number n is assigned to pin, RP8 (see Table 11-7 for peripheral function numbers).

# REGISTER 11-37: RPOR5: PERIPHERAL PIN SELECT OUTPUT REGISTER 5

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP11R5	RP11R4	RP11R3	RP11R2	RP11R1	RP11R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP10R5	RP10R4	RP10R3	RP10R2	RP10R1	RP10R0
bit 7				•			bit 0

Legend:					
R = Readable bit	W = Writable bit	W = Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RP11R<5:0>:** RP11 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP11 (see Table 11-7 for peripheral function numbers).

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **RP10R<5:0>:** RP10 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP10 (see Table 11-7 for peripheral function numbers).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
	—	RP13R5	RP13R4	RP13R3	RP13R2	RP13R1	RP13R0			
bit 15	bit 15 bit 8									
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
—	—	RP12R5	RP12R4	RP12R3	RP12R2	RP12R1	RP12R0			
bit 7							bit 0			
Legend:										
R = Readable bit		W = Writable	bit	U = Unimplem	nented bit, read	l as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown				

# REGISTER 11-38: RPOR6: PERIPHERAL PIN SELECT OUTPUT REGISTER 6

bit 15-14	Unimplemented: Read as '0'
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- bit 13-8**RP13R<5:0>:** RP13 Output Pin Mapping bits<br/>Peripheral Output Number n is assigned to pin, RP13 (see Table 11-7 for peripheral function numbers).bit 7-6**Unimplemented:** Read as '0'
- bit 5-0 **RP12R<5:0>:** RP12 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP12 (see Table 11-7 for peripheral function numbers).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	—	RP15R5	RP15R4	RP15R3	RP15R2	RP15R1	RP15R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP14R5	RP14R4	RP14R3	RP14R2	RP14R1	RP14R0
bit 7			•	•			bit 0
Legend:							

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RP15R<5:0>:** RP15 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP15 (see Table 11-7 for peripheral function numbers).

- bit 7-6 Unimplemented: Read as '0'
- bit 5-0 **RP14R<5:0>:** RP14 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP14 (see Table 11-7 for peripheral function numbers).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP17R5	RP17R4	RP17R3	RP17R2	RP17R1	RP17R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP16R5	RP16R4	RP16R3	RP16R2	RP16R1	RP16R0
bit 7							bit 0
Legend:							

# REGISTER 11-40: RPOR8: PERIPHERAL PIN SELECT OUTPUT REGISTER 8

- <b>J</b>			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	RP17R<5:0>: RP17 Output Pin Mapping bits
	Peripheral Output Number n is assigned to pin, RP17 (see Table 11-7 for peripheral function numbers).
bit 7-6	Unimplemented: Read as '0'
bit 5-0	RP16R<5:0>: RP16 Output Pin Mapping bits
	Peripheral Output Number n is assigned to pin, RP16 (see Table 11-7 for peripheral function numbers).

# REGISTER 11-41: RPOR9: PERIPHERAL PIN SELECT OUTPUT REGISTER 9

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP19R5	RP19R4	RP19R3	RP19R2	RP19R1	RP19R0
bit 15 bi							bit 8
<b>F</b>							
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	RP18R5	RP18R4	RP18R3	RP18R2	RP18R1	RP18R0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 7

bit 13-8 **RP19R<5:0>:** RP19 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP19 (see Table 11-7 for peripheral function numbers).

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **RP18R<5:0>:** RP18 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP18 (see Table 11-7 for peripheral function numbers).

bit 0

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP21R5	RP21R4	RP21R3	RP21R2	RP21R1	RP21R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP20R5	RP20R4	RP20R3	RP20R2	RP20R1	RP20R0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			bit	U = Unimplem	nented bit, read	as '0'	

# REGISTER 11-42: RPOR10: PERIPHERAL PIN SELECT OUTPUT REGISTER 10

bit 15-14	Unimplemented: Read as '0'

'1' = Bit is set

-n = Value at POR

bit 13-8**RP21R<5:0>:** RP21 Output Pin Mapping bits<br/>Peripheral Output Number n is assigned to pin, RP21 (see Table 11-7 for peripheral function numbers).bit 7-6**Unimplemented:** Read as '0'

'0' = Bit is cleared

bit 5-0 **RP20R<5:0>:** RP20 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP20 (see Table 11-7 for peripheral function numbers).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	RP23R5	RP23R4	RP23R3	RP23R2	RP23R1	RP23R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	-	RP22R5	RP22R4	RP22R3	RP22R2	RP22R1	RP22R0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			U = Unimplemented bit, read as '0'				

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RP23R<5:0>:** RP23 Output Pin Mapping bits

'1' = Bit is set

Peripheral Output Number n is assigned to pin, RP23 (see Table 11-7 for peripheral function numbers).

'0' = Bit is cleared

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **RP22R<5:0>:** RP22 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP22 (see Table 11-7 for peripheral function numbers).

-n = Value at POR

x = Bit is unknown

x = Bit is unknown

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	RP25R5	RP25R4	RP25R3	RP25R2	RP25R1	RP25R0
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP24R5	RP24R4	RP24R3	RP24R2	RP24R1	RP24R0
bit 7							bit 0
Legend:							

# REGISTER 11-44: RPOR12: PERIPHERAL PIN SELECT OUTPUT REGISTER 12

Logonal			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	RP25R<5:0>: RP25 Output Pin Mapping bits
	Peripheral Output Number n is assigned to pin, RP25 (see Table 11-7 for peripheral function numbers).
bit 7-6	Unimplemented: Read as '0'
bit 5-0	RP24R<5:0>: RP24 Output Pin Mapping bits
	Peripheral Output Number n is assigned to pin, RP24 (see Table 11-7 for peripheral function numbers).

# REGISTER 11-45: RPOR13: PERIPHERAL PIN SELECT OUTPUT REGISTER 13

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP27R5	RP27R4	RP27R3	RP27R2	RP27R1	RP27R0
bit 15		•					bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	RP26R5	RP26R4	RP26R3	RP26R2	RP26R1	RP26R0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 7

bit 13-8 **RP27R<5:0>:** RP27 Output Pin Mapping bits

Peripheral Output Number n is assigned to pin, RP27 (see Table 11-7 for peripheral function numbers).

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **RP26R<5:0>:** RP26 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP26 (see Table 11-7 for peripheral function numbers).

bit 0

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—			—
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP28R5	RP28R4	RP28R3	RP28R2	RP28R1	RP28R0
bit 7							bit 0
Legend:							

# REGISTER 11-46: RPOR14: PERIPHERAL PIN SELECT OUTPUT REGISTER 14

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5-0 **RP28R<5:0>:** RP28 Output Pin Mapping bits Peripheral Output Number n is assigned to pin, RP28 (see Table 11-7 for peripheral function numbers).

# 12.0 TIMER1

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Timers" (DS39704), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Timer1 module is a 16-bit timer, which can serve as the time counter for the Real-Time Clock (RTC) or operate as a free-running, interval timer/counter. Timer1 can operate in three modes:

- 16-Bit Timer
- 16-Bit Synchronous Counter
- 16-Bit Asynchronous Counter

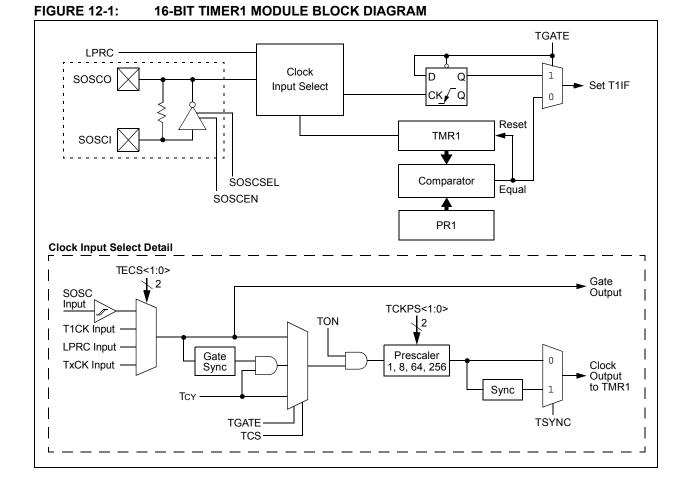
Timer1 also supports these features:

- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation during CPU Idle and Sleep modes
- Interrupt on 16-Bit Period Register Match or Falling Edge of External Gate Signal

Figure 12-1 presents a block diagram of the 16-bit timer module.

To configure Timer1 for operation:

- 1. Set the TON bit (= 1).
- 2. Select the timer prescaler ratio using the TCKPS<1:0> bits.
- 3. Set the Clock and Gating modes using the TCS, TECS<1:0> and TGATE bits.
- 4. Set or clear the TSYNC bit to configure synchronous or asynchronous operation.
- 5. Load the timer period value into the PR1 register.
- 6. If interrupts are required, set the interrupt enable bit, T1IE. Use the priority bits, T1IP<2:0>, to set the interrupt priority.



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U-0       R/W-0       R/W-0       R/W-0       U-0       R/W-0       R/W-0       U-0         —       TGATE       TCKPS1       TCKPS0       —       TSYNC       TCS       —         bit       7       TCKPS1       TCKPS0       —       TSYNC       TCS       —         egend:       R       Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'       n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15       TON: Timer1 On bit       1       = Starts 16-bit Timer1       0 = Stops 16-bit Timer1 (TxCK) external input 10 = LPRC Oscillator       0 = TICK external clock input 00 = Stops 10 = Stop	R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0			
U-0       R/W-0       R/W-0       R/W-0       U-0       R/W-0       R/W-0       U-0         =       TGATE       TCKPS1       TCKPS0       —       TSYNC       TCS       —         egend:       R       Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'       n         n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15       TON: Timer1 On bit       1       Starts 16-bit Timer1         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1         1 = Discontinues module operation in ldle mode       0 = Continues module operation in ldle mode       0 = Continues module operation in ldle mode         0 = Continues module operation in ldle mode       0 = Continues module operation in ldle mode       0 = Continues module operation is lable to         1 = Discontinues module operation in ldle mode       0 = Continues module operation in ldle mode       0 = Continues module operation is disable         0 = IPRC OScillator       0 = ITimer1 Extended Clock Source Select bits (selected when TCS = 1)       1 = Gated Time accumulation is disable         0	TON	_	TSIDL	_		_	TECS1	TECS0			
-         TGATE         TCKPS1         TCKPS0         -         TSYNC         TCS         -           egend:         R         R         Readable bit         W = Writable bit         U = Unimplemented bit, read as '0'         bit           n = Value at POR         '1' = Bit is set         '0' = Bit is cleared         x = Bit is unknown           sit 15         TON: Timer1 On bit         1         = Stops 16-bit Timer1           0 = Stops 16-bit Timer1         0         Stops 16-bit Timer1           0 = Stops 16-bit Timer1         Unimplemented: Read as '0'           sit 13         TSIDL: Timer1 Stop in Idle Mode bit           1 = Discontinues module operation when device enters Idle mode         0           0 = Continues module operation when device enters Idle mode         0           0 = Continues module operation in Idle mode         0           0 = DRC Oscillator         0           0 = DRC Oscillator         0           0 = TCK external took input         00           0 = Stops Timer1 Input Clock Prescale Select bits           1 = Gated time accumulation is enabled           0 = Gated time accumulation is disabled           0 = Gated time accumulation is disabled           0 = CKPS           0 = 1:4           0 = 1:5	bit 15						I	bit 8			
-         TGATE         TCKPS1         TCKPS0         -         TSYNC         TCS         -           egend:         R         R         Readable bit         W = Writable bit         U = Unimplemented bit, read as '0'         bit           n = Value at POR         '1' = Bit is set         '0' = Bit is cleared         x = Bit is unknown           sit 15         TON: Timer1 On bit         1         = Stops 16-bit Timer1           0 = Stops 16-bit Timer1         0         Stops 16-bit Timer1           0 = Stops 16-bit Timer1         Unimplemented: Read as '0'           sit 13         TSIDL: Timer1 Stop in Idle Mode bit           1 = Discontinues module operation when device enters Idle mode         0           0 = Continues module operation when device enters Idle mode         0           0 = Continues module operation in Idle mode         0           0 = DRC Oscillator         0           0 = DRC Oscillator         0           0 = TCK external took input         00           0 = Stops Timer1 Input Clock Prescale Select bits           1 = Gated time accumulation is enabled           0 = Gated time accumulation is disabled           0 = Gated time accumulation is disabled           0 = CKPS           0 = 1:4           0 = 1:5	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	LI-0			
append:       Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'         n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15       TON: Timer1 On bit       1       Starts 16-bit Timer1         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1         0 = Stops 16-bit Timer1       0 = Discontinues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = LPRC Oscillator       0 = IFCS-1:D: Timer1 Extended Clock Source Select bits (selected when TCS = 1)       11 = Gostillator         0 = SOSC       TGATE: Timer1 Gated Time Accumulation Enabled       0 = Gated time accumulation is disabled         0 = 1:1       This bit is ignored.       TGATE: Timer1 Extendel Clock Input Synchronization Select bit		-	-	-			_				
R = Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'         n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15       TON: Timer1 On bit       1       = Starts 16-bit Timer1         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0         0 = Continues module operation when device enters Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation when device enters Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = UPRC Oscillator       11 = Generic timer (TxCK) external input         10 = LPRC Oscillator       0 = TICK external clock input         0 = SOSC       0 = TICK external clock input         0 = SOSC       0 = TiCK         bit 1       = Gated time accumulation is disabled         0 = Gated time accumulation is disabled       0 = Gated time accumulation is disabled         0 = 1:1       1 = 1:256       1 = 1:3	bit 7	TOALE				Torrito	100	bit			
R = Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'         n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15       TON: Timer1 On bit       1       = Starts 16-bit Timer1         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0         0 = Stops 16-bit Timer1       0 = Stops 16-bit Timer1       0         0 = Continues module operation when device enters Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation when device enters Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = Continues module operation in Idle mode       0 = Continues module operation in Idle mode         0 = UPRC Oscillator       11 = Generic timer (TxCK) external input         10 = LPRC Oscillator       0 = TICK external clock input         0 = SOSC       0 = TICK external clock input         0 = SOSC       0 = TiCK         bit 1       = Gated time accumulation is disabled         0 = Gated time accumulation is disabled       0 = Gated time accumulation is disabled         0 = 1:1       1 = 1:256       1 = 1:3	Levendu										
n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 TON: Timer1 On bit 1 = Starts 16-bit Timer1 0 = Stops 16-bit Timer1 1 = Discontinues module operation when device enters Idle mode 0 = Continues module operation when device enters Idle mode 0 = Continues module operation when device enters Idle mode 0 = Continues module operation when device enters Idle mode 0 = Continues module operation when device enters Idle mode 0 = Continues module operation under mode 0 = Stope C 0 = TICK external clock input 0 = SOSC 0 = TOK external clock input 0 = Gated time accumulation is enabled 0 = Gated time accumulation is disabled 0 = Gated time accumulation is disabled 0 = Gated time accumulation is disabled 0 = 1:1 1 = 1:256 1 0 = 1:64 0 = 1:1 1 = Sinchronizes the external clock input When TCS = 0: This bit is ignored. 0 = Does not synchronize the external clock input When TCS = 0: This bit is ignored. 0 = Internal clock (Fosc/2) bit 0 Unimplemented: Read as '0'	-	la hit		L:4		nented bit were					
bit 15 TON: Timer1 On bit 1 = Starts 16-bit Timer1 0 = Stops 16-bit Timer1 0 = Stops 16-bit Timer1 1 = Discontinues module operation when device enters Idle mode 0 = Continues module operation in Idle mode 1 = Discontinues module operation in Idle mode 0 = Continues module operation in Idle mode 1 = Continues module operation in Idle mode 1 = Continues module operation in Idle mode 1 = Continues module operation in Idle mode 0 = Continues module operation in Idle mode 1 = Continues module operation in Idle mode 1 = Continues module operation in Idle mode 0 = Continues module operation in Idle mode 1 = UPRC Oscillator 1 = UPRC Oscillator 1 = ICK external clock input 0 = SOSC 1 = TICK external clock input 0 = SOSC 1 = Gated time accumulation Enable bit When TCS = 1: This bit is ignored. When TCS = 0: 1 = Gated time accumulation is enabled 0 = Gated time accumulation is disabled 5 = Gated time accumulation is disabled 1 = 1:256 1 = 1:26 1 = 1:26 1 = 1:3 0 = 1:1 1 = Synchronizes the external clock Input 0 = Does not synchronize the external clock input 1 = Extended clock is selected by the timer 0 = Internal clock (Fosc/2) bit 0 Unimplemented: Read as '0' Dift 0 Unimp					•						
1 = Stars 16-bit Timer1         0 = Stops 16-bit Timer1         0 = Discontinues module operation when device enters Idle mode         0 = Continues module operation in Idle mode         0 = Contentime (TacK) external input         10 = LFRC Oscillator         0 = TICK external clock input         0 = SOSC         bit 7         Unimplemented: Read as '0'         vhen TCS = 0:         1 = Gated time accumulation is enabled         0 = Gated time accumulation is disabled         0 = Gated time accumulation is disabled         0 = 1:1         0 = 1:2         0 = 1:1         0 = 1:1         0 = 1:1         0 = Tick         1 = Synchronizes the external clock input         0 = Does not s	-n = Value a	t POR	1' = Bit is set		0' = Bit is cle	ared	x = Bit is unkr	IOWN			
0 = Stops 16-bit Timer1         0it 13       TSIDL: Timer1 Stop in Idle Mode bit         1 = Discontinues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = Continues module operation in Idle mode       0         0 = LCRC Oscillator       0         0 = LPRC Oscillator       0         0 = TICK external clock input       0         0 = SOSC       0         vit 7       Unimplemented: Read as '0'         This bit is ignored.       When TCS = 0:         1 = Gated time accumulation is enabled       0         0 = Gated time accumulation is disabled       1 = 1:266         10 = 1:64       0 = 1:1         0 = 1:1       1 = Synchronize the external clock Input Synchronization Select bit <t< td=""><td>bit 15</td><td>TON: Timer1</td><td>On bit</td><td></td><td></td><td></td><td></td><td></td></t<>	bit 15	TON: Timer1	On bit								
bit 14       Unimplemented: Read as '0'         bit 13       TSIDL: Timer1 Stop in Idle Mode bit         1 = Discontinues module operation when device enters Idle mode         0 = Continues module operation in Idle mode         0 = TiCK external clock input         0 = SOSC         0 = TICK external clock input         0 = SOSC         0 = TICK external clock input         0 = SOSC         1 = Gated time accumulation is enabled         0 = Gated time accumulation is disabled         0 = Gated time accumulation is disabled         0 = Gated time accumulation is disabled         1 = 1:266         0 = 1:1         0 = 1:1         0 = 1:1         0 = 1:1         0 = 1:1         1 = Synchroniz											
iii 13       TSIDL: Timer1 Stop in Idle Mode bit         1 = Discontinues module operation when device enters Idle mode         0 = Continues module operation in Idle mode         0 = totinues timer1 Extended Clock Source Select bits (selected when TCS = 1)         11 = Generic timer (TxCK) external input         0 = totinues timer1 Extended Clock Source Select bits (selected when TCS = 1)         0 = totinues timer1 External clock input         0 = totinues timer1 External clock input         0 = totinues accumulation is enabled         0 = totinue accumulation is enabled         0 = totinue accumulation is disabled         0 = totinues timer1 Input Clock Prescale Select bits         11 = 1:256         10 = 1:64         0 = 1:1         11 = Synchronizes the external clock input         0 = totin         11 = Synchronizes the external clock input         0 = totin         11 = Synchronizes the external clock input         0 = totin         1 = Synchronizes the external clock input </td <td></td> <td></td> <td></td> <td>o.'</td> <td></td> <td></td> <td></td> <td></td>				o.'							
1 = Discontinues module operation when device enters Idle mode 0 = Continues module operation in Idle mode0 = Continues module operation when device enters Idle mode 0 = Continues module operation in Idle mode0 = Continues module operation when device enters Idle mode 0 = Continues module operation in Idle mode0 = Continues module operation when device enters Idle mode 0 = Continues module operation when device enters Idle mode0 = Continues module operation when device enters Idle mode 0 = Continues module operation when device enters Idle mode0 = Continues module operation when device enters Idle mode0 = Content time (TxCK) external input 1 = Calcel time (TxCK) external input 0 = SOSC0 = TICK external clock input 0 = SOSC0 = SOSC0 = TICK external clock input 0 = SOSC0 = SOSC0 = TICK external clock input 0 = Gated time accumulation is enabled 0 = Gated time accumulation is disabled0 = Gated time accumulation is disabled0 = CKPS<1:0>: Timer1 Input Clock Prescale Select bits11 = 1:256 10 = 1:111 = Signohronizes the external clock input Synchronization Select bitWhen TCS = 1: 1 = Synchronizes the external clock input 0 = Does not synchronize the external clock input When TCS = 0: This bit is ignored.0 = Internal clock (Fosc/2)0 = Internal clock (Fosc/2)0 = Internal clock (Fosc/2)0 = Internal clock (Fosc/2)0 = Internal clock (Fosc/2)		-									
$0 = Continues module operation in Idle mode$ $0 = Continues module operation in Idle mode$ Unimplemented: Read as '0' if 9-8 $TECS<1:0: Timer1 Extended Clock Source Select bits (selected when TCS = 1) 11 = Generic timer (TxCK) external input 10 = LPRC Oscillator 01 = T1CK external clock input 00 = SOSC of T Unimplemented: Read as '0' of TGATE: Timer1 Gated Time Accumulation Enable bit \frac{When TCS = 1:}{This bit is ignored.} \frac{When TCS = 0:}{1 = Gated time accumulation is disabled} of t 1 1 = 1:256 10 = 1:64 10 = 1:64 10 = 1:64 10 = 1:64 10 = 1:64 10 = 1:18 10 = 1:18 10 = 1:11 11 11 12 13 14 15 15 14 15 15 15 15 15 15 15 15 15 15 15 15 15 $	bit 13		•								
bit 9-8       TECS-(1:0): Timer1 Extended Clock Source Select bits (selected when TCS = 1)         11 = Generic timer (TxCK) external input       10 = LPRC Oscillator         01 = T1CK external clock input       00 = SOSC         bit 7       Unimplemented: Read as '0'         bit 6       TGATE: Timer1 Gated Time Accumulation Enable bit         When TCS = 1:       This bit is ignored.         When TCS = 0:       1 = Gated time accumulation is enabled         0 = Gated time accumulation is disabled       0 = Gated time accumulation is disabled         bit 5-4       TCKPS         11 = 1:256       1 = 1:256         10 = 1:64       1 = 1:26         11 = 1:256       0 = 1:1         12 if X = XPNC: Timer1 External Clock Input Synchronization Select bits         13 Unimplemented: Read as '0'       Xhen TCS = 1:         1 = Synchronizes the external clock input       0 = Does not synchronize the external clock input         0 = Does not synchronize the external clock input       When TCS = 0:         This bit is ignored.       This bit is ignored.         bit 1       TCS: Timer1 Clock Source Select bit         1 = Extended clock is selected by the timer       0 = Internal clock (Fosc/2)         bit 0       Unimplemented: Read as '0'						ale mode					
11 = Generic timer (TxCK) external input         10 = LPRC Oscillator         01 = T1CK external clock input         00 = SOSC         bit 7         Unimplemented: Read as '0'         bit 6         TGATE: Timer1 Gated Time Accumulation Enable bit         When TCS = 1:         This bit is ignored.         When TCS = 0:         1 = Gated time accumulation is enabled         0 = Gated time accumulation is disabled         bit 5-4         TCKPS         11 = 1:256         10 = 1:8         00 = 1:1         bit 3         Unimplemented: Read as '0'         bit 4         TSYNC: Timer1 External Clock Input Synchronization Select bit         When TCS = 1:         1 = Synchronizes the external clock input         0 = Does not synchronize the external clock input         0 = Does not synchronize the external clock input         0 = Does not synchronize the external clock input         0 = Does not synchronize the external clock input         0 = Does not synchronize the external clock input         0 = Does not synchronize the external clock input         0 = Does not synchronize the external clock input         0 = Internal clock (Fosc/2)         Dit 1       TCS: Tim	bit 12-10	Unimplemen	ted: Read as '	0'							
10 = LPRC Oscillator 01 = T1CK external clock input 00 = SOSC Dif 7 Unimplemented: Read as '0' TGATE: Timer1 Gated Time Accumulation Enable bit When TCS = 1: This bit is ignored. When TCS = 0: 1 = Gated time accumulation is enabled 0 = Gated time accumulation is disabled Dif 5-4 TCKPS<1:0>: Timer1 Input Clock Prescale Select bits 11 = 1:256 10 = 1:64 01 = 1:8 00 = 1:1 Dif 3 Unimplemented: Read as '0' Dif 2 TSYNC: Timer1 External Clock Input Synchronization Select bit When TCS = 1: 1 = Synchronizes the external clock input 0 = Does not synchronize the external clock input When TCS = 0: This bit is ignored. Dif 1 TCS: Timer1 Clock Source Select bit 1 = Extended clock is selected by the timer 0 = Internal clock (FOSC/2) Dif 0 Unimplemented: Read as '0'	bit 9-8	TECS<1:0>:	Timer1 Extend	ed Clock Sourc	e Select bits (s	selected when	TCS = 1)				
$01 = T1CK$ external clock input $00 = SOSC$ oit 7Unimplemented: Read as '0'oit 6TGATE: Timer1 Gated Time Accumulation Enable bit $\frac{When TCS = 1:}{This bit is ignored.}$ $\frac{When TCS = 0:}{1 = Gated time accumulation is enabled0 = Gated time accumulation is disabledoit 5-4TCKPS<1:0>: Timer1 Input Clock Prescale Select bits11 = 1:25610 = 1:6401 = 1:800 = 1:1oit 3Unimplemented: Read as '0'oit 4TSYNC: Timer1 External Clock Input Synchronization Select bit\frac{When TCS = 0:}{This bit is ignored.}oit 1TCS: Timer1 Clock Source Select bit1 = Extended clock is selected by the timer0 = Internal clock (FOSC/2)oit 0Unimplemented: Read as '0'$		11 = Generic timer (TxCK) external input									
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$\begin{array}{llllllllllllllllllllllllllllllllllll$											
bit 3       Unimplemented: Read as '0'         bit 2       TSYNC: Timer1 External Clock Input Synchronization Select bit         When TCS = 1:       1 = Synchronizes the external clock input         0 = Does not synchronize the external clock input       0 = Does not synchronize the external clock input         When TCS = 0:       This bit is ignored.         This bit is ignored.       TCS: Timer1 Clock Source Select bit         1 = Extended clock is selected by the timer       0 = Internal clock (Fosc/2)         bit 0       Unimplemented: Read as '0'											
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<ul> <li>0 = Does not synchronize the external clock input When TCS = 0: This bit is ignored.     </li> <li>Dit 1 TCS: Timer1 Clock Source Select bit 1 = Extended clock is selected by the timer 0 = Internal clock (Fosc/2)     </li> <li>Dit 0 Unimplemented: Read as '0'</li> </ul>											
When TCS = 0:         This bit is ignored.         Dit 1         TCS: Timer1 Clock Source Select bit         1 = Extended clock is selected by the timer         0 = Internal clock (Fosc/2)         Dit 0         Unimplemented: Read as '0'					k input						
This bit is ignored.         bit 1         TCS: Timer1 Clock Source Select bit         1 = Extended clock is selected by the timer         0 = Internal clock (Fosc/2)         bit 0         Unimplemented: Read as '0'			-		k input						
1 = Extended clock is selected by the timer 0 = Internal clock (Fosc/2)Dit 0Unimplemented: Read as '0'											
0 = Internal clock (Fosc/2)bit 0Unimplemented: Read as '0'	bit 1	TCS: Timer1	Clock Source	Select bit							
Dit 0 Unimplemented: Read as '0'				ed by the timer							
			· /								
<b>Note 1:</b> Changing the value of T1CON while the timer is running (TON = 1) causes the timer prescale counter to	bit 0	Unimplemen	ted: Read as '	0'							
	Note 1: C	hanging the val	ue of T1CON v	hile the timer is	s running (TON	√ = 1) causes th	ne timer presca	le counter to			

# REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER<sup>(1)</sup>

# 13.0 TIMER2/3

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"Timers"** (DS39704), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Timer2/3 module is a 32-bit timer, which can also be configured as independent, 16-bit timers with selectable operating modes.

As a 32-bit timer, Timer2/3 can operate in three modes:

- Two Independent 16-Bit Timers with All 16-Bit Operating modes (except Asynchronous Counter mode)
- Single 32-Bit Timer
- Single 32-Bit Synchronous Counter

They also support these features:

- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation during Idle and Sleep modes
- Interrupt on a 32-Bit Period Register Match
- A/D Event Trigger (on Timer2/3 in 32-bit mode and Timer3 in 16-bit mode)

Individually, all of the 16-bit timers can function as synchronous timers or counters. They also offer the features listed above, except for the A/D event trigger. This trigger is implemented only on Timer2/3 in 32-bit mode and Timer3 in 16-bit mode. The operating modes and enabled features are determined by setting the appropriate bit(s) in the T2CON and T3CON registers. T2CON is shown in generic form in Register 13-1; T3CON is shown in Register 13-2.

For 32-bit timer/counter operation, Timer2 is the least significant word; Timer3 is the most significant word of the 32-bit timer.

Note: For 32-bit operation, T3CON control bits are ignored. Only T2CON control bits are used for setup and control. Timer2 clock and gate inputs are utilized for the 32-bit timer modules, but an interrupt is generated with the Timer3 interrupt flags. To configure Timer2/3 for 32-bit operation:

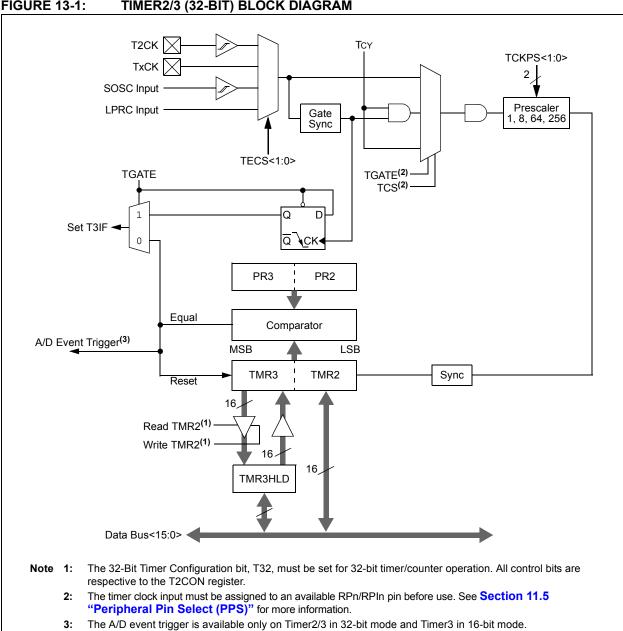
- 1. Set the T32 bit (T2CON<3> = 1).
- 2. Select the prescaler ratio for Timer2 using the TCKPS<1:0> bits.
- Set the Clock and Gating modes using the TCS and TGATE bits. If TCS is set to an external clock, RPINRx (TyCK) must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".
- Load the timer period value. PR3 will contain the most significant word (msw) of the value, while PR2 contains the least significant word (lsw).
- 5. If interrupts are required, set the interrupt enable bit, T3IE. Use the priority bits, T3IP<2:0>, to set the interrupt priority. Note that while Timer2 controls the timer, the interrupt appears as a Timer3 interrupt.
- 6. Set the TON bit (= 1).

The timer value, at any point, is stored in the register pair, TMR<3:2>. TMR3 always contains the most significant word of the count, while TMR2 contains the least significant word.

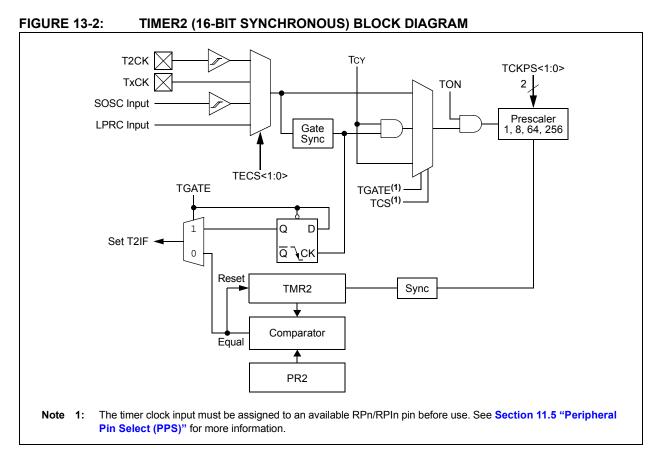
To configure any of the timers for individual 16-bit operation:

- 1. Clear the T32 bit (T2CON<3>).
- 2. Select the timer prescaler ratio using the TCKPS<1:0> bits.
- 3. Set the Clock and Gating modes using the TCS and TGATE bits. See **Section 11.5 "Peripheral Pin Select (PPS)"** for more information.
- 4. Load the timer period value into the PRx register.
- 5. If interrupts are required, set the interrupt enable bit, TxIE. Use the priority bits, TxIP<2:0>, to set the interrupt priority.
- 6. Set the TON (TxCON<15> = 1) bit.

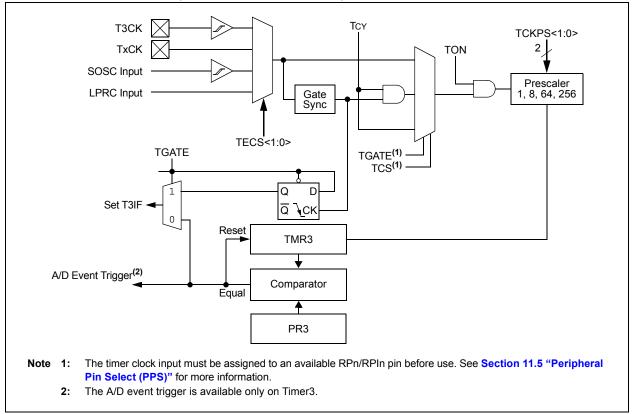
# PIC24FJ256GA705 FAMILY



#### FIGURE 13-1: TIMER2/3 (32-BIT) BLOCK DIAGRAM







R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0				
TON		TSIDL			—	TECS1 <sup>(2)</sup>	TECS0 <sup>(2)</sup>				
bit 15							bit				
U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0				
	TGATE	TCKPS1	TCKPS0	T32 <sup>(3)</sup>	_	TCS <sup>(2)</sup>	_				
bit 7	TOALE			102		100	bit				
Legend:											
R = Readal	ole bit	W = Writable	bit	U = Unimplem	nented bit rea	ad as '0'					
-n = Value a		'1' = Bit is set		'0' = Bit is clea	•	x = Bit is unkn	own				
					areu		IOWIT				
bit 15	TON: Timerx	On bit									
	When TxCO										
	1 = Starts 32	•									
	0 = Stops 32	-									
	When TxCO										
	1 = Starts 16 0 = Stops 16										
bit 14	-	nted: Read as '	0'								
bit 13	-	rx Stop in Idle N									
		ues module op		evice enters Idl	e mode						
		s module opera									
bit 12-10	Unimplemer	nted: Read as '	0'								
bit 9-8	<b>TECS&lt;1:0&gt;:</b> Timerx Extended Clock Source Select bits (selected when TCS = 1) <sup>(2)</sup>										
	When TCS =										
		timer (TxCK) e	external input								
	10 = LPRCC		Suit								
	01 = TyCK external clock input 00 = SOSC										
	When TCS = 0:										
		e ignored; the t	imer is clocked	from the intern	al system clo	ck (Fosc/2).					
bit 7	Unimplemer	nted: Read as '	0'								
bit 6	TGATE: Time	erx Gated Time	Accumulation	Enable bit							
		When TCS = 1:									
	This bit is ign	ored.									
	When TCS =										
		ne accumulation ne accumulation									
L:+ C 4				Colocthite							
bit 5-4		: Timerx Input	CIOCK Prescale	Select bits							
	11 = 1:256 10 = 1:64										
	01 = 1:8										
	00 = 1:1										
	Changing the val		hile the timer is	s running (TON	= 1) causes	the timer presca	le counter to				
	reset and is not r				, . <u> </u>		-				
	If TCS = 1 and T an available RPn										
	n 22 hit mada ti				-		1 ( A )				

# REGISTER 13-1: TxCON: TIMER2 CONTROL REGISTER<sup>(1)</sup>

**3:** In 32-bit mode, the T3CON control bits do not affect 32-bit timer operation.

# **REGISTER 13-1:** TxCON: TIMER2 CONTROL REGISTER<sup>(1)</sup> (CONTINUED)

- bit 3 **T32:** 32-Bit Timer Mode Select bit<sup>(3)</sup>
  - 1 = Timerx and Timery form a single 32-bit timer
     0 = Timerx and Timery act as two 16-bit timers
    - In 32-bit mode, T3CON control bits do not affect 32-bit timer operation.
- bit 2 Unimplemented: Read as '0'
- bit 1 **TCS:** Timerx Clock Source Select bit<sup>(2)</sup>
  - 1 = Timer source is selected by TECS<1:0>0 = Internal clock (Fosc/2)
- bit 0 Unimplemented: Read as '0'
- **Note 1:** Changing the value of TxCON while the timer is running (TON = 1) causes the timer prescale counter to reset and is not recommended.
  - 2: If TCS = 1 and TECS<1:0> = x1, the selected external timer input (TxCK or TyCK) must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".
  - 3: In 32-bit mode, the T3CON control bits do not affect 32-bit timer operation.

R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
TON <sup>(2)</sup>		TSIDL <sup>(2)</sup>	—	_		TECS1 <sup>(2,3)</sup>	TECS0 <sup>(2,3)</sup>
oit 15	·						bit 8
U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	U-0
	TGATE <sup>(2)</sup>	TCKPS1 <sup>(2)</sup>	TCKPS0 <sup>(2)</sup>			TCS <sup>(2,3)</sup>	
bit 7	TOME		1010 00			100	bit (
Legend: R = Reada	able bit	W = Writable	hit	U = Unimplen	nented hit rea	ad as '0'	
-n = Value		'1' = Bit is set	JIL	'0' = Bit is clea		x = Bit is unkn	own
		1 - Dit 13 36t			areu		
bit 15	TON: Timery	On bit <sup>(2)</sup>					
	1 = Starts 16-						
	0 = Stops 16-	-					
bit 14	-	ted: Read as '					
bit 13		y Stop in Idle M ues module ope		ovice entern Id	lo modo		
		s module opera					
bit 12-10	Unimplemen	ted: Read as 'd	)'				
bit 9-8	TECS<1:0>:	Timery Extende	ed Clock Sourc	e Select bits (s	elected when	TCS = 1) <sup>(2,3)</sup>	
		timer (TxCK) e	xternal input				
	10 = LPRC O 01 = TvCK ex	scillator	out				
	00 = SOSC						
bit 7	Unimplemen	ted: Read as 'o	)'				
bit 6	TGATE: Time	ery Gated Time	Accumulation	Enable bit <sup>(2)</sup>			
	When TCS = This bit is igno						
	When TCS =						
		ne accumulatio	n is enabled				
		ne accumulatio					
bit 5-4		: Timery Input	Clock Prescale	Select bits <sup>(2)</sup>			
	11 = 1:256 10 = 1:64						
	01 = 1:8						
	00 = 1:1						
bit 3-2	-	ted: Read as 'o					
bit 1		Clock Source S					
	1 = External c 0 = Internal cl	clock from pin, <sup>-</sup> lock (Fosc/2)	IYCK (on the r	ising edge)			
bit 0		ted: Read as '	)'				
Note 1:	Changing the valu		ile the timer is	running (TON =	= 1) causes th	e timer prescale	counter to
2:	When 32-bit oper functions are set	through T2CON	۱.				
3:	If TCS = 1 and TE available RPn/RP						

# REGISTER 13-2: TyCON: TIMER3 CONTROL REGISTER<sup>(1)</sup>

# 14.0 INPUT CAPTURE WITH DEDICATED TIMERS

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Input Capture with Dedicated Timer" (DS70000352), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

Devices in the PIC24FJ256GA705 family contain three independent input capture modules. Each of the modules offers a wide range of configuration and operating options for capturing external pulse events and generating interrupts.

Key features of the input capture module include:

- Hardware-Configurable for 32-Bit Operation in All modes by Cascading Two Adjacent modules
- Synchronous and Trigger modes of Output Compare Operation with up to 31 User-Selectable Sync/Trigger Sources Available
- A 4-Level FIFO Buffer for Capturing and Holding Timer Values for Several Events
- Configurable Interrupt Generation
- Up to 6 Clock Sources Available for Each module, Driving a Separate Internal 16-Bit Counter

The module is controlled through two registers: ICxCON1 (Register 14-1) and ICxCON2 (Register 14-2). A general block diagram of the module is shown in Figure 14-1.

# 14.1 General Operating Modes

#### 14.1.1 SYNCHRONOUS AND TRIGGER MODES

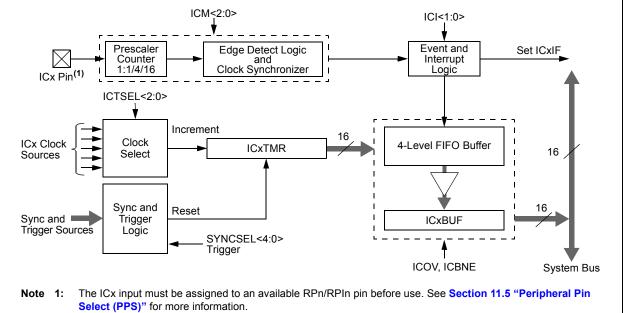
When the input capture module operates in a Free-Running mode, the internal 16-bit counter, ICxTMR, counts up continuously, wrapping around from FFFFh to 0000h on each overflow. Its period is synchronized to the selected external clock source. When a capture event occurs, the current 16-bit value of the internal counter is written to the FIFO buffer.

In Synchronous mode, the module begins capturing events on the ICx pin as soon as its selected clock source is enabled. Whenever an event occurs on the selected Sync source, the internal counter is reset. In Trigger mode, the module waits for a Sync event from another internal module to occur before allowing the internal counter to run.

Standard, free-running operation is selected by setting the SYNCSEL<4:0> bits (ICxCON2<4:0>) to '00000' and clearing the ICTRIG bit (ICxCON2<7>). Synchronous and Trigger modes are selected any time the SYNCSELx bits are set to any value except '00000'. The ICTRIG bit selects either Synchronous or Trigger mode; setting the bit selects Trigger mode operation. In both modes, the SYNCSELx bits determine the Sync/ Trigger source.

When the SYNCSELx bits are set to '00000' and ICTRIG is set, the module operates in Software Trigger mode. In this case, capture operations are started by manually setting the TRIGSTAT bit (ICxCON2<6>).





# 14.1.2 CASCADED (32-BIT) MODE

By default, each module operates independently with its own 16-bit timer. To increase resolution, adjacent even and odd modules can be configured to function as a single 32-bit module. (For example, Modules 1 and 2 are paired, as are Modules 3 and 4, and so on.) The odd numbered module (ICx) provides the Least Significant 16 bits of the 32-bit register pairs and the even numbered module (ICy) provides the Most Significant 16 bits. Wrap-arounds of the ICx registers cause an increment of their corresponding ICy registers.

Cascaded operation is configured in hardware by setting the IC32 bits (ICxCON2<8>) for both modules.

# 14.2 Capture Operations

The input capture module can be configured to capture timer values and generate interrupts on rising edges on ICx or all transitions on ICx. Captures can be configured to occur on all rising edges or just some (every 4<sup>th</sup> or 16<sup>th</sup>). Interrupts can be independently configured to generate on each event or a subset of events.

To set up the module for capture operations:

- 1. Configure the ICx input for one of the available Peripheral Pin Select pins.
- 2. If Synchronous mode is to be used, disable the Sync source before proceeding.
- 3. Make sure that any previous data has been removed from the FIFO by reading ICxBUF until the ICBNE bit (ICxCON1<3>) is cleared.
- 4. Set the SYNCSELx bits (ICxCON2<4:0>) to the desired Sync/Trigger source.
- 5. Set the ICTSELx bits (ICxCON1<12:10>) for the desired clock source.
- 6. Set the ICIx bits (ICxCON1<6:5>) to the desired interrupt frequency.
- 7. Select Synchronous or Trigger mode operation:
  - a) Check that the SYNCSELx bits are not set to '00000'.
  - b) For Synchronous mode, clear the ICTRIG bit (ICxCON2<7>).
  - c) For Trigger mode, set ICTRIG and clear the TRIGSTAT bit (ICxCON2<6>).
- 8. Set the ICMx bits (ICxCON1<2:0>) to the desired operational mode.
- 9. Enable the selected Sync/Trigger source.

For 32-bit cascaded operations, the setup procedure is slightly different:

- 1. Set the IC32 bits for both modules (ICyCON2<8> and ICxCON2<8>), enabling the even numbered module first. This ensures the modules will start functioning in unison.
- 2. Set the ICTSELx and SYNCSELx bits for both modules to select the same Sync/Trigger and time base source. Set the even module first, then the odd module. Both modules must use the same ICTSELx and SYNCSELx bits settings.
- Clear the ICTRIG bit of the even module (ICyCON2<7>). This forces the module to run in Synchronous mode with the odd module, regardless of its Trigger mode setting.
- 4. Use the odd module's ICIx bits (ICxCON1<6:5>) to set the desired interrupt frequency.
- Use the ICTRIG bit of the odd module (ICxCON2<7>) to configure Trigger or Synchronous mode operation.
- Note: For Synchronous mode operation, enable the Sync source as the last step. Both input capture modules are held in Reset until the Sync source is enabled.
- Use the ICMx bits of the odd module (ICxCON1<2:0>) to set the desired Capture mode.

The module is ready to capture events when the time base and the Sync/Trigger source are enabled. When the ICBNE bit (ICxCON1<3>) becomes set, at least one capture value is available in the FIFO. Read input capture values from the FIFO until the ICBNE clears to '0'.

For 32-bit operation, read both the ICxBUF and ICyBUF for the full 32-bit timer value (ICxBUF for the Isw, ICyBUF for the msw). At least one capture value is available in the FIFO buffer when the odd module's ICBNE bit (ICxCON1<3>) becomes set. Continue to read the buffer registers until ICBNE is cleared (performed automatically by hardware).

REGISTER 14-1: ICXCON1: INPUT CAPTURE X CONTROL REGISTER 1	REGISTER 14-1:	ICxCON1: INPUT CAPTURE x CONTROL REGISTER 1
--	----------------	---

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
_		ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0		
oit 15							bit 8
U-0	R/W-0	R/W-0	R-0, HSC	R-0, HSC	R/W-0	R/W-0	R/W-0
_	ICI1	ICIO	ICOV	ICBNE	ICM2 <sup>(1)</sup>	ICM1 <sup>(1)</sup>	ICM0 <sup>(1)</sup>
oit 7		1010	1001	IODITE	101112	101111	bit (
Legend:		HSC = Hardy	vare Settable/C	learable hit			
R = Readat	alo hit	W = Writable			montod bit road		
				-	mented bit, read		
-n = Value a	at POR	'1' = Bit is set	[	'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 15-14	Unimplemer	nted: Read as '	0'				
bit 13	ICSIDL: Inpu	it Capture x Sto	p in Idle Contro	ol bit			
			CPU Idle mode es to operate in		le		
bit 12-10			e x Timer Selec		-		
511 12 10		m clock (Fosc/2					
	110 <b>= Reser</b>		-)				
	101 <b>= Rese</b> r	ved					
	100 <b>= Timer</b>	-					
	011 = Reser						
	010 = Reser 001 = Timer2						
	001 - Timer						
bit 9-7	Unimplemer	nted: Read as '	0'				
bit 6-5	ICI<1:0>: Inp	out Capture x S	elect Number o	f Captures per	Interrupt bits		
	11 = Interrup	t on every four	th capture even	t			
		t on every third					
			ond capture eve	ent			
	•	ot on every capt					
bit 4	-	-	flow Status Flag	g bit (read-only	')		
			w has occurred rflow has occur	red			
bit 3	ICBNE: Inpu	t Capture x Buf	fer Not Empty S	Status bit (read	-only)		
				least one more	e capture value	can be read	
	-	pture x buffer is					
bit 2-0	ICM<2:0>: Ir	nput Capture x	Mode Select bit	s <sup>(1)</sup>			
					errupt pin only v I bits are not ap		e is in Sleep o
		ed (module is d		41-			
			ode: Capture o				
			ode: Capture o e: Capture on e				
			e: Capture on e				
					dge (rising and	falling): ICI<1:	0> bits do no
			eration for this r				2 2.13 GO IN
			ule is turned off				
Note 1.	The ICx input mu	ist also he conf	iqured to an av	ailahle RDn/DE	Pln nin For mo	re information	500

Note 1: The ICx input must also be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".

# REGISTER 14-2: ICxCON2: INPUT CAPTURE x CONTROL REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	_	IC32
bit 15							bit 8

R/W-0	R/W-0, HS	U-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-1
ICTRIG	TRIGSTAT	—	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0
bit 7							bit 0

Legend:	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	1 as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-9	Unimplemented: Read as '0'
bit 8	IC32: Cascade Two Input Capture Modules Enable bit (32-bit operation)
	<ul> <li>1 = ICx and ICy operate in cascade as a 32-bit module (this bit must be set in both modules)</li> <li>0 = ICx functions independently as a 16-bit module</li> </ul>
bit 7	ICTRIG: Input Capture x Sync/Trigger Select bit
	<ul> <li>1 = Triggers ICx from the source designated by the SYNCSELx bits</li> <li>0 = Synchronizes ICx with the source designated by the SYNCSELx bits</li> </ul>
bit 6	TRIGSTAT: Timer Trigger Status bit
	<ul> <li>1 = Timer source has been triggered and is running (set in hardware, can be set in software)</li> <li>0 = Timer source has not been triggered and is being held clear</li> </ul>
bit 5	Unimplemented: Read as '0'

- **Note 1:** Use these inputs as Trigger sources only and never as Sync sources.
  - 2: Never use an Input Capture x module as its own Trigger source by selecting this mode.

#### REGISTER 14-2: ICxCON2: INPUT CAPTURE x CONTROL REGISTER 2 (CONTINUED)

- bit 4-0 SYNCSEL<4:0>: Synchronization/Trigger Source Selection bits
  - 11111 = Not used 11110 = Not used 11101 = Not used 11100 = CTMU trigger<sup>(1)</sup> 11011 = A/D interrupt<sup>(1)</sup> 11010 = CMP3 trigger<sup>(1)</sup> 11001 = CMP2 trigger<sup>(1)</sup>  $11000 = CMP1 trigger^{(1)}$ 10111 = Not used 10110 = MCCP4 IC/OC interrupt 10101 = MCCP3 IC/OC interrupt 10100 = MCCP2 IC/OC interrupt 10011 = MCCP1 IC/OC interrupt  $10010 = IC3 interrupt^{(2)}$ 10001 = IC2 interrupt<sup>(2)</sup> 10000 = IC1 interrupt<sup>(2)</sup> 01111 = Not used 01110 = Not used 01101 = Timer3 match event 01100 = Timer2 match event 01011 = Timer1 match event 01010 = Not used 01001 = Not used 01000 = Not used 00111 = MCCP4 Sync/Trigger out 00110 = MCCP3 Sync/Trigger out 00101 = MCCP2 Sync/Trigger out
  - 00100 = MCCP1 Sync/Trigger out
  - 00011 = OC3 Sync/Trigger out
  - 00010 = OC2 Sync/Trigger out
  - 00001 = OC1 Sync/Trigger out
  - 00000 = Off
- Note 1: Use these inputs as Trigger sources only and never as Sync sources.
  - 2: Never use an Input Capture x module as its own Trigger source by selecting this mode.

NOTES:

# 15.0 OUTPUT COMPARE WITH DEDICATED TIMERS

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Output Compare with Dedicated Timer" (DS70005159), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

All devices in the PIC24FJ256GA705 family feature three independent output compare modules. Each of these modules offers a wide range of configuration and operating options for generating pulse trains on internal device events, and can produce Pulse-Width Modulated (PWM) waveforms for driving power applications.

Key features of the output compare module include:

- Hardware-Configurable for 32-Bit Operation in All modes by Cascading Two Adjacent modules
- Synchronous and Trigger modes of Output Compare Operation with up to 31 User-Selectable Sync/Trigger Sources Available
- Two Separate Period registers (a main register, OCxR, and a secondary register, OCxRS) for Greater Flexibility in Generating Pulses of Varying Widths
- Configurable for Single Pulse or Continuous Pulse Generation on an Output Event, or Continuous PWM Waveform Generation
- Up to 6 Clock Sources Available for Each module, Driving a Separate Internal 16-Bit Counter

# 15.1 General Operating Modes

### 15.1.1 SYNCHRONOUS AND TRIGGER MODES

When the output compare module operates in a Free-Running mode, the internal 16-bit counter, OCxTMR, runs counts up continuously, wrapping around from 0xFFFF to 0x0000 on each overflow. Its period is synchronized to the selected external clock source. Compare or PWM events are generated each time a match between the internal counter and one of the Period registers occurs.

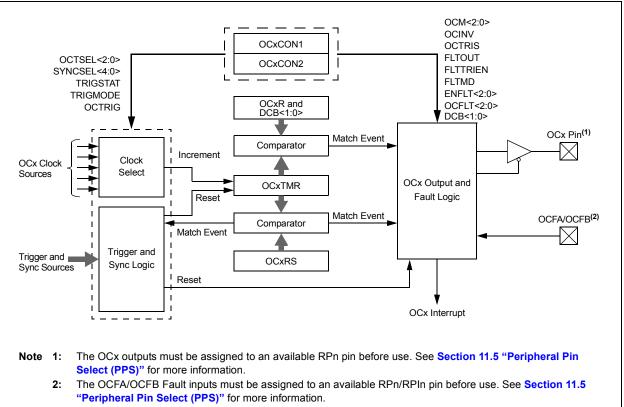
In Synchronous mode, the module begins performing its compare or PWM operation as soon as its selected clock source is enabled. Whenever an event occurs on the selected Sync source, the module's internal counter is reset. In Trigger mode, the module waits for a Sync event from another internal module to occur before allowing the counter to run.

Free-Running mode is selected by default or any time that the SYNCSEL<4:0> bits (OCxCON2<4:0>) are set to '00000'. Synchronous or Trigger modes are selected any time the SYNCSELx bits are set to any value except '00000'. The OCTRIG bit (OCxCON2<7>) selects either Synchronous or Trigger mode; setting the bit selects Trigger mode operation. In both modes, the SYNCSELx bits determine the Sync/Trigger source.

# 15.1.2 CASCADED (32-BIT) MODE

By default, each module operates independently with its own set of 16-Bit Timer and Duty Cycle registers. To increase resolution, adjacent even and odd modules can be configured to function as a single 32-bit module. (For example, Modules 1 and 2 are paired, as are Modules 3 and 4, and so on.) The odd numbered module (OCx) provides the Least Significant 16 bits of the 32-bit register pairs and the even numbered module (OCy) provides the Most Significant 16 bits. Wrap-arounds of the OCx registers cause an increment of their corresponding OCy registers.

Cascaded operation is configured in hardware by setting the OC32 bit (OCxCON2<8>) for both modules. For more details on cascading, refer to the "*dsPIC33*/ *PIC24 Family Reference Manual*", "**Output Compare with Dedicated Timer**" (DS70005159).



## FIGURE 15-1: OUTPUT COMPARE x BLOCK DIAGRAM (16-BIT MODE)

# 15.2 Compare Operations

In Compare mode (Figure 15-1), the output compare module can be configured for Single-Shot or Continuous mode pulse generation. It can also repeatedly toggle an output pin on each timer event.

To set up the module for compare operations:

- 1. Configure the OCx output for one of the available Peripheral Pin Select pins if available on the OCx module you are using. Otherwise, configure the dedicated OCx output pins.
- Calculate the required values for the OCxR and (for Double Compare modes) OCxRS Duty Cycle registers:
  - a) Determine the instruction clock cycle time. Take into account the frequency of the external clock to the timer source (if one is used) and the timer prescaler settings.
  - b) Calculate the time to the rising edge of the output pulse relative to the timer start value (0000h).
  - c) Calculate the time to the falling edge of the pulse based on the desired pulse width and the time to the rising edge of the pulse.

- 3. Write the rising edge value to OCxR and the falling edge value to OCxRS.
- 4. Set the Timer Period register, PRy, to a value equal to or greater than the value in OCxRS.
- 5. Set the OCM<2:0> bits for the appropriate compare operation (= 0xx).
- For Trigger mode operations, set OCTRIG to enable Trigger mode. Set or clear TRIGMODE to configure Trigger mode operation and TRIGSTAT to select a hardware or software trigger. For Synchronous mode, clear OCTRIG.
- Set the SYNCSEL<4:0> bits to configure the Trigger or Sync source. If free-running timer operation is required, set the SYNCSELx bits to '00000' (no Sync/Trigger source).
- Select the time base source with the OCTSEL<2:0> bits. If necessary, set the TON bit for the selected timer, which enables the compare time base to count. Synchronous mode operation starts as soon as the time base is enabled; Trigger mode operation starts after a Trigger source event occurs.

For 32-bit cascaded operation, these steps are also necessary:

- Set the OC32 bits for both registers (OCyCON2<8> and OCxCON2<8>). Enable the even numbered module first to ensure the modules will start functioning in unison.
- Clear the OCTRIG bit of the even module (OCyCON2<7>), so the module will run in Synchronous mode.
- 3. Configure the desired output and Fault settings for OCy.
- 4. Force the output pin for OCx to the output state by clearing the OCTRIS bit.
- If Trigger mode operation is required, configure the Trigger options in OCx by using the OCTRIG (OCxCON2<7>), TRIGMODE (OCxCON1<3>) and SYNCSEL<4:0> (OCxCON2<4:0>) bits.
- Configure the desired Compare or PWM mode of operation (OCM<2:0>) for OCy first, then for OCx.

Depending on the output mode selected, the module holds the OCx pin in its default state and forces a transition to the opposite state when OCxR matches the timer. In Double Compare modes, OCx is forced back to its default state when a match with OCxRS occurs. The OCxIF interrupt flag is set after an OCxR match in Single Compare modes and after each OCxRS match in Double Compare modes.

Single-Shot pulse events only occur once, but may be repeated by simply rewriting the value of the OCxCON1 register. Continuous pulse events continue indefinitely until terminated.

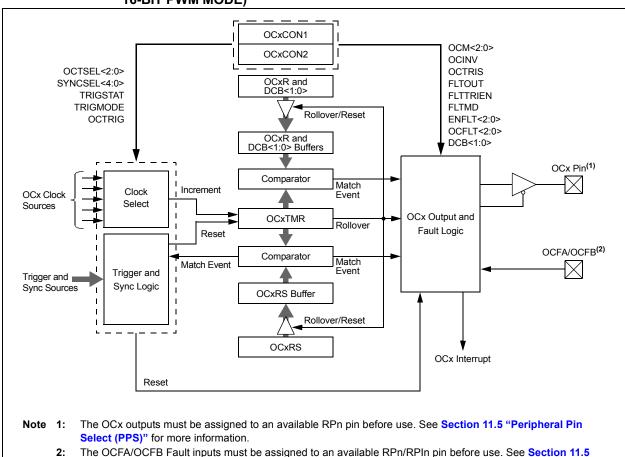
# 15.3 Pulse-Width Modulation (PWM) Mode

In PWM mode, the output compare module can be configured for edge-aligned or center-aligned pulse waveform generation. All PWM operations are doublebuffered (buffer registers are internal to the module and are not mapped into SFR space).

To configure the output compare module for PWM operation:

- 1. Configure the OCx output for one of the available Peripheral Pin Select pins if available on the OC module you are using. Otherwise, configure the dedicated OCx output pins.
- 2. Calculate the desired duty cycles and load them into the OCxR register.
- 3. Calculate the desired period and load it into the OCxRS register.
- Select the current OCx as the synchronization source by writing '0x1F' to the SYNCSEL<4:0> bits (OCxCON2<4:0>) and '0' to the OCTRIG bit (OCxCON2<7>).
- 5. Select a clock source by writing to the OCTSEL<2:0> bits (OCxCON1<12:10>).
- 6. Enable interrupts, if required, for the timer and output compare modules. The output compare interrupt is required for PWM Fault pin utilization.
- Select the desired PWM mode in the OCM<2:0> bits (OCxCON1<2:0>).
- Appropriate Fault inputs may be enabled by using the ENFLT<2:0> bits as described in Register 15-1.
- 9. If a timer is selected as a clock source, set the selected timer prescale value. The selected timer's prescaler output is used as the clock input for the OCx timer and not the selected timer output.

Note: This peripheral contains input and output functions that may need to be configured by the Peripheral Pin Select. See Section 11.5 "Peripheral Pin Select (PPS)" for more information.



#### **FIGURE 15-2:** OUTPUT COMPARE x BLOCK DIAGRAM (DOUBLE-BUFFERED, 16-BIT PWM MODE)

The OCFA/OCFB Fault inputs must be assigned to an available RPn/RPIn pin before use. See Section 11.5 "Peripheral Pin Select (PPS)" for more information.

#### **PWM PERIOD** 15.3.1

The PWM period is specified by writing to PRy, the Timer Period register. The PWM period can be calculated using Equation 15-1.

#### EQUATION 15-1: CALCULATING THE PWM PERIOD<sup>(1)</sup>

PWM Period =  $[(PRy) + 1 \bullet TCY \bullet (Timer Prescale Value)$ 

Where: PWM Frequency = 1/[PWM Period]

Note 1: Based on TCY = TOSC \* 2; Doze mode and PLL are disabled.

Note: A PRy value of N will produce a PWM period of N + 1 time base count cycles. For example, a value of 7, written into the PRy register, will yield a period consisting of 8 time base cycles.

# 15.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the OCxRS and OCxR registers. The OCxRS and OCxR registers can be written to at any time, but the duty cycle value is not latched until a match between PRy and TMRy occurs (i.e., the period is complete). This provides a double buffer for the PWM duty cycle and is essential for glitchless PWM operation.

Some important boundary parameters of the PWM duty cycle include:

- If OCxR, OCxRS and PRy are all loaded with 0000h, the OCx pin will remain low (0% duty cycle).
- If OCxRS is greater than PRy, the pin will remain high (100% duty cycle).

See Example 15-1 for PWM mode timing details. Table 15-1 and Table 15-2 show example PWM frequencies and resolutions for a device operating at 4 MIPS and 10 MIPS, respectively.

# EQUATION 15-2: CALCULATION FOR MAXIMUM PWM RESOLUTION<sup>(1)</sup>

Maximum PWM Resolution (bits) =  $\frac{\log_{10} \left( \frac{F_{CY}}{F_{PWM} \bullet (T_{imer} Prescale Value)} \right)}{\log_{10} (2)}$  bits

Note 1: Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

# EXAMPLE 15-1: PWM PERIOD AND DUTY CYCLE CALCULATIONS<sup>(1)</sup>

- Find the Timer Period register value for a desired PWM frequency of 52.08 kHz, where Fosc = 32 MHz with PLL (32 MHz device clock rate) and a Timer2 prescaler setting of 1:1.
   TCY = 2 Tosc = 62.5 ns
   PWM Period = 1/PWM Frequency = 1/52.08 kHz = 19.2 μS
   PWM Period = (PR2 + 1) TCY (Timer2 Prescale Value)
   19.2 μS = (PR2 + 1) 62.5 ns 1
   PR2 = 306

   Find the maximum resolution of the duty cycle that can be used with a 52.08 kHz frequency and a 32 MHz device clock rate:
   PWM Resolution = log<sub>10</sub>(FCY/FPWM)/log<sub>10</sub>2) bits
   = (log<sub>10</sub>(16 MHz/52.08 kHz)/log<sub>10</sub>2) bits
   = 8.3 bits
- **Note 1:** Based on TCY = 2 \* TOSC; Doze mode and PLL are disabled.

TABLE 15-1:	EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 4 MIPS (Fcy = 4 MHz) <sup>(1)</sup>

PWM Frequency	7.6 Hz	61 Hz	122 Hz	977 Hz	3.9 kHz	31.3 kHz	125 kHz
Timer Prescaler Ratio	8	1	1	1	1	1	1
Period Register Value	FFFFh	FFFFh	7FFFh	0FFFh	03FFh	007Fh	001Fh
Resolution (bits)	16	16	15	12	10	7	5

Note 1: Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

#### TABLE 15-2: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 16 MIPS (Fcy = 16 MHz)<sup>(1)</sup>

PWM Frequency	30.5 Hz	244 Hz	488 Hz	3.9 kHz	15.6 kHz	125 kHz	500 kHz
Timer Prescaler Ratio	8	1	1	1	1	1	1
Period Register Value	FFFFh	FFFFh	7FFFh	0FFFh	03FFh	007Fh	001Fh
Resolution (bits)	16	16	15	12	10	7	5

**Note 1:** Based on FCY = FOSC/2; Doze mode and PLL are disabled.

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U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	ENFLT2 <sup>(2)</sup>	ENFLT1 <sup>(2)</sup>
bit 15							bit 8
R/W-0	R/W-0, HSC	R/W-0, HSC	R/W-0, HSC	R/W-0	R/W-0	R/W-0	R/W-0
ENFLT0 <sup>(2)</sup>	OCFLT2 <sup>(2,3)</sup>	OCFLT1 <sup>(2,4)</sup>	OCFLT0 <sup>(2,4)</sup>	TRIGMODE	OCM2 <sup>(1)</sup>	OCM1 <sup>(1)</sup>	OCM0 <sup>(1)</sup>
bit 7							bit C
Legend:			are Settable/C				
R = Readabl		W = Writable		-	ented bit, read		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15-14	Unimplomon	tod: Dood on "	<b>`</b>				
	-	ted: Read as '		ada Cantral hit			
bit 13		• •	Stop in Idle Mo				
				e in CPU Idle m	node		
bit 12-10	OCTSEL<2:0	>: Output Com	ipare x Timer S	elect bits			
	111 = Periphe	eral clock (Fcy	)				
	110 <b>= Reserv</b>						
	101 = Reserv		ochronous clos	k is supported)			
	011 = Unimpl		ICHIONOUS CIOC	k is supported)			
	010 = Unimpl						
	001 = Timer3						
	000 = Timer2		· · · · · (2)				
bit 9		It Input 2 Enab		a al (3)			
	$\perp$ = Fault 2 (C 0 = Fault 2 is		/3 out) is enabl	ea			
bit 8		It Input 1 Enab	le bit <sup>(2)</sup>				
		CFB pin) is er					
	0 = Fault 1 is						
bit 7	ENFLT0: Fau	lt Input 0 Enab	le bit <sup>(2)</sup>				
		DCFA pin) is er	nabled <sup>(4)</sup>				
	0 = Fault 0 is					or (23)	
bit 6				(Comparator 1/	2/3) Condition S	Status bit <sup>(2,3)</sup>	
	-	ult 2 has occur Fault 2 has oc					
bit 5				(OCFB pin) Co	ndition Status b	oit <sup>(2,4)</sup>	
		ult 1 has occur		(e e: _ p) ee.			
	0 = No PWM	Fault 1 has oc	curred				
bit 4	OCFLT0: PW	M Fault 0 (OCI	A pin) Conditio	on Status bit <sup>(2,4</sup>	)		
	-	ult 0 has occur					
	0 = No PWM	Fault 0 has oc	curred				
	he OCx output n Peripheral Pin \$		nfigured to an a	available RPn p	oin. For more in	formation, see	Section 11.5
<b>2</b> : T	he Fault input er	nable and Faul	t status bits are	valid when OC	CM<2:0> = 111	or 110.	
<b>3:</b> T	he Comparator		Is the OC1-OC	3 channels.			
4. T		The solution of the second	at all a la a sauf				

# REGISTER 15-1: OCxCON1: OUTPUT COMPARE x CONTROL REGISTER 1

4: The OCFA/OCFB Fault input must also be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".

## **REGISTER 15-1:** OCxCON1: OUTPUT COMPARE x CONTROL REGISTER 1 (CONTINUED)

- bit 3 TRIGMODE: Trigger Status Mode Select bit
  - 1 = TRIGSTAT (OCxCON2<6>) is cleared when OCxRS = OCxTMR or in software
  - 0 = TRIGSTAT is only cleared by software

bit 2-0 OCM<2:0>: Output Compare x Mode Select bits<sup>(1)</sup>

- 111 = Center-Aligned PWM mode on  $OCx^{(2)}$
- 110 = Edge-Aligned PWM mode on  $OCx^{(2)}$
- 101 = Double Compare Continuous Pulse mode: Initializes the OCx pin low; toggles the OCx state continuously on alternate matches of OCxR and OCxRS
- 100 = Double Compare Single-Shot mode: Initializes the OCx pin low; toggles the OCx state on matches of OCxR and OCxRS for one cycle
- 011 = Single Compare Continuous Pulse mode: Compare events continuously toggle the OCx pin
- 010 = Single Compare Single-Shot mode: Initializes OCx pin high; compare event forces the OCx pin low
- 001 = Single Compare Single-Shot mode: Initializes OCx pin low; compare event forces the OCx pin high
- 000 = Output compare channel is disabled
- Note 1: The OCx output must also be configured to an available RPn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".
  - 2: The Fault input enable and Fault status bits are valid when OCM<2:0> = 111 or 110.
  - 3: The Comparator 1 output controls the OC1-OC3 channels.
  - 4: The OCFA/OCFB Fault input must also be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
FLTMD	FLTOUT	FLTTRIEN	OCINV		DCB1 <sup>(3)</sup>	DCB0 <sup>(3)</sup>	OC32
bit 15							bit
R/W-0	R/W-0, HS	R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0
OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL
bit 7							bit
Legend:		HS = Hardwa	re Settable bit				
R = Readabl	le hit	W = Writable		U = Unimplen	nented bit, read	1 as '0'	
-n = Value at		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	
		1 - Dit 13 3et			areu		
bit 15	FLTMD: Fault	Mode Select	pit				
	1 = Fault mo	de is maintaine	d until the Fau	It source is ren	noved and the	corresponding	OCFLT0 bit
		n software					
			d until the Faul	It source is rem	noved and a ne	w PWM period	starts
bit 14	FLTOUT: Fau						
		put is driven hi	•				
bit 13		put is driven lo					
DIC 13		ault Output Sta	ite Select bit it on a Fault co	adition			
			fected by a Fault co				
bit 12	OCINV: OCM						
	1 = OCx outp	out is inverted					
	0 = OCx outp	out is not invert	ed				
bit 11	Unimplemen	ted: Read as '	כ'				
bit 10-9	DCB<1:0>: P	WM Duty Cycl	e Least Signific	ant bits <sup>(3)</sup>			
				nstruction cycle			
				nstruction cycle			
				nstruction cycle the instruction			
bit 8				pit (32-bit opera	-		
		module operat					
			ion is disabled				
bit 7	OCTRIG: OC	x Trigger/Sync	Select bit				
				ted by the SYN		ts	
bit 6	TRIGSTAT: T	imer Trigger St	atus bit				
			triggered and is	s running			
	0 = Timer sou	urce has not be	en triggered a	nd is being hele	d clear		
bit 5		-	irection Select	bit			
	1 = OCx pin is 0 = Output Co		eral x is connec	cted to an OCx	pin		
	ever use an Out nother equivaler			own Trigger sc	ource, either by	selecting this r	node or
	se these inputs		-	ever as Svnc s	sources		
2. 0		as mgger sou		over us cyric s			

# REGISTER 15-2: OCxCON2: OUTPUT COMPARE x CONTROL REGISTER 2

3: The DCB<1:0> bits are double-buffered in the PWM modes only (OCM<2:0> (OCxCON1<2:0>) = 111, 110).

#### REGISTER 15-2: OCxCON2: OUTPUT COMPARE x CONTROL REGISTER 2 (CONTINUED)

- bit 4-0 SYNCSEL<4:0>: Trigger/Synchronization Source Selection bits
  - 11111 = OCx Sync out<sup>(1)</sup> 11110 = OCTRIG1 pin 11101 = OCTRIG2 pin 11100 = CTMU trigger<sup>(2)</sup> 11011 = A/D interrupt<sup>(2)</sup> 11010 = CMP3 Trigger<sup>(2)</sup> 11001 = CMP2 Trigger<sup>(2)</sup> 11000 = CMP1 Trigger<sup>(2)</sup> 10111 = Not used 10110 = MCCP4 IC/OC interrupt 10101 = MCCP3 IC/OC interrupt 10100 = MCCP2 IC/OC interrupt 10011 = MCCP1 IC/OC interrupt  $10010 = IC3 interrupt^{(2)}$ 10001 = IC2 interrupt<sup>(2)</sup> 10000 = IC1 interrupt<sup>(2)</sup> 01111 = Not used 01110 = Not used 01101 = Timer3 match event 01100 = Timer2 match event (default) 01011 = Timer1 match event 01010 = Not used 01001 = Not used 01000 = Not used 00111 = MCCP4 Sync/Trigger out
  - 00110 = MCCP3 Sync/Trigger out
  - 00101 = MCCP2 Sync/Trigger out
  - 00100 = MCCP1 Sync/Trigger out
  - 00011 = Not used
  - 00010 = OC3 Sync/Trigger out<sup>(1)</sup>
  - 00001 = OC1 Sync/Trigger out<sup>(1)</sup>
  - 00000 = Off, Free-Running mode with no synchronization and rollover at FFFFh
- **Note 1:** Never use an Output Compare x module as its own Trigger source, either by selecting this mode or another equivalent SYNCSELx setting.
  - 2: Use these inputs as Trigger sources only and never as Sync sources.
  - 3: The DCB<1:0> bits are double-buffered in the PWM modes only (OCM<2:0> (OCxCON1<2:0>) = 111, 110).

NOTES:

# 16.0 CAPTURE/COMPARE/PWM/ TIMER MODULES (MCCP)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Capture/Compare/ PWM/Timer (MCCP and SCCP)" (DS33035), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

PIC24FJ256GA705 family devices include several Capture/Compare/PWM/Timer base modules, which provide the functionality of three different peripherals of earlier PIC24F devices. The module can operate in one of three major modes:

- · General Purpose Timer
- Input Capture
- Output Compare/PWM

This family of devices features 4 instances of the MCCP module. MCCP1 provides up to six outputs and an extended range of power control features, whereas MCCP2-MCCP4 support two outputs.

The MCCPx modules can be operated only in one of the three major modes at any time. The other modes are not available unless the module is reconfigured for the new mode. A conceptual block diagram for the module is shown in Figure 16-1. All three modules share a time base generator and a common Timer register pair (CCPxTMRH/L); other shared hardware components are added as a particular mode requires.

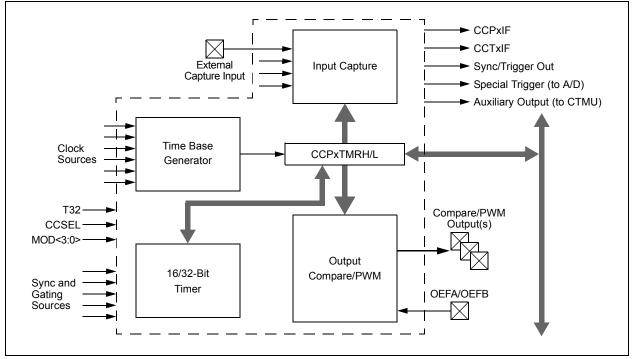
Each module has a total of 8 control and status registers:

- CCPxCON1L (Register 16-1)
- CCPxCON1H (Register 16-2)
- CCPxCON2L (Register 16-3)
- CCPxCON2H (Register 16-4)
- CCPxCON3L (Register 16-5)
- CCPxCON3H (Register 16-6)
- CCPxSTATL (Register 16-7)
- CCPxSTATH (Register 16-8)

Each module also includes 8 buffer/counter registers that serve as Timer Value registers or data holding buffers:

- CCPxTMRH/CCPxTMRL (Timer High/Low Counters)
- CCPxPRH/CCPxPRL (Timer Period High/Low)
- CCPxRAH/CCPxRAL (Primary Output Compare Data Buffer)
- CCPxRBH/CCPxRBL (Secondary Output Compare Data Buffer)
- CCPxBUFH/CCPxBUFL (Input Capture High/Low Buffers)

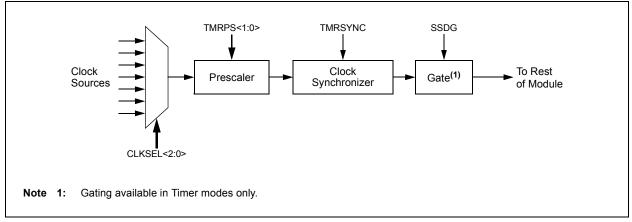
#### FIGURE 16-1: MCCPx CONCEPTUAL BLOCK DIAGRAM



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### 16.1 Time Base Generator

The Timer Clock Generator (TCG) generates a clock for the module's internal time base using one of the clock signals already available on the microcontroller. This is used as the time reference for the module in its three major modes. The internal time base is shown in Figure 16-2. There are eight inputs available to the clock generator, which are selected using the CLKSEL<2:0> bits (CCPxCON1L<10:8>). Available sources include the FRC and LPRC, the Secondary Oscillator and the TCLKI external clock inputs. The system clock is the default source (CLKSEL<2:0> = 000). On PIC24FJ256GA705 family devices, clock sources to the MCCPx module must be synchronized with the system clock. As a result, when clock sources are selected, clock input timing restrictions or module operating restrictions may exist.



### FIGURE 16-2: TIMER CLOCK GENERATOR

### 16.2 General Purpose Timer

Timer mode is selected when CCSEL = 0 and MOD<3:0> = 0000. The timer can function as a 32-bit timer or a dual 16-bit timer, depending on the setting of the T32 bit (Table 16-1).

T32 (CCPxCON1L<5>)	Operating Mode
0	Dual Timer Mode (16-bit)
1	Timer Mode (32-bit)

TABLE 16-1: TIMER OPERATION MODE

Dual 16-Bit Timer mode provides a simple timer function with two independent 16-bit timer/counters. The primary timer uses the CCPxTMRL and CCPxPRL registers. Only the primary timer can interact with other modules on the device. It generates the MCCPx Sync out signals for use by other MCCPx modules. It can also use the SYNC<4:0> bits signal generated by other modules.

The secondary timer uses the CCPxTMRH and CCPxPRH registers. It is intended to be used only as a periodic interrupt source for scheduling CPU events. It does not generate an output Sync/Trigger signal like the primary time base. In Dual Timer mode, the Timer Period High register, CCPxPRH, generates the MCCPx compare event (CCPxIF) used by many other modules on the device.

The 32-Bit Timer mode uses the CCPxTMRL and CCPxTMRH registers, together, as a single 32-bit timer. When CCPxTMRL overflows, CCPxTMRH increments

FIGURE 16-3: DUAL 16-BIT TIMER MODE

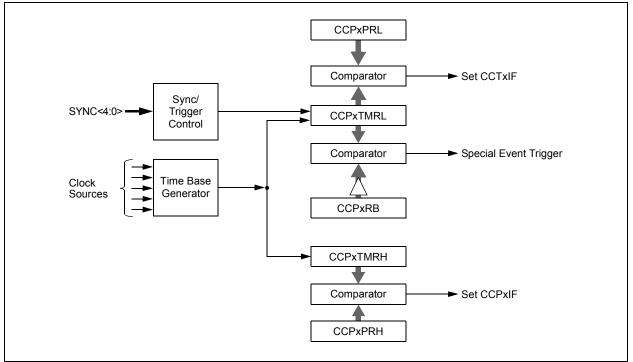
by one. This mode provides a simple timer function when it is important to track long time periods. Note that the T32 bit (CCPxCON1L<5>) should be set before the CCPxTMRL or CCPxPRH registers are written to initialize the 32-bit timer.

#### 16.2.1 SYNC AND TRIGGER OPERATION

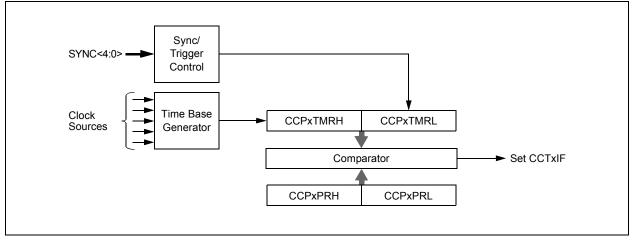
In both 16-bit and 32-bit modes, the timer can also function in either Synchronization ("Sync") or Trigger mode operation. Both use the SYNC<4:0> bits (CCPxCON1H<4:0>) to determine the input signal source. The difference is how that signal affects the timer.

In Sync operation, the Timer Reset or clear occurs when the input selected by SYNC<4:0> is asserted. The timer immediately begins to count again from zero unless it is held for some other reason. Sync operation is used whenever the TRIGEN bit (CCPxCON1H<7>) is cleared. The SYNC<4:0> bits can have any value except '11111'.

In Trigger mode operation, the timer is held in Reset until the input selected by SYNC<4:0> is asserted; when it occurs, the timer starts counting. Trigger operation is used whenever the TRIGEN bit is set. In Trigger mode, the timer will continue running after a trigger event as long as the CCPTRIG bit (CCPxSTATL< 7>) is set. To clear CCPTRIG bit (CCPxSTATL< 7>) is set. To clear CCPTRIG, the TRCLR bit (CCPxSTATL<5>) must be set to clear the trigger event, reset the timer and hold it at zero until another trigger event occurs. On PIC24FJ256GA705 family devices, Trigger mode operation can only be used when the system clock is the time base source (CLKSEL<2:0> = 000).



## FIGURE 16-4: 32-BIT TIMER MODE



### 16.3 Output Compare Mode

Output Compare mode compares the Timer register value with the value of one or two Compare registers, depending on its mode of operation. The Output Compare x module, on compare match events, has the ability to generate a single output transition or a train of

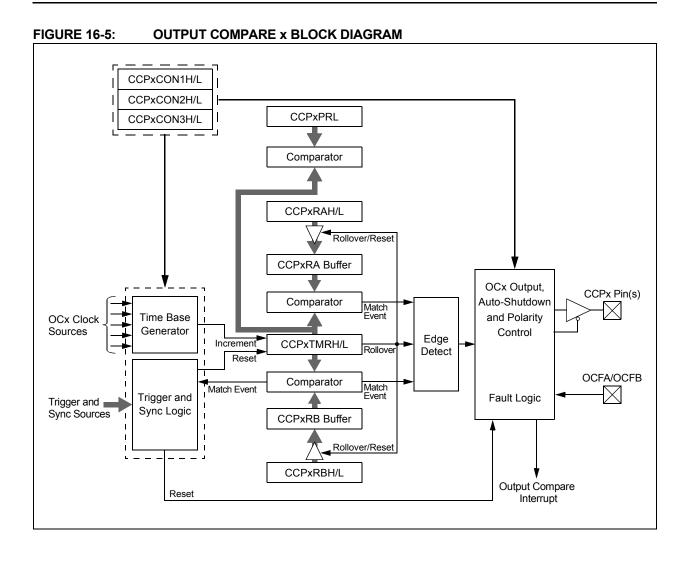
output pulses. Like most PIC<sup>®</sup> MCU peripherals, the Output Compare x module can also generate interrupts on a compare match event.

Table 16-2shows the various modes available inOutput Compare modes.

MOD<3:0> (CCPxCON1L<3:0>)	T32 (CCPxCON1L<5>)	Operating Mode			
0001	0	Output High on Compare (16-bit)			
0001	1	Output High on Compare (32-bit)			
0010 0		Output Low on Compare (16-bit)	Single Edge Mede		
0010 1		Output Low on Compare (32-bit)	Single Edge Mode		
0011	0	Output Toggle on Compare (16-bit)	-		
0011	1	Output Toggle on Compare (32-bit)			
0100	0	Dual Edge Compare (16-bit)	Dual Edge Mode		
0101	0	Dual Edge Compare (16-bit buffered)	PWM Mode		
0110	0	Center-Aligned Pulse (16-bit buffered) <sup>(1)</sup>	Center PWM Mode		
0111	0	Variable Frequency Pulse (16-bit)			
1111	0	External Input Source Mode (16-bit)			

### TABLE 16-2: OUTPUT COMPARE/PWM MODES

Note 1: Center-Aligned PWM mode is only available on MCCP modules. This feature is disabled on SCCP modules.



## 16.4 Input Capture Mode

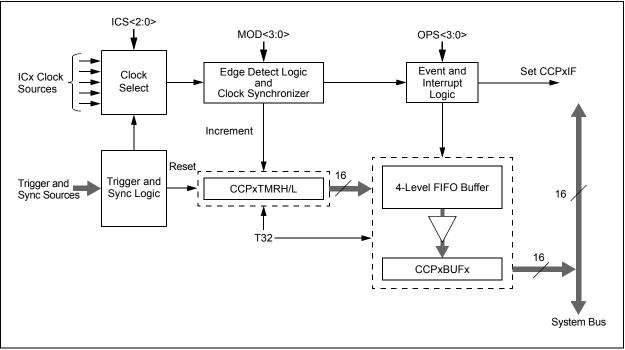
Input Capture mode is used to capture a timer value from an independent timer base upon an event on an input pin or other internal Trigger source. The input capture features are useful in applications requiring frequency (time period) and pulse measurement. Figure 16-6 depicts a simplified block diagram of the Input Capture mode. Input Capture mode uses a dedicated 16/32-bit, synchronous, up counting timer for the capture function. The timer value is written to the FIFO when a capture event occurs. The internal value may be read (with a synchronization delay) using the CCPxTMRH/L registers.

To use Input Capture mode, the CCSEL bit (CCPxCON1L<4>) must be set. The T32 and MOD<3:0> bits are used to select the proper Capture mode, as shown in Table 16-3.

MOD<3:0> (CCPxCON1L<3:0>)	T32 (CCPxCON1L<5>)	Operating Mode					
0000	0	Edge Detect (16-bit capture)					
0000	1	Edge Detect (32-bit capture)					
0001	0	Every Rising (16-bit capture)					
0001	1	Every Rising (32-bit capture)					
0010	0	Every Falling (16-bit capture)					
0010	1	Every Falling (32-bit capture)					
0011	0	Every Rise/Fall (16-bit capture)					
0011	1	Every Rise/Fall (32-bit capture)					
0100	0	Every 4th Rising (16-bit capture)					
0100	1	Every 4th Rising (32-bit capture)					
0101	0	Every 16th Rising (16-bit capture)					
0101	1	Every 16th Rising (32-bit capture)					

#### TABLE 16-3: INPUT CAPTURE MODES





# 16.5 Auxiliary Output

The MCCPx modules have an auxiliary (secondary) output that provides other peripherals access to internal module signals. The auxiliary output is intended to connect to other MCCPx modules, or other digital peripherals, to provide these types of functions:

- Time Base Synchronization
- Peripheral Trigger and Clock Inputs
- Signal Gating

The type of output signal is selected using the AUXOUT<1:0> control bits (CCPxCON2H<4:3>). The type of output signal is also dependent on the module operating mode.

On the PIC24FJ256GA705 family of devices, only the CTMU discharge trigger has access to the auxiliary output signal.

AUXOUT<1:0>	CCSEL	MOD<3:0>	Comments	Signal Description
00	х	xxxx	Auxiliary Output Disabled	No Output
01	0	0000	Time Base Modes	Time Base Period Reset or Rollover
10				Special Event Trigger Output
11				No Output
01	0	0001	Output Compare Modes	Time Base Period Reset or Rollover
10		through		Output Compare Event Signal
11		1111		Output Compare Signal
01	1	xxxx	Input Capture Modes	Time Base Period Reset or Rollover
10				Reflects the Value of the ICDIS bit
11				Input Capture Event Signal

## TABLE 16-4: AUXILIARY OUTPUT

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
CCPON		CCPSIDL	CCPSLP	TMRSYNC	CLKSEL2	CLKSEL1	CLKSEL0				
bit 15							bit				
		DAMA		DAALO	DAMO	DAMA	DAMO				
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
TMRPS1 bit 7	TMRPS0	T32	CCSEL	MOD3	MOD2	MOD1	MOD0				
							bit				
Legend:											
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown				
bit 15		Px Module Ena									
	1 = Module is 0 = Module is		an operating m	node specified b	by the MOD<3:	0> control bits					
bit 14		ted: Read as '	כ'								
bit 13	CCPSIDL: CO	CPx Stop in Idle	e Mode Bit								
				device enters Id	lle mode						
bit 12	0 = Continues module operation in Idle mode										
DIL 12	CCPSLP: CCPx Sleep Mode Enable bit 1 = Module continues to operate in Sleep modes										
		loes not operat									
bit 11	TMRSYNC: Time Base Clock Synchronization bit										
	1 = Module time base clock is synchronized to the internal system clocks; timing restrictions apply										
	0 = Module time base clock is not synchronized to the internal system clocks										
bit 10-8	CLKSEL<2:0>: CCPx Time Base Clock Select bits										
	111 = TCKIA pin 110 = TCKIB pin										
	101 = PLL clo										
	100 = 2x peripheral clock										
	010 = SOSC										
		nce clock outpu	ut								
	000 = System clock										
	For MCCP1: 011 = CLC1 output										
	For MCCP2:										
	011 = CLC2 o	•									
bit 7-6	TMRPS<1:0>: Time Base Prescale Select bits										
	11 = 1:64 Pre 10 = 1:16 Pre										
	01 = 1:4 Pres										
	00 = 1:1 Pres										
bit 5	T32: 32-Bit Ti	ime Base Seleo	ct bit								
				edge output co edge output co							
bit 4		ture/Compare I	-								
-	-	ture peripheral									
				I (exact functior	n is selected by	y the MOD<3:0	> bits)				
Note 1. Cr	enter-Alianed P\	MM mode is on	ly available on		. This feature i	e diezhled on 9					

### REGISTER 16-1: CCPxCON1L: CCPx CONTROL 1 LOW REGISTERS

Note 1: Center-Aligned PWM mode is only available on MCCP modules. This feature is disabled on SCCP modules.

#### REGISTER 16-1: CCPxCON1L: CCPx CONTROL 1 LOW REGISTERS (CONTINUED)

- bit 3-0 MOD<3:0>: CCPx Mode Select bits
  - For CCSEL = 1 (Input Capture modes):
  - 1 xxx = Reserved
  - 011x = Reserved
  - 0101 = Capture every 16th rising edge
  - 0100 = Capture every 4th rising edge
  - 0011 = Capture every rising and falling edge
  - 0010 = Capture every falling edge
  - 0001 = Capture every rising edge
  - 0000 = Capture every rising and falling edge (Edge Detect mode)

#### For CCSEL = 0 (Output Compare/Timer modes):

- 1111 = External Input mode: Pulse generator is disabled, source is selected by ICS<2:0>
- 1110 = Reserved
- 110x = Reserved
- 10xx = Reserved
- 0111 = Variable Frequency Pulse mode
- 0110 = Center-Aligned Pulse Compare mode, buffered<sup>(1)</sup>
- 0101 = Dual Edge Compare mode, buffered
- 0100 = Dual Edge Compare mode
- 0011 = 16-Bit/32-Bit Single Edge mode, toggles output on compare match
- 0010 = 16-Bit/32-Bit Single Edge mode, drives output low on compare match
- 0001 = 16-Bit/32-Bit Single Edge mode, drives output high on compare match
- 0000 = 16-Bit/32-Bit Timer mode, output functions are disabled
- **Note 1:** Center-Aligned PWM mode is only available on MCCP modules. This feature is disabled on SCCP modules.

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0					
OPSSRC <sup>(1)</sup>	RTRGEN <sup>(2)</sup>	—	_	OPS3 <sup>(3)</sup>	OPS2 <sup>(3)</sup>	OPS1 <sup>(3)</sup>	OPS0 <sup>(3)</sup>					
bit 15							bit					
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
TRIGEN	ONESHOT	ALTSYNC	SYNC4	SYNC3	SYNC2	SYNC1	SYNC0					
bit 7							bit					
Legend:												
R = Readable	e bit	W = Writable I	oit	U = Unimplem	nented bit, read	d as '0'						
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown					
bit 15	OPSSRC: Ou	utput Postscaler	Source Sele	ct bit <sup>(1)</sup>								
				er output events	5							
		ostscaler scales		terrupt events								
bit 14	RTRGEN: Retrigger Enable bit <sup>(2)</sup>											
	<ol> <li>Time base can be retriggered when the TRIGEN bit = 1</li> <li>Time base may not be retriggered when the TRIGEN bit = 1</li> </ol>											
bit 13-12		ted: Read as '0										
bit 11-8	<b>OPS3&lt;3:0&gt;:</b> CCPx Interrupt Output Postscale Select bits <sup>(3)</sup>											
	1111 = Interrupt every 16th time base period match											
	1110 = Interrupt every 15th time base period match											
	0100 = Interrupt every 5th time base period match											
		•	•	d match or 4th i	input capture e	vent						
	0010 = Interrupt every 3rd time base period match or 3rd input capture event											
	0001 = Interrupt every 2nd time base period match or 2nd input capture event											
bit 7	0000 = Interrupt after each time base period match or input capture event TRIGEN: CCPx Trigger Enable bit											
	1 = Trigger operation of time base is enabled											
	0 = Trigger operation of time base is disabled											
bit 6	ONESHOT: One-Shot Mode Enable bit											
				rigger mode dur	ation is set by	OSCNT<2:0>						
		t Trigger mode										
bit 5		CPx Clock Sele										
				dule synchroniza gnal is the Time								
bit 4-0		CCPx Synchroi	-	-								
		-5 for the definit										
Note 1: Th	is control bit ha	as no function ir	n Input Captu	e modes.								
		as no function w										
	utput postscale				sult in a FIFO I	ouffer overflow f	or					

## REGISTER 16-2: CCPxCON1H: CCPx CONTROL 1 HIGH REGISTERS

3: Output postscale settings, from 1:5 to 1:16 (0100-1111), will result in a FIFO buffer overflow for Input Capture modes.

SYNC<4:0>	Synchronization Source
11111	None; Timer with Rollover on CCPxPR Match or FFFFh
11110	Reserved
11101	Reserved
11100	CTMU Trigger
11011	A/D Start Conversion
11010	CMP3 Trigger
11001	CMP2 Trigger
11000	CMP1 Trigger
10111	Reserved
10110	Reserved
10101	Reserved
10100	Reserved
10011	Reserved
10010	Reserved
10001	CLC2 Out
10000	CLC1 Out
01111	Reserved
01110	Reserved
01101	Reserved
01100	Reserved
01011	INT2 Pad
01010	INT1 Pad
01001	INTO Pad
01000	Reserved
00111	Reserved
00110	Reserved
00101	MCCP4 Sync Out
00100	MCCP3 Sync Out
00011	MCCP2 Sync Out
00010	MCCP1 Sync Out
00001	MCCPx Sync Out <sup>(1)</sup>
00000	MCCPx Timer Sync Out <sup>(1)</sup>

# TABLE 16-5: SYNCHRONIZATION SOURCES

**Note 1:** CCP1 when connected to CCP1, CCP2 when connected to CCP2, etc.

R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0				
PWMRSEN	ASDGM		SSDG	_	_	—	—				
bit 15							bit 8				
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
ASDG7	ASDG6	ASDG5	ASDG4	ASDG3	ASDG2	ASDG1	ASDG0				
bit 7							bit C				
Legend:											
R = Readable	bit	W = Writable	bit	U = Unimplem	ented bit, read	d as '0'					
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown					
bit 14		it must be clea		e to resume PW e Enable bit	M activity on c	output pins					
bit 14	ASDGM: CCPx Auto-Shutdown Gate Mode Enable bit 1 = Waits until the next Time Base Reset or rollover for shutdown to occur										
	0 = Shutdown event occurs immediately										
bit 13	Unimplemen	ted: Read as '	כי								
bit 12	SSDG: CCPx	Software Shut	down/Gate Co	ontrol bit							
	<ul> <li>1 = Manually forces auto-shutdown, timer clock gate or input capture signal gate event (setting of ASDGM bit still applies)</li> </ul>										
	0 = Normal n	nodule operatio	'n								
bit 11-8	Unimplemen	ted: Read as '	כי								
bit 7-0	ASDG<7:0>: CCPx Auto-Shutdown/Gating Source Enable bits										
	<ul> <li>1 = ASDGx Source n is enabled (see Table 16-6 for auto-shutdown/gating sources)</li> <li>0 = ASDGx Source n is disabled</li> </ul>										

## REGISTER 16-3: CCPxCON2L: CCPx CONTROL 2 LOW REGISTERS

#### TABLE 16-6: AUTO-SHUTDOWN SOURCES

ASDC (7:0)	Auto-Shutdown Source							
ASDG<7:0>	MCCP1	MCCP2	MCCP3	MCCP4				
1xxx xxxx		00	CFB					
x1xx xxxx		00	CFA					
xx1x xxxx	CLC1	CLC2	Not U	Jsed				
xxx1 xxxx		Not	Used					
xxxx 1xxx		Not	Used					
xxxx x1xx		CMF	'3 Out					
xxxx xx1x		CMF	2 Out					
xxxx xxx1		CMF	'1 Out					

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1				
OENSYNC		OCFEN	OCEEN	OCDEN	OCCEN	OCBEN	OCAEN				
bit 15							bit 8				
R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
ICGSM1	ICGSM0	_	AUXOUT1	AUXOUTO	ICS2	ICS1	ICS0				
bit 7							bit (				
Legend:											
R = Readable	e bit	W = Writable	bit	U = Unimplem	ented bit, read	d as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	nown				
bit 15	1 = Update b	y output enable	Synchronization e bits occurs or e bits occurs in	n the next Time	Base Reset o	r rollover					
bit 14	Unimplement	ted: Read as '	D'								
bit 13-8	OCxEN: Output Enable/Steering Control bits										
	0 = OCMx pi		led by the CC	odule and prode Px module; the							
bit 7-6	ICGSM<1:0>: Input Capture Gating Source Mode Control bits										
	01 = One-Sho 00 = Level-Se	ot mode: Falling ot mode: Rising ensitive mode:	g edge from ga	ting source disa ting source ena om gating sour	bles future cap	oture events (IC	DIS = 0				
bit 5	Unimplement	ted: Read as '	D'								
bit 4-3	AUXOUT<1:0	<b>)&gt;:</b> Auxiliary Ou	utput Signal on	Event Selection	n bits						
	10 = Signal o	utput is defined se rollover eve	by module op	t; no signal in T erating mode (s		)					
bit 2-0	ICS<2:0>: Input Capture Source Select bits										
	010 = Compa 001 = Compa	ved output	k) I/O pin								

## REGISTER 16-4: CCPxCON2H: CCPx CONTROL 2 HIGH REGISTERS

## **REGISTER 16-5:** CCPxCON3L: CCPx CONTROL 3 LOW REGISTERS<sup>(1)</sup>

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—			DT<	5:0>		
bit 7							bit 0
Legend:							
R = Readable bit W = Writal			ritable bit U = Unimplemented bit, read as '0'				
-n = Value at I	POR	'1' = Bit is set	'1' = Bit is set '0' = Bit is cleared x = Bit is un			x = Bit is unkr	nown

#### bit 15-6 Unimplemented: Read as '0'

bit 5-0 DT<5:0>: CCPx Dead-Time Select bits<sup>(1)</sup> 111111 = Inserts 63 dead-time delay periods between complementary output signals 11110 = Inserts 62 dead-time delay periods between complementary output signals ... 000010 = Inserts 2 dead-time delay periods between complementary output signals 000001 = Inserts 1 dead-time delay period between complementary output signals 000000 = Dead-time logic is disabled

Note 1: This register is implemented in the MCCP1 module only.

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0				
OETRIG	OSCNT2	OSCNT1	OSCNT0	—	OUTM2 <sup>(1)</sup>	OUTM1 <sup>(1)</sup>	OUTM0 <sup>(1)</sup>				
bit 15							bit 8				
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
		POLACE	POLBDF <sup>(1)</sup>	PSSACE1	PSSACE0	PSSBDF1 <sup>(1)</sup>	PSSBDF0 <sup>(1)</sup>				
bit 7		1 0 2 10 2	1 01001	100/1021	100,1020		bit (				
Legend:											
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'					
-n = Value at		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkn	iown				
bit 15	1 = For Trigg	Px Dead-Time ered mode (TF utput pin opera	RIGEN = 1): Mo	odule does not	drive enabled o	output pins until	triggered				
bit 14-12	OSCNT<2:0>	: One-Shot Ev	ent Count bits								
	110 = Extend 101 = Extend 100 = Extend 011 = Extend 010 = Extend 001 = Extend	s one-shot eve s one-shot eve s one-shot eve s one-shot eve s one-shot eve s one-shot eve	ent by 6 time ba ent by 5 time ba ent by 4 time ba ent by 3 time ba ent by 2 time ba	use periods (8 ti lise periods (7 ti lise periods (6 ti lise periods (5 ti lise periods (4 ti lise periods (3 ti lise period (2 tin ent	me base perio me base perio me base perio me base perio me base perio	ds total) ds total) ds total) ds total) ds total)					
bit 11	Unimplemen	ted: Read as '	כ'								
bit 10-8	OUTM<2:0>: PWMx Output Mode Control bits <sup>(1)</sup>										
	100 = Brush I 011 = Reserv 010 = Half-Br 001 = Push-P	Scan mode DC Output mod DC Output mod	de, reverse ode le								
bit 7-6	Unimplemen	ted: Read as '	כ'								
bit 5	<b>POLACE:</b> CCPx Output Pins, OCMxA, OCMxC and OCMxE, Polarity Control bit 1 = Output pin polarity is active-low										
		n polarity is ac									
bit 4	<b>POLBDF:</b> CCPx Output Pins, OCMxB, OCMxD and OCMxF, Polarity Control bit <sup>(1)</sup> 1 = Output pin polarity is active-low										
		n polarity is ac									
bit 3-2	PSSACE<1:0	>: PWMx Outp	out Pins, OCMx	A, OCMxC and	l OCMxE, Shu	tdown State Co	ntrol bits				
	10 = Pins are	driven inactive		vn event occurs own event occu vent occurs							
bit 1-0	PSSBDF<1:0	>: PWMx Outp	out Pins, OCMx	B, OCMxD, an	d OCMxF, Shu	tdown State Co	ontrol bits <sup>(1)</sup>				
				vn event occurs							

## REGISTER 16-6: CCPxCON3H: CCPx CONTROL 3 HIGH REGISTERS

**Note 1:** These bits are implemented in the MCCP1 module only.

U-0	U-0	U-0	U-0	U-0	W-0	U-0	U-0				
—	—	—	—	—	ICGARM	_	—				
bit 15							bit 8				
<b>I</b>											
R-0	W1-0	W1-0	R/C-0	R/C-0	R/C-0	R/C-0	R/C-0				
CCPTRIG	TRSET	TRCLR	ASEVT	SCEVT	ICDIS	ICOV	ICBNE				
bit 7							bit 0				
Legend:		C = Clearable	hit	W = Writable	hit						
R = Readable	e bit	W1 = Write '1			nented bit, read	ae 'O'					
-n = Value at		'1' = Bit is set	Only bit	'0' = Bit is cle		x = Bit is unkr	own				
					arca		lowin				
bit 15-11	Unimplemen	ted: Read as '	)'								
bit 10	-	out Capture Gat									
				Input Capture :	x module for a	one-shot gatin	ig event when				
		= 01 or 10; rea									
bit 9-8	-	ted: Read as '									
bit 7		CPTRIG: CCPx Trigger Status bit									
	<ol> <li>Timer has been triggered and is running</li> <li>Timer has not been triggered and is held in Reset</li> </ol>										
bit 6		x Trigger Set R									
			-	r when TRIGE	N = 1 (location a	lways reads a	<b>s</b> '0').				
bit 5	TRCLR: CCP	x Trigger Clear	Request bit								
	Writes '1' to the	his location to c	ancel the time	r trigger when	TRIGEN = 1 (loo	cation always i	reads as '0').				
bit 4		x Auto-Shutdov									
	1 = A shutdown event is in progress; CCPx outputs are in the shutdown state										
bit 3	<ul> <li>0 = CCPx outputs operate normally</li> <li>SCEVT: Single Edge Compare Event Status bit</li> </ul>										
bit 5	1 = A single edge compare event has occurred										
	0 = A single edge compare event has occurred										
bit 2	ICDIS: Input (	Capture x Disal	ole bit								
	1 = Event on Input Capture x pin (ICMx) does not generate a capture event										
		Input Capture			event						
bit 1	ICOV: Input Capture x Buffer Overflow Status bit 1 = The Input Capture x FIFO buffer has overflowed										
		t Capture x FIF t Capture x FIF									
bit 0	-	Capture x Buff		-							
	=	apture x buffer		able							
	0 = Input Ca	apture x buffer	is empty								

## REGISTER 16-7: CCPxSTATL: CCPx STATUS REGISTER LOW

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
—	—	—	—	—	—	—	—			
bit 15							bit 8			
U-0	U-0	U-0	R-0	R-0	R-0	R-0	R-0			
—		<u> </u>	PRLWIP	TMRHWIP	TMRLWIP	RBWIP	RAWIP			
bit 7							bit 0			
Legend:										
R = Readal	ole bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'				
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown			
bit 15-5	Unimplement	ted: Read as '	)'							
bit 4	PRLWIP: CCI	PxPRL Write in	Progress Stat	us bit						
				h the buffered o	contents is in p	rogress				
			•	not in progress						
bit 3		CPxTMRH Wri	•							
	<ol> <li>An update to the CCPxTMRH register with the buffered contents is in progress</li> <li>An update to the CCPxTMRH register is not in progress.</li> </ol>									
bit 2		CPxTMRL Writ	•		55.					
			•	with the buffered	l contents is in	progress				
				s not in progres		progreeo				
bit 1	RBWIP: CCP	xRB Write in P	rogress Status	bit						
	1 = An update	e to the CCPxR	B register with	the buffered co	ontents is in pro	ogress				
	0 = An update	e to the CCPxR	B register is no	ot in progress						
bit 0	RAWIP: CCP:	xRA Write in P	rogress Status	bit						
	<ul> <li>1 = An update to the CCPxRA register with the buffered contents is in progress</li> <li>0 = An update to the CCPxRA register is not in progress</li> </ul>									
	0 = An update	e to the CCPxR	A register is no	ot in progress						

## REGISTER 16-8: CCPxSTATH: CCPx STATUS REGISTER HIGH

NOTES:

# 17.0 SERIAL PERIPHERAL INTERFACE (SPI)

Note: This data sheet summarizes the features of the PIC24FJ256GA705 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the "dsPIC33/PIC24 Family Reference Manual", "Serial Peripheral Interface (SPI) with Audio Codec Support" (DS70005136), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Serial Peripheral Interface (SPI) module is a synchronous serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The SPI module is compatible with the Motorola<sup>®</sup> SPI and SIOP interfaces. All devices in the PIC24FJ256GA705 family include three SPI modules.

The module supports operation in two buffer modes. In Standard Buffer mode, data is shifted through a single serial buffer. In Enhanced Buffer mode, data is shifted through a FIFO buffer. The FIFO level depends on the configured mode.

Variable length data can be transmitted and received from 2 to 32 bits.

Note:	Do not perform Read-Modify-Write opera-
	tions (such as bit-oriented instructions) on
	the SPIxBUF register in either Standard or
	Enhanced Buffer mode.

The module also supports a basic framed SPI protocol while operating in either Master or Slave mode. A total of four framed SPI configurations are supported.

The module also supports Audio modes. Four different Audio modes are available.

- I<sup>2</sup>S mode
- Left Justified mode
- · Right Justified mode
- PCM/DSP mode

In each of these modes, the serial clock is free-running and audio data is always transferred.

If an audio protocol data transfer takes place between two devices, then usually one device is the master and the other is the slave. However, audio data can be transferred between two slaves. Because the audio protocols require free-running clocks, the master can be a third party controller. In either case, the master generates two free-running clocks: SCKx and LRC (Left, Right Channel Clock/SSx/FSYNC). The SPI serial interface consists of four pins:

- SDIx: Serial Data Input
- SDOx: Serial Data Output
- SCKx: Shift Clock Input or Output
- SSx: Active-Low Slave Select or Frame Synchronization I/O Pulse

The SPI module can be configured to operate using 2, 3 or 4 pins. In the 3-pin mode,  $\overline{SSx}$  is not used. In the 2-pin mode, both SDOx and  $\overline{SSx}$  are not used.

The SPI module has the ability to generate three interrupts reflecting the events that occur during the data communication. The following types of interrupts can be generated:

- 1. Receive interrupts are signalled by SPIxRXIF. This event occurs when:
  - RX watermark interrupt
  - SPIROV = 1
  - SPIRBF = 1
  - SPIRBE = 1

provided the respective mask bits are enabled in SPIxIMSKL/H.

- 2. Transmit interrupts are signalled by SPIxTXIF. This event occurs when:
  - TX watermark interrupt
  - SPITUR = 1
  - SPITBF = 1
  - SPITBE = 1

provided the respective mask bits are enabled in SPIxIMSKL/H.

- 3. General interrupts are signalled by SPIxIF. This event occurs when
  - FRMERR = 1
  - SPIBUSY = 1
  - SRMT = 1

provided the respective mask bits are enabled in SPIxIMSKL/H.

A block diagram of the module in Enhanced Buffer mode is shown in Figure 17-1.

Note: In this section, the SPI modules are referred to together as SPIx, or separately as SPI1, SPI2 or SPI3. Special Function Registers will follow a similar notation. For example, SPIxCON1 and SPIxCON2 refer to the control registers for any of the three SPI modules.

## 17.1 Master Mode Operation

Perform the following steps to set up the SPIx module for Master mode operation:

- 1. Disable the SPIx interrupts in the respective IECx register.
- 2. Stop and reset the SPIx module by clearing the SPIEN bit.
- 3. Clear the receive buffer.
- Clear the ENHBUF bit (SPIxCON1L<0>) if using Standard Buffer mode or set the bit if using Enhanced Buffer mode.
- 5. If SPIx interrupts are not going to be used, skip this step. Otherwise, the following additional steps are performed:
  - a) Clear the SPIx interrupt flags/events in the respective IFSx register.
  - b) Write the SPIx interrupt priority and sub-priority bits in the respective IPCx register.
  - c) Set the SPIx interrupt enable bits in the respective IECx register.
- 6. Write the Baud Rate register, SPIxBRGL.
- 7. Clear the SPIROV bit (SPIxSTATL<6>).
- 8. Write the desired settings to the SPIxCON1L register with MSTEN (SPIxCON1L<5>) = 1.
- Enable SPI operation by setting the SPIEN bit (SPIxCON1L<15>).
- 10. Write the data to be transmitted to the SPIxBUFL and SPIxBUFH registers. Transmission (and reception) will start as soon as data is written to the SPIxBUFL/H registers.

## 17.2 Slave Mode Operation

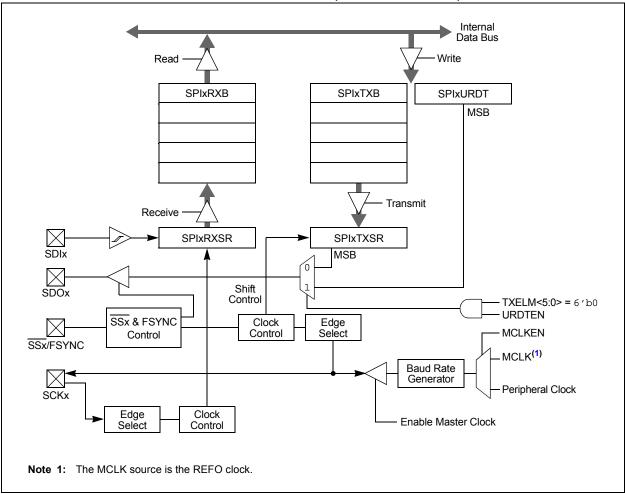
The following steps are used to set up the SPIx module for the Slave mode of operation:

- 1. If using interrupts, disable the SPIx interrupts in the respective IECx register.
- 2. Stop and reset the SPIx module by clearing the SPIEN bit.
- 3. Clear the receive buffer.
- Clear the ENHBUF bit (SPIxCON1L<0>) if using Standard Buffer mode or set the bit if using Enhanced Buffer mode.
- 5. If using interrupts, the following additional steps are performed:
  - a) Clear the SPIx interrupt flags/events in the respective IFSx register.
  - b) Write the SPIx interrupt priority and sub-priority bits in the respective IPCx register.
  - c) Set the SPIx interrupt enable bits in the respective IECx register.

- 6. Clear the SPIROV bit (SPIxSTATL<6>).
- 7. Write the desired settings to the SPIxCON1L register with MSTEN (SPIxCON1L<5>) = 0.
- Enable SPI operation by setting the SPIEN bit (SPIxCON1L<15>).
- 9. Transmission (and reception) will start as soon as the master provides the serial clock.

The following additional features are provided in Slave mode:

- Slave Select Synchronization:
- The SSx pin allows a Synchronous Slave mode. If the SSEN bit (SPIxCON1L<7>) is set, transmission and reception are enabled in Slave mode only if the SSx pin is driven to a low state. The port output or other peripheral outputs must not be driven in order to allow the SSx pin to function as an input. If the SSEN bit is set and the SSx pin is driven high, the SDOx pin is no longer driven and will tri-state, even if the module is in the middle of a transmission. An aborted transmission will be tried again the next time the SSx pin is driven low using the data held in the SPIxTXB register. If the SSEN bit is not set, the SSx pin does not affect the module operation in Slave mode.
- SPITBE Status Flag Operation: The SPITBE bit (SPIxSTATL<3>) has a different function in the Slave mode of operation. The following describes the function of SPITBE for various settings of the Slave mode of operation:
  - If SSEN (SPIxCON1L<7>) is cleared, the SPITBE bit is cleared when SPIxBUF is loaded by the user code. It is set when the module transfers SPIxTXB to SPIxTXSR. This is similar to the SPITBE bit function in Master mode.
  - If SSEN is set, SPITBE is cleared when SPIxBUF is loaded by the user code. However, it is set only when the SPIx module completes data transmission. A transmission will be aborted when the SSx pin goes high and may be retried at a later time. So, each data word is held in SPIxTXB until all bits are transmitted to the receiver.



### FIGURE 17-1: SPIX MODULE BLOCK DIAGRAM (ENHANCED MODE)

### 17.3 Audio Mode Operation

To initialize the SPIx module for Audio mode, follow the steps to initialize it for Master/Slave mode, but also set the AUDEN bit (SPIxCON1H<15>). In Master+Audio mode:

- This mode enables the device to generate SCKx and LRC pulses as long as the SPIEN bit (SPIxCON1L<15>) = 1.
- The SPIx module generates LRC and SCKx continuously in all cases, regardless of the transmit data, while in Master mode.
- The SPIx module drives the leading edge of LRC and SCKx within 1 SCKx period, and the serial data shifts in and out continuously, even when the TX FIFO is empty.

In Slave+Audio mode:

- This mode enables the device to receive SCKx and LRC pulses as long as the SPIEN bit (SPIxCON1L<15>) = 1.
- The SPIx module drives zeros out of SDOx, but does not shift data out or in (SDIx) until the module receives the LRC (i.e., the edge that precedes the left channel).
- Once the module receives the leading edge of LRC, it starts receiving data if DISSDI (SPIxCON1L<4>) = 0 and the serial data shifts out continuously, even when the TX FIFO is empty.

## 17.4 SPI Control Registers

## REGISTER 17-1: SPIxCON1L: SPIx CONTROL REGISTER 1 LOW

REGISTER	17-1: SPIXC	UNIL: SPIX	CONTROL	REGISTER			
R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SPIEN	—	SPISIDL	DISSDO	MODE32 <sup>(1,4</sup>	<sup>4)</sup> MODE16 <sup>(1,4)</sup>	SMP	CKE <sup>(1)</sup>
bit 15							bit 8
	<b>D</b> # 44 A		5444	5444.0	<b>D</b> # 44 A	5.444	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SSEN <sup>(2)</sup>	CKP	MSTEN	DISSDI	DISSCK	MCLKEN <sup>(3)</sup>	SPIFE	ENHBUF
bit 7							bit C
Legend:							
R = Readab	le bit	W = Writable I	oit	U = Unimple	mented bit, read	as '0'	
-n = Value a	t POR	'1' = Bit is set		ʻ0' = Bit is cl		x = Bit is unk	nown
bit 15	SPIEN: SPIX (	)n hit					
DIL 15	1 = Enables m						
			odule disable	s clocks disa	ables interrupt ev	ent generatio	n allows SEF
	modificatio					ent generatie	,
bit 14	Unimplement	ed: Read as 'd	)'				
bit 13	SPISIDL: SPIX	Stop in Idle M	lode bit				
	1 = Halts in CF						
	0 = Continues	to operate in (	CPU Idle mod	е			
bit 12	DISSDO: Disa	ble SDOx Out	put Port bit				
	1 = SDOx pin i 0 = SDOx pin i			in is controlle	d by the port funct	ion	
bit 11-10	MODE<32,16>	•		4)			
	AUDEN = 0:						
	MODE32	MODE16	COMMUNI		FO DEPTH		
	1	x	32-Bit	8			
	0	1	16-Bit	16			
	0	0	8-Bit	32			
	$\frac{\text{AUDEN} = 1}{\text{MODE22}}$						
	MODE32		COMMUNI		32-Bit Channel/6	1 Bit Eramo	
	1	1 0			32-Bit Channel/6		
	0	1			32-Bit Channel/6		
	0	0			16-Bit Channel/3		
bit 9	SMP: SPIx Da	ta Input Samp	le Phase bit				
	Master Mode:						
	1 = Input data	is sampled at	the end of dat	a output time			
	0 = Input data	is sampled at	the middle of	data output tin	ne		
	Slave Mode:						
	Input data is al	ways sampled	at the middle	e of data outpu	t time, regardless	of the SMP s	setting.
Note 1: V	Vhen AUDEN = 1	. this module f	unctions as if	CKE = 0. rega	ardless of its actua	al value.	
	When FRMEN = $1$			0,10gt			
	ICLKEN can only			bit = ∩			
	-				follows the FRMS	YPW hit	

5: The MCLK source is the REFO clock.

### REGISTER 17-1: SPIx CONTROL REGISTER 1 LOW (CONTINUED)

bit 8		CKE: SPIx Clock Edge Select bit <sup>(1)</sup>
		1 = Transmit happens on transition from active clock state to Idle clock state
		0 = Transmit happens on transition from Idle clock state to active clock state
bit 7		SSEN: Slave Select Enable bit (Slave mode) <sup>(2)</sup>
		1 = $\overline{SSx}$ pin is used by the macro in Slave mode; $\overline{SSx}$ pin is used as the slave select input 0 = $\overline{SSx}$ pin is not used by the macro ( $\overline{SSx}$ pin will be controlled by the port I/O)
bit 6		CKP: SPIx Clock Polarity Select bit
		<ul> <li>1 = Idle state for clock is a high level; active state is a low level</li> <li>0 = Idle state for clock is a low level; active state is a high level</li> </ul>
bit 5		MSTEN: Master Mode Enable bit
		1 = Master mode
		0 = Slave mode
bit 4		DISSDI: Disable SDIx Input Port bit
		<ul> <li>1 = SDIx pin is not used by the module; pin is controlled by the port function</li> <li>0 = SDIx pin is controlled by the module</li> </ul>
bit 3		DISSCK: Disable SCKx Output Port bit
		<ul> <li>1 = SCKx pin is not used by the module; pin is controlled by the port function</li> <li>0 = SCKx pin is controlled by the module</li> </ul>
bit 2		MCLKEN: Master Clock Enable bit <sup>(3)</sup>
		1 = MCLK is used by the BRG <sup>(5)</sup>
		0 = Peripheral Clock is used by the BRG
bit 1		SPIFE: Frame Sync Pulse Edge Select bit
		<ul> <li>1 = Frame Sync pulse (Idle-to-active edge) coincides with the first bit clock</li> <li>0 = Frame Sync pulse (Idle-to-active edge) precedes the first bit clock</li> </ul>
bit 0		ENHBUF: Enhanced Buffer Mode Enable bit
		<ol> <li>1 = Enhanced Buffer mode is enabled</li> <li>0 = Enhanced Buffer mode is disabled</li> </ol>
Note	1:	When AUDEN = 1, this module functions as if CKE = 0, regardless of its actual value.
	2:	When FRMEN = 1. SSEN is not used.

- 3: MCLKEN can only be written when the SPIEN bit = 0.
- 4: This channel is not meaningful for DSP/PCM mode as LRC follows the FRMSYPW bit.
- **5:** The MCLK source is the REFO clock.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
AUDEN <sup>(1)</sup>	SPISGNEXT	IGNROV	IGNTUR	AUDMONO <sup>(2)</sup>	URDTEN <sup>(3)</sup>	AUDMOD1 <sup>(4)</sup>	AUDMOD0(4				
bit 15	•			· · · · ·			bit 8				
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FRMCNT2	FRMCNT1	FRMCNT0				
bit 7				-			bit C				
Legend:											
R = Readal	ble bit	W = Writable	oit	U = Unimpleme	ented bit, read	as '0'					
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clear	red	x = Bit is unkr	iown				
bit 15	1 = Audio pro and this r SMP = 0,	module functio regardless of t	d; MSTEN co ns as if FRM heir actual va	ntrols the directio EN = 1, FRMSY							
	•	tocol is disable									
bit 14		SPISGNEXT: SPIx Sign-Extend RX FIFO Read Data Enable bit									
		1 = Data from RX FIFO is sign-extended 0 = Data from RX FIFO is not sign-extended									
bit 13		ore Receive Ov	0	50							
	1 = A Receive by the rec	e Overflow (RC	0V) is NOT a	critical error; duri	ng ROV, data	in the FIFO is r	not overwritter				
bit 12		ore Transmit Ur		·							
	1 = A Transm until the S		UR) is NOT a empty	r critical error and	d data indicate	ed by URDTEN	is transmitted				
bit 11		Audio Data For									
	1 = Audio data 0 = Audio data		each data wo	rd is transmitted	on both left ar	nd right channel	s)				
bit 10	URDTEN: Tra	nsmit Underru	n Data Enable	e bit <sup>(3)</sup>							
				egister during Tra g Transmit Under							
bit 9-8	AUDMOD<1:0	0>: Audio Proto	col Mode Sel	ection bits <sup>(4)</sup>							
	01 = Left Just	stified mode: T ified mode: Thi	s module fund	nctions as if SPIF ctions as if SPIFE f SPIFE = 0, rega	= 1, regardle	ss of its actual					
bit 7		ned SPIx Supp		·							
		PIx support is e PIx support is e		pin is used as the	e FSYNC inpu	t/output)					
2:	AUDEN can only AUDMONO can o URDTEN is only	only be written	when the SPI		only valid for	AUDEN = 1.					
4:	AUDMOD<1:0> b	oits can only be	written when	the SPIEN bit =	0 and are only	valid when AL	JDEN = 1.				

#### REGISTER 17-2: SPIxCON1H: SPIx CONTROL REGISTER 1 HIGH

### REGISTER 17-2: SPIxCON1H: SPIx CONTROL REGISTER 1 HIGH (CONTINUED)

bit 6	FRMSYNC: Frame Sync Pulse Direction Control bit
	1 = Frame Sync pulse input (slave)
	0 = Frame Sync pulse output (master)
bit 5	FRMPOL: Frame Sync/Slave Select Polarity bit
	1 = Frame Sync pulse/slave select is active-high
	0 = Frame Sync pulse/slave select is active-low
bit 4	MSSEN: Master Mode Slave Select Enable bit
	<ul> <li>SPIx slave select support is enabled with polarity determined by FRMPOL (SSx pin is automatically driven during transmission in Master mode)</li> </ul>
	0 = SPIx slave select support is disabled (SSx pin will be controlled by port IO)
bit 3	FRMSYPW: Frame Sync Pulse-Width bit
	<ul> <li>1 = Frame Sync pulse is one serial word length wide (as defined by MODE&lt;32,16&gt;/WLENGTH&lt;4:0&gt;)</li> <li>0 = Frame Sync pulse is one clock (SCK) wide</li> </ul>
bit 2-0	FRMCNT<2:0>: Frame Sync Pulse Counter bits
	Controls the number of serial words transmitted per Sync pulse.
	111 = Reserved
	110 = Reserved
	101 = Generates a Frame Sync pulse on every 32 serial words
	100 = Generates a Frame Sync pulse on every 16 serial words
	011 = Generates a Frame Sync pulse on every 8 serial words
	010 = Generates a Frame Sync pulse on every 4 serial words
	001 = Generates a Frame Sync pulse on every 2 serial words (value used by audio protocols)
	000 = Generates a Frame Sync pulse on each serial word

- **Note 1:** AUDEN can only be written when the SPIEN bit = 0.
  - **2:** AUDMONO can only be written when the SPIEN bit = 0 and is only valid for AUDEN = 1.
  - **3:** URDTEN is only valid when IGNTUR = 1.
  - **4:** AUDMOD<1:0> bits can only be written when the SPIEN bit = 0 and are only valid when AUDEN = 1. When NOT in PCM/DSP mode, this module functions as if FRMSYPW = 1, regardless of its actual value.

### REGISTER 17-3: SPIxCON2L: SPIx CONTROL REGISTER 2 LOW

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	_	_	—	_	—	—
bit 15							bit 8
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_		_		W	_ENGTH<4:0> <sup>(</sup>	(1,2)	
bit 7							bit 0
Legend:							
R = Readab	ole bit	W = Writable	bit	U = Unimplen	nented bit, reac	l as '0'	
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 15-5		ited: Read as '		(1.0)			
bit 4-0		4:0>: Variable V	Vord Length b	bits <sup>(1,2)</sup>			
	11111 = 32-k						
	11110 = 31-k 11101 = 30-k						
	11100 <b>= 29-</b> k						
	11011 <b>= 28-</b> k						
	11010 <b>= 27-</b> k						
	11001 <b>= 26-</b> k	oit data					
	11000 <b>= 25-</b> k						
	10111 <b>= 24</b> -k						
	10110 = 23-k 10101 = 22-k						
	10101 - 22 - 10101 - 21 - 10100 = 21 - 1000 = 21 - 10000 = 21 - 10000 = 21 - 10000 = 21 - 100000 = 21 - 1000000000000000000000000000000000						
	10011 = 20-k						
	10010 <b>= 19-</b> k						
	10001 <b>= 18-</b> k						
	10000 = <b>17</b> -k						
	01111 = <b>16</b> -k						
	01110 = 15-k 01101 = 14-k						
	01100 = <b>13</b> -k						
	01011 = <b>12-</b> k						
	01010 <b>= 11-</b> b	oit data					
	01001 = 10-k						
	01000 <b>= 9-b</b> i						
	00111 = 8-bi 00110 = 7-bi						
	00110 = 7-bi						
	00101 <b>– 0-b</b> i						
	00011 = <b>4</b> -bi						
	00010 <b>= 3-b</b> i						
	00001 <b>= 2-b</b> i						
	00000 <b>= See</b>	MODE<32,16>	bits in SPIxC	CON1L<11:10>			

- **Note 1:** These bits are effective when AUDEN = 0 only.
  - 2: Varying the length by changing these bits does not affect the depth of the TX/RX FIFO.

#### REGISTER 17-4: SPIx STATL: SPIx STATUS REGISTER LOW

U-0	U-0	U-0	R/C-0, HS	R-0, HSC	U-0	U-0	R-0, HSC
—	—	_	FRMERR	SPIBUSY	—	—	SPITUR <sup>(1)</sup>
bit 15							bit 8

R-0, HSC	R/C-0, HS	R-1, HSC	U-0	R-1, HSC	U-0	R-0, HSC	R-0, HSC
SRMT	SPIROV	SPIRBE		SPITBE	—	SPITBF	SPIRBF
bit 7							bit 0

Legend:	C = Clearable bit	HS = Hardware Settable bit	x = Bit is unknown		
R = Readable bit	W = Writable bit	'0' = Bit is cleared	HSC = Hardware Settable/Clearable bit		
-n = Value at POR	'1' = Bit is set	U = Unimplemented bit, read as '0'			

bit 15-13	Unimplemented: Read as '0'
bit 12	FRMERR: SPIx Frame Error Status bit
	<ul><li>1 = Frame error is detected</li><li>0 = No frame error is detected</li></ul>
bit 11	SPIBUSY: SPIx Activity Status bit
	<ul><li>1 = Module is currently busy with some transactions</li><li>0 = No ongoing transactions (at time of read)</li></ul>
bit 10-9	Unimplemented: Read as '0'
bit 8	SPITUR: SPIx Transmit Underrun Status bit <sup>(1)</sup>
	<ul> <li>1 = Transmit buffer has encountered a Transmit Underrun condition</li> <li>0 = Transmit buffer does not have a Transmit Underrun condition</li> </ul>
bit 7	SRMT: Shift Register Empty Status bit
	<ul> <li>1 = No current or pending transactions (i.e., neither SPIxTXB or SPIxTXSR contains data to transmit)</li> <li>0 = Current or pending transactions</li> </ul>
bit 6	SPIROV: SPIx Receive Overflow Status bit
	<ul> <li>1 = A new byte/half-word/word has been completely received when the SPIxRXB is full</li> <li>0 = No overflow</li> </ul>
bit 5	SPIRBE: SPIx RX Buffer Empty Status bit
	1 = RX buffer is empty 0 = RX buffer is not empty
	Standard Buffer Mode: Automatically set in hardware when SPIxBUF is read from, reading SPIxRXB. Automatically cleared in hardware when SPIx transfers data from SPIxRXSR to SPIxRXB. Enhanced Buffer Mode:
	Indicates RXELM<5:0> = $6'$ b000000.
bit 4	Unimplemented: Read as '0'
bit 3	SPITBE: SPIx Transmit Buffer Empty Status bit
	1 = SPIxTXB is empty 0 = SPIxTXB is not empty
	<u>Standard Buffer Mode:</u> Automatically set in hardware when SPIx transfers data from SPIxTXB to SPIxTXSR. Automatically cleared in hardware when SPIxBUF is written, loading SPIxTXB.
	Enhanced Buffer Mode: Indicates TXELM<5:0> = 6'b000000.

**Note 1:** SPITUR is cleared when SPIEN = 0. When IGNTUR = 1, SPITUR provides dynamic status of the Transmit Underrun condition, but does not stop RX/TX operation and does not need to be cleared by software.

### REGISTER 17-4: SPIxSTATL: SPIx STATUS REGISTER LOW (CONTINUED)

- bit 2 Unimplemented: Read as '0' bit 1 SPITBF: SPIx Transmit Buffer Full Status bit 1 = SPIxTXB is full 0 = SPIxTXB not full Standard Buffer Mode: Automatically set in hardware when SPIxBUF is written, loading SPIxTXB. Automatically cleared in hardware when SPIx transfers data from SPIxTXB to SPIxTXSR. Enhanced Buffer Mode: Indicates TXELM<5:0> = 6 'b111111. bit 0 SPIRBF: SPIx Receive Buffer Full Status bit 1 = SPIxRXB is full 0 = SPIxRXB is not full Standard Buffer Mode: Automatically set in hardware when SPIx transfers data from SPIxRXSR to SPIxRXB. Automatically cleared in hardware when SPIxBUF is read from, reading SPIxRXB. Enhanced Buffer Mode: Indicates RXELM<5:0> = 6 'b111111.
- **Note 1:** SPITUR is cleared when SPIEN = 0. When IGNTUR = 1, SPITUR provides dynamic status of the Transmit Underrun condition, but does not stop RX/TX operation and does not need to be cleared by software.

U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
	_	RXELM5 <sup>(3)</sup>	RXELM4 <sup>(2)</sup>	RXELM3 <sup>(1)</sup>	RXELM2	RXELM1	RXELM0
bit 15							bit 8
U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
	_	TXELM5 <sup>(3)</sup>	TXELM4 <sup>(2)</sup>	TXELM3 <sup>(1)</sup>	TXELM2	TXELM1	TXELM0
bit 7							bit 0

	REGISTER 17-5:	SPIxSTATH: SPIx STATUS REGISTER HIGH <sup>(4)</sup>
--	----------------	---

Legend:	HSC = Hardware Settable/Clear	HSC = Hardware Settable/Clearable bit					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'					
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown				

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RXELM<5:0>:** Receive Buffer Element Count bits (valid in Enhanced Buffer mode)<sup>(1,2,3)</sup>

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **TXELM<5:0>:** Transmit Buffer Element Count bits (valid in Enhanced Buffer mode)<sup>(1,2,3)</sup>

**Note 1:** RXELM3 and TXELM3 bits are only present when FIFODEPTH = 8 or higher.

2: RXELM4 and TXELM4 bits are only present when FIFODEPTH = 16 or higher.

3: RXELM5 and TXELM5 bits are only present when FIFODEPTH = 32.

4: See the MODE32/16 bits in the SPIxCON1L register.

#### REGISTER 17-6: SPIxBUFL: SPIx BUFFER REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			DAT	A<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			DAT	Ā<7:0>			
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable bit		U = Unimpleme	ented bit, read	l as '0'	
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is un			x = Bit is unkr	nown			

#### bit 15-0 DATA<15:0>: SPIx FIFO Data bits

When the MODE<32,16> or WLENGTH<4:0> bits select 16 to 9-bit data, the SPIx only uses DATA<15:0>. When the MODE<32,16> or WLENGTH<4:0> bits select 8 to 2-bit data, the SPIx only uses DATA<7:0>.

#### REGISTER 17-7: SPIxBUFH: SPIx BUFFER REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			DATA	\<31:24>				
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			DATA	\<23:16>				
bit 7							bit 0	
Legend:								
R = Readab	le bit	W = Writable bit	ut U = Unimplemented bit, read as '0'					

### bit 15-0 DATA<31:16>: SPIx FIFO Data bits

'1' = Bit is set

When the MODE<32,16> or WLENGTH<4:0> bits select 32 to 25-bit data, the SPIx uses DATA<31:16>. When the MODE<32,16> or WLENGTH<4:0> bits select 24 to 17-bit data, the SPIx only uses DATA<23:16>.

'0' = Bit is cleared

-n = Value at POR

x = Bit is unknown

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
		—	BRG<12:8> <sup>(1)</sup>						
bit 15			b						
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
			BRG	i<7:0> <sup>(1)</sup>					
bit 7							bit 0		
Legend:									
R = Readab	le bit	W = Writable bit		U = Unimpleme	nted bit, read	as '0'			
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unk			iown						

bit 15-13 Unimplemented: Read as '0'

bit 12-0 BRG<12:0>: SPIx Baud Rate Generator Divisor bits<sup>(1)</sup>

**Note 1:** Changing the BRG value when SPIEN = 1 causes undefined behavior.

U-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0
—	—	_	FRMERREN	BUSYEN	—	—	SPITUREN
bit 15							bit 8
R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0
SRMTEN	SPIROVEN	SPIRBEN		SPITBEN	_	SPITBFEN	SPIRBFEN
bit 7							bit C
Legend:							
R = Readab	le hit	W = Writable	hit	U = Unimpleme	anted hit read	ae 'O'	
-n = Value a		'1' = Bit is set	Dit	'0' = Bit is clear		x = Bit is unkr	NOW/D
		1 – Dit 13 301			cu		
bit 15-13	Unimplemen	ted: Read as '	0'				
bit 12	-		ipt Events via FF	RMERR bit			
			n interrupt even				
		0	enerate an interru	•			
bit 11		•	Events via SPIB	JSY bit			
			interrupt event erate an interrup	t event			
bit 10-9		ted: Read as '		tevent			
bit 8	•		o t Events via SPI	TUR hit			
bit 0			R) generates an i				
			not generate ar				
bit 7	SRMTEN: En	able Interrupt	Events via SRM <sup>-</sup>	Г bit			
			RMT) generates es not generate				
bit 6	SPIROVEN: E	Enable Interrup	ot Events via SPI	ROV bit			
			generates an inte does not genera		vent		
bit 5			Events via SPIR	•			
			pty generates ar pty does not ger				
bit 4	Unimplemen	ted: Read as '	0'				
bit 3	SPITBEN: En	able Interrupt	Events via SPIT	BE bit			
			npty generates a npty does not ge				
bit 2	Unimplemen	ted: Read as '	0'				
bit 1	SPITBFEN: E	Enable Interrup	t Events via SPI	TBF bit			
			II generates an ii II does not genei		event		
bit 0	SPIRBFEN: E	Enable Interrup	t Events via SPI	RBF bit			
			l generates an ir				
			I does not gener				

# REGISTER 17-9: SPIxIMSKL: SPIx INTERRUPT MASK REGISTER LOW

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
RXWIEN	ı —	RXMSK5 <sup>(1)</sup>	RXMSK4 <sup>(1,4)</sup>	RXMSK3 <sup>(1,3)</sup>	RXMSK2 <sup>(1,2)</sup>	RXMSK1 <sup>(1)</sup>	RXMSK0 <sup>(1)</sup>			
bit 15							bit 8			
R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
TXWIEN	<u> </u>	TXMSK5 <sup>(1)</sup>	TXMSK4 <sup>(1,4)</sup>	TXMSK3 <sup>(1,3)</sup>	TXMSK2 <sup>(1,2)</sup>	TXMSK1 <sup>(1)</sup>	TXMSK0 <sup>(1)</sup>			
bit 7							bit (			
Legend:										
R = Reada	able bit	W = Writable	bit	U = Unimpleme	ented bit, read as	ʻ0'				
-n = Value	at POR	'1' = Bit is set	:	'0' = Bit is clear	ed	x = Bit is unkr	iown			
bit 14 bit 13-8	RXMSK<5:		/lask bits <sup>(1,2,3,4)</sup>							
	RX mask bit	ts; used in conj	unction with the	RXWIEN bit.						
bit 7			nark Interrupt Ei							
			r element water r element water		hen TXMSK<5:0	> = TXELM<5:	0>			
bit 6	Unimpleme	ented: Read as	'0'							
bit 5-0	TXMSK<5:0	D>: TX Buffer N	lask bits <sup>(1,2,3,4)</sup>							
	TX mask bit	s; used in conju	unction with the	TXWIEN bit.						
Note 1:	Mask values I this case.	higher than FIF	ODEPTH are r	not valid. The mo	odule will not trig	ger a match fo	r any value in			
2:	RXMSK2 and	TXMSK2 bits a	are only present	t when FIFODEF	PTH = 8 or highe	r.				
3:	RXMSK3 and	TXMSK3 bits a	are only present	t when FIFODEF	PTH = 16 or high	er.				
	RXMSK3 and TXMSK3 bits are only present when FIFODEPTH = 16 or higher.									

# REGISTER 17-10: SPIxIMSKH: SPIx INTERRUPT MASK REGISTER HIGH

4: RXMSK4 and TXMSK4 bits are only present when FIFODEPTH = 32.

'1' = Bit is set

uses URDATA<7:0>.

## REGISTER 17-11: SPIxURDTL: SPIx UNDERRUN DATA REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
			URDA	TA<15:8>							
bit 15							bit 8				
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
URDATA<7:0>											
bit 7							bit 0				
Legend:											
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'					as '0'						

'0' = Bit is cleared

bit 15-0 URDATA<15:0>: SPIx Underrun Data bits These bits are only used when URDTEN = 1. This register holds the data to transmit when a Transmit Underrun condition occurs. When the MODE<32,16> or WLENGTH<4:0> bits select 16 to 9-bit data, the SPIx only uses URDATA<15:0>. When the MODE<32,16> or WLENGTH<4:0> bits select 8 to 2-bit data, the SPIx only

#### REGISTER 17-12: SPIxURDTH: SPIx UNDERRUN DATA REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			URDA	TA<31:24>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			URDA	TA<23:16>			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable bit		U = Unimpleme	ented bit, read	d as '0'	
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			own	

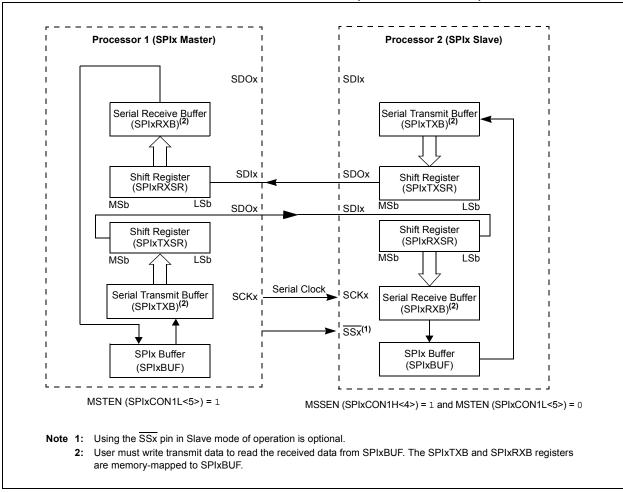
bit 15-0 URDATA<31:16>: SPIx Underrun Data bits

These bits are only used when URDTEN = 1. This register holds the data to transmit when a Transmit Underrun condition occurs.

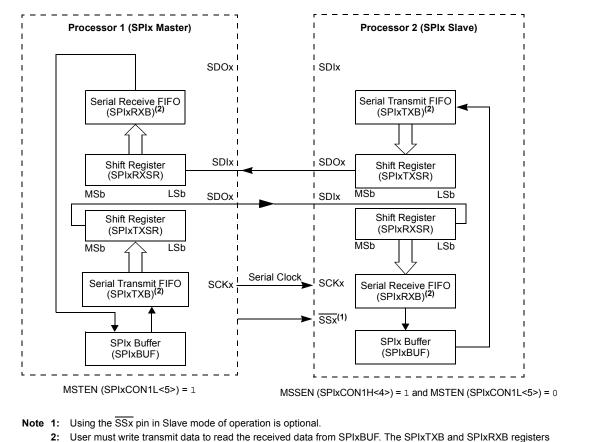
When the MODE<32,16> or WLENGTH<4:0> bits select 32 to 25-bit data, the SPIx only uses URDATA<31:16>. When the MODE<32,16> or WLENGTH<4:0> bits select 24 to 17-bit data, the SPIx only uses URDATA<23:16>.

-n = Value at POR

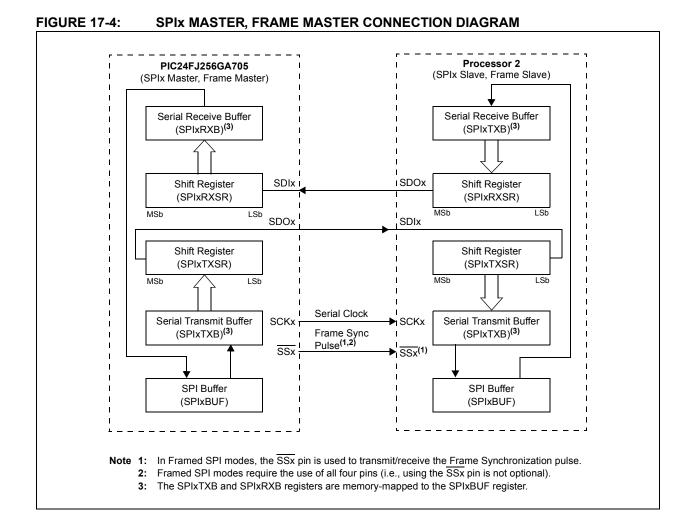
x = Bit is unknown

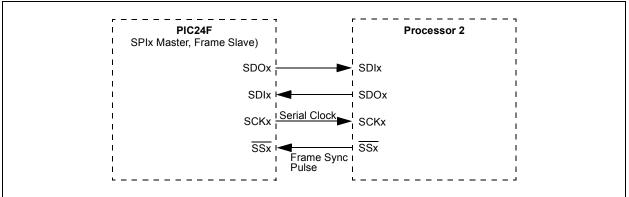






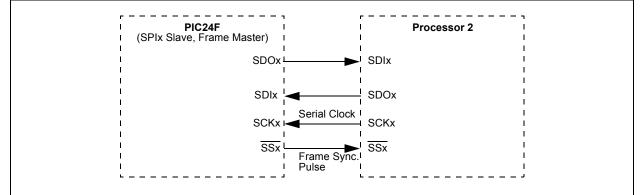
are memory-mapped to SPIxBUF.



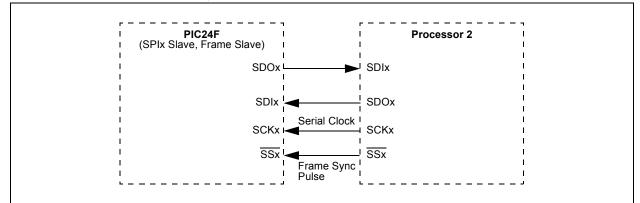


#### FIGURE 17-5: SPIx MASTER, FRAME SLAVE CONNECTION DIAGRAM





#### FIGURE 17-7: SPIx SLAVE, FRAME SLAVE CONNECTION DIAGRAM



#### EQUATION 17-1: RELATIONSHIP BETWEEN DEVICE AND SPIX CLOCK SPEED

 $Baud Rate = \frac{FPB}{(2 * (SPIxBRG + 1))}$ Where: FPB is the Peripheral Bus Clock Frequency.

# 18.0 INTER-INTEGRATED CIRCUIT (I<sup>2</sup>C)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"Inter-Integrated Circuit (I<sup>2</sup>C)"** (DS70000195), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Inter-Integrated Circuit (I<sup>2</sup>C) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, display drivers, A/D Converters, etc.

The I<sup>2</sup>C module supports these features:

- Independent Master and Slave Logic
- 7-Bit and 10-Bit Device Addresses
- General Call Address as Defined in the I<sup>2</sup>C Protocol
- Clock Stretching to Provide Delays for the Processor to Respond to a Slave Data Request
- Both 100 kHz and 400 kHz Bus Specifications
- Configurable Address Masking
- Multi-Master modes to Prevent Loss of Messages in Arbitration
- Bus Repeater mode, Allowing the Acceptance of All Messages as a Slave, regardless of the Address
- · Automatic SCL

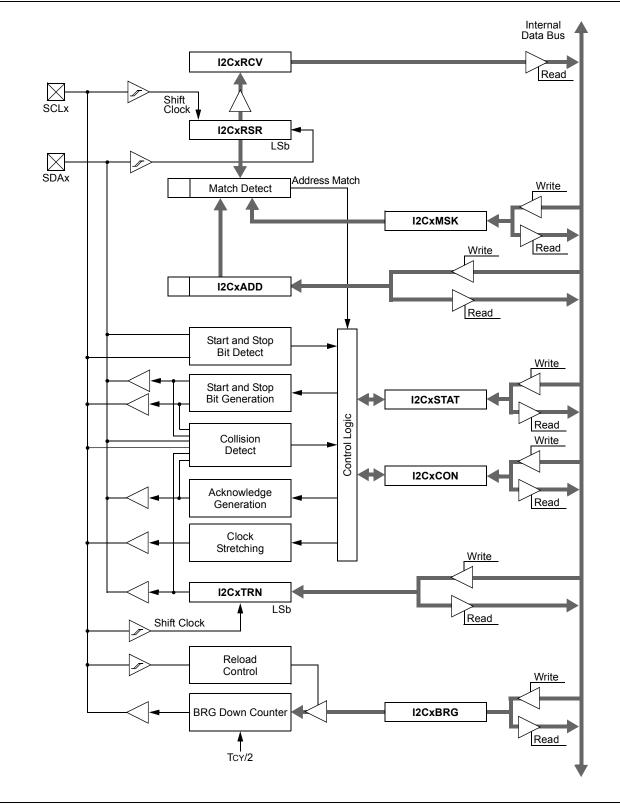
A block diagram of the module is shown in Figure 18-1.

#### 18.1 Communicating as a Master in a Single Master Environment

The details of sending a message in Master mode depends on the communications protocol for the device being communicated with. Typically, the sequence of events is as follows:

- 1. Assert a Start condition on SDAx and SCLx.
- 2. Send the I<sup>2</sup>C device address byte to the slave with a write indication.
- 3. Wait for and verify an Acknowledge from the slave.
- 4. Send the first data byte (sometimes known as the command) to the slave.
- 5. Wait for and verify an Acknowledge from the slave.
- 6. Send the serial memory address low byte to the slave.
- 7. Repeat Steps 4 and 5 until all data bytes are sent.
- 8. Assert a Repeated Start condition on SDAx and SCLx.
- 9. Send the device address byte to the slave with a read indication.
- 10. Wait for and verify an Acknowledge from the slave.
- 11. Enable master reception to receive serial memory data.
- 12. Generate an ACK or NACK condition at the end of a received byte of data.
- 13. Generate a Stop condition on SDAx and SCLx.

## FIGURE 18-1: I2Cx BLOCK DIAGRAM



#### 18.2 Setting Baud Rate When Operating as a Bus Master

To compute the Baud Rate Generator reload value, use Equation 18-1.

# EQUATION 18-1: COMPUTING BAUD RATE RELOAD VALUE<sup>(1,2,3)</sup>

 $FSCL = \frac{FCY}{(I2CxBRG + 2) * 2}$ 

or:

$$I2CxBRG = \left[\frac{FCY}{(FSCL * 2)} - 2\right]$$

**Note 1:** Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

2: These clock rate values are for guidance only. The actual clock rate can be affected by various systemlevel parameters. The actual clock rate should be measured in its intended application.

**3:** BRG values of 0 and 1 are forbidden.

## 18.3 Slave Address Masking

The I2CxMSK register (Register 18-4) designates address bit positions as "don't care" for both 7-Bit and 10-Bit Addressing modes. Setting a particular bit location (= 1) in the I2CxMSK register causes the slave module to respond, whether the corresponding address bit value is a '0' or a '1'. For example, when I2CxMSK is set to '0010000000', the slave module will detect both addresses, '000000000' and '001000000'.

To enable address masking, the Intelligent Peripheral Management Interface (IPMI) must be disabled by clearing the STRICT bit (I2CxCONL<11>).

**Note:** As a result of changes in the I<sup>2</sup>C protocol, the addresses in Table 18-2 are reserved and will not be Acknowledged in Slave mode. This includes any address mask settings that include any of these addresses.

Required System FscL	Fcy	l2CxB	RG Value	
	FCY	(Decimal)	(Hexadecimal)	Actual Fsc∟
100 kHz	16 MHz	78	4E	100 kHz
100 kHz	8 MHz	38	26	100 kHz
100 kHz	4 MHz	18	12	100 kHz
400 kHz	16 MHz	18	12	400 kHz
400 kHz	8 MHz	8	8	400 kHz
400 kHz	4 MHz	3	3	400 kHz
1 MHz	16 MHz	6	6	1.000 MHz
1 MHz	8 MHz	2	2	1.000 MHz

# TABLE 18-1: I2Cx CLOCK RATES<sup>(1,2)</sup>

Note 1: Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

2: These clock rate values are for guidance only. The actual clock rate can be affected by various system-level parameters. The actual clock rate should be measured in its intended application.

	TABLE 18-2:	I2Cx RESERVED ADDRESSES <sup>(1)</sup>
--	-------------	--

Slave Address	R/W Bit	Description			
000 000	0	General Call Address <sup>(2)</sup>			
0000 000	1	Start Byte			
0000 001	x	Cbus Address			
0000 01x	х	Reserved			
0000 1xx	x	HS Mode Master Code			
1111 0xx	x	10-Bit Slave Upper Byte <sup>(3)</sup>			
1111 1xx	х	Reserved			

Note 1: The address bits listed here will never cause an address match independent of address mask settings.

- 2: This address will be Acknowledged only if GCEN = 1.
- 3: A match on this address can only occur on the upper byte in 10-Bit Addressing mode.

R/W-0	U-0	HC, R/W-0	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0			
I2CEN		I2CSIDL	SCLREL <sup>(1)</sup>	STRICT	A10M	DISSLW	SMEN			
bit 15			L		L	•	bit 8			
R/W-0	R/W-0	R/W-0	HC, R/W-0	HC, R/W-0	HC, R/W-0	HC, R/W-0	HC, R/W-0			
GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN			
bit 7							bit (			
Legend:		HC = Hardwa	re Clearable bi	t						
R = Read	able bit	W = Writable	bit	U = Unimplen	nented bit, read	l as '0'				
-n = Value	e at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own			
bit 15	1 = Enables t	Enable bit (writ he I2Cx module the I2Cx modul	e and configure	es the SDAx an		s serial port pin s	S			
bit 14	Unimplemen	ted: Read as '	כי							
bit 13		x Stop in Idle M								
		ues module op s module opera			e mode					
bit 11	If STREN = 0 1 = Releases 0 = Forces clo If STREN = 1 1 = Releases 0 = Holds cloo STRICT: I2C> 1 = Strict ress In Slave that category 0 = Reserved	clock ock low (clock s clock ck low (clock st cstrict Reserve erved addressi Mode: The dev gory are NACK r Mode: The de d addressing w	stretch) retch); user ma ed Address Rul- ng is enforced vice doesn't res ed. vice is allowed ould be Acknow	ay program this e Enable bit (for reserved a spond to reserv to generate ac wledged	ddresses, refer ved address sp Idresses with r	to Table 18-2) bace and addres	sses falling i s space.			
	there is a In Master	a match with an r Mode: Reserv	y of the reserve			served address generate an AC				
bit 10		A10M: 10-Bit Slave Address Flag bit								
		is a 10-bit slav is a 7-bit slave								
bit 9	DISSLW: Slev	w Rate Control	Disable bit							
		control is disat control is enab				o disabled for 1	MHz mode)			
Note 1:	Automatically clear of slave reception ting the SCLREL specified in Secti	h. The user soft bit. This delay	ware must prov must be greate	vide a delay be er than the mini	tween writing t	o the transmit b	ouffer and set			

#### REGISTER 18-1: I2CxCONL: I2Cx CONTROL REGISTER LOW

**2:** Automatically cleared to '0' at the beginning of slave transmission.

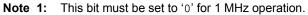
# REGISTER 18-1: I2CxCONL: I2Cx CONTROL REGISTER LOW (CONTINUED)

bit 8	SMEN: SMBus Input Levels Enable bit
	<ul> <li>1 = Enables input logic so thresholds are compliant with the SMBus specification</li> <li>0 = Disables SMBus-specific inputs</li> </ul>
bit 7	GCEN: General Call Enable bit (I <sup>2</sup> C Slave mode only)
	<ul> <li>1 = Enables interrupt when a general call address is received in I2CxRSR; module is enabled for reception</li> <li>0 = General call address is disabled</li> </ul>
bit 6	STREN: SCLx Clock Stretch Enable bit
	In I <sup>2</sup> C Slave mode only; used in conjunction with the SCLREL bit. 1 = Enables clock stretching 0 = Disables clock stretching
bit 5	ACKDT: Acknowledge Data bit
	In I <sup>2</sup> C Master mode during Master Receive mode. The value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.
	In I <sup>2</sup> C Slave mode when AHEN = 1 or DHEN = 1. The value that the slave will transmit when it initiates an Acknowledge sequence at the end of an address or data reception. 1 = NACK is sent 0 = ACK is sent
bit 4	ACKEN: Acknowledge Sequence Enable bit
	In I <sup>2</sup> C Master mode only; applicable during Master Receive mode. 1 = Initiates Acknowledge sequence on SDAx and SCLx pins, and transmits the ACKDT data bit 0 = Acknowledge sequence is Idle
bit 3	<b>RCEN:</b> Receive Enable bit (I <sup>2</sup> C Master mode only)
	1 = Enables Receive mode for $I^2C$ ; automatically cleared by hardware at the end of the 8-bit receive data byte
	0 = Receive sequence is not in progress
bit 2	<b>PEN:</b> Stop Condition Enable bit (I <sup>2</sup> C Master mode only)
	<ul> <li>1 = Initiates Stop condition on the SDAx and SCLx pins</li> <li>0 = Stop condition is Idle</li> </ul>
bit 1	<b>RSEN:</b> Restart Condition Enable bit (I <sup>2</sup> C Master mode only)
	<ul> <li>1 = Initiates Restart condition on the SDAx and SCLx pins</li> <li>0 = Restart condition is Idle</li> </ul>
bit 0	SEN: Start Condition Enable bit (I <sup>2</sup> C Master mode only)
	<ul> <li>1 = Initiates Start condition on the SDAx and SCLx pins</li> <li>0 = Start condition is Idle</li> </ul>
Note 1:	Automatically cleared to '0' at the beginning of slave transmission; automatically cleared to '0' at the end of slave reception. The user software must provide a delay between writing to the transmit buffer and setting the SCLREL bit. This delay must be greater than the minimum setup time for slave transmissions, as specified in Section 32.0 "Electrical Characteristics".

2: Automatically cleared to '0' at the beginning of slave transmission.

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
_	_		_	_		_					
bit 15		•	•				bit				
U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
	PCIE	SCIE	BOEN	SDAHT <sup>(1)</sup>	SBCDE	AHEN	DHEN				
bit 7			_	-			bit				
Legend:											
R = Readab	le hit	W = Writable	hit	LI = Unimplem	ented bit, read	as '0'					
-n = Value a		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkn	own				
		Dicio dec					iowii				
bit 15-7	Unimplemen	ted: Read as '	o'								
bit 6	PCIE: Stop C	ondition Interru	pt Enable bit (	(I <sup>2</sup> C Slave mode	only)						
	<b>PCIE:</b> Stop Condition Interrupt Enable bit (I <sup>2</sup> C Slave mode only) 1 = Enables interrupt on detection of Stop condition										
	0 = Stop dete	0 = Stop detection interrupts are disabled									
bit 5		SCIE: Start Condition Interrupt Enable bit (I <sup>2</sup> C Slave mode only)									
	1 = Enables interrupt on detection of Start or Restart conditions										
<b>L:1</b>	0 = Start detection interrupts are disabled <b>BOEN:</b> Buffer Overwrite Enable bit $(l^2 C Slave mode only)$										
bit 4	<b>BOEN:</b> Buffer Overwrite Enable bit (I <sup>2</sup> C Slave mode only) 1 = I2CxRCV is updated and an ACK is generated for a received address/data byte, ignoring the state										
	of the I2COV bit only if RBF bit = 0										
		is only update		∕ is clear							
bit 3	SDAHT: SDA	x Hold Time Se	election bit <sup>(1)</sup>								
	1 = Minimum of 300 ns hold time on SDAx after the falling edge of SCLx										
	0 = Minimum of 100 ns hold time on SDAx after the falling edge of SCLx										
bit 2		<b>SBCDE:</b> Slave Mode Bus Collision Detect Enable bit (I <sup>2</sup> C Slave mode only)									
	If, on the rising edge of SCLx, SDAx is sampled low when the module is outputting a high state, the BCL bit is set and the bus goes Idle. This Detection mode is only valid during data and ACK transmi										
	sequences.										
	1 = Enables slave bus collision interrupts										
	0 = Slave bus collision interrupts are disabled										
bit 1	AHEN: Address Hold Enable bit (I <sup>2</sup> C Slave mode only)										
	1 = Following the 8th falling edge of SCLx for a matching received address byte; SCLREL b										
	(I2CxCONL<12>) will be cleared and SCLx will be held low 0 = Address holding is disabled										
bit 0		Hold Enable bit		ode only)							
				for a received da	ata byte; slave	hardware clears	s the SCLRE				
	bit (I2Cx0 0 = Data holo	CONL<12>) an		wol b							

#### REGISTER 18-2: I2CxCONH: I2Cx CONTROL REGISTER HIGH



HSC, R-0	HSC, R-0	HSC, R-0	U-0	U-0	HSC, R/C-0	HSC, R-0	HSC, R-0
ACKSTAT	TRSTAT	ACKTIM	_	—	BCL	GCSTAT	ADD10
bit 15							bit 8
HS, R/C-0	HS, R/C-0	HSC, R-0	HSC, R/C-0	HSC, R/C-0	HSC, R-0	HSC, R-0	HSC, R-0
IWCOL	I2COV	D/A	Р	S	R/W	RBF	TBF
bit 7							bit 0
Legend:		C = Clearab		HS = Hardware		'0' = Bit is clear	red
R = Readable		W = Writable		•	ented bit, read as		
-n = Value at	POR	'1' = Bit is se	et	HSC = Hardwa	re Settable/Cleara	ble bit	
bit 15	ACKSTAT: A 1 = Acknowle 0 = Acknowle	edge was not	received fron	n slave	er and Slave moo	les)	
bit 14	<b>TRSTAT:</b> Transmit Status bit (when operating as I <sup>2</sup> C master; applicable to master transmit operation) 1 = Master transmit is in progress (8 bits + ACK) 0 = Master transmit is not in progress						
bit 13	<ul> <li>ACKTIM: Acknowledge Time Status bit (valid in I<sup>2</sup>C Slave mode only)</li> <li>1 = Indicates I<sup>2</sup>C bus is in an Acknowledge sequence, set on 8th falling edge of SCLx clock</li> <li>0 = Not an Acknowledge sequence, cleared on 9th rising edge of SCLx clock</li> </ul>						
bit 12-11	Unimplemented: Read as '0'						
bit 10	-			Slave mode; clea	ared when I <sup>2</sup> C mo	dule is disabled.	12CEN = 0)
	<ul> <li>1 = A bus collision has been detected during a master or slave transmit operation</li> <li>0 = No bus collision has been detected</li> </ul>						
bit 9	GCSTAT: Ge	neral Call Sta	tus bit (clear	ed after Stop det	tection)		
	1 = General o 0 = General o			ved	·		
bit 8	ADD10: 10-E	Bit Address St	atus bit (clea	red after Stop de	etection)		
	ADD10: 10-Bit Address Status bit (cleared after Stop detection) 1 = 10-bit address was matched 0 = 10-bit address was not matched						
bit 7							
		npt to write to are			ecause the I <sup>2</sup> C m	odule is busy; m	ust be cleared
bit 6	12COV: 12Cx	Receive Ove	rflow Flag bit				
	<ul> <li>1 = A byte was received while the I2CxRCV register is still holding the previous byte; I2COV is a "don't care" in Transmit mode, must be cleared in software</li> <li>0 = No overflow</li> </ul>						
bit 5	<b>D/A:</b> Data/Ac 1 = Indicates 0 = Indicates	that the last l	byte received		vas an address		
bit 4	P: I2Cx Stop	bit en Start, Rese that a Stop b	t or Stop is d it has been d	etected; cleared	when the I <sup>2</sup> C mo	dule is disabled,	I2CEN = 0.

#### REGISTER 18-3: I2CxSTAT: I2Cx STATUS REGISTER

#### REGISTER 18-3: I2CxSTAT: I2Cx STATUS REGISTER (CONTINUED)

bit 3	<ul> <li>S: I2Cx Start bit</li> <li>Updated when Start, Reset or Stop is detected; cleared when the I<sup>2</sup>C module is disabled, I2CEN = 0.</li> <li>1 = Indicates that a Start (or Repeated Start) bit has been detected last</li> <li>0 = Start (or Repeated Start) bit was not detected last</li> </ul>
bit 2	<b>R/W</b> : Read/Write Information bit (when operating as $I^2C$ slave)
	<ul> <li>1 = Read: Indicates the data transfer is output from the slave</li> <li>0 = Write: Indicates the data transfer is input to the slave</li> </ul>
bit 1	RBF: Receive Buffer Full Status bit
	1 = Receive is complete, I2CxRCV is full 0 = Receive is not complete, I2CxRCV is empty
bit 0	TBF: Transmit Buffer Full Status bit
	1 = Transmit is in progress, I2CxTRN is full (8-bits of data)
	0 = Transmit is complete, I2CxTRN is empty

#### REGISTER 18-4: I2CxMSK: I2Cx SLAVE MODE ADDRESS MASK REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
_	_	—		—	—	MSK	<9:8>
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			MS	K<7:0>			
bit 7							bit C
Legend:							
R = Readable bit W = Writable bi		bit	U = Unimplemented bit, read as '0'		d as '0'		
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared		x = Bit is unknown		

bit 15-10 Unimplemented: Read as '0'

bit 9-0 MSK<9:0>: I2Cx Mask for Address Bit x Select bits

1 = Enables masking for bit x of the incoming message address; bit match is not required in this position 0 = Disables masking for bit x; bit match is required in this position

# 19.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Universal Asynchronous Receiver Transmitter (UART)" (DS70000582), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Universal Asynchronous Receiver Transmitter (UART) module is one of the serial I/O modules available in the PIC24F device family. The UART is a full-duplex, asynchronous system that can communicate with peripheral devices, such as personal computers, LIN/J2602, RS-232 and RS-485 interfaces. The module also supports a hardware flow control option with the UxCTS and UxRTS pins. The UART module includes an IrDA<sup>®</sup> encoder/decoder unit.

The PIC24FJ256GA705 family devices are equipped with two UART modules, referred to as UART1 and UART2.

The primary features of the UARTx modules are:

- Full-Duplex, 8 or 9-Bit Data Transmission through the UxTX and UxRX Pins
- Even, Odd or No Parity Options (for 8-bit data)
- One or Two Stop bits
- Hardware Flow Control Option with the UxCTS and UxRTS Pins
- Fully Integrated Baud Rate Generator with 16-Bit Prescaler
- Baud Rates Range from up to 1 Mbps and Down to 15 Hz at 16 MIPS in 16x mode

- Baud Rates Range from up to 4 Mbps and Down to 61 Hz at 16 MIPS in 4x mode
- 4-Deep, First-In-First-Out (FIFO) Transmit Data Buffer
- 4-Deep FIFO Receive Data Buffer
- Parity, Framing and Buffer Overrun Error Detection
- Support for 9-Bit mode with Address Detect (9<sup>th</sup> bit = 1)
- Separate Transmit and Receive Interrupts
- · Loopback mode for Diagnostic Support
- · Polarity Control for Transmit and Receive Lines
- · Support for Sync and Break Characters
- Supports Automatic Baud Rate Detection
- IrDA<sup>®</sup> Encoder and Decoder Logic
- Includes DMA Support
- 16x Baud Clock Output for IrDA Support

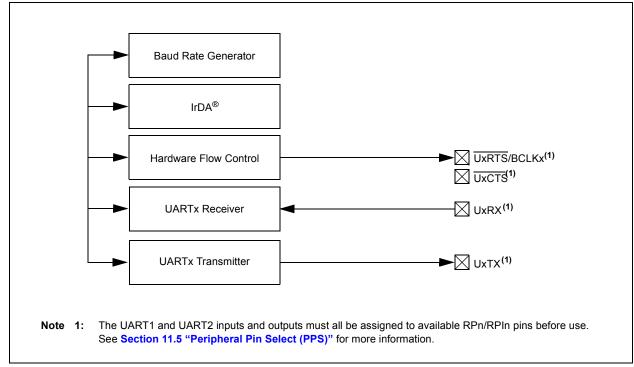
A simplified block diagram of the UARTx module is shown in Figure 19-1. The UARTx module consists of these key important hardware elements:

- · Baud Rate Generator
- · Asynchronous Transmitter
- Asynchronous Receiver

**Note:** Throughout this section, references to register and bit names that may be associated with a specific UART module are referred to generically by the use of 'x' in place of the specific module number. Thus, "UxSTA" might refer to the Status register for either UART1 or UART2.

# PIC24FJ256GA705 FAMILY

#### FIGURE 19-1: UARTX SIMPLIFIED BLOCK DIAGRAM



#### 19.1 UARTx Baud Rate Generator (BRG)

The UARTx module includes a dedicated, 16-bit Baud Rate Generator. The UxBRG register controls the period of a free-running, 16-bit timer. Equation 19-1 shows the formula for computation of the baud rate when BRGH = 0.

# EQUATION 19-1: UARTX BAUD RATE WITH BRGH = $0^{(1,2)}$

Baud Rate = 
$$\frac{FCY}{16 \cdot (UxBRG + 1)}$$
  
UxBRG =  $\frac{FCY}{16 \cdot Baud Rate} - 1$ 

**Note 1:** FCY denotes the instruction cycle clock frequency (Fosc/2).

**2:** Based on FCY = FOSC/2; Doze mode and PLL are disabled.

Example 19-1 shows the calculation of the baud rate error for the following conditions:

- Fcy = 4 MHz
- Desired Baud Rate = 9600

The maximum baud rate (BRGH = 0) possible is FCY/16 (for UxBRG = 0) and the minimum baud rate possible is FCY/(16 \* 65536).

Equation 19-2 shows the formula for computation of the baud rate when BRGH = 1.

# EQUATION 19-2: UARTx BAUD RATE WITH BRGH = $1^{(1,2)}$

Baud Rate = 
$$\frac{FCY}{4 \cdot (UxBRG + 1)}$$
  
UxBRG =  $\frac{FCY}{4 \cdot Baud Rate} - 1$ 

- Note 1: FCY denotes the instruction cycle clock frequency.
  - 2: Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

The maximum baud rate (BRGH = 1) possible is FCY/4 (for UxBRG = 0) and the minimum baud rate possible is FCY/(4 \* 65536).

Writing a new value to the UxBRG register causes the BRG timer to be reset (cleared). This ensures the BRG does not wait for a timer overflow before generating the new baud rate.

## EXAMPLE 19-1: BAUD RATE ERROR CALCULATION (BRGH = 0)<sup>(1)</sup>

Desired Baud Rate = FcY/(16 (UxBRG + 1))Solving for UxBRG Value: UxBRG = ((FCY/Desired Baud Rate)/16) - 1 UxBRG = ((4000000/9600)/16) - 1 UxBRG = 25Calculated Baud Rate = 4000000/(16 (25 + 1)) = 9615 Error = (Calculated Baud Rate – Desired Baud Rate)/Desired Baud Rate = (9615 - 9600)/9600 = 0.16%

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

#### 19.2 Transmitting in 8-Bit Data Mode

- 1. Set up the UARTx:
  - a) Write appropriate values for data, parity and Stop bits.
  - b) Write appropriate baud rate value to the UxBRG register.
  - c) Set up transmit and receive interrupt enable and priority bits.
- 2. Enable the UARTx.
- 3. Set the UTXEN bit (causes a transmit interrupt, two cycles after being set).
- 4. Write a data byte to the lower byte of the UxTXREG word. The value will be immediately transferred to the Transmit Shift Register (TSR) and the serial bit stream will start shifting out with the next rising edge of the baud clock.
- Alternatively, the data byte may be transferred while UTXEN = 0 and then the user may set UTXEN. This will cause the serial bit stream to begin immediately because the baud clock will start from a cleared state.
- 6. A transmit interrupt will be generated as per interrupt control bits, UTXISEL<1:0>.

#### 19.3 Transmitting in 9-Bit Data Mode

- 1. Set up the UARTx (as described in Section 19.2 "Transmitting in 8-Bit Data Mode").
- 2. Enable the UARTx.
- 3. Set the UTXEN bit (causes a transmit interrupt).
- 4. Write UxTXREG as a 16-bit value only.
- 5. A word write to UxTXREG triggers the transfer of the 9-bit data to the TSR. The serial bit stream will start shifting out with the first rising edge of the baud clock.
- 6. A transmit interrupt will be generated as per the setting of control bits, UTXISELx.

# 19.4 Break and Sync Transmit Sequence

The following sequence will send a message frame header, made up of a Break, followed by an auto-baud Sync byte.

- 1. Configure the UARTx for the desired mode.
- 2. Set UTXEN and UTXBRK to set up the Break character.
- 3. Load the UxTXREG with a dummy character to initiate transmission (value is ignored).
- 4. Write '55h' to UxTXREG; this loads the Sync character into the transmit FIFO.
- 5. After the Break has been sent, the UTXBRK bit is reset by hardware. The Sync character now transmits.

# 19.5 Receiving in 8-Bit or 9-Bit Data Mode

- 1. Set up the UARTx (as described in Section 19.2 "Transmitting in 8-Bit Data Mode").
- Enable the UARTx by setting the URXEN bit (UxSTA<12>).
- 3. A receive interrupt will be generated when one or more data characters have been received as per interrupt control bits, URXISEL<1:0>.
- 4. Read the OERR bit to determine if an overrun error has occurred. The OERR bit must be reset in software.
- 5. Read UxRXREG.

The act of reading the UxRXREG character will move the next character to the top of the receive FIFO, including a new set of PERR and FERR values.

# 19.6 Operation of UxCTS and UxRTS Control Pins

UARTx Clear-to-Send (UxCTS) and Request-to-Send (UxRTS) are the two hardware controlled pins that are associated with the UARTx modules. These two pins allow the UARTx to operate in Simplex and Flow Control mode. They are implemented to control the transmission and reception between the Data Terminal Equipment (DTE). The UEN<1:0> bits in the UxMODE register configure these pins.

### 19.7 Infrared Support

The UARTx module provides two types of infrared UART support: one is the IrDA clock output to support an external IrDA encoder and decoder device (legacy module support), and the other is the full implementation of the IrDA encoder and decoder. Note that because the IrDA modes require a 16x baud clock, they will only work when the BRGH bit (UxMODE<3>) is '0'.

#### 19.7.1 IrDA CLOCK OUTPUT FOR EXTERNAL IrDA SUPPORT

To support external IrDA encoder and decoder devices, the BCLKx pin (same as the UxRTS pin) can be configured to generate the 16x baud clock. When UEN<1:0> = 11, the BCLKx pin will output the 16x baud clock if the UARTx module is enabled; it can be used to support the IrDA codec chip.

# 19.7.2 BUILT-IN IrDA ENCODER AND DECODER

The UARTx has full implementation of the IrDA encoder and decoder as part of the UARTx module. The built-in IrDA encoder and decoder functionality is enabled using the IREN bit (UxMODE<12>). When enabled (IREN = 1), the receive pin (UxRX) acts as the input from the infrared receiver. The transmit pin (UxTX) acts as the output to the infrared transmitter.

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
UARTEN <sup>(</sup>	<sup>1)</sup> —	USIDL	IREN <sup>(2)</sup>	RTSMD		UEN1	UEN0
bit 15							bit 8
	C R/W-0			D/M/ O	R/W-0	R/W-0	R/W-0
R/W-0, H0		R/W-0, HC	R/W-0	R/W-0	-		-
WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL1	PDSEL0	STSEL
bit 7							bit (
Legend:		HC = Hardwar	e Clearable b	pit			
R = Reada	able bit	W = Writable b	oit	U = Unimpler	nented bit, read	l as '0'	
-n = Value	at POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkn	own
bit 15	UARTEN: U	JARTx Enable bit <sup>(</sup>	1)				
		is enabled; all UA					
		is disabled; all UAF	-	ontrolled by port	latches, UARTx	power consump	otion is minima
bit 14	•	ented: Read as '0					
bit 13		RTx Stop in Idle M					
		inues module opereties module operati			e mode		
bit 12	IREN: IrDA	<sup>®</sup> Encoder and De	coder Enable	e bit <sup>(2)</sup>			
	1 = IrDA en	coder and decode	r are enable	b			
	0 = IrDA en	coder and decode	r are disable	d			
bit 11		ode Selection for I		it			
		pin is in Simplex r pin is in Flow Con					
bit 10	Unimpleme	ented: Read as '0	,				
bit 9-8		UARTx Enable bi					
	10 = UxTX, 01 = UxTX,	UxRX and BCLK: UxRX, UxCTS ar UxRX and UxRTS and UxRX pins a tches	nd UxRTS pir S pins are en	ns are enabled a abled and <u>used</u>	ind used ; UxCTS pin is	controlled by po	rt latches
bit 7	WAKE: Wal	ke-up on Start Bit	Detect Durin	g Sleep Mode E	nable bit		
	in hard	continues to sam ware on the follow	•	• •	s generated on	the falling edge	, bit is cleare
bit 6		ke-up is enabled JARTx Loopback I	Modo Soloct	hit			
		S Loopback mode		DIL			
		ck mode is disable	ed				
bit 5	-	uto-Baud Enable b					
	cleared	s baud rate meas I in hardware upor ate measurement	n completion		er – requires re	eception of a Sy	nc field (55h
bit 4		ARTx Receive Po		-			
		dle state is '0'	,				
		dle state is '1'					
		L, the peripheral in on, see <b>Section 1</b>	-		-	available RPn/R	PIn pin. For

REGISTER 19-1: UxMODE: UARTx MODE REGISTER

2: This feature is only available for the 16x BRG mode (BRGH = 0).

#### REGISTER 19-1: UxMODE: UARTx MODE REGISTER (CONTINUED)

- bit 3 BRGH: High Baud Rate Enable bit
  - 1 = High-Speed mode (4 BRG clock cycles per bit)0 = Standard Speed mode (16 BRG clock cycles per bit)
- bit 2-1 **PDSEL<1:0>:** Parity and Data Selection bits
- 11 = 9-bit data, no parity
  10 = 8-bit data, odd parity
  01 = 8-bit data, even parity
  - 01 = 8-bit data, even parity
- bit 0 STSEL: Stop Bit Selection bit
  - 1 = Two Stop bits
  - 0 = One Stop bit
- Note 1: If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".
  - **2:** This feature is only available for the 16x BRG mode (BRGH = 0).

	R/W-0	R/W-0	R/W-0	R/W-0, HC	R/W-0	R-0, HSC	R-1, HSC					
UTXISEL1	UTXINV <sup>(1)</sup>	UTXISEL0	URXEN	UTXBRK	UTXEN <sup>(2)</sup>	UTXBF	TRMT					
bit 15							bit 8					
R/W-0	R/W-0	R/W-0	R-1, HSC	R-0, HSC	R-0, HSC	R/C-0, HS	R-0, HSC					
URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA					
bit 7							bit (					
			h:+		are Cetteble/C	leeveble bit						
Legend:	L.:.	C = Clearable		HSC = Hardw								
R = Readable		W = Writable I	DIt	U = Unimplem								
-n = Value at F	-	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown					
HS = Hardware	e Settable bit	HC = Hardwa	re Clearable b	it								
hit 15 10			omionion Into	munt Mada Cala	ation hita							
bit 15,13			ismission inter	rrupt Mode Sele	ection bits							
	11 = Reserved; do not use 10 = Interrupt when a character is transferred to the Transmit Shift Register (TSR), and as a result, the											
	transmit buffer becomes empty											
	01 = Interrupt when the last character is shifted out of the Transmit Shift Register; all transmit											
	operations are completed 00 = Interrupt when a character is transferred to the Transmit Shift Register (this implies there is at leas											
	one character open in the transmit buffer)											
bit 14	UTXINV: UARTx IrDA <sup>®</sup> Encoder Transmit Polarity Inversion bit <sup>(1)</sup>											
	IREN = 0:											
	1 = UxTX Idle state is '0'											
	0 = UxTX Idle state is '1'											
	IREN = 1: 1 = UxTX Idle state is '1'											
	0 = UxTX Idle											
bit 12	URXEN: UAR	RTx Receive En	able bit									
	1 = Receive is enabled, UxRX pin is controlled by UARTx											
	0 = Receive is disabled, UxRX pin is controlled by the port											
bit 11	UTXBRK: UA	RTx Transmit E	Break bit									
	1 = Sends Sync Break on next transmission – Start bit, followed by twelve '0' bits, followed by Stop bit											
	cleared by hardware upon completion 0 = Sync Break transmission is disabled or completed											
bit 10	0 = Sync Break transmission is disabled or completed UTXEN: UARTx Transmit Enable bit(2)											
bit to	1 = Transmit is enabled, UxTX pin is controlled by UARTx											
	0 = Transmit is disabled, any pending transmission is aborted and the buffer is reset; UxTX pin is											
		d by the port										
bit 9			ffer Full Status	s bit (read-only)								
	<ul> <li>1 = Transmit buffer is full</li> <li>0 = Transmit buffer is not full, at least one more character can be written</li> </ul>											
					can de Written							
<b>h</b> : 1 0	TRMT: Transmit Shift Register Empty bit (read-only)											
bit 8		-			<ul> <li>1 = Transmit Shift Register is empty and transmit buffer is empty (the last transmission has completed)</li> <li>0 = Transmit Shift Register is not empty, a transmission is in progress or gueued</li> </ul>							
bit 8	1 = Transmit S	Shift Register is	empty and tra	insmit buffer is e			as completed					

REGISTER 19-2:	<b>UxSTA: UARTx STATUS AND CONTROL REGISTER</b>
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2: If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".

# REGISTER 19-2: UxSTA: UARTx STATUS AND CONTROL REGISTER (CONTINUED)

bit 7-6	URXISEL<1:0>: UARTx Receive Interrupt Mode Selection bits
	<ul> <li>11 = Interrupt is set on an RSR transfer, making the receive buffer full (i.e., has 4 data characters)</li> <li>10 = Interrupt is set on an RSR transfer, making the receive buffer 3/4 full (i.e., has 3 data characters)</li> <li>0x = Interrupt is set when any character is received and transferred from the RSR to the receive buffer; receive buffer has one or more characters</li> </ul>
bit 5	ADDEN: Address Character Detect bit (bit 8 of received data = 1)
	<ul> <li>1 = Address Detect mode is enabled (if 9-bit mode is not selected, this does not take effect)</li> <li>0 = Address Detect mode is disabled</li> </ul>
bit 4	RIDLE: Receiver Idle bit (read-only)
	1 = Receiver is Idle 0 = Receiver is active
bit 3	PERR: Parity Error Status bit (read-only)
	<ul> <li>1 = Parity error has been detected for the current character (the character at the top of the receive FIFO)</li> <li>0 = Parity error has not been detected</li> </ul>
bit 2	FERR: Framing Error Status bit (read-only)
	<ul> <li>1 = Framing error has been detected for the current character (the character at the top of the receive FIFO)</li> <li>0 = Framing error has not been detected</li> </ul>
bit 1	OERR: Receive Buffer Overrun Error Status bit (clear/read-only)
	<ul> <li>1 = Receive buffer has overflowed</li> <li>0 = Receive buffer has not overflowed (clearing a previously set OERR bit ('1' to '0' transition) will reset the receive buffer and the RSR to the empty state)</li> </ul>
bit 0	URXDA: UARTx Receive Buffer Data Available bit (read-only)
	<ul> <li>1 = Receive buffer has data, at least one more character can be read</li> <li>0 = Receive buffer is empty</li> </ul>
Note 1:	The value of this bit only affects the transmit properties of the module when the $IrDA^{(B)}$ encoder is enabled (IREN = 1).

2: If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".

#### REGISTER 19-3: UxRXREG: UARTx RECEIVE REGISTER (NORMALLY READ-ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R-0	
	_	—		_	_	_	UxRXREG8	
bit 15				-			bit 8	
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	
			UxRX	REG<7:0>				
bit 7							bit 0	
Legend:								
R = Readable bit W = Writable bit			it	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set				'0' = Bit is cleared x = Bit is unknown				

bit 15-9 Unimplemented: Read as '0'

bit 8-0 UxRXREG<8:0>: Data of the Received Character bits

#### REGISTER 19-4: UxTXREG: UARTx TRANSMIT REGISTER (NORMALLY WRITE-ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	W-x
—	—			—		—	UxTXREG8
bit 15							bit 8

W-x	W-x	W-x	W-x	W-x	W-x	W-x	W-x			
	UxTXREG<7:0>									
bit 7							bit 0			

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-9 Unimplemented: Read as '0'

bit 8-0 UxTXREG<8:0>: Data of the Transmitted Character bits

#### REGISTER 19-5: UxBRG: UARTx BAUD RATE GENERATOR REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			BRO	6<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			BR	G<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit W = Writ		W = Writable b	e bit U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit		'1' = Bit is set	et '0' = Bit is cleared x = Bit is unkn				nown

bit 15-0 BRG<15:0>: Baud Rate Divisor bits

#### REGISTER 19-6: UxADMD: UARTx ADDRESS DETECT AND MATCH REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
ADMMASK7	ADMMASK6	ADMMASK5	ADMMASK4	ADMMASK3	ADMMASK2	ADMMASK1	ADMMASK0	
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
ADMADDR7	ADMADDR6	ADMADDR5	ADMADDR4	ADMADDR3	ADMADDR2	ADMADDR1	ADMADDR0	
bit 7							bit 0	
Legend:								
R = Readable	bit	W = Writable I	oit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		
bit 15_8				MD<7.0>) Mag	skina hite			

DIT 15-8	ADMMASK ?:0 : ADMADDR ?:0 (UXADMD ?:0 ) Masking bits
	For ADMMASKx:
	1 = ADMADDRx is used to detect the address match
	0 = ADMADDRx is not used to detect the address match
bit 7-0	ADMADDR<7:0>: Address Detect Task Off-Load bits
	Used with the ADMMASK<7:0> bits (UxADMD<15:8> to off-load the task of detecting the address character from the processor during Address Detect mode.

# 20.0 ENHANCED PARALLEL MASTER PORT (EPMP)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Enhanced Parallel Master Port (EPMP)" (DS39730), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Enhanced Parallel Master Port (EPMP) module provides a parallel, 4-bit (Master mode only) or 8-bit (Master and Slave modes) data bus interface to communicate with off-chip modules, such as memories, FIFOs, LCD Controllers and other microcontrollers. This module can serve as either the master or the slave on the communication bus.

For EPMP Master modes, all external addresses are mapped into the internal Extended Data Space (EDS). This is done by allocating a region of the EDS for each Chip Select, and then assigning each Chip Select to a particular external resource, such as a memory or external controller. This region should not be assigned to another device resource, such as RAM or SFRs. To perform a write or read on an external resource, the CPU simply performs a write or read within the address range assigned for the EPMP. Key features of the EPMP module are:

- Extended Data Space (EDS) Interface Allows
   Direct Access from the CPU
- Up to 10 Programmable Address Lines
- · Up to 2 Chip Select Lines
- Up to 2 Acknowledgment Lines (one per Chip Select)
- 4-Bit or 8-Bit Wide Data Bus
- Programmable Strobe Options (per Chip Select):
  - Individual read and write strobes or;
    Read/Write strobe with enable strobe
- Programmable Address/Data Multiplexing
- Programmable Address Wait States
- Programmable Data Wait States (per Chip Select)
- Programmable Polarity on Control Signals (per Chip Select)
- · Legacy Parallel Slave Port Support
- Enhanced Parallel Slave Support:
  - Address support
  - 4-byte deep auto-incrementing buffer

Only the higher pin count packages in the family implement the EPMP. The EPMP feature is not available on 28-pin devices.

#### 20.1 Memory Addressable in Different Modes

The memory space addressable by the device depends on the address/data multiplexing selection; it varies from 1K to 2 MB. Refer to Table 20-1 for different Memory-Addressable modes.

#### 20.2 PMDOUT1 and PMDOUT2 Registers

The EPMP Data Output 1 and Data Output 2 registers are used only in Slave mode. These registers act as a buffer for outgoing data.

# 20.3 PMDIN1 and PMDIN2 Registers

The EPMP Data Input 1 and Data Input 2 registers are used in Slave modes to buffer incoming data. These registers hold data that is asynchronously clocked in. In Master mode, PMDIN1 is the holding register for incoming data.

Data Port Size	PMA<9:8>	PMA<7:0>	PMD<7:4>	PMD<3:0>	Accessible Memory	
	Demulti	plexed Address	(ADRMUX<1:0>	= 00)		
8-Bit (PTSZ<1:0> = 00)	Addr<9:8>	Addr<7:0>	Data		1K	
4-Bit (PTSZ<1:0> = 01)	Addr<9:8>	Addr<7:0>	—	Data	1K	
	1 Ad	dress Phase (AD	<b>ORMUX&lt;1:0&gt; =</b> 0	1)		
8-Bit (PTSZ<1:0> = 00)	—	PMALL	Addr<7	0> Data	1K	
4-Bit (PTSZ<1:0> = 01)	Addr<9:8>	PMALL	Addr<7:4>	Addr<3:0>	1K	
			—	Data (1)	7	
	2 Add	Iress Phases (Al	DRMUX<1:0> = 1	.0)	·	
8-Bit (PTSZ<1:0> = 00)	_	PMALL	Addr<7:0>		64K	
		PMALH	Addr<	:15:8>	7	
		_	Da	ata	1	
4-Bit (PTSZ<1:0> = 01)	Addr<9:8>	PMALL	Addr<3:0>		1K	
		PMALH	Addr	<7:4>	7	
		—	Da	ata	7	
	3 Add	Iress Phases (Al	DRMUX<1:0> = 1	.1)	·	
8-Bit (PTSZ<1:0> = 00)	—	PMALL	Addr	<7:0>	2 Mbytes	
		PMALH	Addr<	:15:8>	7	
		PMALU	Addr<	22:16>	7	
		_	Da	ata	7	
4-Bit (PTSZ<1:0> = 01)	Addr<13:12>	PMALL	Addr	<3:0>	16K	
		PMALH	Addr	<7:4>	1	
		PMALU	Addr<	:11:8>	1	
		_	Da	ata	1	

#### TABLE 20-1: EPMP FEATURE DIFFERENCES BY DEVICE PIN COUNT

Pin Name (Alternate Function)	Туре	Description
PMA<22:16>	0	Address Bus bits<22:16>
PMA14	0	Address Bus bit 14
	I/O	Data Bus bit 14 (16-bit port with Multiplexed Addressing)
(PMCS1)	0	Chip Select 1 (alternate location)
PMA<13:8>	0	Address Bus bits<13:8>
Γ	I/O	Data Bus bits<13:8> (16-bit port with Multiplexed Addressing)
PMA<7:3>	0	Address Bus bits<7:3>
PMA2	0	Address Bus bit 2
(PMALU)	0	Address Latch Upper Strobe for Multiplexed Address
PMA1	I/O	Address Bus bit 1
(PMALH)	0	Address Latch High Strobe for Multiplexed Address
PMA0	I/O	Address Bus bit 0
(PMALL)	0	Address Latch Low Strobe for Multiplexed Address
PMD<15:8>	I/O	Data Bus bits<15:8> (Demultiplexed Addressing)
PMD<7:4>	I/O	Data Bus bits<7:4>
	0	Address Bus bits<7:4> (4-bit port with 1-Phase Multiplexed Addressing)
PMD<3:0>	I/O	Data Bus bits<3:0>
PMCS1	0	Chip Select 1
PMCS2	0	Chip Select 2
PMWR	I/O	Write Strobe <sup>(1)</sup>
(PMENB)	I/O	Enable Signal <sup>(1)</sup>
PMRD	I/O	Read Strobe <sup>(1)</sup>
(PMRD/PMWR)	I/O	Read/Write Signal <sup>(1)</sup>
PMBE1	0	Byte Indicator
PMBE0	0	Nibble or Byte Indicator
PMACK1	I	Acknowledgment Signal 1
PMACK2	I	Acknowledgment Signal 2

**Note 1:** Signal function depends on the setting of the MODE<1:0> and SM bits (PMCON1<9:8> and PMCSxCF<8>).

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0				
PMPEN	_	PSIDL	ADRMUX1	ADRMUX0		MODE1	MODE0				
bit 15							bit				
R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0				
CSF1	CSF0	ALP	ALMODE		BUSKEEP	IRQM1	IRQM0				
bit 7	0010	7121	TENODE		BOOKEE	integration	bit				
Legend: R = Readab	lo hit	W = Writable	hit		nented bit, read	1 00 '0'					
-n = Value a		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	own				
			•	0 Dit io olo		X Dit lo uniti					
bit 15	PMPEN: Par	allel Master Po	rt Enable bit								
	1 = EPMP is										
bit 14	0 = EPMP is	ited: Read as '	0'								
bit 13	•		Stop in Idle Mo	nde hit							
			peration when c		lle mode						
			ation in Idle mo								
bit 12-11	ADRMUX<1:	0>: Address/D	ata Multiplexing	Selection bits							
	11 = Lower address bits are multiplexed with data bits using 3 address phases										
	10 = Lower address bits are multiplexed with data bits using 2 address phases 01 = Lower address bits are multiplexed with data bits using 1 address phase										
			e multiplexed wi		ng 1 address p	nase					
bit 10			-	, pino							
bit 9-8	Unimplemented: Read as '0' MODE<1:0>: Parallel Port Mode Select bits										
	11 = Master mode										
			sed are PMRD								
			ed are PMRD, I								
h:+ 7 C	• •		Port; pins used	are PMRD, PM	IWR, PMCS a	nd PMD<7:0>					
bit 7-6	CSF<1:0>: Chip Select Function bits										
	11 = Reserved 10 = PMA14 is used for Chip Select 1										
	01 = Reserved										
	00 = PMCS2 is used for Chip Select 2, PMCS1 is used for Chip Select 1										
bit 5		s Latch Polarity									
	<ul> <li>1 = Active-high (PMALL, PMALH and PMALU)</li> <li>0 = Active-low (PMALL, PMALH and PMALU)</li> </ul>										
L:1 4		•		LU)							
bit 4		ddress Latch S				at if the ourrant					
		1 = Enables "smart" address strobes (each address phase is only present if the current access would cause a different address in the latch than the previous address)									
		"smart" addres									
bit 3	Unimplemen	ted: Read as '	0'								
bit 2	BUSKEEP: E	Bus Keeper bit									
		•	value when not pedance state			ı					
bit 1-0	IRQM<1:0>:	Interrupt Requ	est Mode bits								
			vhen Read Buff peration when F								
	10 = Reserve	he									
			at the end of a								

## REGISTER 20-1: PMCON1: EPMP CONTROL REGISTER 1

R-0, HSC	U-0	R/C-0, HS	R/C-0, HS	U-0	U-0	U-0	U-0
BUSY	—	ERROR	TIMEOUT	—	—	—	—
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RADDR23 <sup>(1)</sup>	) RADDR22 <sup>(1)</sup>	RADDR21 <sup>(1)</sup>	RADDR20 <sup>(1)</sup>	RADDR19 <sup>(1)</sup>	RADDR18 <sup>(1)</sup>	RADDR17 <sup>(1)</sup>	RADDR16 <sup>(1)</sup>
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimpleme	ented, read as '	0'		
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared x = Bit is unknow		nown	
C = Clearabl	e bit	HS = Hardward	e Settable bit	HSC = Hardwa	are Settable/Cl	earable bit	
bit 15	BUSY: Busy b	oit (Master mod	e only)				
	1 = Port is bu	,					
	0 = Port is no	2					
bit 14	Unimplement	ted: Read as '0	)'				
bit 13	ERROR: Erro	r bit					
1 = Transaction error (illegal transaction was requested)							
				• •			
		on completed s					
bit 12		•					
bit 12	0 = Transacti TIMEOUT: Tir 1 = Transacti	ne-out bit on timed out	successfully				
	0 = Transacti TIMEOUT: Tir 1 = Transacti 0 = Transacti	ne-out bit on timed out on completed s	successfully successfully				
bit 12 bit 11-8	0 = Transacti TIMEOUT: Tir 1 = Transacti 0 = Transacti	ne-out bit on timed out	successfully successfully				

#### REGISTER 20-2: PMCON2: EPMP CONTROL REGISTER 2

Note 1: If RADDR<23:16> = 00000000, then the last EDS address for Chip Select 2 will be FFFFFh.

R/W-0 PTWREN bit 15 U-0  bit 7	R/W-0 PTRDEN U-0	R/W-0 PTBE1EN U-0	R/W-0 PTBE0EN	U-0	R/W-0 AWAITM1	R/W-0 AWAITM0	R/W-0 AWAITE			
bit 15 U-0 —			PTBE0EN	—	AWAITM1	AWAITM0	AWAITE			
U-0 —	U-0	U-0								
—	U-0	U-0					bit 8			
—	U-0	U-0								
	_		U-0	U-0	U-0	U-0	U-0			
hit 7				<u> </u>						
bit 7 bit										
Legend:										
R = Readable	e bit	W = Writable I	oit	U = Unimplem	nented bit, read	l as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own			
bit 15	PTWREN: Wr	ite/Enable Stro	be Port Enable	e bit						
	1 = PMWR/PMENB port is enabled									
L:L 4 4	0 = PMWR/PMENB port is disabled									
bit 14	PTRDEN: Read/Write Strobe Port Enable bit 1 = PMRD/PMWR port is enabled									
		MWR port is dis								
bit 13		gh Nibble/Byte		nable bit						
	1 = PMBE1 p									
	0 = PMBE1 p	ort is disabled								
bit 12	PTBE0EN: Lo	w Nibble/Byte	Enable Port E	nable bit						
	1 = PMBE0 p									
	-	ort is disabled								
bit 11	-	ted: Read as '(								
bit 10-9		>: Address Lat	ch Strobe Wait	State bits						
	11 = Wait of 3									
		10 = Wait of 2½ Tcy 01 = Wait of 1½ Tcy								
	00 = Wait of ½	∕₂ TCY								
bit 8	AWAITE: Add	Iress Hold After	Address Latc	h Strobe Wait S	state bits					
	1 = Wait of 1									
	$0 = $ Wait of $\frac{1}{4}$									
bit 7-0	Unimplement	ted: Read as '0	)'							

#### REGISTER 20-3: PMCON3: EPMP CONTROL REGISTER 3

#### REGISTER 20-4: PMCON4: EPMP CONTROL REGISTER 4

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
	PTEN14			PTEN	<13:8>			
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
	PTEN<7:3>					PTEN<2:0>		
bit 7							bit 0	
<u></u>								
Legend:								
R = Readabl	e bit	W = Writable	bit	U = Unimplemented bit, read as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown		
bit 15	Unimpleme	nted: Read as '0	)'					
bit 14	PTEN14: PM	IA14 Port Enabl	e bit					
		functions as eith functions as por		ne 14 or Chip S	elect 1			
bit 13-3	PTEN<13:3>	: EPMP Addres	s Port Enable	bits				
	1 = PMA<13	3:3> function as	EPMP addres	s lines				
	0 = PMA<13	3:3> function as	port I/Os					
bit 2-0	PTEN<2:0>:	PMALU/PMALH	H/PMALL Strol	be Enable bits				
		0> function as e 0> function as p		lines or address	alatch strobes			

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0				
CSDIS	CSP	CSPTEN	BEP		WRSP	RDSP	SM				
bit 15							bit 8				
			11.0	11.0		11.0					
R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0				
ACKP	PTSZ1	PTSZ0	—	—	—	_					
bit 7							bit (				
Legend:											
R = Readab	le bit	W = Writable	bit	U = Unimplen	nented bit, rea	d as '0'					
-n = Value a	It POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown				
bit 15	•	Select x Disab									
		the Chip Selec									
		the Chip Selec		у							
bit 14		elect x Polarity	DIT								
	1 = Active-hi										
bit 13	0 = Active-low (PMCSx) CSPTEN: PMCSx Port Enable bit										
	1 = PMCSx port is enabled										
		port is disabled									
bit 12	BEP: Chip Se	elect x Nibble/E	Byte Enable Po	larity bit							
		yte enable is ac									
	-	yte enable is ac		E0, PMBE1)							
bit 11	-	ted: Read as '									
bit 10	<b>WRSP:</b> Chip Select x Write Strobe Polarity bit For Slave modes and Master mode when SM = 0:										
				SM = 0:							
		obe is active-hi obe is active-lo									
		ode when SM	. ,								
		trobe is active-		)							
		trobe is active-									
bit 9	RDSP: Chip S	Select x Read	Strobe Polarity	' bit							
		des and Maste		SM = 0:							
		obe is active-hi									
		obe is active-lo									
		ode when SM									
		ite strobe is act									
bit 8		ect x Strobe M	•	,							
				MRD/PMWR an	d PMENB)						
	0 = Reads a	nd writes strobe	es (PMRD and	I PMWR)	-						
bit 7	ACKP: Chip	Select x Ackno	wledge Polarit	y bit							
		ctive-high (PM) ctive-low (PMA	/								
bit 6-5	PTSZ<1:0>:	Chip Select x F	ort Size bits								
	11 = Reserve	ed									
	10 = Reserve		•								
	•	rt size (PMD<3 rt size (PMD<7	,								
hit 4 0	-	rt size (PMD<7	-								
bit 4-0	Unimplemen	ted: Read as '	U								

# REGISTER 20-5: PMCSxCF: EPMP CHIP SELECT x CONFIGURATION REGISTER

#### REGISTER 20-6: PMCSxBS: EPMP CHIP SELECT x BASE ADDRESS REGISTER<sup>(2)</sup>

R/W <sup>(1)</sup>	R/W <sup>(1)</sup>	R/W <sup>(1)</sup>	R/W <sup>(1)</sup>	R/W <sup>(1)</sup>	R/W <sup>(1)</sup>	R/W <sup>(1)</sup>	R/W <sup>(1)</sup>
			BASE	<23:16>			
bit 15							bit 8
(1)				(1)			
R/W <sup>(1)</sup>	U-0	U-0	U-0	R/W <sup>(1)</sup>	U-0	U-0	U-0
BASE15	—	—	—	BASE11	—	—	—
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable b	oit	U = Unimplem	ented bit, read	d as '0'	
-n = Value at POR '1' = Bit is set			'0' = Bit is clea	ared	x = Bit is unknown		
bit 15-7	BASE<23:1	5>: Chip Select x	Base Addre	ss bits <sup>(1)</sup>			
h:+ C 4		mtadi Daad aa (o	,				

bit 6-4 Unimplemented: Read as '0'

bit 3 BASE11: Chip Select x Base Address bit<sup>(1)</sup>

bit 2-0 Unimplemented: Read as '0'

Note 1: The value at POR is 0080h for PMCS1BS and 8080h for PMCS2BS.

2: If the whole PMCS2BS register is written together as 0x0000, then the last EDS address for the Chip Select 1 will be FFFFFh. In this case, Chip Select 2 should not be used. PMCS1BS has no such feature.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0			
ACKM1	ACKM0	AMWAIT2	AMWAIT1	AMWAIT0		_				
bit 15	•						bit 8			
DAMA	D/14/ 0	DAMA	DANO	DAMA	DAMA	<b>D</b> /// 0	DAMA			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
DWAITB1 bit 7	DWAITB0	DWAITM3	DWAITM2	DWAITM1	DWAITM0	DWAITE1	DWAITE0 bit 0			
							Dit C			
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimplem	ented bit, read	l as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	iown			
bit 15-14	ACKM<1:0>:	Chip Select x	Acknowledge N	/lode bits						
	11 = Reserve									
				a read/write ope						
	01 = PMACKx is used to determine when a read/write operation is complete with time-out $(f_{\rm DWA})$									
	(If DWAITM<3:0> = 0000, the maximum time-out is 255 TcY or else it is DWAITM<3:0> cycles.) 00 = PMACKx is not used									
bit 13-11	AMWAIT<2:0	>: Chip Select	x Alternate Ma	ster Wait State	bits					
	111 = Wait of 10 alternate master cycles									
		f 4 alternate ma f 3 alternate ma	-							
bit 10-8	000 = Wait of 3 alternate master cycles Unimplemented: Read as '0'									
bit 7-6	-			Before Read/Wr	ite Strobe Wait	State bits				
	11 = Wait of 3¼ TCY									
	10 = Wait of 2									
	01 = Wait of									
bit 5-2	00 = Wait of C		v Data Boad/M	Vrite Strobe Wa	it Stata hite					
DIL 3-2	For Write Ope	-	x Dala Redu/v							
	1111 = Wait									
	0001 = Wait									
	0000 = Wait									
	For Read Ope									
		01 1074 101								
	0001 = Wait									
bit 1-0	0000 = Wait of <sup>3</sup> / <sub>4</sub> Tcy DWAITE<1:0>: Chip Select x Data Hold After Read/Write Strobe Wait State bits									
	For Write Ope	•								
	11 = Wait of 3									
	10 = Wait of 2									
	01 = Wait of 00 = Wait of									
	For Read Op									
	11 = Wait of 3									
	10 = Wait of 2	2 TCY								
	10 = Wait of 2 01 = Wait of 2 00 = Wait of 0	1 TCY								

#### REGISTER 20-7: PMCSxMD: EPMP CHIP SELECT x MODE REGISTER

#### REGISTER 20-8: PMSTAT: EPMP STATUS REGISTER (SLAVE MODE ONLY)

R-0, HSC	R/W-0, HS	U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
IBF	IBOV	—	—	IB3F <sup>(1)</sup>	IB2F <sup>(1)</sup>	IB1F <sup>(1)</sup>	IB0F <sup>(1)</sup>
bit 15							bit 8

R-1, HSC	R/W-0, HS	U-0	U-0	R-1, HSC	R-1, HSC	R-1, HSC	R-1, HSC
OBE	OBUF	—	—	OB3E	OB2E	OB1E	OB0E
bit 7							bit 0

Legend:	HS = Hardware Settable bit	HSC = Hardware Settable/C	learable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	IBF: Input Buffer Full Status bit
	1 = All writable Input Buffer registers are full
	0 = Some or all of the writable Input Buffer registers are empty
bit 14	IBOV: Input Buffer Overflow Status bit
	<ul> <li>1 = A write attempt to a full Input register occurred (must be cleared in software)</li> <li>0 = No overflow occurred</li> </ul>
bit 13-12	Unimplemented: Read as '0'
bit 11-8	IB3F:IB0F: Input Buffer x Status Full bits <sup>(1)</sup>
	1 = Input buffer contains unread data (reading the buffer will clear this bit)
	0 = Input buffer does not contain unread data
bit 7	OBE: Output Buffer Empty Status bit
	1 = All readable Output Buffer registers are empty
	0 = Some or all of the readable Output Buffer registers are full
bit 6	OBUF: Output Buffer Underflow Status bit
	<ul><li>1 = A read occurred from an empty Output Buffer register (must be cleared in software)</li><li>0 = No underflow occurred</li></ul>
bit 5-4	Unimplemented: Read as '0'
bit 3-0	<b>OB3E:OB0E:</b> Output Buffer x Status Empty bits
	1 = Output Buffer x is empty (writing data to the buffer will clear this bit)
	0 = Output Buffer x contains untransmitted data

**Note 1:** Even though an individual bit represents the byte in the buffer, the bits corresponding to the word (Byte 0 and 1 or Byte 2 and 3) get cleared, even on byte reading.

R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
IOCON	—	_	—	—			—		
bit 15							bit 8		
U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0		
—	—	—	—	—	—	—	PMPTTL		
bit 7	bit 7 bit 0								
Legend:	Legend:								

### REGISTER 20-9: PADCON: PAD CONFIGURATION CONTROL REGISTER

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 IOCON: Used for Non-PMP functionality

bit 14-1 Unimplemented: Read as '0'

bit 0

PMPTTL: EPMP Module TTL Input Buffer Select bit

1 = EPMP module inputs (PMDx, PMCS1) use TTL input buffers

0 = EPMP module inputs use Schmitt Trigger input buffers

# 21.0 REAL-TIME CLOCK AND CALENDAR (RTCC) WITH TIMESTAMP

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Real-Time Clock and Calendar, refer to the "dsPIC33/PIC24 Family Reference Manual", "RTCC with Timestamp" (DS70005193), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The RTCC provides the user with a Real-Time Clock and Calendar (RTCC) function that can be calibrated.

Key features of the RTCC module are:

- Selectable Clock Source
- Provides Hours, Minutes and Seconds Using 24-Hour Format
- · Visibility of One Half Second Period
- Provides Calendar Weekday, Date, Month and Year
- Alarm-Configurable for Half a Second, 1 Second, 10 Seconds, 1 Minute, 10 Minutes, 1 Hour, 1 Day, 1 Week, 1 Month or 1 Year
- Alarm Repeat with Decrementing Counter
- · Alarm with Indefinite Repeat Chime
- Year 2000 to 2099 Leap Year Correction
- BCD Format for Smaller Software Overhead
- Optimized for Long-Term Battery Operation
- User Calibration of the 32.768 kHz Clock Crystal/32 kHz INTRC Frequency with Periodic Auto-Adjust
- Fractional Second Synchronization
- Calibration to within ±2.64 Seconds Error per Month
- Calibrates up to 260 ppm of Crystal Error
- Ability to Periodically Wake-up External Devices without CPU Intervention (external power control)
- Power Control Output for External Circuit Control
- Calibration takes Effect Every 15 Seconds
- Timestamp Capture register for Time and Date
- Programmable Prescaler and Clock Divider Circuit allows Operation with Any Clock Source up to 32 MHz, Including 32.768 kHz Crystal, 50/60 Hz Powerline Clock, External Real-Time Clock (RTC) or 31.25 kHz LPRC Clock

# 21.1 RTCC Source Clock

The RTCC clock divider block converts the incoming oscillator source into accurate 1/2 and 1 second clocks for the RTCC. The clock divider is optimized to work with three different oscillator sources:

- · 32.768 kHz crystal oscillator
- 31 kHz Low-Power RC Oscillator (LPRC)
- External 50 Hz or 60 Hz powerline frequency

An asynchronous prescaler, PS<1:0> (RTCCON2L<5:4>), is provided that allows the RTCC to work with higher speed clock sources, such as the system clock. Divide ratios of 1:16, 1:64 or 1:256 may be selected, allowing sources up to 32 MHz to clock the RTCC.

#### 21.1.1 COARSE FREQUENCY DIVISION

The clock divider block has a 16-bit counter used to divide the input clock frequency. The divide ratio is set by the DIV<15:0> register bits (RTCCON2H<15:0>). The DIV<15:0> bits should be programmed with a value to produce a nominal 1/2 second clock divider count period.

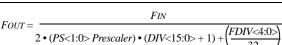
#### 21.1.2 FINE FREQUENCY DIVISION

The fine frequency division is set using the FDIV<4:0> (RTCCON2L<15:11>) bits. Increasing the FDIVx value will lengthen the overall clock divider period.

If FDIV<4:0> = 00000, the fine frequency division circuit is effectively disabled. Otherwise, it will optionally remove a clock pulse from the input of the clock divider every 1/2 second. This functionality will allow the user to remove up to 31 pulses over a fixed period of 16 seconds, depending on the value of FDIVx.

The value for DIV<15:0> is calculated as shown in Equation 21-1. The fractional remainder of the DIV<15:0> calculation result can be used to calculate the value for FDIV<4:0>.

#### EQUATION 21-1: RTCC CLOCK DIVIDER OUTPUT FREQUENCY

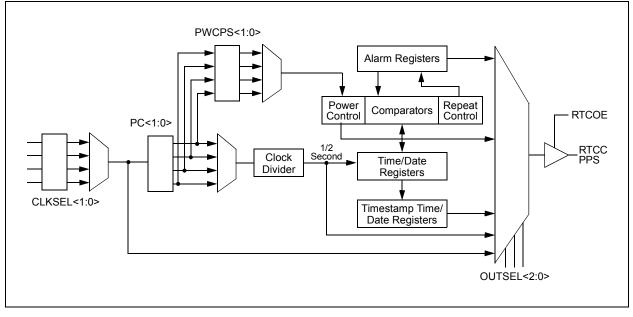


The DIV<15:0> value is the integer part of this calculation:

$$DIV < 15:0 > = \frac{FIN}{2 \cdot (PS < 1:0 > Prescaler)} - 1$$

The FDIV<4:0> value is the fractional part of the DIV<15:0> calculation, multiplied by 32.

#### FIGURE 21-1: RTCC BLOCK DIAGRAM



#### 21.2 RTCC Module Registers

The RTCC module registers are organized into four categories:

- RTCC Control Registers
- RTCC Value Registers
- Alarm Value Registers
- Timestamp Registers

#### 21.2.1 REGISTER MAPPING

Previous RTCC implementations used a Register Pointer to access the RTCC Time and Date registers, as well as the Alarm Time and Date registers. These Registers are now mapped to memory and are individually addressable.

#### 21.2.2 WRITE LOCK

To prevent spurious changes to the Time Control or Time Value registers, the WRLOCK bit (RTCCON1L1<11>) must be cleared ('0'). The POR default state is when the WRLOCK bit is '0' and is cleared on any device Reset (POR, BOR, MCLR). It is recommended that the WRLOCK bit be set to '1' after the Date and Time registers are properly initialized, and after the RTCEN bit (RTCCON1L<15>) has been set.

Any attempt to write to the RTCEN bit, the RTCCON2L/H registers, or the Date or Time registers, will be ignored as long as WRLOCK is '1'. The Alarm, Power Control and Timestamp registers can be changed when WRLOCK is '1'.

EXAMPLE 21-1: SETTING THE WRLOCK BIT

Clearing the WRLOCK bit requires an unlock sequence after it has been written to a '1', writing two bytes consecutively to the NVMKEY register. A sample assembly sequence is shown in Example 21-1. If WRLOCK is already cleared, it can be set to '1' without using the unlock sequence.

Note: To avoid accidental writes to the timer, it is recommended that the WRLOCK bit (RTCCON1L<11>) is kept clear at any other time. For the WRLOCK bit to be set, there is only one instruction cycle time window allowed between the 55h/AA sequence and the setting of WRLOCK; therefore, it is recommended that code follow the procedure in Example 21-1.

#### 21.2.3 SELECTING RTCC CLOCK SOURCE

The clock source for the RTCC module can be selected using the CLKSEL<1:0> bits in the RTCCON2L register. When the bits are set to '00', the Secondary Oscillator (SOSC) is used as the reference clock and when the bits are '01', LPRC is used as the reference clock. When CLKSEL<1:0> = 10, the external powerline (50 Hz and 60 Hz) is used as the clock source. When CLKSEL<1:0> = 11, the system clock is used as the clock source.

DISI	#6	;disable interrupts for 6 instructions
MOV	#NVKEY, W1	
MOV	#0x55, W2	; first unlock code
MOV	W2, [W1]	; write first unlock code
MOV	#0xAA, W3	; second unlock sequence
MOV	W3, [W1]	; write second unlock sequence
BCLR	RTCCON1L, #WRLOCK	; clear the WRLOCK bit

# 21.3 Registers

#### 21.3.1 RTCC CONTROL REGISTERS

### REGISTER 21-1: RTCCON1L: RTCC CONTROL REGISTER 1 (LOW)

R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
RTCEN	—	—	—	WRLOCK	PWCEN	PWCPOL	PWCPOE
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	R/W-0
RTCOE	OUTSEL2	OUTSEL1	OUTSEL0	_	_	_	TSAEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	<b>RTCEN:</b> RTCC Enable bit 1 = RTCC is enabled and counts from selected clock source 0 = RTCC is not enabled
bit 14-12	Unimplemented: Read as '0'
bit 11	WRLOCK: RTCC Register Write Lock
	<ul><li>1 = RTCC registers are locked</li><li>0 = RTCC registers may be written to by user</li></ul>
bit 10	PWCEN: Power Control Enable bit
	<ul><li>1 = Power control is enabled</li><li>0 = Power control is disabled</li></ul>
bit 9	PWCPOL: Power Control Polarity bit
	<ol> <li>Power control output is active-high</li> <li>Power control output is active-low</li> </ol>
bit 8	PWCPOE: Power Control Output Enable bit
	<ul><li>1 = Power control output pin is enabled</li><li>0 = Power control output pin is disabled</li></ul>
bit 7	RTCOE: RTCC Output Enable bit
	<ul><li>1 = RTCC output is enabled</li><li>0 = RTCC output is disabled</li></ul>
bit 6-4	OUTSEL<2:0>: RTCC Output Signal Selection bits
	111 = Unused 110 = Unused
	101 = Unused
	100 = Timestamp A event 011 = Power control
	010 = RTCC input clock
	001 = Second clock
	000 = Alarm event
bit 3-1	Unimplemented: Read as '0'
bit 0	<b>TSAEN:</b> Timestamp A Enable bit
	<ul> <li>1 = Timestamp event will occur when a low pulse is detected on the TMPRN pin</li> <li>0 = Timestamp is disabled</li> </ul>

### REGISTER 21-2: RTCCON1H: RTCC CONTROL REGISTER 1 (HIGH)

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0			
ALRMEN	CHIME	—	—	AMASK3	AMASK2	AMASK1	AMASK0			
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
ALMRPT7	ALMRPT6	ALMRPT5	ALMRPT4	ALMRPT3	ALMRPT2	ALMRPT1	ALMRPTO			
bit 7	7.2.011	, izini ti ro	, ( <b>L</b> ini († † †		,	, , , , , , , , , , , , , , , , , , , ,	bit (			
Legend:										
R = Readable	a hit	W = Writable b	nit		nented bit, read	1 26 (0)				
-n = Value at		'1' = Bit is set	JIL	'0' = Bit is clea		x = Bit is unkr				
	FUR	I - DILIS SEL			areu		IOWIT			
bit 15	ALRMEN: Ala	arm Enable bit								
	1 = Alarm is ( CHIME = 0 = Alarm is (	/	d automaticall	y after an alarn	n event whenev	ver ALMRPT<7	7:0> = 00h and			
bit 14	CHIME: Chim									
	1 = Chime is	enabled; ALMR								
		disabled; ALMF		stop once they	reach 00h					
bit 13-12	-	ted: Read as '0								
bit 11-8		>: Alarm Mask (	Configuration b	oits						
	0000 = Every 0000 = Every									
	0010 = Every									
	0011 = Every									
	0100 = Every									
	0101 = Every									
	0110 = Once a day									
	0111 = Once a week									
	1000 = Once a month									
	1001 = Once a year (except when configured for February 29th, once every 4 years) 101x = Reserved – do not use									
bit 7-0	11xx = Reserved – do not use <b>ALMRPT&lt;7:0&gt;:</b> Alarm Repeat Counter Value bits									
	11111111 = Alarm will repeat 255 more times									
	•									
	•									
	•	Alarm will repea	4.0	_						

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0			
FDIV4	FDIV3	FDIV2	FDIV1	FDIV0	_	—				
bit 15	·	•					bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0			
PWCPS1	PWCPS0	PS1	PS0	—	_	CLKSEL1	CLKSEL0			
bit 7							bit C			
Legend:										
R = Readable	e bit	W = Writable	oit	U = Unimplem	ented bit, rea	ad as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown			
				ut clock cycles e ut clock cycles e						
bit 10-8		ted: Read as '(	•			105				
bit 7-6	<b>PWCPS&lt;1:0&gt;</b> 00 = 1:1 01 = 1:16 10 = 1:64 11 = 1:256	Power Control	bl Prescale Se	elect bits						
bit 5-4	<b>PS&lt;1:0&gt;:</b> Pre 00 = 1:1 01 = 1:16 10 = 1:64 11 = 1:256	scale Select bi	ts							
bit 3-2	Unimplemented: Read as '0'									
bit 1-0	-	>: Clock Select								

#### REGISTER 21-3: RTCCON2L: RTCC CONTROL REGISTER 2 (LOW)

#### 21.3.2 RTCVAL REGISTER MAPPINGS

# REGISTER 21-4: RTCCON2H: RTCC CONTROL REGISTER 2 (HIGH)<sup>(1)</sup>

R/W-0	R/W-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			DIV<	15:8>			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			DIV	<7:0>			
bit 7							bit 0
Legend:							

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 DIV<15:0>: Clock Divide bits

Sets the period of the clock divider counter; value should cause a nominal 1/2 second underflow.

**Note 1:** A write to this register is only allowed when WRLOCK = 1.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
PWCSAMP6	PWCSAMP5	PWCSAMP4	PWCSAMP3	PWCSAMP2	PWCSAMP1	PWCSAMP0	
						bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
PWCSTAB6	PWCSTAB5	PWCSTAB4	PWCSTAB3	PWCSTAB2	PWCSTAB1	PWCSTAB0	
						bit 0	
bit	W = Writable b	bit	U = Unimplem	ented bit, read	as '0'		
POR	'1' = Bit is set		'0' = Bit is clea	ired	x = Bit is unk	nown	
<pre>11111111 = Sample window is always enabled, even when PWCEN = 0 11111110 = Sample window is 254 TPWCCLK clock periods</pre>							
11111111 = S 11111110 = S • •	Stability window Stability window Stability window	is 255 TPWCCLI is 254 TPWCCLI	K clock periods K clock periods	<sub>S</sub> (1)			
	PWCSAMP6         R/W-0         PWCSTAB6         bit         POR         PWCSAMP         PWCSAMP         1111111         S         1111111         S         00000001         PWCSTAB         00000000         PWCSTAB         1111111         S         1111111         S         00000001         N         PWCSTAB         00000001	PWCSAMP6         PWCSAMP5           R/W-0         R/W-0           PWCSTAB6         PWCSTAB5           bit         W = Writable b           POR         '1' = Bit is set           PWCSAMP<7:0>: Power Cor           1111111 = Sample window is           1111110 = Sample window is           00000001 = Sample window is           00000000 = No sample window is           00000000 = No sample window           1111111 = Stability window           1111111 = Stability window           1111111 = Stability window	PWCSAMP6       PWCSAMP5       PWCSAMP4         R/W-0       R/W-0       R/W-0         PWCSTAB6       PWCSTAB5       PWCSTAB4         bit       W = Writable bit       PWCSTAB4         PWCSAMP       1' = Bit is set       PWCSAMP         PWCSAMP       '1' = Bit is set       PWCSAMP         PWCSAMP       '1' = Bit is set       PWCSAMP         PWCSAMP       Sample window is always enable       1111111         Sample window is 254 TPWCCLK       '         ·       00000001 = Sample window is 1 TPWCCLK clc         00000000 = No sample window       PWCSTAB         PWCSTAB       ': Power Control Stability Wi         1111111 = Stability window is 255 TPWCCLI         ·       :         ·       :	PWCSAMP6       PWCSAMP5       PWCSAMP4       PWCSAMP3         R/W-0       R/W-0       R/W-0       R/W-0         PWCSTAB6       PWCSTAB5       PWCSTAB4       PWCSTAB3         bit       W = Writable bit       U = Unimplem         POR       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       PWCSAMP       PWCSTAB5         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       '1' = Bit is set       '0' = Bit is cleated         PWCSAMP       Sample window is always enabled, even when P       '1'1'1'1'1'1'''''''''''''''''''''''''	PWCSAMP6       PWCSAMP5       PWCSAMP4       PWCSAMP3       PWCSAMP2         R/W-0       R/W-0       R/W-0       R/W-0       R/W-0         PWCSTAB6       PWCSTAB5       PWCSTAB4       PWCSTAB3       PWCSTAB2         bit       W = Writable bit       U = Unimplemented bit, read         PWCSAMP       '0' = Bit is cleared         PWCSAMP       PWCSTAB5       PWCSTAB4         PWCSAMP       '0' = Bit is cleared         PWCSAMP       PWCSAMP       '0' = Bit is cleared         PWCSAMP       PWCSTAB5       PWCSTAB5         PWCSAMP       '1' = Bit is set       '0' = Bit is cleared         PWCSAMP       PWCSTON       PWCSTAB5       PWCSTAB5         PWCSAMP       PWCSTON       Sample window is always enabled, even when PWCEN = 0         1111110       = Sample window is 254 TPWCCLK clock periods       '         .       .       .       .         00000001       = Sample window is 1 TPWCCLK clock period       .         00000001       = Sample window       PWCSTAB         PWCSTAB       PWCSTAB       .         .       .       .         .       .       .         .       .       .	PWCSAMP6       PWCSAMP5       PWCSAMP4       PWCSAMP3       PWCSAMP2       PWCSAMP1         R/W-0       R/W-0       R/W-0       R/W-0       R/W-0       R/W-0         PWCSTAB6       PWCSTAB5       PWCSTAB4       PWCSTAB3       PWCSTAB2       PWCSTAB1         bit       W = Writable bit       U = Unimplemented bit, read as '0'       POC       POC       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unk         PWCSAMP       Ti = Bit is set       '0' = Bit is cleared       x = Bit is unk         PWCSAMP       PWCSAMP       PWCSTAB5       PWCSTAB5       PWCSTAB5         PWCSTAB5       PWCSTAB4       PWCSTAB3       PWCSTAB2       PWCSTAB1         PWCSAMP       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unk         PWCSAMP       Power Control Sample Window Timer bits       1111111       Sample window is 254 TPWCCLK clock periods         00000001       Sample window       S1 TPWCCLK clock periods       00000000 = No sample window       255 TPWCCLK clock periods         1111111       Stability window is 254 TPWCCLK clock periods       1111110 = Stability window is 254 TPWCCLK clock periods	

#### REGISTER 21-5: RTCCON3L: RTCC CONTROL REGISTER 3 (LOW)

Note 1: The sample window always starts when the stability window timer expires, except when its initial value is 00h.

U-0       U-0       R/C-0       U-0       R/C-0       R-0         -       -       ALMEVT       -       TSAEVT <sup>(1)</sup> SYNC       ALMSYNC       HAL         bit 7         Legend:       C = Clearable bit       U = Unimplemented bit, read as '0'         n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'       bit 5       ALMEVT: Alarm Event bit       1 = An alarm event has occurred       0 = An alarm event has not occurred         bit 4       Unimplemented: Read as '0'       bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has cocurred         bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has not occurred       0 = A timestamp event has not occurred         bit 4       Unimplemented: Read as '0'       bit 1 = TIME registers may change during software read       0 = TIME registers may change during software read         0 = A timestamp event has not occurred       SYNC: Synchronization Status bit       1 = TIME registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALMENT-7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
-       ALMEVT       -       TSAEVT <sup>(1)</sup> SYNC       ALMSYNC       HAL         bit 7         Legend:       C = Clearable bit       U = Unimplemented bit, read as '0'         -n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'         bit 5       ALMEVT: Alarm Event bit       1 = An alarm event has occurred         0 = An alarm event has not occurred       0 = An alarm event has occurred       0 = A timestamp event has occurred         bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has not occurred         bit 2       SYNC: Synchronization Status bit       1 = TIME registers may change during software read         0 = TIME registers may be read safely       bit 1       ALMSYNC: Alarm Synchronization Status bit         1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second       0 = First half period of a second	_	—	_	—	—	_	_	_			
-       ALMEVT       -       TSAEVT <sup>(1)</sup> SYNC       ALMSYNC       HAL         bit 7         Legend:       C = Clearable bit       U = Unimplemented bit, read as '0'         -n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'         bit 5       ALMEVT: Alarm Event bit       1 = An alarm event has occurred         0 = An alarm event has not occurred       0 = An alarm event has occurred       0 = A timestamp event has occurred         bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred       0 = A timestamp event has occurred         bit 2       SYNC: Synchronization Status bit       1 = TIME registers may change during software read       0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit       1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read       0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second         0 = First half period of a second       0 = First half period of a second	15		·		·			bit			
-       ALMEVT       -       TSAEVT <sup>(1)</sup> SYNC       ALMSYNC       HAL         bit 7         Legend:       C = Clearable bit       U = Unimplemented bit, read as '0'         -n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'         bit 5       ALMEVT: Alarm Event bit       1 = An alarm event has occurred         0 = An alarm event has not occurred       0 = An alarm event has occurred       0 = A timestamp event has occurred         bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred       0 = A timestamp event has occurred         bit 2       SYNC: Synchronization Status bit       1 = TIME registers may change during software read       0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit       1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read       0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second         0 = First half period of a second       0 = First half period of a second											
bit 7         Legend:       C = Clearable bit         R = Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'         -n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'       bit 5       ALMEVT: Alarm Event bit         1 = An alarm event has occurred       0 = An alarm event has not occurred       0 = An alarm event has not occurred         bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred       0 = A timestamp event has occurred         bit 2       SYNC: Synchronization Status bit       1 = TIME registers may change during software read       0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit       1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second       0 = First half period of a second	U-0	U-0	R/C-0	U-0		R-0	R-0	R-0			
Legend:       C = Clearable bit         R = Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'         -n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'         bit 5       ALMEVT: Alarm Event bit         1 = An alarm event has occurred       0 = An alarm event has not occurred         bit 4       Unimplemented: Read as '0'         bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred       0 = A timestamp event has occurred         bit 2       SYNC: Synchronization Status bit         1 = TIME registers may be read safely       Ead as '0'         bit 1       ALMESYNC: Alarm Synchronization Status bit         1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second       0 = First half period of a second			ALMEVT	—	TSAEVT <sup>(1)</sup>	SYNC	ALMSYNC	HALFSEC <sup>(2</sup>			
R = Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'         -n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'       bit 5       ALMEVT: Alarm Event bit         1 = An alarm event has occurred       0 = An alarm event has not occurred       0 = An alarm event has not occurred         bit 4       Unimplemented: Read as '0'       bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred       0 = A timestamp event has not occurred       0 = A timestamp event has not occurred         bit 2       SYNC: Synchronization Status bit       1 = TIME registers may change during software read       0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit       1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = A larm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second       0 = First half period of a second	7							bit			
R = Readable bit       W = Writable bit       U = Unimplemented bit, read as '0'         -n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'       bit 5       ALMEVT: Alarm Event bit         1 = An alarm event has occurred       0 = An alarm event has not occurred       0 = An alarm event has not occurred         bit 4       Unimplemented: Read as '0'       bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has not occurred       0 = A timestamp event has not occurred       0 = A timestamp event has not occurred         bit 2       SYNC: Synchronization Status bit       1 = TIME registers may change during software read       0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit       1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = A larm registers and Alarm Control bits may be written/modified safely       bit 0         HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second         0 = First half period of a second       0 = First half period of a second	aend:		C = Clearable	bit							
-n = Value at POR       '1' = Bit is set       '0' = Bit is cleared       x = Bit is unknown         bit 15-6       Unimplemented: Read as '0'       bit 5       ALMEVT: Alarm Event bit         1 = An alarm event has occurred       0 = An alarm event has not occurred       bit 4         bit 3       TSAEVT: Timestamp A Event bit( <sup>1</sup> )       1 = A timestamp event has occurred         bit 4       Unimplemented: Read as '0'       bit 3         bit 5       FALMEVT: Timestamp A Event bit( <sup>1</sup> )       1 = A timestamp event has occurred         bit 2       SYNC: Synchronization Status bit       1 = TIME registers may change during software read         0 = TIME registers may be read safely       bit 1       ALMSYNC: Alarm Synchronization Status bit         1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely       bit 0         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second         1 = Second half period of a second       0 = First half period of a second	-	ole bit	W = Writable	bit	U = Unimplem	ented bit. read	d as '0'				
bit 15-6 Unimplemented: Read as '0' bit 5 ALMEVT: Alarm Event bit 1 = An alarm event has occurred 0 = An alarm event has not occurred bit 4 Unimplemented: Read as '0' bit 3 TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred 0 = A timestamp event has not occurred bit 2 SYNC: Synchronization Status bit 1 = TIME registers may change during software read 0 = TIME registers may be read safely bit 1 ALMSYNC: Alarm Synchronization Status bit 1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read 0 = Alarm registers and Alarm Control bits may be written/modified safely bit 0 HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second 0 = First half period of a second	= Value a	at POR	'1' = Bit is set		•			nown			
bit 5       ALMEVT: Alarm Event bit         1 = An alarm event has not occurred         0 = An alarm event has not occurred         bit 4       Unimplemented: Read as '0'         bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred         0 = A timestamp event has not occurred         bit 2       SYNC: Synchronization Status bit         1 = TIME registers may change during software read         0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit         1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second       0 = First half period of a second											
<ul> <li>1 = An alarm event has occurred</li> <li>0 = An alarm event has not occurred</li> <li>bit 4 Unimplemented: Read as '0'</li> <li>bit 3 TSAEVT: Timestamp A Event bit<sup>(1)</sup></li> <li>1 = A timestamp event has occurred</li> <li>0 = A timestamp event has not occurred</li> <li>bit 2 SYNC: Synchronization Status bit</li> <li>1 = TIME registers may change during software read</li> <li>0 = TIME registers may be read safely</li> <li>bit 1 ALMSYNC: Alarm Synchronization Status bit</li> <li>1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> <li>bit 0 HALFSEC: Half Second Status bit<sup>(2)</sup></li> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ul>	15-6	Unimplemen	ted: Read as '	)'							
<ul> <li>a larm event has not occurred</li> <li>bit 4</li> <li>Unimplemented: Read as '0'</li> <li>bit 3</li> <li>TSAEVT: Timestamp A Event bit<sup>(1)</sup></li> <li>1 = A timestamp event has occurred</li> <li>0 = A timestamp event has not occurred</li> <li>bit 2</li> <li>SYNC: Synchronization Status bit</li> <li>1 = TIME registers may change during software read</li> <li>0 = TIME registers may be read safely</li> <li>bit 1</li> <li>ALMSYNC: Alarm Synchronization Status bit</li> <li>1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> <li>bit 0</li> <li>HALFSEC: Half Second Status bit<sup>(2)</sup></li> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ul>	5	ALMEVT: Ala	arm Event bit								
<ul> <li>bit 4 Unimplemented: Read as '0'</li> <li>bit 3 TSAEVT: Timestamp A Event bit<sup>(1)</sup> <ol> <li>= A timestamp event has occurred</li> <li>= A timestamp event has not occurred</li> </ol> </li> <li>bit 2 SYNC: Synchronization Status bit <ol> <li>= TIME registers may change during software read</li> <li>= TIME registers may be read safely</li> </ol> </li> <li>bit 1 ALMSYNC: Alarm Synchronization Status bit <ol> <li>= Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>= Alarm registers and Alarm Control bits may be written/modified safely</li> </ol> </li> <li>bit 0 HALFSEC: Half Second Status bit<sup>(2)</sup> <ol> <li>= Second half period of a second</li> <li>= First half period of a second</li> </ol> </li> </ul>		1 = An alarm	event has occu	rred							
bit 3       TSAEVT: Timestamp A Event bit <sup>(1)</sup> 1 = A timestamp event has occurred         0 = A timestamp event has not occurred         bit 2       SYNC: Synchronization Status bit         1 = TIME registers may change during software read         0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit         1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second       0 = First half period of a second		0 <b>= An alarm</b>	event has not o	occurred							
<ul> <li>1 = A timestamp event has occurred</li> <li>0 = A timestamp event has not occurred</li> <li>bit 2</li> <li>SYNC: Synchronization Status bit</li> <li>1 = TIME registers may change during software read</li> <li>0 = TIME registers may be read safely</li> <li>bit 1</li> <li>ALMSYNC: Alarm Synchronization Status bit</li> <li>1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> <li>bit 0</li> <li>HALFSEC: Half Second Status bit<sup>(2)</sup></li> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ul>	4	•									
<ul> <li>0 = A timestamp event has not occurred</li> <li>bit 2</li> <li>SYNC: Synchronization Status bit         <ol> <li>1 = TIME registers may change during software read</li> <li>0 = TIME registers may be read safely</li> </ol> </li> <li>bit 1</li> <li>ALMSYNC: Alarm Synchronization Status bit         <ol> <li>1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> </ol> </li> <li>bit 0</li> <li>HALFSEC: Half Second Status bit<sup>(2)</sup> <ol> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ol> </li> </ul>	3	TSAEVT: Tim	nestamp A Ever	nt bit <sup>(1)</sup>							
bit 2       SYNC: Synchronization Status bit         1 = TIME registers may change during software read       0 = TIME registers may be read safely         bit 1       ALMSYNC: Alarm Synchronization Status bit         1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK<3:0>) should not be r and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read         0 = Alarm registers and Alarm Control bits may be written/modified safely         bit 0       HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second       0 = First half period of a second											
<ul> <li>1 = TIME registers may change during software read</li> <li>0 = TIME registers may be read safely</li> <li>bit 1</li> <li>ALMSYNC: Alarm Synchronization Status bit</li> <li>1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> <li>bit 0</li> <li>HALFSEC: Half Second Status bit<sup>(2)</sup></li> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ul>	-		•								
<ul> <li>0 = TIME registers may be read safely</li> <li>bit 1 ALMSYNC: Alarm Synchronization Status bit</li> <li>1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> <li>bit 0 HALFSEC: Half Second Status bit<sup>(2)</sup></li> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ul>	2										
<ul> <li>1 = Alarm registers (ALMTIME and ALMDATE) and Alarm bits (AMASK&lt;3:0&gt;) should not be r and Alarm Control bits (ALRMEN, ALMRPT&lt;7:0&gt;) may change during software read</li> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> <li>bit 0 HALFSEC: Half Second Status bit<sup>(2)</sup></li> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ul>					tware read						
and Alarm Control bits (ALRMEN, ALMRPT<7:0>) may change during software read 0 = Alarm registers and Alarm Control bits may be written/modified safely bit 0 HALFSEC: Half Second Status bit <sup>(2)</sup> 1 = Second half period of a second 0 = First half period of a second	1	ALMSYNC:	Alarm Synchron	ization Status	bit						
<ul> <li>0 = Alarm registers and Alarm Control bits may be written/modified safely</li> <li>bit 0</li> <li>HALFSEC: Half Second Status bit<sup>(2)</sup></li> <li>1 = Second half period of a second</li> <li>0 = First half period of a second</li> </ul>											
<ul><li>1 = Second half period of a second</li><li>0 = First half period of a second</li></ul>											
0 = First half period of a second	0	HALFSEC: H	alf Second Sta	tus bit <sup>(2)</sup>							
		1 = Second h	alf period of a s	second							
Note de la constance monumite o (2) to this location to initiate o Timostome A such timostome - such a		0 = First half	period of a seco	ond							
Note 1: User software may write a '1' to this location to initiate a Timestamp A event; timestamp capture i	<b>te 1։</b> Լ	Jser software ma	ay write a '1' to	this location to	o initiate a Times	tamp A event;	; timestamp cap	pture is not			

### REGISTER 21-6: RTCSTATL: RTCC STATUS REGISTER (LOW)

**2:** This bit is read-only; it is cleared to '0' on a write to the SECONE<3:0> bits.

#### 21.3.3 RTCC VALUE REGISTERS

#### REGISTER 21-7: TIMEL: RTCC TIME REGISTER (LOW)

U-0	R/W-x						
_	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 14-12	SECTEN<2:0>: Binary Coded Decimal Value of Seconds '10' Digit bits
	Contains a value from 0 to 5.
bit 11-8	SECONE<3:0>: Binary Coded Decimal Value of Seconds '1' Digit bits
	Contains a value from 0 to 9.

bit 7-0 Unimplemented: Read as '0'

#### REGISTER 21-8: TIMEH: RTCC TIME REGISTER (HIGH)

U-0	U-0	R/W-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 15							bit 8
U-0	R/W-0	R/W-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0' bit 13-12 HRTEN<1:0>: Binary Coded Decimal Value of Hours '10' Digit bits Contains a value from 0 to 2. bit 11-8 HRONE<3:0>: Binary Coded Decimal Value of Hours '1' Digit bits Contains a value from 0 to 9. bit 7 Unimplemented: Read as '0' bit 6-4 MINTEN<2:0>: Binary Coded Decimal Value of Minutes '10' Digit bits Contains a value from 0 to 5. bit 3-0 MINONE<3:0>: Binary Coded Decimal Value of Minutes '1' Digit bits Contains a value from 0 to 9.

x = Bit is unknown

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	_	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
—		_	_	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplem	nented bit, read	as '0'	

'0' = Bit is cleared

#### REGISTER 21-9: DATEL: RTCC DATE REGISTER (LOW)

'1' = Bit is set

bit 15-14	Unimplemented: Read as '0'
bit 13-12	DAYTEN<1:0>: Binary Coded Decimal Value of Days '10' Digit bits
	Contains a value from 0 to 3.
bit 11-8	DAYONE<3:0>: Binary Coded Decimal Value of Days '1' Digit bits
	Contains a value from 0 to 9.
bit 7-3	Unimplemented: Read as '0'
bit 2-0	WDAY<2:0>: Binary Coded Decimal Value of Weekdays '1' Digit bits

Contains a value from 0 to 6.

-n = Value at POR

#### REGISTER 21-10: DATEH: RTCC DATE REGISTER (HIGH)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-x	R/W-x	R/W-x	R/W-x
YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0
bit 15							bit 8

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	MTHTEN	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-12	YRTEN<3:0>: Binary Coded Decimal Value of Years '10' Digit bits
-----------	---

bit 11-8 **YRONE<3:0>:** Binary Coded Decimal Value of Years '1' Digit bits

bit 7-5 Unimplemented: Read as '0'

bit 4	MTHTEN: Binary Coded Decimal Value of Months '10' Digit bit
	Contains a value from 0 to 1.

bit 3-0 MTHONE<3:0>: Binary Coded Decimal Value of Months '1' Digit bits Contains a value from 0 to 9.

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#### 21.3.4 ALARM VALUE REGISTERS

#### REGISTER 21-11: ALMTIMEL: RTCC ALARM TIME REGISTER (LOW)

U-0	R/W-0						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	_		_	_	_		—
bit 7							bit 0

Legend	ł
--------	---

Legena:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	Unimplemented: Read as '0'
bit 14-12	SECTEN<2:0>: Binary Coded Decimal Value of Seconds '10' Digit bits
	Contains a value from 0 to 5.
bit 11-8	SECONE<3:0>: Binary Coded Decimal Value of Seconds '1' Digit bits
	Contains a value from 0 to 9.
bit 7-0	Unimplemented: Read as '0'

#### REGISTER 21-12: ALMTIMEH: RTCC ALARM TIME REGISTER (HIGH)

Legend:R = Readable bitW = Writable bit		U = Unimplem	nented bit, read	as '0'			
bit 7							bit 0
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
bit 15							bit 8
_	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

-n = Value a	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 15-14	Unimpler	nented: Read as '0'		
bit 13-12	HRTEN<	1:0>: Binary Coded Decima	al Value of Hours '10' Digit bits	
	Contains	a value from 0 to 2.		
bit 11-8	HRONE<	3:0>: Binary Coded Decima	al Value of Hours '1' Digit bits	
	Contains	a value from 0 to 9.		
bit 7	Unimpler	nented: Read as '0'		
bit 6-4	MINTEN<	2:0>: Binary Coded Decim	al Value of Minutes '10' Digit bits	i
	Contains	a value from 0 to 5.		
bit 3-0	MINONE	<3:0>: Binary Coded Decin	nal Value of Minutes '1' Digit bits	
	Contains	a value from 0 to 9.		

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—		—	—	—	WDAY2	WDAY1	WDAY0
bit 7		•		•			bit 0
Legend:							
R = Readable bit W = Writable bit		oit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			nown	
•							

### REGISTER 21-13: ALMDATEL: RTCC ALARM DATE REGISTER (LOW)

bit 15-14	Unimplemented: Read as '0'
bit 13-12	DAYTEN<1:0>: Binary Coded Decimal Value of Days '10' Digit bits
	Contains a value from 0 to 3.
bit 11-8	DAYONE<3:0>: Binary Coded Decimal Value of Days '1' Digit bits
	Contains a value from 0 to 9.
bit 7-3	Unimplemented: Read as '0'
bit 2-0	WDAY<2:0>: Binary Coded Decimal Value of Weekdays '1' Digit bits
	Contains a value from 0 to 6.

#### REGISTER 21-14: ALMDATEH: RTCC ALARM DATE REGISTER (HIGH)

| R/W-0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| YRTEN3 | YRTEN2 | YRTEN1 | YRTEN0 | YRONE3 | YRONE2 | YRONE1 | YRONE0 |
| bit 15 |        |        |        |        |        |        | bit 8  |

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	MTHTEN	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-12	YRTEN<3:0>: Binary Coded Decimal Value of Years '10' Digit bits
-----------	---

- bit 11-8YRONE<3:0>: Binary Coded Decimal Value of Years '1' Digit bitsbit 7-5Unimplemented: Read as '0'
- bit 4 MTHTEN: Binary Coded Decimal Value of Months '10' Digit bit Contains a value from 0 to 1.
- bit 3-0 MTHONE<3:0>: Binary Coded Decimal Value of Months '1' Digit bits Contains a value from 0 to 9.

#### 21.3.5 TIMESTAMP REGISTERS

#### REGISTER 21-15: TSATIMEL: RTCC TIMESTAMP A TIME REGISTER (LOW)<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
						bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	_	—	—
						bit 0
	SECTEN2	SECTEN2 SECTEN1	SECTEN2 SECTEN1 SECTEN0	SECTEN2 SECTEN1 SECTEN0 SECONE3	SECTEN2 SECTEN1 SECTEN0 SECONE3 SECONE2	SECTEN2 SECTEN1 SECTEN0 SECONE3 SECONE2 SECONE1

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15 Unimplemented: Read as '0'

bit 14-12 SECTEN<2:0>: Binary Coded Decimal Value of Seconds '10' Digit bits Contains a value from 0 to 5.

bit 11-8 SECONE<3:0>: Binary Coded Decimal Value of Seconds '1' Digit bits Contains a value from 0 to 9.

bit 7-0 Unimplemented: Read as '0'

**Note 1:** If TSAEN = 0, bits<15:0> can be used for persistent storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 15							bit 8
U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7						I	bit 0
• • • • • •							
Legend:							
R = Readab	le bit	W = Writable bit		U = Unimplemented bit, read			
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	
			<b>`</b>				
bit 15-14	Unimplemen	ted: Read as '	)				
bit 15-14 bit 13-12	Unimplemen HRTEN<1:0>			e of Hours '10'	Diait bits		
bit 15-14 bit 13-12	HRTEN<1:0>		Decimal Value	e of Hours '10'	Digit bits		
	HRTEN<1:0> Contains a va	: Binary Codec lue from 0 to 2	l Decimal Value		•		
bit 13-12	HRTEN<1:0> Contains a va HRONE<3:0>	: Binary Codec lue from 0 to 2	l Decimal Value d Decimal Valu	e of Hours '10' e of Hours '1' [	•		
bit 13-12	HRTEN<1:0> Contains a va HRONE<3:0> Contains a va	: Binary Codec lue from 0 to 2 : Binary Codec	l Decimal Value d Decimal Valu		•		
bit 13-12 bit 11-8	HRTEN<1:0> Contains a va HRONE<3:0> Contains a va Unimplemen	: Binary Codec lue from 0 to 2 : Binary Codec lue from 0 to 9 ted: Read as '	l Decimal Value d Decimal Valu <sub>0</sub> '	e of Hours '1' [	Digit bits		
bit 13-12 bit 11-8 bit 7	HRTEN<1:0> Contains a va HRONE<3:0> Contains a va Unimplemen MINTEN<2:0	: Binary Codec lue from 0 to 2 : Binary Codec lue from 0 to 9 ted: Read as '	l Decimal Value d Decimal Valu o' d Decimal Valu		Digit bits		
bit 13-12 bit 11-8 bit 7	HRTEN<1:0> Contains a va HRONE<3:0> Contains a va Unimplemen MINTEN<2:03 Contains a va	: Binary Codec lue from 0 to 2 : Binary Codec lue from 0 to 9 ted: Read as ' >: Binary Code lue from 0 to 5	l Decimal Value d Decimal Valu <sub>D</sub> ' d Decimal Valu	e of Hours '1' [	Digit bits 0' Digit bits		

# REGISTER 21-16: TSATIMEH: RTCC TIMESTAMP A TIME REGISTER (HIGH)<sup>(1)</sup>

**Note 1:** If TSAEN = 0, bits<15:0> can be used for persistence storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 15	·						bit 8
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
	_		_	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0
Legend:							
R = Readab	ole bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'	
-n = Value a	it POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	
bit 15-14	Unimplemen	ted: Read as '	כי				
bit 13-12	DAYTEN<1:0	>: Binary Code	ed Decimal Valu	ue of Days '10'	Digit bits		
	Contains a va	lue from 0 to 3					
bit 11-8	DAYONE<3:0	>: Binary Code	ed Decimal Val	ue of Days '1' I	Digit bits		
	Contains a value from 0 to 9.						
bit 7-3	Unimplemen	ted: Read as '	כי				
bit 2-0	WDAY<2:0>:	Binary Coded	Decimal Value	of Weekdays ':	1' Digit bits		
	Contains a va	lue from 0 to 6					

# REGISTER 21-17: TSADATEL: RTCC TIMESTAMP A DATE REGISTER (LOW)<sup>(1)</sup>

**Note 1:** If TSAEN = 0, bits<15:0> can be used for persistence storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0		
bit 15				·		•	bit 8		
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
	—	—	MTHTEN	MTHONE3	MTHONE2	MTHONE1	MTHONE0		
bit 7							bit 0		
Legend:									
R = Readable	e bit	W = Writable	bit	U = Unimplemented bit, read as '0'					
-n = Value at POR '1		'1' = Bit is set	1' = Bit is set		ared	x = Bit is unknown			
bit 15-12	YRTEN<3:0>	: Binary Coded	I Decimal Value	e of Years '10' l	Digit bits				
bit 11-8	YRONE<3:0>	Binary Codeo	d Decimal Valu	e of Years '1' D	igit bits				
bit 7-5	Unimplemented: Read as '0'								
bit 4	MTHTEN: Bir	nary Coded Dec	cimal Value of	Months '10' Dig	git bit				
	Contains a value from 0 to 1.								

# REGISTER 21-18: TSADATEH: RTCC TIMESTAMP A DATE REGISTER (HIGH)<sup>(1)</sup>

bit 3-0	MTHONE<2:0>: Binary Coded Decimal Value of Months '1' Digit bits
	Contains a value from 0 to 9.

**Note 1:** If TSAEN = 0, bits<15:0> can be used for persistence storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

#### 21.4 Calibration

#### 21.4.1 CLOCK SOURCE CALIBRATION

A crystal oscillator that is connected to the RTCC may be calibrated to provide an accurate 1 second clock in two ways. First, coarse frequency adjustment is performed by adjusting the value written to the DIV<15:0> bits. Secondly, a 5-bit value can be written to the FDIV<4:0> control bits to perform a fine clock division.

The DIVx and FDIVx values can be concatenated and considered as a 21-bit prescaler value. If the oscillator source is slightly faster than ideal, the FDIV<4:0> value can be increased to make a small decrease in the RTC frequency. The value of DIV<15:0> should be increased to make larger decreases in the RTC frequency. If the oscillator source is slower than ideal, FDIV<4:0> may be decreased for small calibration changes and DIV<15:0> may need to be decreased to make larger calibration changes.

Before calibration, the user must determine the error of the crystal. This should be done using another timer resource on the device or an external timing reference. It is up to the user to include in the error value, the initial error of the crystal, drift due to temperature and drift due to crystal aging.

#### 21.5 Alarm

- · Configurable from half second to one year
- Enabled using the ALRMEN bit (RTCCON1H<15>)
- One-time alarm and repeat alarm options are available

#### 21.5.1 CONFIGURING THE ALARM

The alarm feature is enabled using the ALRMEN bit. This bit is cleared when an alarm is issued. Writes to the Alarm Value registers should only take place when ALRMEN = 0.

As shown in Figure 21-2, the interval selection of the alarm is configured through the AMASK<3:0> bits (RTCCON1H<11:8>). These bits determine which and how many digits of the alarm must match the clock value for the alarm to occur.

The alarm can also be configured to repeat based on a preconfigured interval. The amount of times this occurs, once the alarm is enabled, is stored in the ALMRPT<7:0> bits (RTCCON1H<7:0>). When the value of the ALMRPTx bits equals 00h and the CHIME bit (RTCCON1H<14>) is cleared, the repeat function is disabled and only a single alarm will occur. The alarm can be repeated, up to 255 times, by loading ALMRPT<7:0> with FFh.

After each alarm is issued, the value of the ALMRPTx bits is decremented by one. Once the value has reached 00h, the alarm will be issued one last time, after which, the ALRMEN bit will be cleared automatically and the alarm will turn off.

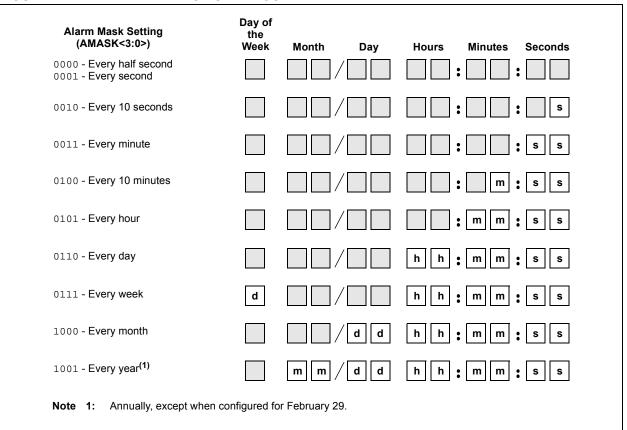
Indefinite repetition of the alarm can occur if the CHIME bit = 1. Instead of the alarm being disabled when the value of the ALMRPTx bits reaches 00h, it rolls over to FFh and continues counting indefinitely while CHIME is set.

#### 21.5.2 ALARM INTERRUPT

At every alarm event, an interrupt is generated. This output is completely synchronous to the RTCC clock and can be used as a trigger clock to the other peripherals.

Note:	Changing any of the register bits, other than the RTCOE bit (RTCCON1L<7>), the ALMRPT<7:0> bits (RTCCON1H<7:0> and the CHIME bit, while the alarm is enabled (ALRMEN = 1), can result in a false alarm event leading to a false alarm
	interrupt. To avoid a false alarm event, the timer and alarm values should only be changed while the alarm is disabled (ALRMEN = 0).





#### 21.6 Power Control

The RTCC includes a power control feature that allows the device to periodically wake-up an external device, wait for the device to be stable before sampling wake-up events from that device and then shut down the external device. This can be done completely autonomously by the RTCC, without the need to wake-up from the current lower power mode.

To use this feature:

- 1. Enable the RTCC (RTCEN = 1).
- 2. Set the PWCEN bit (RTCCON1L<10>).
- Configure the RTCC pin to drive the PWC control signal (RTCOE = 1 and OUTSEL<2:0> = 011).

The polarity of the PWC control signal may be chosen using the PWCPOL bit (RTCCON1L<9>). An activelow or active-high signal may be used with the appropriate external switch to turn on or off the power to one or more external devices. The active-low setting may also be used in conjunction with an open-drain setting on the RTCC pin, in order to drive the ground pin(s) of the external device directly (with the appropriate external VDD pull-up device), without the need for external switches. Finally, the CHIME bit should be set to enable the PWC periodicity. Once the RTCC and PWC are enabled and running, the PWC logic will generate a control output and a sample gate output. The control output is driven out on the RTCC pin (when RTCOE = 1 and OUTSEL<2:0 > = 011) and is used to power up or down the device, as described above.

Once the control output is asserted, the stability window begins, in which the external device is given enough time to power up and provide a stable output.

Once the output is stable, the RTCC provides a sample gate during the sample window. The use of this sample gate depends on the external device being used, but typically, it is used to mask out one or more wake-up signals from the external device.

Finally, both the stability and the sample windows close after the expiration of the sample window and the external device is powered down.

#### 21.6.1 POWER CONTROL CLOCK SOURCE

The stability and sample windows are controlled by the PWCSAMPx and PWCSTABx bit fields in the RTCCON3L register (RTCCON3L<15:8> and <7:0>, respectively). As both the stability and sample windows are defined in terms of the RTCC clock, their absolute values vary by the value of the PWC clock base period (TPWCCLK). For example, using a 32.768 kHz SOSC input clock would produce a TPWCCLK of 1/32768 = 30.518 µs. The 8-bit magnitude of PWCSTABx and PWCSAMPx allows for a window size of 0 to 255 TPWCCLK. The period of the PWC clock can also be adjusted with a 1:1, 1:16, 1:64 or 1:256 prescaler, determined by the PWCPS<1:0> bits (RTCCON2L<7:6>).

In addition, certain values for the PWCSTABx and PWCSAMPx fields have specific control meanings in determining power control operations. If either bit field is 00h, the corresponding window is inactive. In addition, if the PWCSTABx field is FFh, the stability window remains active continuously, even if power control is disabled.

### 21.7 Event Timestamping

The RTCC includes a set of Timestamp registers that may be used for the capture of Time and Date register values when an external input signal is received. The RTCC will trigger a timestamp event when a low pulse occurs on the TMPRN pin.

#### 21.7.1 TIMESTAMP OPERATION

The event input is enabled for timestamping using the TSAEN bit (RTCCON1L<0>). When the timestamp event occurs, the present time and date values will be stored in the TSATIMEL/H and TSADATEL/H registers, the TSAEVT status bit (RTCSTATL<3>) will be set and an RTCC interrupt will occur. A new timestamp capture event cannot occur until the user clears the TSAEVT status bit.

Note 1:	The TSATIMEL/H and TSADATEL/H regis-							
	ter pairs can be used for data storage when							
	TSAEN = 0. The values of TSATIMEL/H							
	and TSADATEL/H will be maintained							
	throughout all types of non-Power-on							
	Resets (MCLR, WDT, etc).							

#### 21.7.2 MANUAL TIMESTAMP OPERATION

The current time and date may be captured in the TSATIMEL/H and TSADATEL/H registers by writing a '1' to the TSAEVT bit location while the timestamp functionality is enabled (TSAEN = 1). This write will not set the TSAEVT bit, but it will initiate a timestamp capture. The TSAEVT bit will be set when the capture operation is complete. The user must poll the TSAEVT bit to determine when the capture operation is complete.

After the Timestamp registers have been read, the TSAEVT bit should be cleared to allow further hardware or software timestamp capture events.

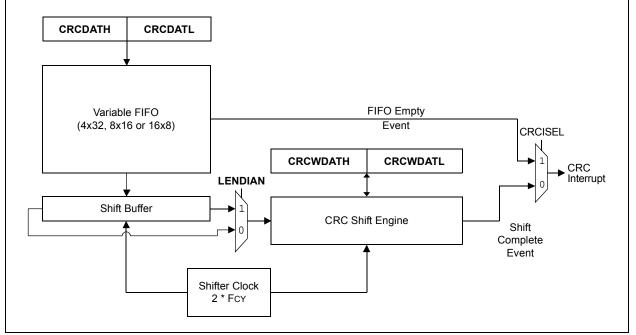
#### 22.0 32-BIT PROGRAMMABLE CYCLIC REDUNDANCY CHECK (CRC) GENERATOR

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "32-Bit Programmable Cyclic Redundancy Check (CRC)" (DS30009729), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM. The 32-bit programmable CRC generator provides a hardware implemented method of quickly generating checksums for various networking and security applications. It offers the following features:

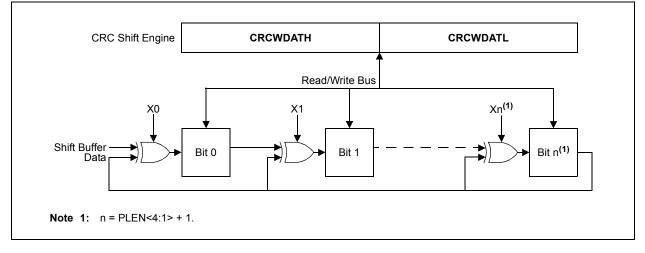
- User-Programmable CRC Polynomial Equation, up to 32 Bits
- Programmable Shift Direction (little or big-endian)
- Independent Data and Polynomial Lengths
- Configurable Interrupt Output
- Data FIFO

Figure 22-1 displays a simplified block diagram of the CRC generator. A simple version of the CRC shift engine is displayed in Figure 22-2.

#### FIGURE 22-1: CRC BLOCK DIAGRAM



#### FIGURE 22-2: CRC SHIFT ENGINE DETAIL



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#### 22.1 User Interface

#### 22.1.1 POLYNOMIAL INTERFACE

The CRC module can be programmed for CRC polynomials of up to the  $32^{nd}$  order, using up to 32 bits.

Polynomial length, which reflects the highest exponent in the equation, is selected by the PLEN<4:0> bits (CRCCON2<4:0>).

The CRCXORL and CRCXORH registers control which exponent terms are included in the equation. Setting a particular bit includes that exponent term in the equation. Functionally, this includes an XOR operation on the corresponding bit in the CRC engine. Clearing the bit disables the XOR.

For example, consider two CRC polynomials, one a 16-bit and the other a 32-bit equation.

# EQUATION 22-1: 16-BIT, 32-BIT CRC POLYNOMIALS

#### X16 + X12 + X5 + 1

and

 $\begin{array}{c} X32 + X26 + X23 + X22 + X16 + X12 + X11 + X10 + \\ X8 + X7 + X5 + X4 + X2 + X + 1 \end{array}$ 

To program these polynomials into the CRC generator, set the register bits, as shown in Table 22-1.

Note that the appropriate positions are set to '1' to indicate that they are used in the equation (for example, X26 and X23). The '0' bit required by the equation is always XORed; thus, X0 is a don't care. For a polynomial of length 32, it is assumed that the 32<sup>nd</sup> bit will be used. Therefore, the X<31:1> bits do not have the 32<sup>nd</sup> bit.

#### 22.1.2 DATA INTERFACE

The module incorporates a FIFO that works with a variable data width. Input data width can be configured to any value between 1 and 32 bits using the DWIDTH<4:0> bits (CRCCON2<12:8>). When the data width is greater than 15, the FIFO is 4 words deep. When the DWIDTHx bits are between 15 and 8, the FIFO is 8 words deep. When the DWIDTHx bits are less than 8, the FIFO is 16 words deep.

The data for which the CRC is to be calculated must first be written into the FIFO. Even if the data width is less than 8, the smallest data element that can be written into the FIFO is 1 byte. For example, if the DWIDTHx bits are 5, then the size of the data is DWIDTH<4:0> + 1 or 6. The data is written as a whole byte; the two unused upper bits are ignored by the module.

Once data is written into the MSb of the CRCDAT registers (that is, the MSb as defined by the data width), the value of the VWORD<4:0> bits (CRCCON1<12:8>) increments by one. For example, if the DWIDTHx bits are 24, the VWORDx bits will increment when bit 7 of CRCDATH is written. Therefore, CRCDATL must always be written to before CRCDATH.

The CRC engine starts shifting data when the CRCGO bit (CRCCON1<4>) is set and the value of the VWORDx bits is greater than zero.

Each word is copied out of the FIFO into a buffer register, which decrements the VWORDx bits. The data is then shifted out of the buffer. The CRC engine continues shifting at a rate of two bits per instruction cycle, until the VWORDx bits reach zero. This means that for a given data width, it takes half that number of instructions for each word to complete the calculation. For example, it takes 16 cycles to calculate the CRC for a single word of 32-bit data.

When the VWORDx bits reach the maximum value for the configured value of the DWIDTHx bits (4, 8 or 16), the CRCFUL bit (CRCCON1<7>) becomes set. When the VWORDx bits reach zero, the CRCMPT bit (CRCCON1<6>) becomes set. The FIFO is emptied and the VWORD<4:0> bits are set to '00000' whenever CRCEN is '0'.

At least one instruction cycle must pass after a write to CRCWDAT before a read of the VWORDx bits is done.

#### TABLE 22-1: CRC SETUP EXAMPLES FOR 16 AND 32-BIT POLYNOMIALS

CRC Control Bits	Bit Values				
	16-Bit Polynomial	32-Bit Polynomial			
PLEN<4:0>	01111	11111			
X<31:16>	0000 0000 0000 0001	0000 0100 1100 0001			
X<15:1>	0001 0000 0010 000	0001 1101 1011 011			

#### 22.1.3 DATA SHIFT DIRECTION

The LENDIAN bit (CRCCON1<3>) is used to control the shift direction. By default, the CRC will shift data through the engine, MSb first. Setting LENDIAN (= 1) causes the CRC to shift data, LSb first. This setting allows better integration with various communication schemes and removes the overhead of reversing the bit order in software. Note that this only changes the direction the data is shifted into the engine. The result of the CRC calculation will still be a normal CRC result, not a reverse CRC result.

#### 22.1.4 INTERRUPT OPERATION

The module generates an interrupt that is configurable by the user for either of two conditions.

If CRCISEL is '0', an interrupt is generated when the VWORD<4:0> bits make a transition from a value of '1' to '0'. If CRCISEL is '1', an interrupt will be generated after the CRC operation finishes and the module sets the CRCGO bit to '0'. Manually setting CRCGO to '0' will not generate an interrupt. Note that when an interrupt occurs, the CRC calculation would not yet be complete. The module will still need (PLENx + 1)/2 clock cycles after the interrupt is generated until the CRC calculation is finished.

#### 22.1.5 TYPICAL OPERATION

To use the module for a typical CRC calculation:

- 1. Set the CRCEN bit to enable the module.
- 2. Configure the module for desired operation:
  - a) Program the desired polynomial using the CRCXOR registers and PLEN<4:0> bits.
  - b) Configure the data width and shift direction using the DWIDTH<4:0> and LENDIAN bits.
- 3. Set the CRCGO bit to start the calculations.
- 4. Set the desired CRC non-direct initial value by writing to the CRCWDAT registers.
- Load all data into the FIFO by writing to the CRCDAT registers as space becomes available (the CRCFUL bit must be zero before the next data loading).
- 6. Wait until the data FIFO is empty (CRCMPT bit is set).
- Read the result: If the data width (DWIDTH<4:0> bits) is more than the polynomial length (PLEN<4:0> bits):
  - a) Wait (DWIDTH<4:0> + 1)/2 instruction cycles to make sure that shifts from the shift buffer are finished.
  - b) Change the data width to the polynomial length (DWIDTH<4:0> = PLEN<4:0>).
  - c) Write one dummy data word to the CRCDAT registers.
  - d) Wait 2 instruction cycles to move the data from the FIFO to the shift buffer and (PLEN<4:0> + 1)/2 instruction cycles to shift out the result.

Or, if the data width (DWIDTH<4:0> bits) is less than the polynomial length (PLEN<4:0> bits):

- Clear the CRC Interrupt Selection bit (CRCISEL = 0) to get the interrupt when all shifts are done. Clear the CRC interrupt flag. Write dummy data in the CRCDAT registers and wait until the CRC interrupt flag is set.
- 2. Read the final CRC result from the CRCWDAT registers.
- Restore the data width (DWIDTH<4:0> bits) for further calculations (OPTIONAL). If the data width (DWIDTH<4:0> bits) is equal to, or less than, the polynomial length (PLEN<4:0> bits):
  - a) Clear the CRC Interrupt Selection bit (CRCISEL = 0) to get the interrupt when all shifts are done.
  - b) Suspend the calculation by setting CRCGO = 0.
  - c) Clear the CRC interrupt flag.
  - Write the dummy data with the total data length equal to the polynomial length in the CRCDAT registers.
  - e) Resume the calculation by setting CRCGO = 1.
  - f) Wait until the CRC interrupt flag is set.
  - g) Read the final CRC result from the CRCWDAT registers.

There are eight registers used to control programmable CRC operation:

- CRCCON1
- CRCCON2
- CRCXORL
- CRCXORH
- CRCDATL
- CRCDATH
- CRCWDATL
- CRCWDATH

The CRCCON1 and CRCCON2 registers (Register 22-1 and Register 22-2) control the operation of the module and configure the various settings.

The CRCXOR registers (Register 22-3 and Register 22-4) select the polynomial terms to be used in the CRC equation. The CRCDAT and CRCWDAT registers are each register pairs that serve as buffers for the double-word input data, and CRC processed output, respectively.

	11.0	DAMA					
R/W-0 CRCEN	U-0	R/W-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
	—	CSIDL	VWORD4	VWORD3	VWORD2	VWORD1	VWORD0
bit 15							bit 8
R-0, HSC	R-1, HSC	R/W-0	R/W-0, HC	R/W-0	U-0	U-0	U-0
CRCFUL	CRCMPT	CRCISEL	CRCGO	LENDIAN		_	
bit 7							bit 0
Legend:		HC = Hardware	e Clearable bit	HSC = Hardw	are Settable/C	learable bit	
R = Readab	ole bit	W = Writable b	it	U = Unimplem	nented bit, read	d as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15	1 = Enable	s module; all sta	te machines, po	inters and CRC	WDAT/CRCDA	\T registers res	et; other SFRs
bit 14		nted: Read as '	0'				
bit 13	-	C Stop in Idle Mo					
	1 = Discont	inues module oper	peration when de		e mode		
bit 12-8	VWORD<4:	0>: CRC Pointe	r Value bits				
	Indicates the when PLEN	e number of valie $<4:0> \le 7.$	d words in the Fl	FO. Has a max	imum value of	8 when PLEN<	<4:0> ≥ 7 or 16
bit 7	<b>CRCFUL:</b> C 1 = FIFO is 0 = FIFO is		t				
bit 6	CRCMPT: C	RC FIFO Empty	/ bit				
	1 = FIFO is 0 = FIFO is						
bit 5		CRC Interrupt Se	election bit				
	1 = Interrup	t on FIFO is emp t on shift is comp	oty; the final wor		shifting throug	h the CRC	
bit 4	CRCGO: St	art CRC bit		-			
	1 = Starts C	CRC serial shifte	r				
		erial shifter is tur					
bit 3		Data Shift Direct					
		ord is shifted into ord is shifted into					
bit 2-0		ented: Read as '			n (nig enulan)		
	ommpleme	ineu. Neau do	U				

#### REGISTER 22-1: CRCCON1: CRC CONTROL 1 REGISTER

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	DWIDTH4	DWIDTH3	DWIDTH2	DWIDTH1	DWIDTH0
bit 15	•						bit 8
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	PLEN4	PLEN3	PLEN2	PLEN1	PLEN0
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplemented bit, read as '0'			
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			iown	

#### REGISTER 22-2: CRCCON2: CRC CONTROL 2 REGISTER

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **DWIDTH<4:0>:** CRC Data Word Width Configuration bits

Configures the width of the data word (Data Word Width – 1).

bit 7-5 Unimplemented: Read as '0'

bit 4-0 **PLEN<4:0>:** Polynomial Length Configuration bits Configures the length of the polynomial (Polynomial Length – 1).

#### REGISTER 22-3: CRCXORL: CRC XOR POLYNOMIAL REGISTER, LOW WORD

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			Х<	:15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			X<7:1>				
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-1 X<15:1>: XOR of Polynomial Term x<sup>n</sup> Enable bits

bit 0 Unimplemented: Read as '0'

#### REGISTER 22-4: CRCXORH: CRC XOR POLYNOMIAL REGISTER, HIGH WORD

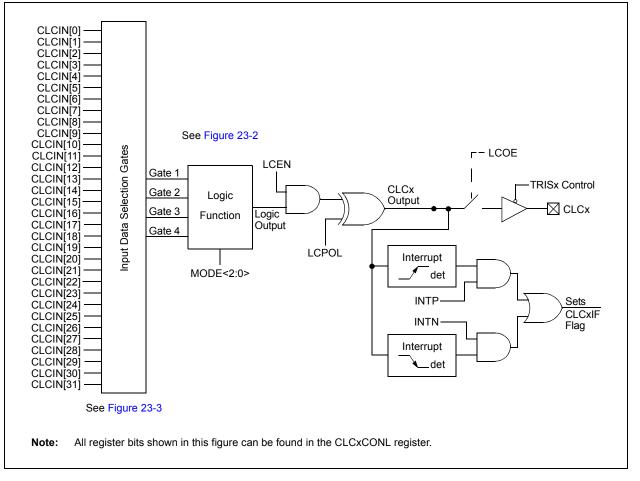
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
N/W-U	N/ VV-0	N/W-U			N/VV-0	N/ W-U	N/W-0
			X<	31:24>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			Х<	23:16>			
bit 7							bit C
Logondy							
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is clea	ared	x = Bit is unkr	nown	

bit 15-0 X<31:16>: XOR of Polynomial Term x<sup>n</sup> Enable bits

### 23.0 CONFIGURABLE LOGIC CELL (CLC) GENERATOR

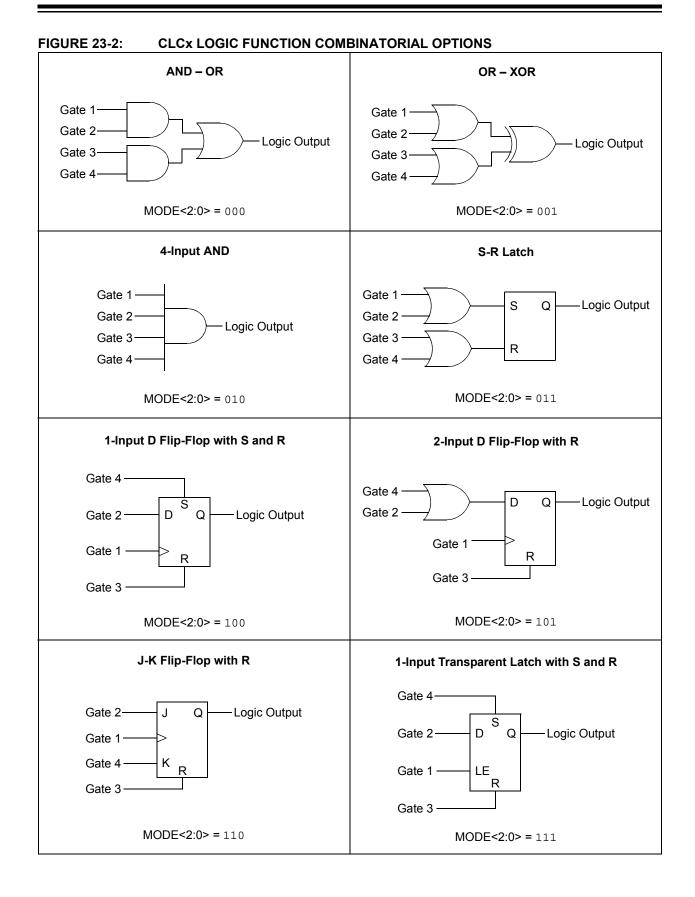
Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Configurable Logic Cell (CLC)" (DS70005298), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM. The Configurable Logic Cell (CLC) module allows the user to specify combinations of signals as inputs to a logic function and to use the logic output to control other peripherals or I/O pins. This provides greater flexibility and potential in embedded designs, since the CLC module can operate outside the limitations of software execution and supports a vast amount of output designs.

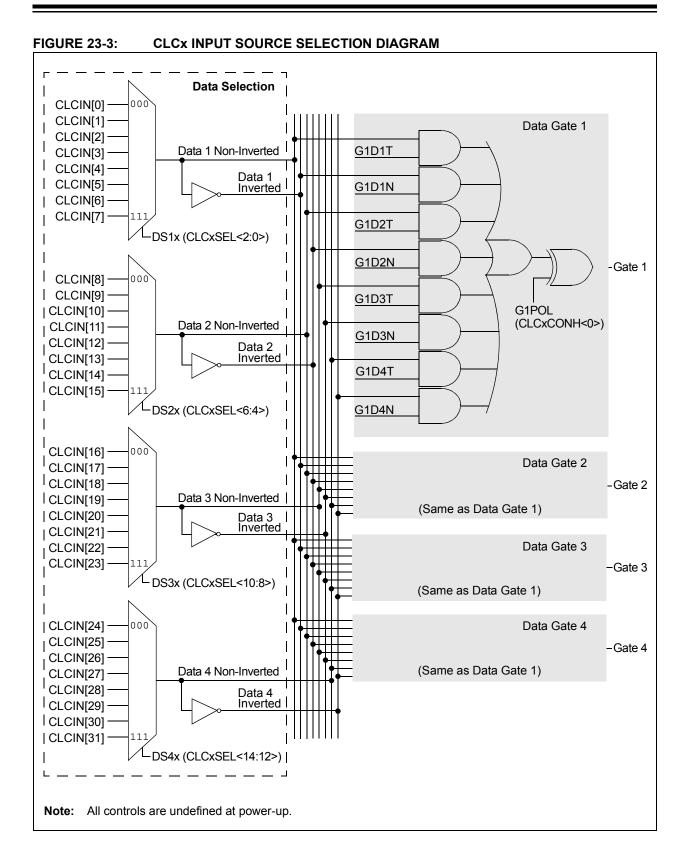
There are four input gates to the selected logic function. These four input gates select from a pool of up to 32 signals that are selected using four data source selection multiplexers. Figure 23-1 shows an overview of the module. Figure 23-3 shows the details of the data source multiplexers and logic input gate connections.



#### FIGURE 23-1: CLCx MODULE

# PIC24FJ256GA705 FAMILY





#### 23.1 Control Registers

The CLCx module is controlled by the following registers:

- CLCxCONL
- CLCxCONH
- CLCxSEL
- CLCxGLSL
- CLCxGLSH

The CLCx Control registers (CLCxCONL and CLCxCONH) are used to enable the module and interrupts, control the output enable bit, select output polarity and select the logic function. The CLCx Control registers also allow the user to control the logic polarity of not only the cell output, but also some intermediate variables. The CLCx Input MUX Select register (CLCxSEL) allows the user to select up to 4 data input sources using the 4 data input selection multiplexers. Each multiplexer has a list of 8 data sources available.

The CLCx Gate Logic Input Select registers (CLCxGLSL and CLCxGLSH) allow the user to select which outputs from each of the selection MUXes are used as inputs to the input gates of the logic cell. Each data source MUX outputs both a true and a negated version of its output. All of these 8 signals are enabled, ORed together by the logic cell input gates.

#### REGISTER 23-1: CLCxCONL: CLCx CONTROL REGISTER (LOW)

R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0			
LCEN	—	—	_	INTP	INTN	—	—			
bit 15							bit 8			
R/W-0	R-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0			
LCOE	LCOUT	LCPOL	—		MODE2	MODE1	MODE0			
bit 7							bit 0			
Legend:										
R = Readab	le bit	W = Writable	oit	U = Unimpler	nented bit, read	l as '0'				
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkn	nown			
bit 15	LCEN: CLCx	Enable bit								
		enabled and mi								
		disabled and ha	•	utputs						
bit 14-12	-	ted: Read as '								
bit 11		Positive Edge Ir								
		will be generate will not be gene		ng edge occurs	on LCOUT					
bit 10		Negative Edge		ole bit						
				ing edge occurs	s on LCOUT					
	0 = Interrupt	will not be gene	erated							
bit 9-8	Unimplemen	ted: Read as '	)'							
bit 7	LCOE: CLCx	Port Enable bit								
		t pin output is e								
1.11.0	•	t pin output is d								
bit 6	LCOUT: CLCx Data Output Status bit									
	1 = CLCx output high 0 = CLCx output low									
bit 5		LCPOL: CLCx Output Polarity Control bit								
		ut of the modul	•							
	0 = The outp	ut of the modul	e is not inverte	ed						
bit 4-3	Unimplemen	ted: Read as 'd	)'							

#### REGISTER 23-1: CLCxCONL: CLCx CONTROL REGISTER (LOW) (CONTINUED)

bit 2-0 MODE<2:0>: CLCx Mode bits

- 111 = Cell is a 1-input transparent latch with S and R
- 110 = Cell is a JK flip-flop with R
- 101 = Cell is a 2-input D flip-flop with R
- 100 = Cell is a 1-input D flip-flop with S and R
- 011 = Cell is an SR latch
- 010 = Cell is a 4-input AND
- 001 = Cell is an OR-XOR
- 000 = Cell is an AND-OR

#### REGISTER 23-2: CLCxCONH: CLCx CONTROL REGISTER (HIGH)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—		—		_	—
bit 15							bit 8

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	G4POL	G3POL	G2POL	G1POL
bit 7							bit 0

#### Legend:

Legena.				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-4	Unimplemented: Read as '0'
bit 3	G4POL: Gate 4 Polarity Control bit
	<ul> <li>1 = The output of Channel 4 logic is inverted when applied to the logic cell</li> <li>0 = The output of Channel 4 logic is not inverted</li> </ul>
bit 2	G3POL: Gate 3 Polarity Control bit
	<ul><li>1 = The output of Channel 3 logic is inverted when applied to the logic cell</li><li>0 = The output of Channel 3 logic is not inverted</li></ul>
bit 1	G2POL: Gate 2 Polarity Control bit
	<ul> <li>1 = The output of Channel 2 logic is inverted when applied to the logic cell</li> <li>0 = The output of Channel 2 logic is not inverted</li> </ul>
bit 0	G1POL: Gate 1 Polarity Control bit
	<ul> <li>1 = The output of Channel 1 logic is inverted when applied to the logic cell</li> <li>0 = The output of Channel 1 logic is not inverted</li> </ul>

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0					
_		DS4<2:0>				DS3<2:0>						
bit 15							bita					
	DAMA		DAMA		DAMA	<b>D</b> 444.0	DAMA					
U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0					
		DS2<2:0>		—		DS1<2:0>						
bit 7							bit					
Legend:												
R = Readab	ole bit	W = Writable b	oit	U = Unimpler	mented bit, rea	d as '0'						
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cle		x = Bit is unkn	own					
bit 15	Unimpleme	nted: Read as '0	3									
bit 14-12	DS4<2:0>: [	Data Selection M	UX 4 Signal S	Selection bits								
		P3 Compare Eve	•	• • •								
		P1 Compare Eve	nt Interrupt F	lag (CCP1IF)								
	101 = Unim 100 = CTMI											
		100 = CTMU A/D trigger 011 = SPIx Input (SDIx) corresponding to the CLCx module (see Table 23-1)										
	010 = Comp	010 = Comparator 3 output										
		001 = Module-specific CLCx output (see Table 23-1)										
	000 = CLCII	•	,									
bit 11	-	nted: Read as '0										
bit 10-8	DS3<2:0>: Data Selection MUX 3 Signal Selection bits											
	<ul><li>111 = MCCP3 Compare Event Interrupt Flag (CCP3IF)</li><li>110 = MCCP2 Compare Event Interrupt Flag (CCP2IF)</li></ul>											
	110 = MCCP2 Compare Event Interrupt Flag (CCP2IF) 101 = DMA Channel 1 interrupt											
		x RX output corr										
		Output (SDOx) c	orresponding	to the CLCx m	odule (see Tab	le 23-1)						
		010 = Comparator 2 output 001 = CLCx output (see Table 23-1)										
	000 = CLCI		6 23-1)									
bit 7		nted: Read as '0	,									
bit 6-4	•			Selection bits								
	DS2<2:0>: Data Selection MUX 2 Signal Selection bits 111 = MCCP2 Compare Event Interrupt Flag (CCP2IF)											
	110 = MCCP1 Compare Event Interrupt Flag (CCP1IF)											
		101 = DMA Channel 0 interrupt										
		100 = A/D conversion done interrupt										
		011 = UARTx TX input corresponding to the CLCx module (see Table 23-1) 010 = Comparator 1 output										
		output (see Tabl	e 23-1)									
	000 <b>= CLCII</b>	NB I/O pin										
bit 3	-	nted: Read as '0										
bit 2-0	DS1<2:0>: [	Data Selection M	UX 1 Signal	Selection bits								
	-	3 match event										
	110 = Timer 101 = Unim	2 match event										
	101 <b>– Ohim</b> 100 <b>= REFC</b>											
		C/LPRC clock so	urce									
		C clock source										
		m clock (TCY)										
	000 <b>= CLCII</b>	va I/O pin										

Bit Field Value		Input Source				
BITFI		CLC1	CLC2			
DS4<2:0>	011	SDI1	SDI2			
	001	CLC2 Output	CLC1 Output			
DS3<2:0>	100	U1RX	U2RX			
	011	SDO1	SDO2			
	001	CLC1 Output	CLC2 Output			
DS2<2:0>	011	U1TX	U2TX			
	001	CLC2 Output	CLC1 Output			

#### TABLE 23-1: MODULE-SPECIFIC INPUT DATA SOURCES

#### REGISTER 23-4: CLCxGLSL: CLCx GATE LOGIC INPUT SELECT LOW REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
G2D4T	G2D4N	G2D3T	G2D3N	G2D2T	G2D2N	G2D1T	G2D1N
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| G1D4T | G1D4N | G1D3T | G1D3N | G1D2T | G1D2N | G1D1T | G1D1N |
| bit 7 |       |       |       |       |       |       | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	G2D4T: Gate 2 Data Source 4 True Enable bit
	<ul> <li>1 = The Data Source 4 signal is enabled for Gate 2</li> <li>0 = The Data Source 4 signal is disabled for Gate 2</li> </ul>
bit 14	G2D4N: Gate 2 Data Source 4 Negated Enable bit
	<ul><li>1 = The Data Source 4 inverted signal is enabled for Gate 2</li><li>0 = The Data Source 4 inverted signal is disabled for Gate 2</li></ul>
bit 13	G2D3T: Gate 2 Data Source 3 True Enable bit
	<ul> <li>1 = The Data Source 3 signal is enabled for Gate 2</li> <li>0 = The Data Source 3 signal is disabled for Gate 2</li> </ul>
bit 12	G2D3N: Gate 2 Data Source 3 Negated Enable bit
	<ul> <li>1 = The Data Source 3 inverted signal is enabled for Gate 2</li> <li>0 = The Data Source 3 inverted signal is disabled for Gate 2</li> </ul>
bit 11	G2D2T: Gate 2 Data Source 2 True Enable bit
	<ul><li>1 = The Data Source 2 signal is enabled for Gate 2</li><li>0 = The Data Source 2 signal is disabled for Gate 2</li></ul>
bit 10	G2D2N: Gate 2 Data Source 2 Negated Enable bit
	<ul> <li>1 = The Data Source 2 inverted signal is enabled for Gate 2</li> <li>0 = The Data Source 2 inverted signal is disabled for Gate 2</li> </ul>
bit 9	G2D1T: Gate 2 Data Source 1 True Enable bit
	<ul><li>1 = The Data Source 1 signal is enabled for Gate 2</li><li>0 = The Data Source 1 signal is disabled for Gate 2</li></ul>

#### REGISTER 23-4: CLCxGLSL: CLCx GATE LOGIC INPUT SELECT LOW REGISTER (CONTINUED)

bit 8	G2D1N: Gate 2 Data Source 1 Negated Enable bit
	<ul><li>1 = The Data Source 1 inverted signal is enabled for Gate 2</li><li>0 = The Data Source 1 inverted signal is disabled for Gate 2</li></ul>
bit 7	G1D4T: Gate 1 Data Source 4 True Enable bit
	<ul> <li>1 = The Data Source 4 signal is enabled for Gate 1</li> <li>0 = The Data Source 4 signal is disabled for Gate 1</li> </ul>
bit 6	G1D4N: Gate 1 Data Source 4 Negated Enable bit
	<ul> <li>1 = The Data Source 4 inverted signal is enabled for Gate 1</li> <li>0 = The Data Source 4 inverted signal is disabled for Gate 1</li> </ul>
bit 5	G1D3T: Gate 1 Data Source 3 True Enable bit
	<ul><li>1 = The Data Source 3 signal is enabled for Gate 1</li><li>0 = The Data Source 3 signal is disabled for Gate 1</li></ul>
bit 4	G1D3N: Gate 1 Data Source 3 Negated Enable bit
	<ul> <li>1 = The Data Source 3 inverted signal is enabled for Gate 1</li> <li>0 = The Data Source 3 inverted signal is disabled for Gate 1</li> </ul>
bit 3	G1D2T: Gate 1 Data Source 2 True Enable bit
	<ul> <li>1 = The Data Source 2 signal is enabled for Gate 1</li> <li>0 = The Data Source 2 signal is disabled for Gate 1</li> </ul>
bit 2	G1D2N: Gate 1 Data Source 2 Negated Enable bit
	<ul> <li>1 = The Data Source 2 inverted signal is enabled for Gate 1</li> <li>0 = The Data Source 2 inverted signal is disabled for Gate 1</li> </ul>
bit 1	G1D1T: Gate 1 Data Source 1 True Enable bit
	<ul> <li>1 = The Data Source 1 signal is enabled for Gate 1</li> <li>0 = The Data Source 1 signal is disabled for Gate 1</li> </ul>
bit 0	G1D1N: Gate 1 Data Source 1 Negated Enable bit
	<ul> <li>1 = The Data Source 1 inverted signal is enabled for Gate 1</li> <li>0 = The Data Source 1 inverted signal is disabled for Gate 1</li> </ul>

#### REGISTER 23-5: CLCxGLSH: CLCx GATE LOGIC INPUT SELECT HIGH REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
G4D4T	G4D4N	G4D3T	G4D3N	G4D2T	G4D2N	G4D1T	G4D1N	
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
G3D4T	G3D4N	G3D3T	G3D3N	G3D2T	G3D2N	G3D1T	G3D1N	
bit 7	GSD4N	63031	G3D3N	G3D21	GSDZN	G3D11	bit C	
Laward								
Legend:	a h:t	$\lambda = \lambda $	L :4		nented bit ree			
R = Readabl		W = Writable bit		-	nented bit, rea	a as 0 x = Bit is unknown		
-n = Value at	PUR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	lown	
bit 15	G4D4T: Gate	4 Data Source	4 True Enable	bit				
		Source 4 signa						
		Source 4 signa						
bit 14	G4D4N: Gate	4 Data Source	e 4 Negated Er	able bit				
		Source 4 inver						
		Source 4 inver	-		e 4			
bit 13		4 Data Source						
	<ul> <li>1 = The Data Source 3 signal is enabled for Gate 4</li> <li>0 = The Data Source 3 signal is disabled for Gate 4</li> </ul>							
bit 12	G4D3N: Gate 4 Data Source 3 Negated Enable bit							
	<ul> <li>1 = The Data Source 3 inverted signal is enabled for Gate 4</li> <li>0 = The Data Source 3 inverted signal is disabled for Gate 4</li> </ul>							
bit 11		4 Data Source	•					
	1 = The Data	Source 2 signa Source 2 signa	I is enabled fo	r Gate 4				
bit 10		4 Data Source						
		Source 2 inver	•		e 4			
	0 = The Data	Source 2 inver	ted signal is di	sabled for Gate	e 4			
bit 9	G4D1T: Gate	4 Data Source	1 True Enable	bit				
		Source 1 signa						
		Source 1 signa						
bit 8		4 Data Source	-					
		Source 1 inver Source 1 inver						
bit 7	G3D4T: Gate	3 Data Source	4 True Enable	bit				
	<ul> <li>1 = The Data Source 4 signal is enabled for Gate 3</li> <li>0 = The Data Source 4 signal is disabled for Gate 3</li> </ul>							
bit 6	G3D4N: Gate	3 Data Source	4 Negated Er	able bit				
	1 = The Data	Source 4 inver Source 4 inver	ted signal is er	habled for Gate				
bit 5		3 Data Source	-					
		Source 3 signa						
		Source 3 signa						
bit 4	G3D3N: Gate	3 Data Source	e 3 Negated Er	able bit				
		Source 3 inver						
	0 - The Data	Source 3 inver	ted signal is di	sabled for Gate	- 3			

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# REGISTER 23-5: CLCxGLSH: CLCx GATE LOGIC INPUT SELECT HIGH REGISTER (CONTINUED)

bit 3	G3D2T: Gate 3 Data Source 2 True Enable bit
	1 = The Data Source 2 signal is enabled for Gate 3
	0 = The Data Source 2 signal is disabled for Gate 3
bit 2	G3D2N: Gate 3 Data Source 2 Negated Enable bit
	1 = The Data Source 2 inverted signal is enabled for Gate 3
	$\ensuremath{_{0}}$ = The Data Source 2 inverted signal is disabled for Gate 3
bit 1	G3D1T: Gate 3 Data Source 1 True Enable bit
	1 = The Data Source 1 signal is enabled for Gate 3
	0 = The Data Source 1 signal is disabled for Gate 3
bit 0	G3D1N: Gate 3 Data Source 1 Negated Enable bit
	GSD IN. Gale 5 Data Source Theyated Linable bit
	1 = The Data Source 1 inverted signal is enabled for Gate 3

### 24.0 12-BIT A/D CONVERTER WITH THRESHOLD DETECT

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the 12-Bit A/D Converter, refer to the "dsPIC33/PIC24 Family Reference Manual", "12-Bit A/D Converter with Threshold Detect" (DS39739), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The A/D Converter has the following key features:

- Successive Approximation Register (SAR)
   Conversion
- Selectable 10-Bit or 12-Bit (default) Conversion Resolution
- · Conversion Speeds of up to 200 ksps (12-bit)
- Up to 19 Analog Input Channels (internal and external)
- Multiple Internal Reference Input Channels
- External Voltage Reference Input Pins
- Unipolar Differential Sample-and-Hold (S/H)
   Amplifier
- Automated Threshold Scan and Compare
   Operation to Pre-Evaluate Conversion Results
- Selectable Conversion Trigger Source
- Fixed Length (one word per channel), Configurable Conversion Result Buffer
- Four Options for Results Alignment
- Configurable Interrupt Generation
- Enhanced DMA Operations with Indirect Address Generation
- Operation During CPU Sleep and Idle modes

The 12-bit A/D Converter module is an enhanced version of the 10-bit module offered in earlier PIC24 devices. It is a Successive Approximation Register (SAR) Converter, enhanced with 12-bit resolution, a wide range of automatic sampling options, tighter integration with other analog modules and a configurable results buffer.

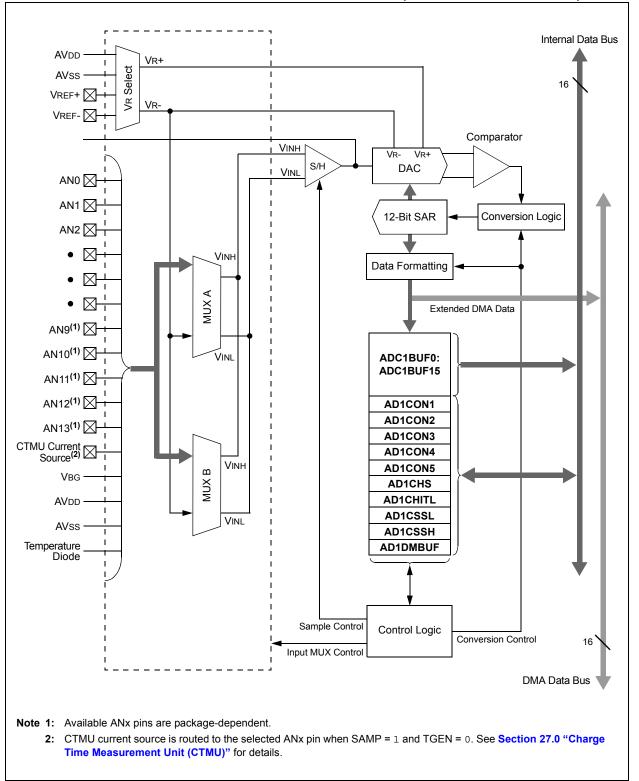
It also includes a unique Threshold Detect feature that allows the module itself to make simple decisions based on the conversion results, and enhanced operation with the DMA Controller through Peripheral Indirect Addressing (PIA).

A simplified block diagram for the module is shown in Figure 24-1.

#### 24.1 Basic Operation

To perform a standard A/D conversion:

- 1. Configure the module:
  - a) Configure port pins as analog inputs by setting the appropriate bits in the ANSx registers (see Section 11.2 "Configuring Analog Port Pins (ANSx)" for more information).
  - b) Select the voltage reference source to match the expected range on analog inputs (AD1CON2<15:13>).
  - c) Select the positive and negative multiplexer inputs for each channel (AD1CHS<15:0>).
  - d) Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3<7:0>).
  - e) Select the appropriate sample/conversion sequence (AD1CON1<7:4> and AD1CON3<12:8>).
  - For Channel A scanning operations, select the positive channels to be included (AD1CSSH and AD1CSSL registers).
  - g) Select how conversion results are presented in the buffer (AD1CON1<9:8> and AD1CON5 register).
  - h) Select the interrupt rate (AD1CON2<5:2>).
  - i) Turn on A/D module (AD1CON1<15>).
- 2. Configure the A/D interrupt (if required):
  - a) Clear the AD1IF bit (IFS0<13>).
  - b) Enable the AD1IE interrupt (IEC0<13>).
  - c) Select the A/D interrupt priority (IPC3<6:4>).
- If the module is configured for manual sampling, set the SAMP bit (AD1CON1<1>) to begin sampling.



#### FIGURE 24-1: 12-BIT A/D CONVERTER BLOCK DIAGRAM (PIC24FJ256GA705 FAMILY)

# 24.2 Extended DMA Operations

In addition to the standard features available on all 12-bit A/D Converters, PIC24FJ256GA705 family devices implement a limited extension of DMA functionality. This extension adds features that work with the device's DMA Controller to expand the A/D module's data storage abilities beyond the module's built-in buffer.

The Extended DMA functionality is controlled by the DMAEN bit (AD1CON1<11>); setting this bit enables the functionality. The DMABM bit (AD1CON1<12>) configures how the DMA feature operates.

### 24.2.1 EXTENDED BUFFER MODE

Extended Buffer mode (DMABM = 1) maps the A/D Data Buffer registers and data from all channels above 13 into a user-specified area of data RAM. This allows users to read the conversion results of channels above 13, which do not have their own memory-mapped A/D buffer locations, from data memory.

To accomplish this, the DMA must be configured in Peripheral Indirect Addressing mode and the DMA destination address must point to the beginning of the buffer. The DMA count must be set to generate an interrupt after the desired number of conversions.

In Extended Buffer mode, the A/D control bits will function similarly to non-DMA modes. The BUFREGEN bit will still select between FIFO mode and Channel-Aligned mode, but the number of words in the destination FIFO will be determined by the SMPI<4:0> bits in DMA mode. In FIFO mode, the BUFM bit will still split the output FIFO into two sets of 13 results (the SMPIx bits should be set accordingly) and the BUFS bit will still indicate which set of results is being written to and which can be read.

### 24.2.2 PIA MODE

When DMABM = 0, the A/D module is configured to function with the DMA Controller for Peripheral Indirect Addressing (PIA) mode operations. In this mode, the A/D module generates an 11-bit Indirect Address (IA). This is ORed with the destination address in the DMA Controller to define where the A/D conversion data will be stored.

In PIA mode, the buffer space is created as a series of contiguous smaller buffers, one per analog channel. The size of the channel buffer determines how many analog channels can be accommodated. The size of the buffer is selected by the DMABL<2:0> bits (AD1CON4<2:0>). The size options range from a single word per buffer to 128 words. Each channel is allocated a buffer of this size, regardless of whether or not the channel will actually have conversion data.

The IA is created by combining the base address within a channel buffer with three to five bits (depending on the buffer size) to identify the channel. The base address ranges from zero to seven bits wide, depending on the buffer size. The address is right-padded with a '0' in order to maintain address alignment in the Data Space. The concatenated channel and base address bits are then left-padded with zeros, as necessary, to complete the 11-bit IA.

The IA is configured to auto-increment which channel is written in each analog input's sub-buffer during write operations by using the SMPIx bits (AD1CON2<6:2>).

As with PIA operations for any DMA-enabled module, the base destination address in the DMADSTn register must be masked properly to accommodate the IA. Table 24-1 shows how complete addresses are formed. Note that the address masking varies for each buffer size option. Because of masking requirements, some address ranges may not be available for certain buffer sizes. Users should verify that the DMA base address is compatible with the buffer size selected.

Figure 24-2 shows how the parts of the address define the buffer locations in data memory. In this case, the module "allocates" 256 bytes of data RAM (1000h to 1100h) for 32 buffers of four words each. However, this is not a hard allocation and nothing prevents these locations from being used for other purposes. For example, in the current case, if Analog Channels 1, 3 and 8 are being sampled and converted, conversion data will only be written to the channel buffers, starting at 1008h, 1018h and 1040h. The holes in the PIA buffer space can be used for any other purpose. It is the user's responsibility to keep track of buffer locations and prevent data overwrites.

# 24.3 Registers

The 12-bit A/D Converter is controlled through a total of 13 registers:

- AD1CON1 through AD1CON5 (Register 24-1 through Register 24-5)
- AD1CHS (Register 24-6)
- ANCFG (Register 24-7)

- AD1CHITL (Register 24-8)
- AD1CSSH and AD1CSSL (Register 24-9 and Register 24-10)
- AD1CTMENH and AD1CTMENL (Register 24-11 and Register 24-12)
- AD1DMBUF (not shown) The 16-bit conversion buffer for Extended Buffer mode

<b>ΤΔΒΙ Ε 24-1</b> ·	INDIRECT ADDRESS GENERATION IN PIA MODE
IADLL 24-1.	

DMABL<2:0>	Buffer Size per Channel (words)	Generated Offset Address (lower 11 bits)	Available Input Channels	Allowable DMADSTn Addresses
000	1	000 00cc ccc0	32	xxxx xxxx xx00 0000
001	2	000 0ccc ccn0	32	xxxx xxxx x000 0000
010	4	000 cccc cnn0	32	xxxx xxxx 0000 0000
011	8	00c cccc nnn0	32	xxxx xxx0 0000 0000
100	16	0cc cccn nnn0	32	xxxx xx00 0000 0000
101	32	ccc ccnn nnn0	32	xxxx x000 0000 0000
110	64	ccc cnnn nnn0	16	xxxx x000 0000 0000
111	128	ccc nnnn nnn0	8	xxxx x000 0000 0000

**Legend:** CCC = Channel number (three to five bits), n = Base buffer address (zero to seven bits), x = User-definable range of DMADSTn for base address, 0 = Masked bits of DMADSTn for IA

# 24.4 Achieving Maximum A/D Converter Performance

In order to get the shortest overall conversion time (called the 'throughput') while maintaining accuracy, several factors must be considered. These are described in detail below.

- Dependence of AVDD If the AVDD supply is < 2.7V, the Charge Pump Enable bit (PUMPEN, AD1CON3<13>) should be set to '1'. The input channel multiplexer has a varying resistance with AVDD (the lower AVDD, the higher the internal switch resistance). The charge pump provides a higher internal AVDD to keep the switch resistance as low as possible.
- Dependence on TAD The ADC timing is driven by TAD, not TCYC. Selecting the TAD time correctly is critical to getting the best ADC throughput. It is important to note that the overall ADC throughput is not simply the 'Conversion Time' of the SAR. It is the combination of the Conversion Time, the Sample Time and additional TAD delays for internal synchronization logic.
- Relationship between TCYC and TAD There is not a fixed 1:1 timing relationship between TCYC and TAD. The fastest possible throughput is fundamentally set by TAD (min), not by TCYC. The TAD time is set as a programmable integer multiple of TCYC by the ADCS<7:0> bits. Referring to Table 32-25, the TAD (min) time is greater than the 4 MHz period of the dedicated ADC RC clock generator. Therefore, TAD must be 2 TCYC in order to use the RC clock for fastest throughput. The TAD (min) is a multiple of 3.597 MHz as opposed to 4 MHz. To run as fast as possible, TCYC must be a multiple of TAD (min) because values of ADCSx are integers. For example, if a standard 'color burst' crystal of 14.31818 MHz is used, TCYC is 279.4 ns, which is very close to TAD (min) and the ADC throughput is optimal. Running at 16 MHz will actually reduce the throughput, because TAD will have to be 500 ns as the TCYC of 250 ns violates TAD (min).

 Dependence on driving Source Resistance (Rs) – Certain transducers have high output impedance (> 2.5 k $\Omega$ ). Having a high Rs will require longer sampling time to charge the S/H cap through the resistance path (see Figure 25-3). The worst case is a full-range voltage step of AVss to AVDD with the sampling cap at AVss. The capacitor time constant is (Rs + RIC + Rss) (CHOLD) and the sample time needs to be 6 time constants minimum (8 are preferred). Since the ADC logic timing is TAD-based, the sample time (in TAD) must be long enough, over all conditions, to charge/discharge CHOLD. Do not assume one TAD is sufficient sample time; longer times may be required to achieve the accuracy needed by the application. The value of CHOLD is 40 pF.

A small amount of charge is present at the ADC input pin when the sample switch is closed. If Rs is high, this will generate a DC error exceeding 1 LSB. Keeping Rs <  $50\Omega$  is recommenced for best results. The error can also be reduced by increasing sample time (a  $2 k\Omega$  value of Rs requires a  $3 \mu$ S sample time to eliminate the error).

Calculating Throughput – The throughput of the ADC is based on TAD. The throughput is given by:

*Throughput* = 1/(Sample Time + SAR Conversion Time + Clock Sync Time)

### where:

Sample Time is the calculated TAD periods for the application. SAR Conversion Time is 12 TAD for 10-bit and 14 TAD for 12-bit conversions. Clock Sync Time is 2.5 TAD (worst case).

**Example:** For a 12-bit ADC throughput, if using FRC = 8 MHz and the Sample Time is 1 TAD, the use of an 8 MHz FRC means the TCYC = 250 ns and this requires: TAD = 2 TCYC = 500 ns. Therefore, the throughput is:

 $Throughput = \frac{1}{(500 \text{ ns})} + (14 * 500 \text{ ns}) + (2.5 * 500 \text{ ns}) = \frac{114.28 \text{KS/sec}}{114.28 \text{KS/sec}}$ 

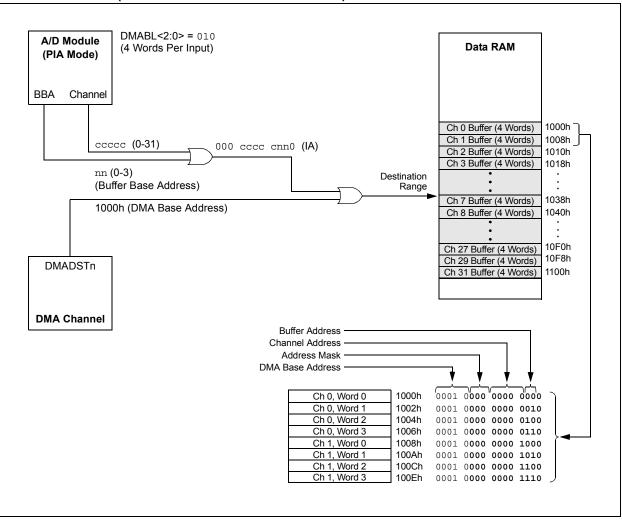
Note that the clock sync delay could be as little as 1.5 TAD, which could produce 121 KS/sec, but that cannot be ensured as the timing relationship is asynchronous and not specified. The worst case timing of 2.5 TAD should be used to calculate throughput.

**Example:** A certain transducer has a 20 k $\Omega$  output impedance. If AVDD is 3.0, the maximum sample time needed would be determined by the following:

Sample Time = 
$$6 * (Rs + Ric + Rss) * CHOLD$$
  
=  $6 * (20K + 250 + 350) * 40 \, pF$   
=  $4.95 \, uS$ 

If TAD = 500 ns, this requires a Sample Time of 4.95  $\mu$ s/ 500 ns = 10 TAD (for a full-step voltage on the transducer output). Rss is 350 $\Omega$  because AVDD is above 2.7V.

# FIGURE 24-2: EXAMPLE OF BUFFER ADDRESS GENERATION IN PIA MODE (4-WORD BUFFERS PER CHANNEL)



R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
ADON		ADSIDL	DMABM <sup>(1)</sup>	DMAEN	MODE12	FORM1	FORM0			
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0, HSC	R/C-0, HSC			
SSRC3	SSRC2	SSRC1	SSRC0	—	ASAM	SAMP	DONE			
bit 7							bit			
Legend:		C = Clearable		•	nented bit, read					
R = Readable		W = Writable			are Settable/C					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own			
bit 15		Derating Mode	, hit							
DIC 15		erter is operati								
	0 = A/D Conv	•	ng							
bit 14	Unimplemen	ted: Read as '	0'							
bit 13	ADSIDL: A/D	Stop in Idle M	ode bit							
			eration when de		le mode					
			ation in Idle mod							
bit 12	DMABM: Extended DMA Buffer Mode Select bit <sup>(1)</sup> 1 = Extended Buffer mode: Buffer address is defined by the DMADSTn register									
							>			
bit 11	<ul> <li>PIA mode: Buffer addresses are defined by the DMA Controller and AD1CON4&lt;2:0&gt;</li> <li>DMAEN: Extended DMA/Buffer Enable bit</li> </ul>									
			er features are	enabled						
	0 = Extended	features are d	isabled							
bit 10	MODE12: A/I	D 12-Bit Opera	tion Mode bit							
	1 = 12-bit A/D									
bit 9-8	0 = 10-bit A/D	•	ormat bits (see	formata fallowi	ng)					
DIL 9-0		al result, signe	-	IOITTIALS IOITOWI	ng)					
			ult, unsigned, le	ft justified						
		result, signed,		-						
			t, unsigned, righ							
bit 7-4		-	Source Select	bits						
	0000 = SAMF 0001 = INTO	<sup>o</sup> is cleared by	sonware							
	0001 = INTO 0010 = Timer3									
	0100 = CTMU trigger									
			er during Sleep during Sleep m							
		Convert mode	during Sleep In	iuue)						
bit 3	Unimplemen	ted: Read as '	0'							
bit 2	-	Sample Auto-St								
		-	iately after last	conversion; SA	MP bit is auto	-set				
	0 = Sampling	-								

### REGISTER 24-1: AD1CON1: A/D CONTROL REGISTER 1

Note 1: This bit is only available when Extended DMA and buffer features are available (DMAEN = 1).

## REGISTER 24-1: AD1CON1: A/D CONTROL REGISTER 1 (CONTINUED)

- bit 1SAMP: A/D Sample Enable bit1 = A/D Sample-and-Hold amplifiers are sampling0 = A/D Sample-and-Hold amplifiers are holdingbit 0DONE: A/D Conversion Status bit1 = A/D conversion cycle has completed
  - 0 = A/D conversion cycle has not started or is in progress
- Note 1: This bit is only available when Extended DMA and buffer features are available (DMAEN = 1).

REGISTER		CON2: A/D CO	_							
R/W-0	R/W-0	R/W-0	r-0	R/W-0	R/W-0	U-0	U-0			
PVCFG1	PVCFG0	NVCFG0		BUFREGEN	CSCNA					
bit 15							bit 8			
R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
BUFS	SMPI4	SMPI3	SMPI2	SMPI1	SMPI0	BUFM	ALTS			
bit 7							bit 0			
Legend:		r = Reserved b	oit							
R = Readabl	e bit	W = Writable b	oit	U = Unimpleme	ented bit, read	1 as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unkn	own			
bit 15-14	PVCFG<1:0>	A/D Converter	Positive Vol	tage Reference C	Configuration b	oits				
		mented, do not	use							
	01 = External 00 = AVDD	I VREF+								
bit 13		Converter Neo	ative Voltage	e Reference Conf	figuration bit					
	1 = External \	-	jaare renage		.garation ait					
	0 = AVss									
bit 12	Reserved: M	aintain as '0'								
bit 11	BUFREGEN:	A/D Buffer Reg	ister Enable	bit						
		on result is loade t buffer is treate		Iffer location dete	ermined by the	e converted chai	nnel			
bit 10	CSCNA: Sca	n Input Selectio	ns for CH0+ I	During Sample A	bit					
	1 = Scans inp									
	0 = Does not	-								
bit 9-8	Unimplemen	ted: Read as '0	,							
bit 7	BUFS: Buffer Fill Status bit									
		N = 1 and DMAI			ratartı (buffa					
	[buffer sta		e – 1)]. User s	ouffer from [buffe should access da			0			
	-	•	· •	buffer from [buffe	r start] to [buf	fer start + (buffe	er size/2) – 1]			
			located from	buffer start + (buf	fer size/2)] to [	buffer start + (bu	uffer size – 1)]			
	When DMAE			DC1BUF25, user	should acces	s data in				
		F0-ADC1BUF1			SHOULD ALLES					
				C1BUF12, user s	should access	data in				
	ADC1BU	F13-ADC1BUF	25							

# REGISTER 24-2: AD1CON2: A/D CONTROL REGISTER 2

# REGISTER 24-2: AD1CON2: A/D CONTROL REGISTER 2 (CONTINUED)

bit 6-2	SMPI<4:0>: Interrupt Sample/DMA Increment Rate Select bits
	When DMAEN = 1 and DMABM = 0:
	11111 = Increments the DMA address after completion of the 32nd sample/conversion operation
	11110 = Increments the DMA address after completion of the 31st sample/conversion operation
	•
	•
	•
	00001 = Increments the DMA address after completion of the 2nd sample/conversion operation 00000 = Increments the DMA address after completion of each sample/conversion operation
	When DMAEN = 1 and DMABM = 1:
	11111 = Resets the DMA offset after completion of the 32nd sample/conversion operation 11110 = Resets the DMA offset after completion of the 31nd sample/conversion operation
	•
	•
	•
	00001 = Resets the DMA offset after completion of the 2nd sample/conversion operation 00000 = Resets the DMA offset after completion of every sample/conversion operation
	When DMAEN = 0:
	11111 = Interrupts at the completion of the conversion for each 32nd sample
	11110 = Interrupts at the completion of the conversion for each 31st sample
	•
	•
	•
	00001 = Interrupts at the completion of the conversion for every other sample 00000 = Interrupts at the completion of the conversion for each sample
bit 1	BUFM: Buffer Fill Mode Select bit
	<ul> <li>1 = Starts buffer filling at ADC1BUF0 on first interrupt and ADC1BUF13 on next interrupt</li> <li>0 = Always starts filling buffer at ADC1BUF0</li> </ul>
bit 0	ALTS: Alternate Input Sample Mode Select bit
	<ul> <li>1 = Uses channel input selects for Sample A on first sample and Sample B on next sample</li> <li>0 = Always uses channel input selects for Sample A</li> </ul>

R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
ADRC <sup>(1)</sup>	EXTSAM	PUMPEN <sup>(2)</sup>	SAMC4	SAMC3	SAMC2	SAMC1	SAMC0				
bit 15							bit 8				
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
ADCS7	ADCS6	ADCS5	ADCS4	ADCS3	ADCS2	ADCS1	ADCS0				
bit 7							bit (				
Legend:											
R = Readabl	le bit	W = Writable b	oit	U = Unimplem	nented bit, read	d as '0'					
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown				
bit 15	ADRC: A/D (	Conversion Cloc	k Source bit <sup>(1</sup>	)							
	1 = Dedicate	d ADC RC clock	generator (4	MHz nominal).							
		rived from syster									
bit 14	EXTSAM: Extended Sampling Time bit										
			3								
			•								
	1 = A/D is stil	ll sampling after ished sampling	•								
bit 13	1 = A/D is stil 0 = A/D is fini	I sampling after	SAMP = 0								
bit 13	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Ch	ll sampling after ished sampling	SAMP = $0$ able bit <sup>(2)</sup>								
bit 13	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p	ll sampling after ished sampling narge Pump Ena	SAMP = 0 able bit <sup>(2)</sup> s is enabled								
bit 13 bit 12-8	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p 0 = Charge p	I sampling after ished sampling narge Pump Ena ump for switche	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled	is							
	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p 0 = Charge p	I sampling after ished sampling narge Pump Ena ump for switche ump for switche Auto-Sample T	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled	is							
	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p 0 = Charge p <b>SAMC&lt;4:0&gt;:</b>	I sampling after ished sampling narge Pump Ena ump for switche ump for switche Auto-Sample T	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled	ts							
	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> CH 1 = Charge p 0 = Charge p <b>SAMC&lt;4:0&gt;:</b> 11111 = 31	I sampling after ished sampling narge Pump Ena ump for switche ump for switche Auto-Sample T IAD	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled	ts							
	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> CH 1 = Charge p 0 = Charge p <b>SAMC&lt;4:0&gt;:</b> 11111 = 31 T	I sampling after ished sampling narge Pump Ena ump for switche ump for switche Auto-Sample T IAD	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled	ls							
bit 12-8	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p 0 = Charge p <b>SAMC&lt;4:0&gt;:</b> 11111 = 31 T ••• 00001 = 1 TA 00000 = 0 TA	I sampling after ished sampling narge Pump Ena ump for switche ump for switche Auto-Sample T IAD	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled ime Select bi								
	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p 0 = Charge p <b>SAMC&lt;4:0&gt;:</b> 11111 = 31 T ••• 00001 = 1 TA 00000 = 0 TA <b>ADCS&lt;7:0&gt;:</b>	I sampling after ished sampling harge Pump Ena ump for switche ump for switche Auto-Sample T TAD	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled ime Select bin n Clock Selec								
bit 12-8	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p 0 = Charge p <b>SAMC&lt;4:0&gt;:</b> 11111 = 31 T ••• 00001 = 1 TA 00000 = 0 TA <b>ADCS&lt;7:0&gt;:</b> 11111111 =	I sampling after ished sampling harge Pump Ena ump for switche ump for switche Auto-Sample T FAD AD A/D Conversior 256 • Tcy = TAD	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled ime Select bin n Clock Selec								
bit 12-8	1 = A/D is stil 0 = A/D is fini <b>PUMPEN:</b> Cf 1 = Charge p 0 = Charge p <b>SAMC&lt;4:0&gt;:</b> 11111 = 31 T ••• 00001 = 1 TA 00000 = 0 TA <b>ADCS&lt;7:0&gt;:</b> 11111111 =	I sampling after ished sampling harge Pump Ena ump for switche ump for switche Auto-Sample T FAD AD A/D Conversior 256 • TCY = TAD	SAMP = 0 able bit <sup>(2)</sup> s is enabled s is disabled ime Select bin n Clock Selec								

### REGISTER 24-3: AD1CON3: A/D CONTROL REGISTER 3

ADRC = 1 will violate the TAD (min) specification.
2: The user should enable the charge pump if AVDD is < 2.7 V. Longer sample times are required due to the increase of the internal resistance of the MUX if the charge pump is disabled.</li>

## REGISTER 24-4: AD1CON4: A/D CONTROL REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
_	—	—	—	—	[	DMABL<2:0> <sup>(1</sup>	)
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'							
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared x = Bit is unknown		

#### bit 15-3 Unimplemented: Read as '0'

- bit 2-0 DMABL<2:0>: DMA Buffer Size Select bits<sup>(1)</sup>
  - 111 = Allocates 128 words of buffer to each analog input
  - 110 = Allocates 64 words of buffer to each analog input
  - 101 = Allocates 32 words of buffer to each analog input
  - 100 = Allocates 16 words of buffer to each analog input
  - 011 = Allocates 8 words of buffer to each analog input
  - 010 = Allocates 4 words of buffer to each analog input
  - 001 = Allocates 2 words of buffer to each analog input
  - 000 = Allocates 1 word of buffer to each analog input
- **Note 1:** The DMABL<2:0> bits are only used when AD1CON1<11> = 1 and AD1CON1<12> = 0; otherwise, their value is ignored.

R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0			
ASEN	LPEN	CTMREQ	BGREQ	_	—	ASINT1	ASINT0			
bit 15	·	•					bit			
U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0			
			_	WM1	WM0	CM1	CM0			
bit 7						0	bit			
Logondi										
<b>Legend:</b> R = Readab	le hit	W = Writable I	nit	U = Unimplem	onted hit read	d as 'O'				
			JIL	-		x = Bit is unki	2014/2			
-n = Value a	IPUR	'1' = Bit is set		'0' = Bit is clea	areu		IOWII			
bit 15	ASEN: Auto-	Scan Enable bit	i i							
	1 = Auto-sca									
	0 = Auto-sca									
bit 14		Power Enable bi								
	•	er is enabled aff								
bit 13	-	er is enabled after								
DIL 13		TMU Request b enabled when t		alad and active						
		not enabled by								
bit 12		BGREQ: Band Gap Request bit								
	1 = Band gap	o is enabled whe	en the A/D is e	nabled and acti	ve					
bit 11-10	Unimplemen	nted: Read as 'o	)'							
bit 9-8	ASINT<1:0>	: Auto-Scan (Th	reshold Detect	t) Interrupt Mod	e bits					
	10 = Interrup	ot after Threshol ot after valid com ot after Threshol rrupt	pare has occu	urred		compare has o	occurred			
bit 7-4	Unimplemer	nted: Read as 'd	)'							
bit 3-2	<b>WM&lt;1:0&gt;:</b> W	/rite Mode bits								
	11 = Reserve									
		mpare only (co				s are generate	d when a vali			
	match occurs, as defined by the CMx and ASINTx bits) 01 = Convert and save (conversion results are saved to locations as determined by the register bit									
	when a match occurs, as defined by the CMx bits)									
	00 = Legacy	operation (conv	ersion data is	saved to a loca	tion determine	ed by the Buffer	register bits)			
bit 1-0	CM<1:0>: Compare Mode bits									
		Window mode			conversion res	sult is outside	of the windo			
		by the correspo Vindow mode: V			ersion result is	inside the wind	how defined h			
		esponding buffe								
	01 = Greater	Than mode: Va		rs if the result is	greater than t	he value in the	correspondin			
	Duffor r	aniatan								
		egister nan mode: Valid	match anothing '	fthe readities to	o those the second	in the comment	nondine Duff			

# REGISTER 24-5: AD1CON5: A/D CONTROL REGISTER 5

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CH0NB2	CH0NB1	CH0NB0	CH0SB4	CH0SB3	CH0SB2	CH0SB1	CH0SB0
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CH0NA2	CH0NA1	CHONAO	CH0SA4	CH0SA3	CH0SA2	CH0SA1	CH0SA0
bit 7	0.101.0.1	0.10.0.0		0.100.10	0.1001.2	0.100.11	bit
Legend:							
R = Readabl	e bit	W = Writable I	oit	U = Unimplem	nented bit, read	l as '0'	
-n = Value at		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkn	iown
	1xx = Unimpl 01x = Unimpl 001 = Unimpl 000 = AVss	emented emented					
bit 12-8	11110 = AVD 11101 = AVS 11100 = Ban 10000-1101 01111 = No e	D <sup>(1)</sup> S <sup>(1)</sup> d Gap Reference external channe external channe 3 2 1 0	ce (V <sub>BG</sub> ) <sup>(1)</sup> Is connected (	used for CTMU	)	sensor)	
bit 7-5		: Sample A Cha	-	ve Input Select	bits		
bit 4-0	CH0SA<4:0> Same definition	-		e Input Select b	pits		

### REGISTER 24-6: AD1CHS: A/D SAMPLE SELECT REGISTER

Note 1: These input channels do not have corresponding memory-mapped result buffers.

### REGISTER 24-7: ANCFG: A/D BAND GAP REFERENCE CONFIGURATION REGISTER

		-	-	_			
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_			_		—	—	_
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
_	—	—	—	—	VBGEN3 <sup>(1)</sup>	VBGEN2 <sup>(1)</sup>	VBGEN1 <sup>(1)</sup>
bit 7							bit 0
Legend:							
R = Readal	ble bit	W = Writable	bit	U = Unimplem	nented bit, read	1 as '0'	
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15-3	Unimplemen	ted: Read as '	0'				
bit 2	VBGEN3: A/I	D Band Gap Re	eference Enable	e bit <sup>(1)</sup>			
	1 = Band gap	reference is er	nabled				
	0 = Band gap	reference is di	sabled				
bit 1	VBGEN2: CT	MU and Comp	arator Band Ga	ap Reference E	inable bit <sup>(1)</sup>		
	1 = Band gap	reference is ei	nabled				
		· · ·					

0 = Band gap reference is disabled

### bit 0 VBGEN1: VREG, BOR, HLVD, FRC, NVM and A/D Boost Band Gap Reference Enable bit<sup>(1)</sup>

- 1 = Band gap reference is enabled
- 0 = Band gap reference is disabled
- **Note 1:** When a module requests a band gap reference voltage, that reference will be enabled automatically after a brief start-up time. The user can manually enable the band gap references using the ANCFG register before enabling the module requesting the band gap reference to avoid this start-up time (~1 ms).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
_			CHH<13:8> <sup>(1)</sup>						
bit 15	÷	·					bit 8		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
			CHH	I<7:0>					
bit 7							bit 0		
Legend:									
R = Readab	le bit	W = Writable bit	t	U = Unimplen	nented bit, rea	ad as '0'			
-n = Value a	It POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknow			nown		
bit 15-14	-	nted: Read as '0'	(1)						
bit 13-0	CHH<13:0>:	A/D Compare Hit	bits <sup>(1)</sup>						
	If CM<1:0> =	11:							
	1 = A/D Res	ult Buffer n has be	en written w	ith data or a ma	tch has occu	rred			
	0 = A/D Res	ult Buffer n has no	t been writte	en with data					
	For All Other	Values of CM<1:0	)> <u>:</u>						
	1 = A match	has occurred on A	VD Result C	hannel n					
	0 = No matcl	h has occurred on	A/D Result	Channel n					

**Note 1:** The CHH<13:10> bits are not implemented on 28-pin devices.

## REGISTER 24-9: AD1CSSH: A/D INPUT SCAN SELECT REGISTER (HIGH WORD)

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	—	—			CSS<28:24>			
bit 15							bit 8	
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
—	—	—	—	—	—	—	—	
bit 7	pit 7						bit 0	
Legend:								
R = Readable	bit	W = Writable b	bit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unkr			iown		

bit 15-13	Unimplemented: Read as '0'
bit 12-8	CSS<28:24>: A/D Input Scan Selection bits
	1 = Includes corresponding channel for input scan
	0 = Skips channel for input scan
bit 7-0	Unimplemented: Read as '0'

# REGISTER 24-10: AD1CSSL: A/D INPUT SCAN SELECT REGISTER (LOW WORD)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			CSS	S<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			CS	S<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown

bit 15-0 CSS<15:0>: A/D Input Scan Selection bits

1 = Includes corresponding channel for input scan

0 = Skips channel for input scan

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
_		CTMEN<30:28>		—	—	CTMEN	<25:24>
bit 15						•	bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			CTMEN	<23:16> <sup>(1)</sup>			
bit 7							bit 0
Legend:							
R = Readab	ole bit	W = Writable bi	t	U = Unimplem	nented bit, read	as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unkn	iown
bit 15	Unimpleme	nted: Read as '0'					
bit 14-12	CTMEN<30:	:28>: CTMU Enab	led During C	Conversion bits			
		s enabled and con s not connected to			nel during conv	ersion	
bit 11-10	Unimpleme	nted: Read as '0'					
bit 9-0	CTMEN<25	: <b>16&gt;:</b> CTMU Enab	led During C	Conversion bits <sup>(1</sup>	)		
		enabled and con	•			ersion	
		s not connected to			-		
Note di		hite are not evail.		:			

## REGISTER 24-11: AD1CTMENH: A/D CTMU ENABLE REGISTER (HIGH WORD)

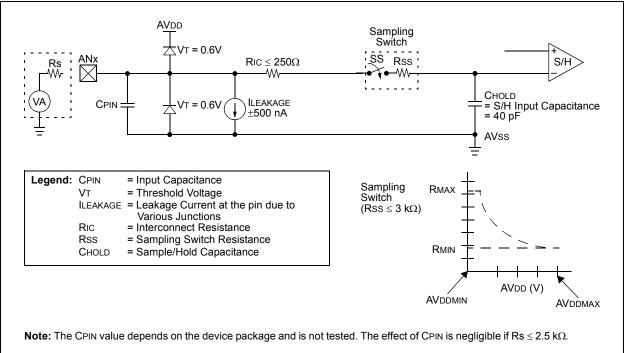
Note 1: CTMEN<23:16> bits are not available on 64-pin parts.

## REGISTER 24-12: AD1CTMENL: A/D CTMU ENABLE REGISTER (LOW WORD)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			CTN	IEN<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			CTN	/IEN<7:0>			
bit 7							bit C
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-0 **CTMEN<15:0>:** CTMU Enabled During Conversion bits 1 = CTMU is enabled and connected to the selected channel during conversion 0 = CTMU is not connected to this channel





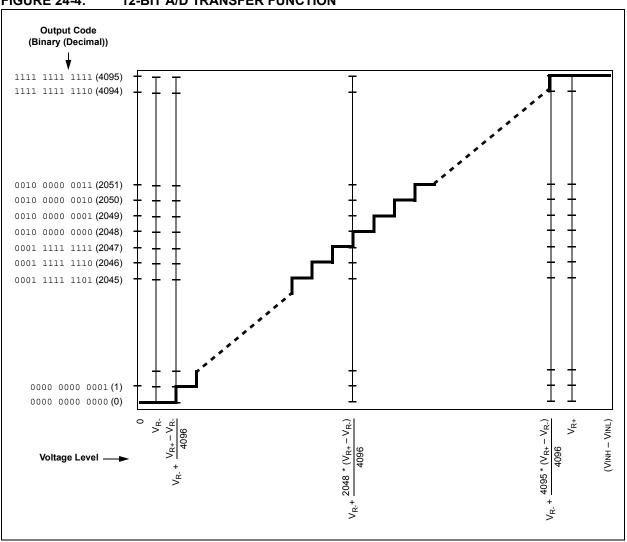
### EQUATION 24-1: A/D CONVERSION CLOCK PERIOD

$$TAD = TCY (ADCS + 1)$$

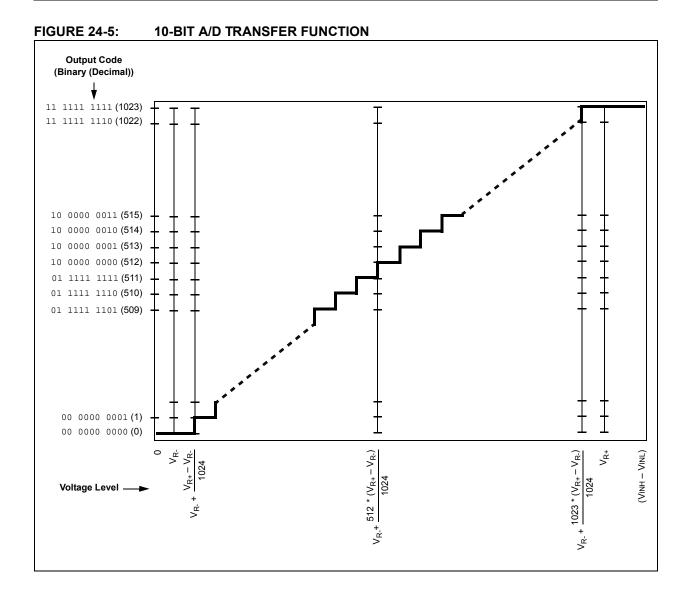
$$ADCS = \frac{TAD}{TCY} - 1$$

ź

**Note:** Based on Tcy = 2/Fosc; Doze mode and PLL are disabled.



### FIGURE 24-4: 12-BIT A/D TRANSFER FUNCTION



NOTES:

# 25.0 TRIPLE COMPARATOR MODULE

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Scalable Comparator Module" (DS39734), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The triple comparator module provides three dual input comparators. The inputs to the comparator can be configured to use any one of five external analog inputs (CxINA, CxINB, CxINC, CxIND and CVREF+) and a

voltage reference input from one of the internal band gap references or the comparator voltage reference generator (VBG and CVREF).

The comparator outputs may be directly connected to the CxOUT pins. When the respective COE bit equals '1', the I/O pad logic makes the unsynchronized output of the comparator available on the pin.

A simplified block diagram of the module in shown in Figure 25-1. Diagrams of the possible individual comparator configurations are shown in Figure 25-2 through Figure 25-4.

Each comparator has its own control register, CMxCON (Register 25-1), for enabling and configuring its operation. The output and event status of all three comparators is provided in the CMSTAT register (Register 25-2).

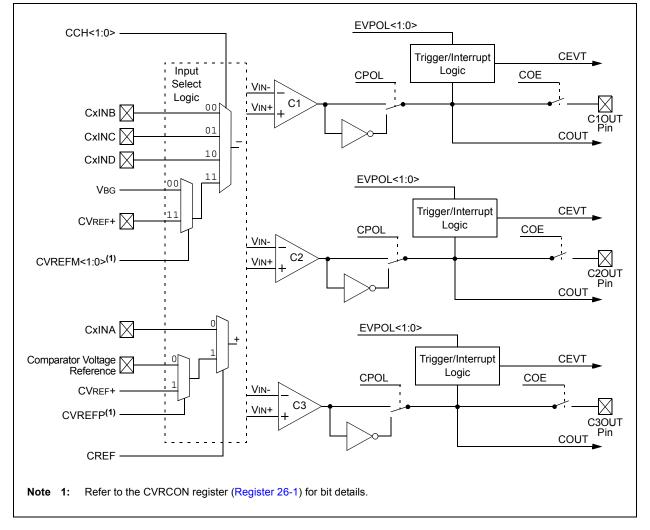


FIGURE 25-1: TRIPLE COMPARATOR MODULE BLOCK DIAGRAM



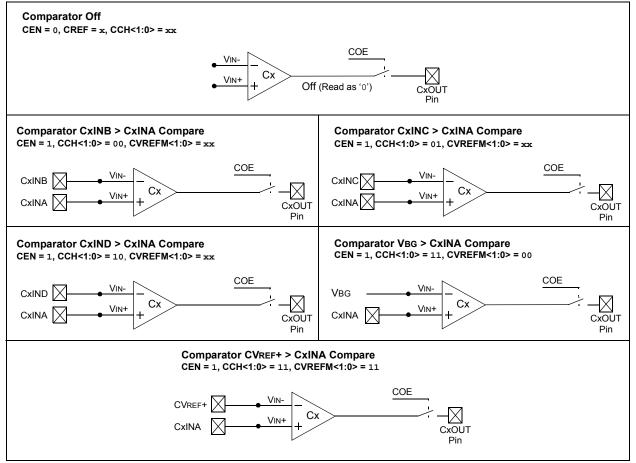
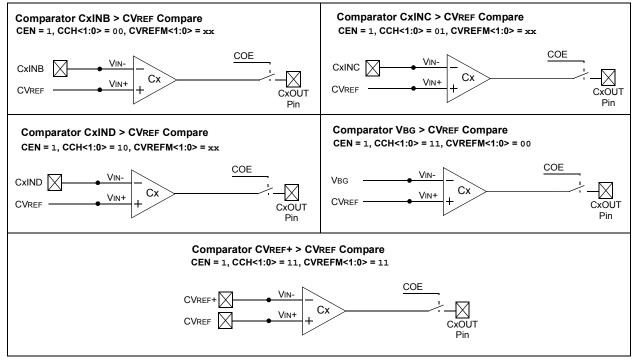
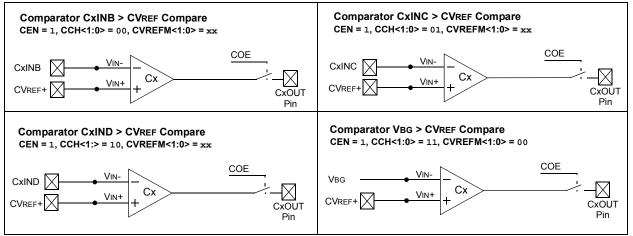


FIGURE 25-3: INDIVIDUAL COMPARATOR CONFIGURATIONS WHEN CREF = 1 AND CVREFP = 0







# REGISTER 25-1: CMxCON: COMPARATOR x CONTROL REGISTERS (COMPARATORS 1 THROUGH 3)

R/W-0 CEN bit 15 R/W-0 EVPOL1	R/W-0 COE R/W-0	R/W-0 CPOL	U-0	U-0	U-0	R/W-0, HS CEVT	R-0, HSC COUT bit 8		
bit 15 R/W-0 EVPOL1			—	_	—	CEVT			
R/W-0 EVPOL1	R/W-0	11-0					bit 8		
EVPOL1	R/W-0	11-0							
EVPOL1	R/W-0	11-0							
-		0-0	R/W-0	U-0	U-0	R/W-0	R/W-0		
	EVPOL0		CREF		—	CCH1	CCH0		
bit 7							bit 0		
Legend:		HS = Hardware	e Settable bit	HSC = Hardv	vare Settable	/Clearable bit			
R = Readabl	e bit	W = Writable b	oit	U = Unimpler	nented bit, re	ad as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown		
bit 15 bit 14	1 = Compara 0 = Compara <b>COE:</b> Compa 1 = Compara	arator Enable bit ator is enabled ator is disabled arator Output En ator output is pre ator output is inte	able bit esent on the C>	xOUT pin					
bit 13	•	parator Output P		pit					
	1 = Compara	ator output is inv ator output is not	erted						
bit 12-10	Unimplemer	nted: Read as '0	,						
bit 9	CEVT: Comparator Event bit								
	are disal	ator event that is bled until the bit ator event has n	is cleared	POL<1:0> has o	occurred; sub	sequent triggers	and interrupts		
bit 8	COUT: Comp	parator Output bi	t						
	$\frac{\text{When CPOL}}{1 = \text{VIN} + > \text{V}}$ $0 = \text{VIN} + < \text{V}$ $\frac{\text{When CPOL}}{1 = \text{VIN} + < \text{V}}$	/IN- /IN- = 1:							
	1 = VIN+ < V 0 = VIN+ > V								
bit 7-6	EVPOL<1:0> 11 = Trigger/ 10 = Trigger/ If CPOL High-to If CPOL Low-to-	: Trigger/Event/	s generated on s generated on <u>ed polarity):</u> hly. <u>plarity):</u> nly. s generated on	any change of transition of the	e comparator		CEVT = 0)		
	If CPOL Low-to- If CPOL	<u>= = 0 (non-invert</u> high transition o <u>= = 1 (inverted p</u> -low transition or	nly. olarity):						
	If CPOL Low-to- If CPOL High-to	high transition o _ = 1 (inverted p	nly. <u>olarity):</u> nly.	sabled					

### REGISTER 25-1: CMxCON: COMPARATOR x CONTROL REGISTERS (COMPARATORS 1 THROUGH 3) (CONTINUED)

- bit 4 **CREF:** Comparator Reference Select bits (non-inverting input)
  - 1 = Non-inverting input connects to the internal CVREF voltage
  - 0 = Non-inverting input connects to the CxINA pin
- bit 3-2 Unimplemented: Read as '0'
- bit 1-0 CCH<1:0>: Comparator Channel Select bits
  - 11 = Inverting input of the comparator connects to the internal selectable reference voltage specified by the CVREFM<1:0> bits in the CVRCON register
  - 10 = Inverting input of the comparator connects to the CxIND pin
  - 01 = Inverting input of the comparator connects to the CxINC pin
  - 00 = Inverting input of the comparator connects to the CxINB pin

### REGISTER 25-2: CMSTAT: COMPARATOR MODULE STATUS REGISTER

R/W-0	U-0	U-0	U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC
CMIDL	—	_	—	—	C3EVT	C2EVT	C1EVT
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC
—	—		—	—	C3OUT	C2OUT	C1OUT
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15	CMIDL: Comparator Stop in Idle Mode bit
	<ul> <li>1 = Discontinues operation of all comparators when device enters Idle mode</li> <li>0 = Continues operation of all enabled comparators in Idle mode</li> </ul>
bit 14-11	Unimplemented: Read as '0'
bit 10	C3EVT: Comparator 3 Event Status bit (read-only)
	Shows the current event status of Comparator 3 (CM3CON<9>).
bit 9	C2EVT: Comparator 2 Event Status bit (read-only)
	Shows the current event status of Comparator 2 (CM2CON<9>).
bit 8	C1EVT: Comparator 1 Event Status bit (read-only)
	Shows the current event status of Comparator 1 (CM1CON<9>).
bit 7-3	Unimplemented: Read as '0'
bit 2	C3OUT: Comparator 3 Output Status bit (read-only)
	Shows the current output of Comparator 3 (CM3CON<8>).
bit 1	C2OUT: Comparator 2 Output Status bit (read-only)
	Shows the current output of Comparator 2 (CM2CON<8>).
bit 0	C10UT: Comparator 1 Output Status bit (read-only)
	Shows the current output of Comparator 1 (CM1CON<8>).

NOTES:

# 26.0 COMPARATOR VOLTAGE REFERENCE

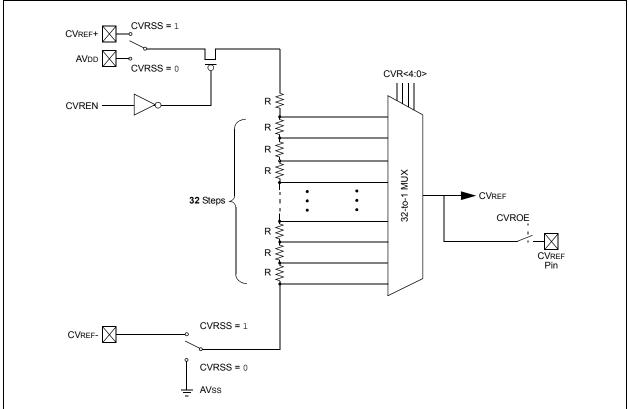
Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the "dsPIC33/PIC24 Family Reference Manual", "Dual Comparator Module" (DS39710), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

# 26.1 Configuring the Comparator Voltage Reference

The voltage reference module is controlled through the CVRCON register (Register 26-1). The comparator voltage reference provides two ranges of output voltage, each with 16 distinct levels. The primary difference between the ranges is the size of the steps selected by the CVREF Value Selection bits (CVR<4:0>), with one range offering finer resolution.

The comparator reference supply voltage can come from either VDD and VSS, or the external VREF+ and VREF-. The voltage source is selected by the CVRSS bit (CVRCON<5>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output.



### FIGURE 26-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM

	11.0	11.0	11.0	11.0						
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0			
	_	—		—	CVREFP	CVREFM1	CVREFM0			
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0			
bit 7		I					bit 0			
Legend:										
R = Readabl	le bit	W = Writable b	bit	U = Unimplen	nented bit, read	d as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown			
bit 15-11	Unimplemen	ted: Read as '0	,							
bit 10	CVREFP: Comparator Voltage Reference Select bit (valid only when CREF is '1')									
	<ul> <li>1 = CVREF+ is used as a reference voltage to the comparators</li> <li>0 = The CVR&lt;4:0&gt; bits (5-bit DAC) within this module provide the reference voltage to the comparators</li> </ul>									
		-	-	-		-	-			
bit 9-8	<b>CVREFM&lt;1:0&gt;:</b> Comparator Band Gap Reference Source Select bits (valid only when CCH<1:0> = 11)									
	00 = Band gap voltage is provided as an input to the comparators 01 = Reserved									
	10 = Reserved									
	11 = CVREF+	is provided as a	an input to the	e comparators						
bit 7	CVREN: Comparator Voltage Reference Enable bit									
	1 = CVREF circuit is powered on									
	0 = CVREF circuit is powered down									
bit 6	CVROE: Comparator VREF Output Enable bit									
	<ol> <li>CVREF voltage level is output on the CVREF pin</li> <li>CVREF voltage level is disconnected from the CVREF pin</li> </ol>									
bit 5		nparator VREF S								
bit 5		•			VREE-					
	1 = Comparator reference source, CVRSRC = CVREF+ – CVREF- 0 = Comparator reference source, CVRSRC = AVDD – AVSS									
bit 4-0	<b>CVR&lt;4:0&gt;:</b> C	comparator VREI	Value Selec	tion bits ( $0 \le CV$	/R<4:0> ≤ 31)					
	When CVRSS									
	•	REF-) + (CVR<4	:0>/32) • (CV	REF+ – CVREF-)	1					
	When CVRSS		(22) - (A)/pp							
	OVREF = (AVS	ss) + (CVR<4:0	≈13Z) ● (AVDD	- AVSS)						

## REGISTER 26-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

# 27.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Charge Time Measurement Unit, refer to the "dsPIC33/PIC24 Family Reference Manual", "Charge Time Measurement Unit (CTMU) and CTMU Operation with Threshold Detect" (DS30009743), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Charge Time Measurement Unit (CTMU) is a flexible analog module that provides charge measurement, accurate differential time measurement between pulse sources and asynchronous pulse generation. Its key features include:

- Thirteen External Edge Input Trigger Sources
- Polarity Control for Each Edge Source
- Control of Edge Sequence
- Control of Response to Edge Levels or Edge
   Transitions
- Time Measurement Resolution of One Nanosecond
- Accurate Current Source Suitable for Capacitive Measurement

Together with other on-chip analog modules, the CTMU can be used to precisely measure time, measure capacitance, measure relative changes in capacitance or generate output pulses that are independent of the system clock. The CTMU module is ideal for interfacing with capacitive-based touch sensors.

The CTMU is controlled through three registers: CTMUCON1L, CTMUCON1H and CTMUCON2L. CTMUCON1L enables the module, controls the mode of operation of the CTMU, controls edge sequencing, selects the current range of the current source and trims the current. CTMUCON1H controls edge source selection and edge source polarity selection. The CTMUCON2L register selects the current discharge source.

# 27.1 Measuring Capacitance

The CTMU module measures capacitance by generating an output pulse, with a width equal to the time between edge events, on two separate input channels. The pulse edge events to both input channels can be selected from four sources: two internal peripheral modules (OC1 and Timer1) and up to 13 external pins (CTED1 through CTED13). This pulse is used with the module's precision current source to calculate capacitance according to the relationship:

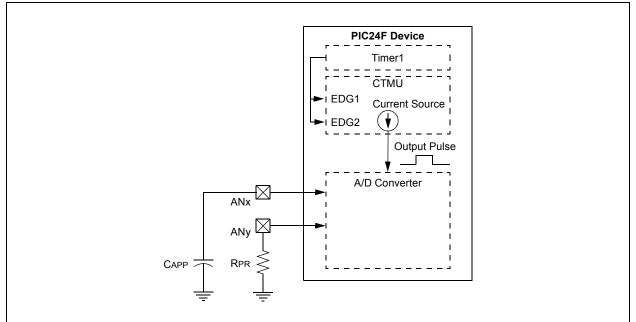
### EQUATION 27-1:

$$I = C \bullet \frac{dV}{dT}$$

For capacitance measurements, the A/D Converter samples an external Capacitor (CAPP) on one of its input channels, after the CTMU output's pulse. A Precision Resistor (RPR) provides current source calibration on a second A/D channel. After the pulse ends, the converter determines the voltage on the capacitor. The actual calculation of capacitance is performed in software by the application.

Figure 27-1 illustrates the external connections used for capacitance measurements, and how the CTMU and A/D modules are related in this application. This example also shows the edge events coming from Timer1, but other configurations using external edge sources are possible. A detailed discussion on measuring capacitance and time with the CTMU module is provided in the *"dsPIC33/PIC24 Family Reference Manual"*, **"Charge Time Measurement Unit (CTMU) and CTMU Operation with Threshold Detect"** (DS30009743).

# FIGURE 27-1: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR CAPACITANCE MEASUREMENT



# 27.2 Measuring Time/Routing Current Source to A/D Input Pin

Time measurements on the pulse width can be similarly performed using the A/D module's Internal Capacitor (CAD) and a precision resistor for current calibration. Figure 27-2 displays the external connections used for time measurements, and how the CTMU and A/D modules are related in this application. This example also shows both edge events coming from the external CTEDx pins, but other configurations using internal edge sources are possible.

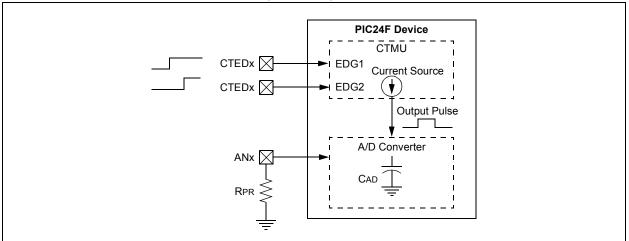
This mode is enabled by clearing the TGEN bit (CTMUCON1L<12>). The current source is tied to the input of the A/D after the sampling switch. Therefore, the A/D bit, SAMP, must be set to '1' in order for the current to be routed through the channel selection MUX to the desired pin.

# 27.3 Pulse Generation and Delay

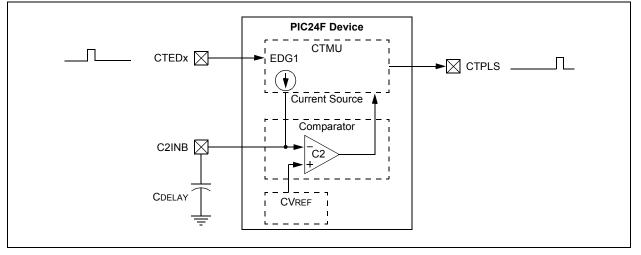
The CTMU module can also generate an output pulse with edges that are not synchronous with the device's system clock. More specifically, it can generate a pulse with a programmable delay from an edge event input to the module. When the module is configured for pulse generation delay by setting the TGEN bit (CTMUCON1<12>), the internal current source is connected to the B input of Comparator 2. A Capacitor (CDELAY) is connected to the Comparator 2 pin, C2INB, and the Comparator Voltage Reference, CVREF, is connected to C2INA. CVREF is then configured for a specific trip point. The module begins to charge CDELAY when an edge event is detected. When CDELAY charges above the CVREF trip point, a pulse is output on CTPLS. The length of the pulse delay is determined by the value of CDELAY and the CVREF trip point.

Figure 27-3 illustrates the external connections for pulse generation, as well as the relationship of the different analog modules required. While CTED1 is shown as the input pulse source, other options are available. A detailed discussion on pulse generation with the CTMU module is provided in the "dsPIC33/ PIC24 Family Reference Manual".

### FIGURE 27-2: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR TIME MEASUREMENT (TGEN = 0)



### FIGURE 27-3: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR PULSE DELAY GENERATION (TGEN = 1)



# 27.4 Measuring Die Temperature

The CTMU can be configured to use the A/D to measure the die temperature using dedicated A/D Channel 24. Perform the following steps to measure the diode voltage:

- The internal current source must be set for either 5.5  $\mu$ A (IRNG<1:0> = 0x2) or 55  $\mu$ A (IRNG<1:0> = 0x3).
- In order to route the current source to the diode, the EDG1STAT and EDG2STAT bits must be equal (either both '0' or both '1').
- The CTMREQ bit (AD1CON5<13>) must be set to '1'.
- The A/D Channel Select bits must be 24 (0x18) using a single-ended measurement.

The voltage of the diode will vary over temperature according to the graphs shown below (Figure 27-4). Note that the graphs are different, based on the magnitude of

the current source selected. The slopes are nearly linear over the range of -40°C to +100°C and the temperature can be calculated as follows:

### **EQUATION 27-2:**

For 5.5 µA Current Source:

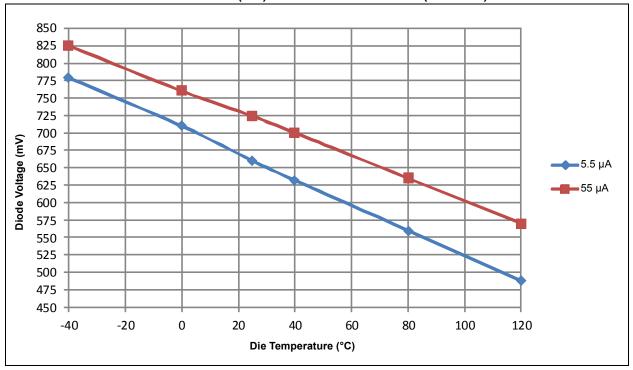
$$Tdie = \frac{710 \ mV - V diode}{1.8}$$

where Vdiode is in mV, Tdie is in °C

For 55 µA Current Source:

$$Tdie = \frac{760 \ mV - V diode}{1.55}$$

where Vdiode is in mV, Tdie is in °C



## FIGURE 27-4: DIODE VOLTAGE (mV) vs. DIE TEMPERATURE (TYPICAL)

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG		
bit 15					1 1		bit		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0		
bit 7							bit		
Legend:									
R = Readable	e bit	W = Writable I	oit	U = Unimple	mented bit, read	as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	eared	x = Bit is unkn	own		
bit 15	CTMUEN: C	TMU Enable bit							
	1 = Module is 0 = Module is	s enabled							
bit 14		nted: Read as '0	)'						
bit 13	-	CTMU Stop in le							
	1 = Discontin	ues module operations module operations and the second sec	eration when c		dle mode				
bit 12	TGEN: Time Generation Enable bit								
					nt source to the contract to the source to the s		put pin		
bit 11	EDGEN: Edge Enable bit								
	1 = Edges ar 0 = Edges ar	e not blocked e blocked							
bit 10	EDGSEQEN: Edge Sequence Enable bit								
		vent must occur sequence is nee		2 event can oo	cur				
bit 9	IDISSEN: Analog Current Source Control bit								
	•	urrent source ou urrent source ou							
bit 8	CTTRIG: CTMU Trigger Control bit								
	00	utput is enabled utput is disabled							
bit 7-2	ITRIM<5:0>: Current Source Trim bits								
	011111 = Maximum positive change from nominal current 011110								
	•								
	•								
	000000 <b>= No</b>	inimum positive ominal current o inimum negative	utput specified	d by IRNG<1:0	>				
	•								
	• 100010								

## REGISTER 27-1: CTMUCON1L: CTMU CONTROL REGISTER 1 LOW

### REGISTER 27-1: CTMUCON1L: CTMU CONTROL REGISTER 1 LOW (CONTINUED)

bit 1-0 IRNG<1:0>: Current Source Range Select bits If IRNGH = 0: 11 = 55  $\mu$ A range 10 = 5.5  $\mu$ A range 01 = 550  $\mu$ A range 00 = 550  $\mu$ A range If IRNGH = 1: 11 = Reserved 10 = Reserved 01 = 2.2 mA range 00 = 550  $\mu$ A range

EDG1MOD	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
	EDG1POL	EDG1SEL3	EDG1SEL2	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT			
oit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0			
EDG2MOD	EDG2POL	EDG2SEL3	EDG2SEL2	EDG2SEL1	EDG2SEL0	_	IRNGH			
pit 7				LDOLOLLI			bit 0			
egend:										
R = Readable bit W = Writable bit		nit	U = Unimplemented bit, read as '0'							
				-						
-n = Value at POR		i = Bit is set	'1' = Bit is set '0' = Bit is cleared		ared	x = Bit is unknown				
bit 15	EDG1MOD: E	Edge 1 Edge-Se	ensitive Select	bit						
	1 = Input is eq									
bit 14	<ul> <li>0 = Input is level-sensitive</li> <li>EDG1POL: Edge 1 Polarity Select bit</li> </ul>									
14	<ul> <li>1 = Edge 1 is programmed for a positive edge response</li> <li>0 = Edge 1 is programmed for a negative edge response</li> </ul>									
bit 13-10	EDG1SEL<3:0>: Edge 1 Source Select bits									
	1111 = CMP C3OUT									
	1110 = CMP C2OUT									
	1101 = CMP C10UT									
	1100 = IC3 interrupt									
	1011 = IC2 interrupt 1010 = IC1 interrupt									
	1010 = CTED8 pin									
	1000 = CTED7 pin									
	0111 = CTED6 pin									
	0110 = CTED5 pin									
	0101 = CTED4 pin									
	0100 = CTED3 pin									
	0011 = CTED1 pin									
	0010 = CTED2 pin 0001 = OC1									
	0000 = Timer	1 match								
oit 9	EDG2STAT: Edge 2 Status bit									
	Indicates the status of Edge 2 and can be written to control current source.									
	1 = Edge 2 has occurred									
	0 = Edge 2 has not occurred									
	EDG1STAT: Edge 1 Status bit									
oit 8	EDGISTAL			Indicates the status of Edge 1 and can be written to control current source.						
vit 8	Indicates the	status of Edge		vritten to contro	or current source	Э.				
vit 8	Indicates the s 1 = Edge 1 ha	status of Edge as occurred		vritten to contro		Э.				
	Indicates the s 1 = Edge 1 ha 0 = Edge 1 ha	status of Edge as occurred as not occurred	1 and can be w			9.				
bit 8 bit 7	Indicates the s 1 = Edge 1 ha 0 = Edge 1 ha EDG2MOD: E	status of Edge as occurred as not occurred Edge 2 Edge-Se	1 and can be w		in current source	<del>2</del> .				
	Indicates the s 1 = Edge 1 ha 0 = Edge 1 ha EDG2MOD: E 1 = Input is ec	status of Edge as occurred as not occurred Edge 2 Edge-Se dge-sensitive	1 and can be w		in current source	9.				
bit 7	Indicates the s 1 = Edge 1 ha 0 = Edge 1 ha <b>EDG2MOD:</b> E 1 = Input is ec 0 = Input is le	status of Edge as occurred as not occurred Edge 2 Edge-Se dge-sensitive vel-sensitive	1 and can be w		a current source	e.				
	Indicates the s 1 = Edge 1 ha 0 = Edge 1 ha <b>EDG2MOD:</b> E 1 = Input is le <b>EDG2POL:</b> E	status of Edge as occurred as not occurred Edge 2 Edge-Se dge-sensitive	1 and can be w ensitive Select Select bit	bit	a current source	<del>2</del> .				

## REGISTER 27-2: CTMUCON1H: CTMU CONTROL REGISTER 1 HIGH

### REGISTER 27-2: CTMUCON1H: CTMU CONTROL REGISTER 1 HIGH (CONTINUED)

- bit 5-2 EDG2SEL<3:0>: Edge 2 Source Select bits
  - 1111 = CMP C3OUT 1110 = CMP C2OUT 1101 = CMP C1OUT 1100 = Peripheral clock 1011 = IC3 interrupt 1010 = IC2 interrupt 1001 = IC1 interrupt 1000 = CTED13 pin 0111 = CTED12 pin 0110 = CTED11 pin 0101 = CTED10 pin 0100 = CTED9 pin 0011 = CTED1 pin 0010 = CTED2 pin 0001 = OC1 0000 = Timer1 match
- bit 1 Unimplemented: Read as '0'
- bit 0 IRNGH: High-Current Range Select bit
  - 1 = Uses the higher current ranges (550  $\mu$ A-2.2 mA)
  - 0 = Uses the lower current ranges (550 nA-50 μA)
  - Current output is set by the IRNG<1:0> bits in the CTMUCON1L register.

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
_	—	—	—	—	—	—	—		
bit 15							bit 8		
U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0		
—	—	—	IRSTEN	—	DSCHS2	DSCHS1	DSCHS0		
bit 7							bit 0		
Legend:									
R = Readal	ole bit	W = Writable	bit	U = Unimplemented bit, read as '0'					
-n = Value at POR '1' = Bit is set '0' = Bit is cleared					x = Bit is unknown				
bit 15-5	Unimpleme	nted: Read as '	0'						
bit 4	IRSTEN: CT	MU Current So	urce Reset Ena	able bit					
		elected by DSC			rol bit will rese	t CTMU edge o	letect logic		
bit 3	Unimpleme	nted: Read as '	0'						
bit 2-0	DSCHS<2:0	>: Discharge So	ource Select Bi	its					
	111 = CLC2 110 = CLC1 101 = Disab 100 = A/D e 011 = MCCI	2 out out oled end of conversio P3 auxiliary outp P2 auxiliary outp	n out out						

000 = Disabled

NOTES:

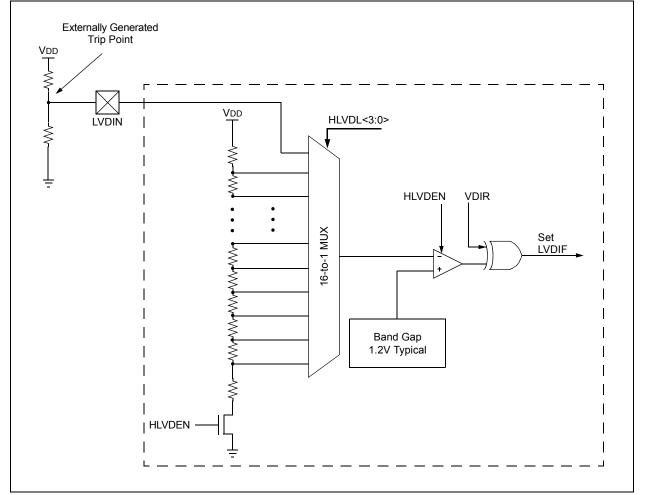
## 28.0 HIGH/LOW-VOLTAGE DETECT (HLVD)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the High/Low-Voltage Detect, refer to the "dsPIC33/PIC24 Family Reference Manual", "High-Level Integration with Programmable High/Low-Voltage Detect (HLVD)" (DS39725), which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM. The High/Low-Voltage Detect (HLVD) module is a programmable circuit that allows the user to specify both the device voltage trip point and the direction of change.

An interrupt flag is set if the device experiences an excursion past the trip point in the direction of change. If the interrupt is enabled, the program execution will branch to the interrupt vector address and the software can then respond to the interrupt. The LVDIF flag may be set during a POR or BOR event. The firmware should clear the flag before the application uses it for the first time, even if the interrupt was disabled.

The HLVD Control register (see Register 28-1) completely controls the operation of the HLVD module. This allows the circuitry to be "turned off" by the user under software control, which minimizes the current.

#### FIGURE 28-1: HIGH/LOW-VOLTAGE DETECT (HLVD) MODULE BLOCK DIAGRAM



R/W-0	U-0	R/W-0	U-0	R/W-0	HS, HC, R-0	HS, HC, R-0		
HLVDEN	—	LSIDL		VDIR	BGVST	IRVST	LVDEVT <sup>(2)</sup>	
bit 15							bit 8	
U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	
_	—	_		HLVDL3	HLVDL2	HLVDL1	HLVDL0	
bit 7							bit C	
Legend:		HS = Hardware	e Settable bit	HC = Hardwa	re Clearable bit			
R = Readabl	e bit	W = Writable b	oit	U = Unimpler	nented bit, read	l as '0'		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle		x = Bit is unkr	iown	
bit 15	HLVDEN: Hig 1 = HLVD is 0 = HLVD is		Detect Power I	Enable bit				
bit 14	Unimplemen	ted: Read as '0	,					
bit 13		Stop in Idle Mo						
		ues module opera s module opera			le mode			
bit 12	Unimplemented: Read as '0'							
bit 11	VDIR: Voltage	e Change Direct	tion Select bit					
		curs when voltag						
bit 10		d Gap Voltage S	-					
		that the band gather that the band gather the						
bit 9	IRVST: Intern	al Reference Vo	ltage Stable F	lag bit				
	specified 0 = Internal r	eference voltage voltage range eference voltage e specified volta	e is unstable; t	he High-Voltag	e Detect logic w	vill not generate		
bit 8		/-Voltage Event						
		t is true during o t is not true duri						
bit 7-4	Unimplemen	ted: Read as '0	3					
bit 3-0		: High/Low-Volta	-					
	1111 = Exter 1110 = Trip F 1101 = Trip F 1100 = Trip F	oint 2 <sup>(1)</sup>	is used (input	comes from th	e LVDIN pin)			
	•							
	•							
	0100 <b>= Trip F</b> 00xx <b>= Unus</b>	oint 11 <sup>(1)</sup>						

#### REGISTER 28-1: HLVDCON: HIGH/LOW-VOLTAGE DETECT CONTROL REGISTER

2: The LVDIF flag cannot be cleared by software unless LVDEVT = 0. The voltage must be monitored so that the HLVD condition (as set by VDIR and HLVDL<3:0>) is not asserted.

## 29.0 SPECIAL FEATURES

- Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the following sections of the *"dsPIC33/PIC24 Family Reference Manual"*, which are available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.
  - "Watchdog Timer (WDT)" (DS39697)
  - "High-Level Device Integration" (DS39719)
  - "Programming and Diagnostics" (DS39716)

PIC24FJ256GA705 family devices include several features intended to maximize application flexibility and reliability, and minimize cost through elimination of external components. These are:

- Flexible Configuration
- Watchdog Timer (WDT)
- Code Protection
- JTAG Boundary Scan Interface
- In-Circuit Serial Programming<sup>™</sup>
- · In-Circuit Emulation

## 29.1 Configuration Bits

The Configuration bits are stored in the last page location of implemented program memory. These bits can be set or cleared to select various device configurations. There are two types of Configuration bits: system operation bits and code-protect bits. The system operation bits determine the power-on settings for system-level components, such as the oscillator and the Watchdog Timer. The code-protect bits prevent program memory from being read and written.

#### 29.1.1 CONSIDERATIONS FOR CONFIGURING PIC24FJ256GA705 FAMILY DEVICES

In PIC24FJ256GA705 family devices, the Configuration bytes are implemented as volatile memory. This means that configuration data must be programmed each time the device is powered up. Configuration data is stored in the three words at the top of the on-chip program memory space, known as the Flash Configuration Words. Their specific locations are shown in Table 29-1. The configuration data is automatically loaded from the Flash Configuration Words to the proper Configuration registers during device Resets.

Note: Configuration data is reloaded on all types of device Resets.

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration Word for configuration data. This is to make certain that program code is not stored in this address when the code is compiled.

The upper byte of all Flash Configuration Words in program memory should always be '0000 0000'. This makes them appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since Configuration bits are not implemented in the corresponding locations, writing '0's to these locations has no effect on device operation.

Configuration Register	PIC24FJ256GA70X	PIC24FJ128GA70X	PIC24FJ64GA70X	
FSEC	02AF00h	015F00h	00AF00h	
FBSLIM	02AF10h	015F10h	00AF10h	
FSIGN	02AF14h	015F14h	00AF14h	
FOSCSEL	02AF18h	015F18h	00AF18h	
FOSC	02AF1Ch	015F1Ch	00AF1Ch	
FWDT	02AF20h	015F20h	00AF20h	
FPOR	02AF24h	015F24h	00AF24h	
FICD	02AF28h	015F28h	00AF28h	
FDEVOPT1	02AF2Ch	015F2Ch	00AF2Ch	

TABLE 29-1: CONFIGURATION WORD ADDRESSES

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1				
_	—	—	_	—	—	—	—				
bit 23							bit 16				
R/PO-1	U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1				
AIVTDIS	—	—		CSS2	CSS1	CSS0	CWRP				
bit 15							bit 8				
R/PO-1	R/PO-1	R/PO-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1				
GSS1	GSS0	GWRP		BSEN	BSS1	BSS0	BWRP				
bit 7	0000	OWN		DOLIN	DOOT	DOOU	bit 0				
Legend:		PO = Program	Once bit								
R = Readabl	e bit	W = Writable b	oit	U = Unimplen	nented bit, read	d as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	iown				
bit 23-16	•	ted: Read as '1									
bit 15		ernate Interrupt									
				N) bit is not avail							
bit 14-12	<ul> <li>0 = Enables AIVT; INTCON2&lt;8&gt; (AIVTEN) bit is available</li> <li>Unimplemented: Read as '1'</li> </ul>										
bit 11-9	•			Code Protection	l evel bits						
	CSS<2:0>: Configuration Segment (CS) Code Protection Level bits 111 = No protection (other than CWRP)										
	110 = Standard security										
	10x = Enhance										
bit 8	0xx = High se		ant Program \	Nrite Protection	hit						
DILO		ition Segment is			DIL						
		ition Segment is									
bit 7-6	<b>GSS&lt;1:0&gt;:</b> G	eneral Segmer	t (GS) Code	Protection Leve	l bits						
		11 = No protection (other than GWRP)									
	10 = Standard security 0x = High security										
bit 5	Ũ	-	ooram Write	Protection hit							
Sit 0	<b>GWRP:</b> General Segment Program Write Protection bit 1 = General Segment is not write-protected										
		Segment is write		-							
bit 4	Unimplemen	ted: Read as '1	,								
bit 3	BSEN: Boot S	Segment (BS) C	Control bit								
		Segment is enal									
1.1.0.4	•	ment size is det	•								
bit 2-1		oot Segment Co		n Level bits							
	11 = No prote	ection (other tha d security	II DWRP)								
	0x = High sec	•									
bit 0	BWRP: Boot	Segment Progr	am Write Pro	tection bit							
		ment can be wr									
		ment is write-pr									

x = Bit is unknown

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1		
_	—	—	—	—	—	—	—		
bit 23							bit 16		
U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1		
—	—	—			BSLIM<12:8>				
bit 15							bit 8		
R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1		
			BSLIN	/I<7:0>					
bit 7							bit 0		
Legend:		PO = Prograr	n Once bit						
R = Readable	e bit	W = Writable	bit	U = Unimplen	nented bit, read	l as '0'			

#### **REGISTER 29-2: FBSLIM CONFIGURATION REGISTER**

'1' = Bit is set

bit 23-13 Unimplemented: Read as '1'

-n = Value at POR

bit 12-0 **BSLIM<12:0>:** Active Boot Segment Code Flash Page Address Limit (Inverted) bits This bit field contains the last active Boot Segment Page + 1 (i.e., first page address of GS). The value is stored as an inverted page address, such that programming additional '0's can only increase the size of BS. If BSLIM<12:0> is set to all '1's (unprogrammed default), the active Boot Segment size is zero.

'0' = Bit is cleared

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—	—	—	—	—	—	—	
bit 23							bit 16	
r-0	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	_	—	—	—		—	—	
bit 15							bit 8	
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—	—	—	—		—	—	
bit 7							bit 0	
Legend: PO = Program Once bit			n Once bit	r = Reserved bit				
R = Readable	bit	W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown	

bit 23-16 Unimplemented: Read as '1'

bit 15 Reserved: Maintain as '0'

bit 14-0 Unimplemented: Read as '1'

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23	•		•	•	•	•	bit 16
U-1	U-1	U-1	U-1	U-1	U-1	r-0	r-0
—	—	—	—	—	—	—	—
bit 15					•	•	bit 8

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
IESO	PLLMODE3	PLLMODE2	PLLMODE1	PLLMODE0	FNOSC2	FNOSC1	FNOSC0
bit 7							bit 0

Legend:	PO = Program Once bit	r = Reserved bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 23-10	Unimplemented: Read as '1'
bit 9-8	Reserved: Maintain as '0'
bit 7	<ul> <li>IESO: Two-Speed Oscillator Start-up Enable bit</li> <li>1 = Starts up the device with FRC, then automatically switches to the user-selected oscillator when ready</li> <li>0 = Starts up the device with the user-selected oscillator source</li> </ul>
bit 6-3	PLLMODE<3:0>: Frequency Multiplier Select bits 1111 = No PLL is used (PLLEN bit is unavailable)
	<ul> <li>1110 = 8x PLL is selected</li> <li>1101 = 6x PLL is selected</li> <li>0110 = 4x PLL is selected (Input Frequency = 48 MHz)</li> <li>0110 = 96 MHz PLL is selected (Input Frequency = 32 MHz)</li> <li>0101 = 96 MHz PLL is selected (Input Frequency = 24 MHz)</li> <li>0100 = 96 MHz PLL is selected (Input Frequency = 20 MHz)</li> <li>0011 = 96 MHz PLL is selected (Input Frequency = 16 MHz)</li> <li>0010 = 96 MHz PLL is selected (Input Frequency = 12 MHz)</li> <li>0010 = 96 MHz PLL is selected (Input Frequency = 8 MHz)</li> <li>0001 = 96 MHz PLL is selected (Input Frequency = 4 MHz)</li> </ul>
bit 2-0	FNOSC<2:0>: Oscillator Selection bits
	<ul> <li>111 = Oscillator with Frequency Divider (OSCFDIV)</li> <li>110 = Reserved</li> <li>101 = Low-Power RC Oscillator (LPRC)</li> <li>100 = Secondary Oscillator (SOSC)</li> <li>011 = Primary Oscillator with PLL (XTPLL, HSPLL, ECPLL)</li> <li>010 = Primary Oscillator (XT, HS, EC)</li> <li>001 = Fast RC Oscillator with PLL (FRCPLL)</li> <li>000 = Fast RC Oscillator (FRC)</li> </ul>

## REGISTER 29-5: FOSC CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—		—	—	—	—	—
bit 23							bit 16
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—		—	—	—	—	—
bit 15							bit 8
R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
FCKSM1	FCKSM0	IOL1WAY	PLLSS	SOSCSEL	OSCIOFCN	POSCMD1	POSCMD0
bit 7							bit 0

Legend:	PO = Program Once bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 23-8	Unimplemented: Read as '1'
bit 7-6	FCKSM<1:0>: Clock Switching and Monitor Selection bits
	<ul> <li>1x = Clock switching and the Fail-Safe Clock Monitor are disabled</li> <li>01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled</li> <li>00 = Clock switching and the Fail-Safe Clock Monitor are enabled</li> </ul>
bit 5	IOL1WAY: Peripheral Pin Select Configuration bit
	<ul> <li>1 = The IOLOCK bit can be set only once (with unlock sequence).</li> <li>0 = The IOLOCK bit can be set and cleared as needed (with unlock sequence)</li> </ul>
bit 4	PLLSS: PLL Secondary Selection Configuration bit
	This Configuration bit only takes effect when the PLL is NOT being used by the system (i.e., not selected as part of the system clock source). Used to generate an independent clock out of REFO. 1 = PLL is fed by the Primary Oscillator 0 = PLL is fed by the on-chip Fast RC (FRC) Oscillator
bit 3	SOSCSEL: SOSC Selection Configuration bit
	1 = Crystal (SOSCI/SOSCO) mode 0 = Digital (SOSCI) Externally Supplied Clock mode
bit 2	OSCIOFCN: CLKO Enable Configuration bit
	<ul> <li>1 = CLKO output signal is active on the OSCO pin (when the Primary Oscillator is disabled or configured for EC mode)</li> <li>0 = CLKO output is disabled</li> </ul>
bit 1-0	POSCMD<1:0>: Primary Oscillator Configuration bits
	<ul> <li>11 = Primary Oscillator mode is disabled</li> <li>10 = HS Oscillator mode is selected (10 MHz-32 MHz)</li> <li>01 = XT Oscillator mode is selected (1.5 MHz-10 MHz)</li> <li>00 = External Clock mode is selected</li> </ul>

REGISTER 29-6: F	WDT CONFIGURATION REGISTER
------------------	----------------------------

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

U-1	R/PO-1	R/PO-1	U-1	R/PO-1	U-1	R/PO-1	R/PO-1
	WDTCLK1	WDTCLK0	—	WDTCMX		WDTWIN1	WDTWIN0
bit 15							bit 8

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
WINDIS	FWDTEN1	FWDTEN0	FWPSA	WDTPS3	WDTPS2	WDTPS1	WDTPS0
bit 7							bit 0

Legend:	PO = Program Once bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 23-15	Unimplemented: Read as '1'
bit 14-13	WDTCLK<1:0>: Watchdog Timer Clock Select bits (when WDTCMX = 1)
	<ul> <li>11 = Always uses LPRC</li> <li>10 = Uses FRC when WINDIS = 0, system clock is not LPRC and device is not in Sleep; otherwise, uses LPRC</li> <li>01 = Always uses SOSC</li> <li>00 = Uses peripheral clock when system clock is not LPRC and device is not in Sleep; otherwise, uses</li> </ul>
	LPRC
bit 12	Unimplemented: Read as '1'
bit 11	WDTCMX: WDT Clock MUX Control bit
	<ul> <li>1 = Enables WDT clock MUX, WDT clock is selected by WDTCLK&lt;1:0&gt;</li> <li>0 = WDT clock is LPRC</li> </ul>
bit 10	Unimplemented: Read as '1'
bit 9-8	WDTWIN<1:0>: Watchdog Timer Window Width bits
	11 = WDT window is 25% of the WDT period
	10 = WDT window is 37.5% of the WDT period 01 = WDT window is 50% of the WDT period
	00 = WDT window is 75% of the WDT period
bit 7	WINDIS: Windowed Watchdog Timer Disable bit
	1 = Windowed WDT is disabled
	0 = Windowed WDT is enabled
bit 6-5	FWDTEN<1:0>: Watchdog Timer Enable bits
	11 = WDT is enabled
	<ul> <li>10 = WDT is disabled (control is placed on the SWDTEN bit)</li> <li>01 = WDT is enabled only while device is active and disabled in Sleep; SWDTEN bit is disabled</li> </ul>
	00 = WDT and SWDTEN are disabled
bit 4	FWPSA: Watchdog Timer Prescaler bit
	1 = WDT prescaler ratio of 1:128
	0 = WDT prescaler ratio of 1:32

#### REGISTER 29-6: FWDT CONFIGURATION REGISTER (CONTINUED)

- bit 3-0 WDTPS<3:0>: Watchdog Timer Postscale Select bits 1111 = 1:32,768 1110 = 1:16,384 1101 = 1:8,192 1100 = 1:4,096 1011 = 1:2,048 1010 = 1:1,024 1001 = 1:512 1000 = 1:256 0111 = 1:128 0110 = 1:64 0101 = 1:32 0100 = 1:16
  - 0011 = 1:8 0010 = 1:4
  - 0010 = 1.40001 = 1.2
  - 0000 = 1:1

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
	—	—	—	_	-	—	—	
bit 23							bit 16	
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
	—	_	_			_		
bit 15							bit 8	
U-1	U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	
_	—	—	—	DNVPEN	LPCFG	BOREN1	BOREN0	
bit 7							bit 0	
Legend:		PO = Progran	n Once bit					
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown				
bit 23-4	Unimplement	ted: Read as 'i	L'					
bit 3	DNVPEN: Do	wnside Voltage	Protection En	able bit				
	1 = Downside protection is enabled when BOR is inactive							

0 = Downside protection is disabled when BOR is inactive

0 = Retention feature is available and controlled by RETEN during Sleep

11 = Brown-out Reset is enabled in hardware; SBOREN bit is disabled

01 = Brown-out Reset is controlled with the SBOREN bit setting00 = Brown-out Reset is disabled in hardware; SBOREN bit is disabled

10 = Brown-out Reset is enabled only while device is active and is disabled in Sleep; SBOREN bit is

**LPCFG:** Low-Power Regulator Control bit

BOREN<1:0>: Brown-out Reset Enable bits

1 = Retention feature is not available

disabled

bit 2

bit 1-0

#### **REGISTER 29-7: FPOR CONFIGURATION REGISTER**

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	_	—	—	—	—	_	_	
bit 23							bit 16	
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—	—	—	—	—	_	_	
bit 15							bit 8	
r-1	U-1	R/PO-1	U-1	U-1	U-1	R/PO-1	R/PO-1	
—	—	JTAGEN	—	—	—	ICS1	ICS0	
bit 7							bit 0	
Legend:		PO = Progran	n Once bit	r = Reserved	bit			
R = Readable	e bit	W = Writable	bit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown		

## **REGISTER 29-8: FICD CONFIGURATION REGISTER**

bit 5	JTAGEN: JTAG Port Enable bit	
	1 = JTAG port is enabled	
	$\circ - ITAC$ part is disabled	

Unimplemented: Read as '1'

Unimplemented: Read as '1'

Reserved: Maintain as '1'

- 0 = JTAG port is disabled
- bit 4-2 Unimplemented: Read as '1'

bit 23-8

bit 7

bit 6

- bit 1-0 ICS<1:0>: ICD Communication Channel Select bits
  - 11 = Communicates on PGC1/PGD1
  - 10 = Communicates on PGC2/PGD2
  - 01 = Communicates on PGC3/PGD3
  - 00 = Reserved; do not use

REGISTER 29-9: FDE	VOPT1 CONFIGURATION REGISTER
--------------------	------------------------------

REGISTER	(29-9: FDE)	OPT1 CONF	GURATION	REGISTER				
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—	—	—	—	—	—	—	
bit 23							bit 16	
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
_		_	_	_	_		_	
bit 15							bit 8	
U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	U-1	
_	_	_	ALTI2C1	SOSCHP	TMPRPIN	ALTCMPI		
bit 7				•			bit C	
Legend:		PO = Prograi						
R = Readat		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value a	at POR	'1' = Bit is set	t	'0' = Bit is clea	ared	x = Bit is unkno	own	
bit 23-5	Unimplemer	ted: Read as '	1'					
bit 4	ALTI2C1: Alt	ALTI2C1: Alternate I2C1 bit						
		1 = SDA1 and SCL1 on RB9 and RB8 0 = ASDA1 and ASCL1 on RB5 and RB6						
bit 3	SOSCHP: SO	OSC High-Pow	er Enable bit (v	alid only when	SOSCSEL = 1	)		
				ee Section 9.7.	3 "Low-Powe	r SOSC Operati	on" for more	
bit 2	TMPRPIN: T	TMPRPIN: Tamper Pin Enable bit						
		1 = $\overline{\text{TMPRN}}$ pin function is disabled (RB9) 0 = $\overline{\text{TMPRN}}$ pin function is enabled						
bit 1	ALTCMPI: A	ternate Compa	arator Input Ena	able bit				

- 1 = C1INC, C2INC and C3INC are on their standard pin locations 0 = C1INC, C2INC and C3INC are on RB9<sup>(1)</sup>
- bit 0 Unimplemented: Read as '1'
- **Note 1:** RB9 is used for multiple functions, but only one use case is allowable.

Address	Name								В	it			_				
Address	Name	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FF0000h	DEVID		FAMID<7:0> DEV<7:0>														
FF0002h	DEVREV						_	_							REV	<3:0>	

#### TABLE 29-2: PIC24FJ CORE DEVICE ID REGISTERS

#### TABLE 29-3: DEVICE ID BIT FIELD DESCRIPTIONS

Bit Field	Register	Description
FAMID<7:0>	DEVID	Encodes the family ID of the device; FAMID = 0x75.
DEV<7:0>	DEVID	Encodes the individual ID of the device.
REV<3:0>	DEVREV	Encodes the sequential (numerical) revision identifier of the device.

#### TABLE 29-4: PIC24FJ256GA705 FAMILY DEVICE IDs

Device	DEVID
PIC24FJ64GA705	07
PIC24FJ128GA705	0B
PIC24FJ256GA705	0F
PIC24FJ64GA704	05
PIC24FJ128GA704	09
PIC24FJ256GA704	0D
PIC24FJ64GA702	06
PIC24FJ128GA702	0A
PIC24FJ256GA702	0E

## 29.2 Unique Device Identifier (UDID)

All PIC24FJ256GA705 family devices are individually encoded during final manufacturing with a Unique Device Identifier, or UDID. The UDID cannot be erased by a bulk erase command or any other user-accessible means. This feature allows for manufacturing traceability of Microchip Technology devices in applications where this is a requirement. It may also be used by the application manufacturer for any number of things that may require unique identification, such as:

- · Tracking the device
- · Unique serial number
- Unique security key

The UDID comprises five 24-bit program words. When taken together, these fields form a unique 120-bit identifier.

The UDID is stored in five read-only locations, located between 0x801600 and 0x801608 in the device Configuration space. Table 29-5 lists the addresses of the identifier words and shows their contents.

UDID	Address	Description
UDID1	0x801600	UDID Word 1
UDID2	0x801602	UDID Word 2
UDID3	0x801604	UDID Word 3
UDID4	0x801606	UDID Word 4
UDID5	0x801608	UDID Word 5

TABLE 29-5: UDID ADDRESSES

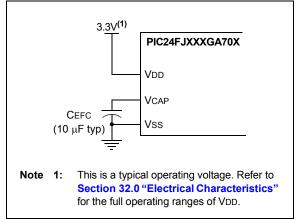
## 29.3 On-Chip Voltage Regulator

All PIC24FJ256GA705 family devices power their core digital logic at a nominal 1.8V. This may create an issue for designs that are required to operate at a higher typical voltage, such as 3.3V. To simplify system design, all devices in the PIC24FJ256GA705 family incorporate an on-chip regulator that allows the device to run its core logic from VDD.

This regulator is always enabled. It provides a constant voltage (1.8V nominal) to the digital core logic, from a VDD of about 2.1V, all the way up to the device's VDDMAX. It does not have the capability to boost VDD levels. In order to prevent "brown-out" conditions when the voltage drops too low for the regulator, the Brown-out Reset occurs. Then, the regulator output follows VDD with a typical voltage drop of 300 mV.

A low-ESR capacitor (such as ceramic) must be connected to the VCAP pin (Figure 29-1). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor (CEFC) is provided in Section 32.1 "DC Characteristics".

# FIGURE 29-1: CONNECTIONS FOR THE ON-CHIP REGULATOR



#### 29.3.1 ON-CHIP REGULATOR AND POR

The voltage regulator takes approximately 10  $\mu$ s for it to generate output. During this time, designated as TVREG, code execution is disabled. TVREG is applied every time the device resumes operation after any power-down, including Sleep mode. TVREG is determined by the status of the VREGS bit (RCON<8>) and the WDTWIN<1:0> Configuration bits (FWDT<9:8>). Refer to Section 32.0 "Electrical Characteristics" for more information on TVREG.

Note:	For more information, see <b>Section 32.0</b> "Electrical Characteristics". The informa-
	tion in this data sheet supersedes the information in the FRM.

#### 29.3.2 VOLTAGE REGULATOR STANDBY MODE

The on-chip regulator always consumes a small incremental amount of current over IDD/IPD, including when the device is in Sleep mode, even though the core digital logic does not require power. To provide additional savings in applications where power resources are critical, the regulator can be made to enter Standby mode, on its own, whenever the device goes into Sleep mode. This feature is controlled by the VREGS bit (RCON<8>). Clearing the VREGS bit enables the Standby mode. When waking up from Standby mode, the regulator needs to wait for TVREG to expire before wake-up.

#### 29.3.3 LOW-VOLTAGE RETENTION REGULATOR

When in Sleep mode, PIC24FJ256GA705 family devices may use a separate low-power, low-voltage retention regulator to power critical circuits. This regulator, which operates at 1.2V nominal, maintains power to data RAM and the RTCC while all other core digital logic is powered down. The low-voltage retention regulator is described in more detail in Section 10.2.4 "Low-Voltage Retention Regulator".

## 29.4 Watchdog Timer (WDT)

For PIC24FJ256GA705 family devices, the WDT is driven by the LPRC Oscillator, the Secondary Oscillator (SOSC) or the system timer. When the device is in Sleep mode, the LPRC Oscillator will be used. When the WDT is enabled, the clock source is also enabled.

The nominal WDT clock source from LPRC is 31 kHz. This feeds a prescaler that can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the FWPSA Configuration bit. With a 31 kHz input, the prescaler yields a nominal WDT Time-out (TWDT) period of 1 ms in 5-bit mode or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPS<3:0> Configuration bits (FWDT<3:0>), which allows the selection of a total of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler time-out periods, ranges from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- · On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSCx bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE (RCON<3:2>) bits will need to be cleared in software after the device wakes up. The WDT Flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

Note:	The CLRWDT and PWRSAV instructions
	clear the prescaler and postscaler counts
	when executed.

#### 29.4.1 WINDOWED OPERATION

The Watchdog Timer has an optional Fixed Window mode of operation. In this Windowed mode, CLRWDT instructions can only reset the WDT during the last 1/4 of the programmed WDT period. A CLRWDT instruction executed before that window causes a WDT Reset, similar to a WDT time-out.

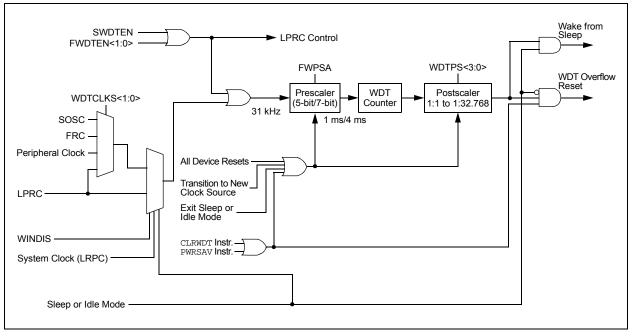
Windowed WDT mode is enabled by programming the WINDIS Configuration bit (FWDT<7>) to '0'.

#### 29.4.2 CONTROL REGISTER

The WDT is enabled or disabled by the FWDTEN<1:0> Configuration bits (FWDT<6:5>). When the Configuration bits, FWDTEN<1:0> = 11, the WDT is always enabled.

The WDT can be optionally controlled in software when the Configuration bits, FWDTEN<1:0> = 10. When FWDTEN<1:0> = 00, the Watchdog Timer is always disabled. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user to enable the WDT for critical code segments and disable the WDT during non-critical code segments for maximum power savings.





#### 29.5 Program Verification and Code Protection

PIC24FJ256GA705 family devices offer basic implementation of CodeGuard<sup>™</sup> Security that supports General Segment (GS) security and Boot Segment (BS) security. This feature helps protect individual intellectual property.

Note:	For more information on usage, configura-					
	tion and operation, refer to the "dsPIC33/					
	PIC24 Family Reference Manual",					
	"CodeGuard™ Intermediate Security"					
	(DS70005182).					

#### 29.6 JTAG Interface

PIC24FJ256GA705 family devices implement a JTAG interface, which supports boundary scan device testing.

## 29.7 In-Circuit Serial Programming

PIC24FJ256GA705 family microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock (PGCx) and data (PGDx), and three other lines for power (VDD), ground (Vss) and MCLR. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

## 29.8 Customer OTP Memory

PIC24FJ256GA705 family devices provide 256 bytes of One-Time-Programmable (OTP) memory, located at addresses, 801700h through 8017FEh. This memory can be used for persistent storage of application-specific information that will not be erased by reprogramming the device. This includes many types of information, such as (but not limited to):

- Application checksums
- Code revision information
- Product information
- Serial numbers
- System manufacturing dates
- Manufacturing lot numbers

PIC24FJ256GA705 family devices provide 256 bytes of One-Time-Programmable (OTP) memory, and this OTP memory can be written by program execution(i.e., TBLWT instructions) and during device programming. Data is not cleared by a chip erase.

Note: Data in the OTP memory section MUST NOT be programmed more than once.

## 29.9 In-Circuit Debugger

This function allows simple debugging functions when used with MPLAB<sup>®</sup> IDE. Debugging functionality is controlled through the PGCx (Emulation/Debug Clock) and PGDx (Emulation/Debug Data) pins.

To use the in-circuit debugger function of the device, the design must implement ICSP™ connections to MCLR, VDD, Vss and the PGCx/PGDx pin pair, designated by the ICS<1:0> Configuration bits. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins.

# 30.0 DEVELOPMENT SUPPORT

The PIC<sup>®</sup> microcontrollers (MCU) and dsPIC<sup>®</sup> digital signal controllers (DSC) are supported with a full range of software and hardware development tools:

- · Integrated Development Environment
- MPLAB<sup>®</sup> X IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB XC Compiler
  - MPASM<sup>™</sup> Assembler
  - MPLINK<sup>™</sup> Object Linker/ MPLIB<sup>™</sup> Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- · Simulators
  - MPLAB X SIM Software Simulator
- · Emulators
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers/Programmers
  - MPLAB ICD 3
  - PICkit™ 3
- Device Programmers
  - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits and Starter Kits
- Third-party development tools

#### 30.1 MPLAB X Integrated Development Environment Software

The MPLAB X IDE is a single, unified graphical user interface for Microchip and third-party software, and hardware development tool that runs on Windows<sup>®</sup>, Linux and Mac  $OS^{®}$  X. Based on the NetBeans IDE, MPLAB X IDE is an entirely new IDE with a host of free software components and plug-ins for high-performance application development and debugging. Moving between tools and upgrading from software simulators to hardware debugging and programming tools is simple with the seamless user interface.

With complete project management, visual call graphs, a configurable watch window and a feature-rich editor that includes code completion and context menus, MPLAB X IDE is flexible and friendly enough for new users. With the ability to support multiple tools on multiple projects with simultaneous debugging, MPLAB X IDE is also suitable for the needs of experienced users.

Feature-Rich Editor:

- Color syntax highlighting
- Smart code completion makes suggestions and provides hints as you type
- Automatic code formatting based on user-defined rules
- · Live parsing

User-Friendly, Customizable Interface:

- Fully customizable interface: toolbars, toolbar buttons, windows, window placement, etc.
- · Call graph window
- Project-Based Workspaces:
- Multiple projects
- Multiple tools
- · Multiple configurations
- · Simultaneous debugging sessions

File History and Bug Tracking:

- · Local file history feature
- Built-in support for Bugzilla issue tracker

## 30.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- · Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- · Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

#### 30.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel<sup>®</sup> standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

#### 30.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

## 30.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- Command-line interface
- · Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

## 30.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

#### 30.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

#### 30.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a highspeed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

## 30.9 PICkit 3 In-Circuit Debugger/ Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a fullspeed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming<sup>™</sup> (ICSP<sup>™</sup>).

## 30.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

## 30.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM<sup>™</sup> and dsPICDEM<sup>™</sup> demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ<sup>®</sup> security ICs, CAN, IrDA<sup>®</sup>, PowerSmart battery management, SEEVAL<sup>®</sup> evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

## 30.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent<sup>®</sup> and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika<sup>®</sup>

## 31.0 INSTRUCTION SET SUMMARY

**Note:** This chapter is a brief summary of the PIC24F Instruction Set Architecture (ISA) and is not intended to be a comprehensive reference source.

The PIC24F instruction set adds many enhancements to the previous PIC<sup>®</sup> MCU instruction sets, while maintaining an easy migration from previous PIC MCU instruction sets. Most instructions are a single program memory word. Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction. The instruction set is highly orthogonal and is grouped into four basic categories:

- Word or byte-oriented operations
- Bit-oriented operations
- · Literal operations
- Control operations

Table 31-1 shows the general symbols used in describing the instructions. The PIC24F instruction set summary in Table 31-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand, which is typically a register, 'Wb', without any address modifier
- The second source operand, which is typically a register, 'Ws', with or without an address modifier
- The destination of the result, which is typically a register, 'Wd', with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- The file register specified by the value, 'f'
- The destination, which could either be the file register, 'f', or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/ shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register, 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand, which is a register, 'Wb', without any address modifier
- The second source operand, which is a literal value
- The destination of the result (only if not the same as the first source operand), which is typically a register, 'Wd', with or without an address modifier

The control instructions may use some of the following operands:

- · A program memory address
- The mode of the Table Read and Table Write instructions

All instructions are a single word, except for certain double-word instructions, which were made double-word instructions so that all the required information is available in these 48 bits. In the second word, the 8 MSbs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the Program Counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles, with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all Table Reads and Table Writes, and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles.

Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or two-word instruction. Moreover, double-word moves require two cycles. The double-word instructions execute in two instruction cycles.

#### TABLE 31-1: SYMBOLS USED IN OPCODE DESCRIPTIONS

Field	Description
#text	Means literal defined by "text"
(text)	Means "content of text"
[text]	Means "the location addressed by text"
{ }	Optional field or operation
<n:m></n:m>	Register bit field
.b	Byte mode selection
.d	Double-Word mode selection
.S	Shadow register select
.W	Word mode selection (default)
bit4	4-bit Bit Selection field (used in word addressed instructions) $\in \{015\}$
C, DC, N, OV, Z	MCU Status bits: Carry, Digit Carry, Negative, Overflow, Sticky Zero
Expr	Absolute address, label or expression (resolved by the linker)
f	File register address ∈ {0000h1FFFh}
lit1	1-bit unsigned literal $\in \{0,1\}$
lit4	4-bit unsigned literal ∈ {015}
lit5	5-bit unsigned literal ∈ {031}
lit8	8-bit unsigned literal ∈ {0255}
lit10	10-bit unsigned literal ∈ {0255} for Byte mode, {01023} for Word mode
lit14	14-bit unsigned literal ∈ {016383}
lit16	16-bit unsigned literal ∈ {065535}
lit23	23-bit unsigned literal ∈ {08388607}; LSb must be '0'
None	Field does not require an entry, may be blank
PC	Program Counter
Slit10	10-bit signed literal ∈ {-512511}
Slit16	16-bit signed literal ∈ {-3276832767}
Slit6	6-bit signed literal ∈ {-1616}
Wb	Base W register ∈ {W0W15}
Wd	Destination W register ∈ { Wd, [Wd], [Wd++], [Wd], [++Wd], [Wd] }
Wdo	Destination W register ∈ { Wnd, [Wnd], [Wnd++], [Wnd], [++Wnd], [Wnd], [Wnd+Wb] }
Wm,Wn	Dividend, Divisor Working register pair (direct addressing)
Wn	One of 16 Working registers ∈ {W0W15}
Wnd	One of 16 destination Working registers ∈ {W0W15}
Wns	One of 16 source Working registers ∈ {W0W15}
WREG	W0 (Working register used in file register instructions)
Ws	Source W register ∈ { Ws, [Ws], [Ws++], [Ws], [++Ws], [Ws] }
Wso	Source W register ∈ { Wns, [Wns], [Wns++], [Wns], [++Wns], [Wns], [Wns+Wb] }

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
ADD	ADD	f	f = f + WREG	1	1	C, DC, N, OV, Z
	ADD	f,WREG	WREG = f + WREG	1	1	C, DC, N, OV, Z
	ADD	#lit10,Wn	Wd = lit10 + Wd	1	1	C, DC, N, OV, Z
	ADD	Wb,Ws,Wd	Wd = Wb + Ws	1	1	C, DC, N, OV, Z
	ADD	Wb,#lit5,Wd	Wd = Wb + lit5	1	1	C, DC, N, OV, Z
ADDC	ADDC	f	f = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	f,WREG	WREG = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	#lit10,Wn	Wd = lit10 + Wd + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,Ws,Wd	Wd = Wb + Ws + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,#lit5,Wd	Wd = Wb + lit5 + (C)	1	1	C, DC, N, OV, Z
AND	AND	f	f = f .AND. WREG	1	1	N, Z
	AND	f,WREG	WREG = f .AND. WREG	1	1	N, Z
	AND	#lit10,Wn	Wd = lit10 .AND. Wd	1	1	N, Z
	AND	Wb,Ws,Wd	Wd = Wb .AND. Ws	1	1	N, Z
	AND	Wb,#lit5,Wd	Wd = Wb .AND. lit5	1	1	N, Z
ASR	ASR	f	f = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	f,WREG	WREG = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	Ws,Wd	Wd = Arithmetic Right Shift Ws	1	1	C, N, OV, Z
	ASR	Wb,Wns,Wnd	Wnd = Arithmetic Right Shift Wb by Wns	1	1	N, Z
	ASR	Wb,#lit5,Wnd	Wnd = Arithmetic Right Shift Wb by lit5	1	1	N, Z
BCLR	BCLR	f,#bit4	Bit Clear f	1	1	None
	BCLR	Ws,#bit4	Bit Clear Ws	1	1	None
BRA	BRA	C,Expr	Branch if Carry	1	1 (2)	None
	BRA	GE,Expr	Branch if Greater than or Equal	1	1 (2)	None
	BRA	GEU, Expr	Branch if Unsigned Greater than or Equal	1	1 (2)	None
	BRA	GT,Expr	Branch if Greater than	1	1 (2)	None
	BRA	GTU, Expr	Branch if Unsigned Greater than	1	1 (2)	None
	BRA	LE, Expr	Branch if Less than or Equal	1	1 (2)	None
	BRA	LEU, Expr	Branch if Unsigned Less than or Equal	1	1 (2)	None
	BRA	LT, Expr	Branch if Less than	1	1 (2)	None
	BRA	LTU, Expr	Branch if Unsigned Less than	1	1 (2)	None
	BRA	N,Expr	Branch if Negative	1	1 (2)	None
	BRA	NC, Expr	Branch if Not Carry	1	1 (2)	None
	BRA	NN, Expr	Branch if Not Negative	1	1 (2)	None
	BRA	NOV, Expr	Branch if Not Overflow	1	1 (2)	None
	BRA	NZ, Expr	Branch if Not Zero	1	1 (2)	None
		OV, Expr	Branch if Overflow	1	1 (2)	None
	BRA		Branch Unconditionally	1	2	None
	BRA	Expr		1		
	BRA	Z,Expr	Branch if Zero		1 (2)	None
	BRA	Wn	Computed Branch	1	2	None
BSET	BSET	f,#bit4	Bit Set f	1	1	None
DGW	BSET	Ws,#bit4	Bit Set Ws	1	1	None
BSW	BSW.C	Ws,Wb	Write C bit to Ws <wb></wb>	1	1	None
DEG	BSW.Z	Ws,Wb	Write Z bit to Ws <wb></wb>	1	1	None
BTG	BTG	f,#bit4	Bit Toggle f	1	1	None
	BTG	Ws,#bit4	Bit Toggle Ws	1	1	None
BTSC	BTSC	f,#bit4	Bit Test f, Skip if Clear	1	1 (2 or 3)	None
	BTSC	Ws,#bit4	Bit Test Ws, Skip if Clear	1	1 (2 or 3)	None

TABLE 31-2:	<b>INSTRUCTION SET OVERVIEW</b>

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
BTSS	BTSS	f,#bit4	Bit Test f, Skip if Set	1	1 (2 or 3)	None
	BTSS	Ws,#bit4	Bit Test Ws, Skip if Set	1	1 (2 or 3)	None
BTST	BTST	f,#bit4	Bit Test f	1	1	Z
	BTST.C	Ws,#bit4	Bit Test Ws to C	1	1	С
	BTST.Z	Ws,#bit4	Bit Test Ws to Z	1	1	Z
	BTST.C	Ws,Wb	Bit Test Ws <wb> to C</wb>	1	1	С
	BTST.Z	Ws,Wb	Bit Test Ws <wb> to Z</wb>	1	1	Z
BTSTS	BTSTS	f,#bit4	Bit Test then Set f	1	1	Z
	BTSTS.C	Ws,#bit4	Bit Test Ws to C, then Set	1	1	С
	BTSTS.Z	Ws,#bit4	Bit Test Ws to Z, then Set	1	1	Z
CALL	CALL	lit23	Call Subroutine	2	2	None
	CALL	Wn	Call Indirect Subroutine	1	2	None
CLR	CLR	f	f = 0x0000	1	1	None
	CLR	WREG	WREG = 0x0000	1	1	None
	CLR	Ws	Ws = 0x0000	1	1	None
CLRWDT	CLRWDT		Clear Watchdog Timer	1	1	WDTO, Sleep
СОМ	СОМ	f	$f = \overline{f}$	1	1	N, Z
	СОМ	f,WREG	WREG = f	1	1	N, Z
			$Wd = \overline{Ws}$	1	1	N, Z
<b>G</b> D	COM	Ws,Wd		1	1	
CP	CP	f	Compare f with WREG		1	C, DC, N, OV, Z
	CP	Wb,#lit5	Compare Wb with lit5	1		C, DC, N, OV, Z
~~ ^	CP	Wb,Ws	Compare Wb with Ws (Wb – Ws)	1	1	C, DC, N, OV, Z
CP0	CP0	f	Compare f with 0x0000	1	1	C, DC, N, OV, Z
	CP0	Ws	Compare Ws with 0x0000	1	1	C, DC, N, OV, Z
CPB	CPB	f	Compare f with WREG, with Borrow	1	1	C, DC, N, OV, Z
	CPB	Wb,#lit5	Compare Wb with lit5, with Borrow	1	1	C, DC, N, OV, Z
	CPB	Wb,Ws	Compare Wb with Ws, with Borrow (Wb – Ws – $\overline{C}$ )	1	1	C, DC, N, OV, Z
CPSEQ	CPSEQ	Wb,Wn	Compare Wb with Wn, Skip if =	1	1 (2 or 3)	None
CPSGT	CPSGT	Wb,Wn	Compare Wb with Wn, Skip if >	1	1 (2 or 3)	None
CPSLT	CPSLT	Wb,Wn	Compare Wb with Wn, Skip if <	1	1 (2 or 3)	None
CPSNE	CPSNE	Wb,Wn	Compare Wb with Wn, Skip if ≠	1	1 (2 or 3)	None
DAW	DAW.B	Wn	Wn = Decimal Adjust Wn	1	1	С
DEC	DEC	f	f = f - 1	1	1	C, DC, N, OV, Z
	DEC	f,WREG	WREG = f-1	1	1	C, DC, N, OV, Z
	DEC	Ws,Wd	Wd = Ws – 1	1	1	C, DC, N, OV, Z
DEC2	DEC2	f	f = f - 2	1	1	C, DC, N, OV, Z
	DEC2	f,WREG	WREG = f - 2	1	1	C, DC, N, OV, Z
	DEC2	Ws,Wd	Wd = Ws - 2	1	1	C, DC, N, OV, Z
DISI	DISI	#lit14	Disable Interrupts for k Instruction Cycles	1	1	None
DIV	DIV.SW	Wm,Wn	Signed 16/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.SD	Wm,Wn	Signed 32/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.UW	Wm,Wn	Unsigned 16/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.UD	Wm,Wn	Unsigned 32/16-bit Integer Divide	1	18	N, Z, C, OV
EXCH	EXCH	Wns,Wnd	Swap Wns with Wnd	1	1	None
FF1L	FF1L	Ws,Wnd	Find First One from Left (MSb) Side	1	1	С
FF1R	FF1R	Ws,Wnd	Find First One from Right (LSb) Side	1	1	С

#### TABLE 31-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
GOTO	GOTO	Expr	Go to Address	2	2	None
	GOTO	Wn	Go to Indirect	1	2	None
INC	INC	f	f = f + 1	1	1	C, DC, N, OV, Z
	INC	f,WREG	WREG = f + 1	1	1	C, DC, N, OV, Z
	INC	Ws,Wd	Wd = Ws + 1	1	1	C, DC, N, OV, Z
INC2	INC2	f	f = f + 2	1	1	C, DC, N, OV, Z
	INC2	f,WREG	WREG = f + 2	1	1	C, DC, N, OV, Z
	INC2	Ws,Wd	Wd = Ws + 2	1	1	C, DC, N, OV, Z
IOR	IOR	f	f = f .IOR. WREG	1	1	N, Z
	IOR	f,WREG	WREG = f .IOR. WREG	1	1	N, Z
	IOR	#lit10,Wn	Wd = lit10 .IOR. Wd	1	1	N, Z
	IOR	Wb,Ws,Wd	Wd = Wb .IOR. Ws	1	1	N, Z
	IOR	Wb,#lit5,Wd	Wd = Wb .IOR. lit5	1	1	N, Z
LNK	LNK	#lit14	Link Frame Pointer	1	1	None
LSR	LSR	f	f = Logical Right Shift f	1	1	C, N, OV, Z
	LSR	f,WREG	WREG = Logical Right Shift f	1	1	C, N, OV, Z
	LSR	Ws,Wd	Wd = Logical Right Shift Ws	1	1	C, N, OV, Z
	LSR	Wb,Wns,Wnd	Wnd = Logical Right Shift Wb by Wns	1	1	N, Z
	LSR	Wb,#lit5,Wnd	Wnd = Logical Right Shift Wb by lit5	1	1	N, Z
MOV	MOV	f,Wn	Move f to Wn	1	1	None
110 V	MOV	[Wns+Slit10],Wnd	Move [Wns+Slit10] to Wnd	1	1	None
	MOV	f	Move (Wisi Shirle) to Wild	1	1	N, Z
			Move f to WREG	1	1	N, Z
	MOV	f,WREG			1	,
	MOV	#lit16,Wn	Move 16-bit Literal to Wn	1		None
	MOV.b	#lit8,Wn	Move 8-bit Literal to Wn	1	1	None
	MOV	Wn,f	Move Wn to f	1	1	None
	MOV	Wns,[Wns+Slit10]	Move Wns to [Wns+Slit10]	1	1	None
	MOV	Wso,Wdo	Move Ws to Wd	1	1	None
	MOV	WREG, f	Move WREG to f	1	1	N, Z
	MOV.D	Wns,Wd	Move Double from W(ns):W(ns+1) to Wd	1	2	None
	MOV.D	Ws,Wnd	Move Double from Ws to W(nd+1):W(nd)	1	2	None
MUL	MUL.SS	Wb,Ws,Wnd	{Wnd+1, Wnd} = Signed(Wb) * Signed(Ws)	1	1	None
	MUL.SU	Wb,Ws,Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(Ws)	1	1	None
	MUL.US	Wb,Ws,Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Signed(Ws)	1	1	None
	MUL.UU	Wb,Ws,Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(Ws)	1	1	None
	MUL.SU	Wb,#lit5,Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(lit5)	1	1	None
	MUL.UU	Wb,#lit5,Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(lit5)	1	1	None
	MUL	f	W3:W2 = f * WREG	1	1	None
NEG	NEG	f	$f = \overline{f} + 1$	1	1	C, DC, N, OV, Z
	NEG	f,WREG	WREG = $\overline{f}$ + 1	1	1	C, DC, N, OV, Z
	NEG	Ws,Wd	Wd = Ws + 1	1	1	C, DC, N, OV, Z
NOP	NOP		No Operation	1	1	None
	NOPR		No Operation	1	1	None
POP	POP	f	Pop f from Top-of-Stack (TOS)	1	1	None
	POP	Wdo	Pop from Top-of-Stack (TOS) to Wdo	1	1	None
	POP.D	Wnd	Pop from Top-of-Stack (TOS) to W(nd):W(nd+1)	1	2	None
	POP.S		Pop Shadow Registers	1	1	All
PUSH	PUSH	f	Push f to Top-of-Stack (TOS)	1	1	None
	PUSH	Wso	Push Wso to Top-of-Stack (TOS)	1	1	None
	PUSH.D	Wns	Push W(ns):W(ns+1) to Top-of-Stack (TOS)	1	2	None
	PUSH.S		Push Shadow Registers	1	1	None

TABLE 31-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic	Assembly Syntax PWRSAV #lit1		Description	# of Words	# of Cycles	Status Flags Affected
PWRSAV			Go into Sleep or Idle mode	1	1	WDTO, Sleep
RCALL	RCALL	Expr	Relative Call	1	2	None
	RCALL	Wn	Computed Call	1	2	None
REPEAT	REPEAT	#lit14	Repeat Next Instruction lit14 + 1 times	1	1	None
	REPEAT	Wn	Repeat Next Instruction (Wn) + 1 times	1	1	None
RESET	RESET		Software Device Reset	1	1	None
RETFIE	RETFIE		Return from Interrupt	1	3 (2)	None
RETLW	RETLW	#lit10,Wn	Return with Literal in Wn	1	3 (2)	None
RETURN	RETURN		Return from Subroutine	1	3 (2)	None
RLC	RLC	f	f = Rotate Left through Carry f	1	1	C, N, Z
	RLC	f,WREG	WREG = Rotate Left through Carry f	1	1	C, N, Z
	RLC	Ws,Wd	Wd = Rotate Left through Carry Ws	1	1	C, N, Z
RLNC	RLNC	f	f = Rotate Left (No Carry) f	1	1	N, Z
	RLNC	f,WREG	WREG = Rotate Left (No Carry) f	1	1	N, Z
	RLNC	Ws,Wd	Wd = Rotate Left (No Carry) Ws	1	1	N, Z
RRC	RRC	f	f = Rotate Right through Carry f	1	1	C, N, Z
	RRC	f,WREG	WREG = Rotate Right through Carry f	1	1	C, N, Z
	RRC	Ws,Wd	Wd = Rotate Right through Carry Ws	1	1	C, N, Z
RRNC	RRNC	f	f = Rotate Right (No Carry) f	1	1	N, Z
	RRNC	f,WREG	WREG = Rotate Right (No Carry) f	1	1	N, Z
	RRNC	Ws,Wd	Wd = Rotate Right (No Carry) Ws	1	1	N, Z
SE	SE	Ws,Wnd	Wnd = Sign-Extended Ws	1	1	C, N, Z
SETM	SETM	f	f = FFFFh	1	1	None
	SETM	WREG	WREG = FFFFh	1	1	None
	SETM	Ws	Ws = FFFFh	1	1	None
SL	SL	f	f = Left Shift f	1	1	C, N, OV, Z
	SL	f,WREG	WREG = Left Shift f	1	1	C, N, OV, Z
	SL	Ws,Wd	Wd = Left Shift Ws	1	1	C, N, OV, Z
	SL	Wb,Wns,Wnd	Wnd = Left Shift Wb by Wns	1	1	N, Z
	SL	Wb,#lit5,Wnd	Wnd = Left Shift Wb by lit5	1	1	N, Z
SUB	SUB	f	f = f – WREG	1	1	C, DC, N, OV, Z
	SUB	f,WREG	WREG = f – WREG	1	1	C, DC, N, OV, Z
	SUB	#lit10,Wn	Wn = Wn – lit10	1	1	C, DC, N, OV, Z
	SUB	Wb,Ws,Wd	Wd = Wb – Ws	1	1	C, DC, N, OV, Z
	SUB	Wb,#lit5,Wd	Wd = Wb - lit5	1	1	C, DC, N, OV, Z
SUBB	SUBB	f	$f = f - WREG - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBB	f,WREG	WREG = f – WREG – $(\overline{C})$	1	1	C, DC, N, OV, Z
	SUBB	#lit10,Wn	$Wn = Wn - lit10 - (\overline{C})$	1	1	C, DC, N, OV, Z
			$Wd = Wb - Ws - (\overline{C})$	1	1	
	SUBB	Wb,Ws,Wd				C, DC, N, OV, Z
QUIDE	SUBB	Wb,#lit5,Wd	Wd = Wb - lit5 - (C)	1	1	C, DC, N, OV, Z
SUBR	SUBR	f wppg	f = WREG - f	1	1	C, DC, N, OV, Z
	SUBR	f,WREG	WREG = WREG - f	1	1	C, DC, N, OV, Z
	SUBR	Wb,Ws,Wd	Wd = Ws - Wb	1	1	C, DC, N, OV, Z
	SUBR	Wb,#lit5,Wd	Wd = lit5 - Wb	1	1	C, DC, N, OV, Z
SUBBR	SUBBR	f	$f = WREG - f - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBBR	f,WREG	WREG = WREG - $f - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBBR	Wb,Ws,Wd	$Wd = Ws - Wb - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBBR	Wb,#lit5,Wd	$Wd = lit5 - Wb - (\overline{C})$	1	1	C, DC, N, OV, Z
SWAP	SWAP.b	Wn	Wn = Nibble Swap Wn	1	1	None
	SWAP	Wn	Wn = Byte Swap Wn	1	1	None

#### TABLE 31-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic	Assembly Syntax		Description	# of Words	# of Cycles	Status Flags Affected
TBLRDH	TBLRDH	Ws,Wd	Read Prog<23:16> to Wd<7:0>	1	2	None
TBLRDL	TBLRDL	Ws,Wd	Read Prog<15:0> to Wd	1	2	None
TBLWTH	TBLWTH	Ws,Wd	Write Ws<7:0> to Prog<23:16>	1	2	None
TBLWTL	TBLWTL	Ws,Wd	Write Ws to Prog<15:0>	1	2	None
ULNK	ULNK		Unlink Frame Pointer	1	1	None
XOR	XOR	f	f = f .XOR. WREG	1	1	N, Z
	XOR	f,WREG	WREG = f .XOR. WREG	1	1	N, Z
	XOR	#lit10,Wn	Wd = lit10 .XOR. Wd	1	1	N, Z
	XOR	Wb,Ws,Wd	Wd = Wb .XOR. Ws	1	1	N, Z
	XOR	Wb,#lit5,Wd	Wd = Wb .XOR. lit5	1	1	N, Z
ZE	ZE	Ws,Wnd	Wnd = Zero-Extend Ws	1	1	C, Z, N

TABLE 31-2: INSTRUCTION SET OVERVIEW (CONTINUED)

NOTES:

# 32.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC24FJ256GA705 family electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC24FJ256GA705 family are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these, or any other conditions above the parameters indicated in the operation listings of this specification, is not implied.

## Absolute Maximum Ratings<sup>(†)</sup>

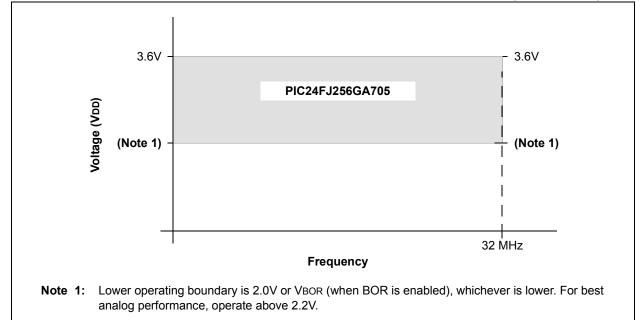
t

Ambient temperature under bias Storage temperature	-65°C to +150°C
Voltage on VDD with respect to Vss	-0.3V to +4.0V
Voltage on any general purpose digital or analog pin (not 5.5V toler	ant) with respect to Vss0.3V to (VDD + 0.3V)
Voltage on any general purpose digital or analog pin (5.5V tolerant,	including MCLR) with respect to Vss:
When VDD = 0V:	-0.3V to +4.0V
When $V_{DD} \ge 2.0V$ :	-0.3V to +6.0V
Voltage on AVDD with respect to Vss	(VDD – 0.3V) to (lesser of: 4.0V or (VDD + 0.3V))
Voltage on AVss with respect to Vss	-0.3V to +0.3V
Maximum current out of Vss pin	
Maximum current into VDD pin (Note 1)	
Maximum output current sunk by any I/O pin	
Maximum output current sourced by any I/O pin	
Maximum current sunk by all ports	
Maximum current sourced by all ports (Note 1)	

Note 1: Maximum allowable current is a function of device maximum power dissipation (see Table 32-1).

**NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

## 32.1 DC Characteristics



#### FIGURE 32-1: PIC24FJ256GA705 FAMILY VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)

#### TABLE 32-1: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min	Тур	Max	Unit
PIC24FJ256GA705:					
Operating Junction Temperature Range	TJ	-40	—	+85	°C
Operating Ambient Temperature Range	erature Range TA -40 — +85				°C
Power Dissipation: Internal Chip Power Dissipation: $PINT = VDD x (IDD - \Sigma IOH)$ I/O Pin Power Dissipation: $PI/O = \Sigma (\{VDD - VOH\} x IOH) + \Sigma (VOL x IOL)$	PD	PINT + PI/O			W
Maximum Allowed Power Dissipation	PDMAX	(Tj – Ta)/θja			W

#### TABLE 32-2: THERMAL PACKAGING CHARACTERISTICS

Characteristic	Symbol	Тур	Мах	Unit	Notes
Package Thermal Resistance, 6x6 mm 28-Pin QFN	θJA			°C/W	(Note 1)
Package Thermal Resistance, 4x4x0.6 mm 28-Pin UQFN	θJA		-	°C/W	(Note 1)
Package Thermal Resistance, 7.50 mm 28-Pin SOIC	θJA		_	°C/W	(Note 1)
Package Thermal Resistance, 5.30 mm 28-Pin SSOP	θJA		_	°C/W	(Note 1)
Package Thermal Resistance, 300 mil 28-Pin SPDIP	θJA		_	°C/W	(Note 1)
Package Thermal Resistance, 6x6x0.5 mm 48-Pin UQFN	θJA	33.7	_	°C/W	(Note 1)
Package Thermal Resistance, 10x10x1 mm 44-Pin TQFP	θJA	28	_	°C/W	(Note 1)
Package Thermal Resistance, 7x7x1 mm 48-Pin TQFP	θJA	39.3	—	°C/W	(Note 1)

**Note 1:** Junction to ambient thermal resistance; Theta-JA ( $\theta$ JA) numbers are achieved by package simulations.

#### TABLE 32-3: DC CHARACTERISTICS: TEMPERATURE AND VOLTAGE SPECIFICATIONS

DC CH4	ARACTE	RISTICS	Standard Opera Operating temp		(unless otherwise stated) +85°C for Industrial					
Param No.	Symbol	Characteristic	Min	Тур	Мах	Units	Conditions			
Operating Voltage										
DC10	Vdd	Supply Voltage	2.0	—	3.6	V	BOR is disabled			
			VBOR	_	3.6	V	BOR is enabled			
DC12	Vdr	RAM Data Retention Voltage <sup>(1)</sup>	Greater of: VPORREL or VBOR	_	_	V	VBOR is used only if BOR is enabled (BOREN = 1)			
DC16	VPOR	<b>VDD Start Voltage</b> to Ensure Internal Power-on Reset Signal	Vss	_	_	V	(Note 2)			
DC17A	SVDD	Recommended VDD Rise Rate to Ensure Internal Power-on Reset Signal	1V/20 ms	_	1V/10 µS	sec	(Note 2, Note 4)			
DC17B	VBOR	<b>Brown-out Reset</b> <b>Voltage</b> on VDD Transition, High-to-Low	2.0	2.1	2.2	V	(Note 3)			

**Note 1:** This is the limit to which VDD may be lowered and the RAM contents will always be retained.

**2:** If the VPOR or SVDD parameters are not met, or the application experiences slow power-down VDD ramp rates, it is recommended to enable and use BOR.

**3:** On a rising VDD power-up sequence, application firmware execution begins at the higher of the VPORREL or VBOR level (when BOREN = 1).

4: VDD rise times outside this window may not internally reset the processor and are not parametrically tested.

DC CHARAG	CTERISTICS			Standard Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial						
Parameter No.	Typical <sup>(1)</sup>	Мах	Units	Operating Temperature	VDD	Conditions				
Operating C	Operating Current (IDD) <sup>(2)</sup>									
DC19	230	365	μA	-40°C to +85°C	2.0V	0.5 MIPS,				
	250	365	μΑ	-40°C to +85°C	3.3V	Fosc = 1 MHz				
DC20	430	640	μA	-40°C to +85°C	2.0V	1 MIPS,				
	440	640	μΑ	-40°C to +85°C	3.3V	Fosc = 2 MHz				
DC23	1.5	2.4	mA	-40°C to +85°C	2.0V	4 MIPS,				
	1.65	2.4	mA	-40°C to +85°C	3.3V	Fosc = 8 MHz				
DC24	6.1	7.7	mA	-40°C to +85°C	2.0V	16 MIPS,				
	6.3	7.7	mA	-40°C to +85°C	3.3V	Fosc = 32 MHz				
DC31	43	130	μA	-40°C to +85°C	2.0V	LPRC (15.5 KIPS),				
	46	130	μA	-40°C to +85°C	3.3V	Fosc = 31 kHz				
DC32	1.6	2.5	mA	-40°C to +85°C	2.0V	FRC (4 MIPS),				
	1.65	2.5	mA	-40°C to +85°C	3.3V	Fosc = 8 MHz				

#### TABLE 32-4: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

**Note 1:** Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Typical parameters are for design guidance only and are not tested.

2: The test conditions for all IDD measurements are as follows: OSC1 driven with external square wave from rail-to-rail. All I/O pins are configured as outputs and driving low. MCLR = VDD; WDT and FSCM are disabled. CPU, program memory and data memory are operational. No peripheral modules are operating or being clocked (defined PMDx bits are all '1's). JTAG interface is disabled.

DC CHARAC	TERISTICS			Dperating Conditions: emperature	: 2.0V to 3.6V (unless otherwise stated) -40°C $\leq$ TA $\leq$ +85°C for Industrial			
Parameter No.			Units	Units Operating Temperature		Conditions		
Idle Current (	IIDLE) <sup>(2)</sup>		•	·	•			
DC40	95	400	μΑ	-40°C to +85°C	2.0V	1 MIPS,		
	105	400	μΑ	-40°C to +85°C	3.3V	Fosc = 2 MHz		
DC43	290	1200	μΑ	-40°C to +85°C	2.0V	4 MIPS,		
	315	1200	μΑ	-40°C to +85°C	3.3V	Fosc = 8 MHz		
DC47	1.05	3.7	mA	-40°C to +85°C	2.0V	16 MIPS,		
	1.16	3.7	mA	-40°C to +85°C	3.3V	Fosc = 32 MHz		
DC50	350	1100	μA	-40°C to +85°C	2.0V	FRC (4 MIPS),		
	360	1100	μA	-40°C to +85°C	3.3V	Fosc = 8 MHz		
DC51	29	110	μΑ	-40°C to +85°C	2.0V	LPRC (15.5 KIPS),		
	33	110	μΑ	-40°C to +85°C	3.3V	Fosc = 31 kHz		

TABLE 32-5: DC CHARACTERISTICS: IDLE CURRENT (II	IDLE)
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**Note 1:** Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Base IIDLE current is measured with the core off, the clock on and all modules turned off. Peripheral Module Disable SFR registers are all '1's. All I/O pins are configured as outputs and driven low. JTAG interface is disabled.

DC CHARA	CTERISTIC	s	Standard Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial						
Parameter No.				Operating Temperature	VDD	Conditions			
Power-Dov	vn Current <sup>(4</sup>	4,5)	•	•		·			
DC60	2.5	10	μA	-40°C					
	3.2	10	μΑ	+25°C	2.0V				
	11.5	45	μA	+85°C		- Sleep <sup>(2)</sup>			
	3.2	10	μA	-40°C	3.3V	- Sieeh, ,			
	4.4	10	μA	+25°C					
	12.2	45	μA	+85°C					
DC61	165	_	nA	-40°C					
	190		nA	+25°C	2.0V				
	14.5	_	μΑ	+85°C		Low Voltage Detention Sleen <sup>(3)</sup>			
	220		nA	-40°C		Low-Voltage Retention Sleep <sup>(3)</sup>			
	300	_	nA	+25°C	3.3V				
	15	_	μA	+85°C					

#### TABLE 32-6: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

**Note 1:** Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The retention low-voltage regulator is disabled; RETEN (RCON<12>) = 0, LPCFG (FPOR<2>) = 1.

3: The retention low-voltage regulator is enabled; RETEN (RCON<12>) = 1,  $\overline{\text{LPCFG}}$  (FPOR<2>) = 0.

4: Base IPD is measured with all peripherals and clocks shut down. All I/Os are configured as outputs and driven low. WDT, BOR and JTAG are all disabled.

5: These currents are measured on the device containing the most memory in this family.

DC CHARAC	TERISTICS			<b>Operating Condit</b> temperature	<b>3.6V (unless otherwise stated)</b> ≤ TA ≤ +85°C for Industrial				
Parameter No.	Typical <sup>(1)</sup>	Max	Units	Operating Temperature	VDD	Conditions			
Incremental Current Brown-out Reset (∆BOR) <sup>(2)</sup>									
DC25	3	5	μA	-40°C to +85°C	2.0V	4BOR <sup>(2)</sup>			
	4	5	μA	-40°C to +85°C	3.3V				
Incremental Current Watchdog Timer (△WDT) <sup>(2)</sup>									
DC71	220	1000	nA	-40°C to +85°C	2.0V	∆WDT <sup>(2)</sup>			
	300	1000	nA	-40°C to +85°C	3.3V				
Incremental C	Current High	/Low-Voltag	e Detect (∆ŀ	ILVD) <sup>(2)</sup>					
DC75	1.3	5	μA	-40°C to +85°C	2.0V	AHLVD <sup>(2)</sup>			
	1.9	5	μA	-40°C to +85°C	3.3V				
Incremental C	Current Real	-Time Clock	and Calend	lar (∆RTCC) <sup>(2)</sup>					
DC77	2.5	_	μA	-40°C to +85°C	2.0V	∆RTCC (with SOSC enabled in			
	3	_	μA	-40°C to +85°C	3.3V	Low-Power mode) <sup>(2)</sup>			
DC77A	350	1000	nA	-40°C to +85°C	2.0V	∆RTCC (with LPRC enabled) <sup>(2)</sup>			
	400	1000	nA	-40°C to +85°C	3.3V				

# TABLE 32-7: DC CHARACTERISTICS: △ CURRENT (BOR, WDT, HLVD, RTCC)<sup>(3)</sup>

**Note 1:** Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Incremental current while the module is enabled and running.

**3:** The ∆ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current. The current includes the selected clock source enabled for WDT and RTCC.

DC CH	ARACTE	RISTICS		$\begin{array}{llllllllllllllllllllllllllllllllllll$							
Param No.	Symbol	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Conditions				
	VIL	Input Low Voltage <sup>(3)</sup>									
DI10		I/O Pins with ST Buffer	Vss	_	0.2 VDD	V					
DI11		I/O Pins with TTL Buffer	Vss	—	0.15 VDD	V					
DI15		MCLR	Vss	_	0.2 VDD	V					
DI16		OSCI (XT mode)	Vss	—	0.2 VDD	V					
DI17		OSCI (HS mode)	Vss	—	0.2 VDD	V					
DI18		I/O Pins with I <sup>2</sup> C Buffer	Vss	—	0.3 VDD	V					
DI19		I/O Pins with SMBus Buffer	Vss	—	0.8	V	SMBus is enabled				
	Viн	Input High Voltage <sup>(3)</sup>									
DI20		I/O Pins with ST Buffer: with Analog Functions, Digital Only	0.8 Vdd 0.8 Vdd	_	Vdd 5.5	V V					
DI21		I/O Pins with TTL Buffer: with Analog Functions, Digital Only	0.25 Vdd + 0.8 0.25 Vdd + 0.8	_	Vdd 5.5	V V					
DI25		MCLR	0.8 Vdd	—	Vdd	V					
DI26		OSCI (XT mode)	0.7 Vdd	_	Vdd	V					
DI27		OSCI (HS mode)	0.7 Vdd	—	Vdd	V					
DI28		I/O Pins with I <sup>2</sup> C Buffer: with Analog Functions, Digital Only	0.7 Vdd 0.7 Vdd	_	VDD 5.5	V V					
DI29		I/O Pins with SMBus Buffer:									
		with Analog Functions,	2.1	—	VDD	V	$2.5V \le VPIN \le VDD$				
D120		Digital Only	2.1	_	5.5 450	V	VDD = 3.3V, VPIN = VSS				
DI30		CNx Pull-up Current CNx Pull-Down Current	150 230	_	450 500	μA	VDD = 3.3V, $VPIN = VSSVDD = 3.3V$ , $VPIN = VDD$				
DI30A		Input Leakage Current <sup>(2)</sup>	230		500	μA	VDD = 3.3V, VPIN = VDD				
DI50	lil	I/O Ports	_	—	±1	μΑ	$Vss \le VPIN \le VDD,$ pin at high-impedance				
DI51		Analog Input Pins	_	—	±1	μA	Vss $\leq$ VPIN $\leq$ VDD, pin at high-impedance				
DI55		MCLR		—	±1	μA	$Vss \leq V \text{PIN} \leq V \text{DD}$				
DI56		OSCI/CLKI	—	—	±1	μA	$\label{eq:VSS} \begin{split} &V{\sf SS} \leq V{\sf PIN} \leq V{\sf DD}, \\ &{\sf EC}, \; XT \; and \; HS \; modes \end{split}$				

#### TABLE 32-8: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS

**Note 1:** Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Negative current is defined as current sourced by the pin.

3: Refer to Table 1-1 for I/O pin buffer types.

DC CHA	RACTER	ISTICS	Standard O Operating to			ns: 2.0V to 3.6V (unless otherwise stated) -40°C $\leq$ TA $\leq$ +85°C for Industrial		
Param No.	Symbol	Characteristic	Min Typ <sup>(1)</sup> Max Units		Units	Conditions		
	Vol	Output Low Voltage						
DO10		I/O Ports	_	—	0.4	V	IOL = 6.6 mA, VDD = 3.6V	
			_	—	0.8	V	IOL = 18 mA, VDD = 3.6V	
			_	—	0.35	V	IOL = 5.0 mA, VDD = 2V	
DO16		OSCO/CLKO	_	—	0.18	V	IOL = 6.6 mA, VDD = 3.6V	
			_	—	0.2	V	IOL = 5.0 mA, VDD = 2V	
	Voн	Output High Voltage						
DO20		I/O Ports	3.4	—	—	V	IOH = -3.0 mA, VDD = 3.6V	
			3.25	—	—	V	IOH = -6.0 mA, VDD = 3.6V	
			2.8	—	—	V	ІОН = -18 mA, VDD = 3.6V	
			1.65	—	—	V	ІОН = -1.0 mA, VDD = 2V	
			1.4	—	—	V	IOH = -3.0 mA, VDD = 2V	
DO26		OSCO/CLKO	3.3	—	—	V	IOH = -6.0 mA, VDD = 3.6V	
			1.85		_	V	IOH = -1.0 mA, VDD = 2V	

#### TABLE 32-9: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

**Note 1:** Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

#### TABLE 32-10: DC CHARACTERISTICS: PROGRAM MEMORY

DC CHA	DC CHARACTERISTICS			•	ating Co perature		s: 2.0V to 3.6V (unless otherwise stated) -40°C $\leq$ TA $\leq$ +85°C for Industrial		
Param No.	Symbol	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Conditions		
		Program Flash Memory							
D130	Eр	Cell Endurance	10000		_	E/W	-40°C to +85°C		
D131	Vpr	VDD for Read	VMIN	—	3.6	V	VміN = Minimum operating voltage		
D132B		VDD for Self-Timed Write	VMIN		3.6	V	VміN = Minimum operating voltage		
D133A	Tiw	Self-Timed Word Write Cycle Time	—	20	—	μS			
		Self-Timed Row Write Cycle Time	—	1.5	—	ms			
D133B	TIE	Self-Timed Page Erase Time	20	—	40	ms			
D134	TRETD	Characteristic Retention	20	—	_	Year	If no other specifications are violated		
D135	IDDP	Supply Current during Programming		5		mA			

**Note 1:** Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated.

TABLE 32-11:	INTERNAL VOLTAGE REGULATOR SPECIFICATIONS
--------------	---

Operatin	<b>Operating Conditions:</b> -40°C < TA < +85°C (unless otherwise stated)									
Param No.	Symbol	Characteristics	Min	Тур	Max	Units	Comments			
DVR	TVREG	Voltage Regulator Start-up Time		10	-	μS	VREGS = 0 with any POR or BOR			
DVR10	Vbg	Internal Band Gap Reference	1.14	1.2	1.26	V				
DVR11	Tbg	Band Gap Reference Start-up Time	_	1	-	ms				
DVR20	Vrgout	Regulator Output Voltage	1.6	1.8	2.0	V	Vdd > 1.9V			
DVR21	CEFC	External Filter Capacitor Value	10	—	—	μF	Series resistance < $3\Omega$ recommended; < $5\Omega$ required			
DVR30	Vlvr	Low-Voltage Regulator Output Voltage		1.2	_	V	$RETEN = 1, \overline{LPCFG} = 0$			

## TABLE 32-12: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

<b>Operating Conditions:</b> -40°C < TA < +85°C (unless otherwise stated)										
Param No.	Symbol	Charac	Characteristic			Max	Units	Conditions		
DC18 \	VHLVD	HLVD Voltage on VDD	HLVDL<3:0> = 0100 <sup>(1)</sup>	3.45	_	3.73	V			
		Transition	HLVDL<3:0> = 0101	3.25		3.58	V			
			HLVDL<3:0> = 0110	2.95		3.25	V			
			HLVDL<3:0> = 0111	2.75		3.04	V			
			HLVDL<3:0> = 1000	2.65		2.92	V			
			HLVDL<3:0> = 1001	2.45	—	2.70	V			
			HLVDL<3:0> = 1010	2.35	—	2.60	V			
			HLVDL<3:0> = 1011	2.25		2.49	V			
			HLVDL<3:0> = 1100	2.15		2.39	V			
			HLVDL<3:0> = 1101	2.08	—	2.28	V			
			HLVDL<3:0> = 1110	2.00		2.15	V			
DC101	VTHL	HLVD Voltage on LVDIN Pin Transition	HLVDL<3:0> = 1111	_	1.20	—	V			
DC105	TONLVD	HLVD Module Enable Time			5		μS	From POR or HLVDEN = 1		

Г

**Note 1:** Trip points for values of HLVD<3:0>, from '0000' to '0011', are not implemented.

#### TABLE 32-13: COMPARATOR DC SPECIFICATIONS

Operati	<b>Operating Conditions:</b> $2.0V < V_{DD} < 3.6V$ , $-40^{\circ}C < T_A < +85^{\circ}C$ (unless otherwise stated)									
Param No.	Symbol	Characteristic Min Typ Max Units		Comments						
D300	VIOFF	Input Offset Voltage		12	50	mV	(Note 1)			
D301	VICM	Input Common-Mode Voltage	0	_	Vdd	V	(Note 1)			
D302	CMRR	Common-Mode Rejection Ratio	55	_		dB	(Note 1)			
D306	IQCMP	AVDD Quiescent Current per Comparator	_	27		μA	Comparator is enabled			
D307	TRESP	Response Time	_	300		ns	(Note 2)			
D308	TMC2OV	Comparator Mode Change to Valid Output	_	_	10	μs				
D309	IDD	Operating Supply Current	_	30		μA	AVDD = 3.3V			

Note 1: Parameters are characterized but not tested.

2: Measured with one input at VDD/2 and the other transitioning from Vss to VDD, 40 mV step, 15 mV overdrive.

#### TABLE 32-14: COMPARATOR VOLTAGE REFERENCE DC SPECIFICATIONS

Operatin	<b>Operating Conditions:</b> 2.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)									
Param No.	Symbol	Characteristic Min Typ Max Units Com								
VR310	TSET	Settling Time	—	_	10	μs	(Note 1)			
VRD311	CVRAA	Absolute Accuracy	-100	—	+100	mV				
VRD312	CVRur	Unit Resistor Value (R)	_	4.5	_	kΩ				

**Note 1:** Measures the interval while CVR<4:0> transitions from '11111' to '00000'.

#### TABLE 32-15: CTMU CURRENT SOURCE SPECIFICATIONS

DC CH/	ARACTER	RISTICS	Standard Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial							
Param No.	Sym	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Comments	Conditions		
DCT10	IOUT1	CTMU Current Source, Base Range	—	550		nA	CTMUCON1L<1:0> = 00 <sup>(2)</sup>			
DCT11	IOUT2	CTMU Current Source, 10x Range	-	5.5		μA	CTMUCON1L<1:0> = 01			
DCT12	IOUT3	CTMU Current Source, 100x Range	-	55		μA	CTMUCON1L<1:0> = 10	2.5V < VDD < VDDMAX		
DCT13	IOUT4	CTMU Current Source, 1000x Range	—	550	_	μA	CTMUCON1L<1:0> = $11^{(2)}$ , CTMUCON1H<0> = 0			
DCT14	IOUT5	CTMU Current Source, High Range	—	2.2	_	mA	CTMUCON1L<1:0> = 01, CTMUCON1H<0> = 1			
DCT21	VDELTA1	Temperature Diode Voltage Change per Degree Celsius	—	-1.8	_	mV/°C	Current = 5.5 μA			
DCT22	VDELTA2	Temperature Diode Voltage Change per Degree Celsius	—	-1.55	—	mV/°C	Current = 55 µA			
DCT23	VD1	Forward Voltage	—	710	_	mV	At 0°C, 5.5 μΑ			
DCT24	VD2	Forward Voltage	—	760	—	mV	At 0°C, 55 μΑ			

Note 1: Nominal value at center point of current trim range (CTMUCON1L<7:2> = 000000).

**2:** Do not use this current range with the internal temperature sensing diode.

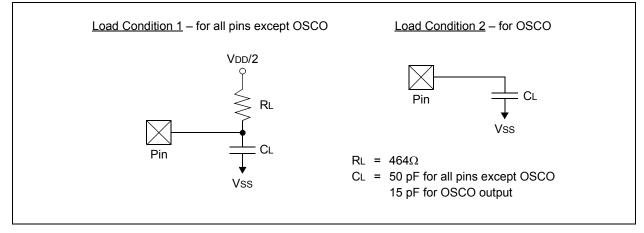
# 32.2 AC Characteristics and Timing Parameters

The information contained in this section defines the PIC24FJ256GA705 family AC characteristics and timing parameters.

#### TABLE 32-16: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

	Standard Operating Condition	s: 2.0V to 3.6V (unless otherwise stated)
AC CHARACTERISTICS	Operating temperature	$-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial
	Operating voltage VDD range as o	described in Section 32.1 "DC Characteristics".

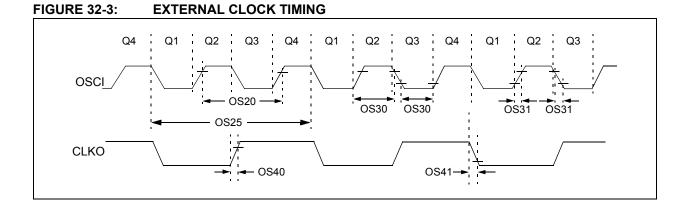
#### FIGURE 32-2: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



#### TABLE 32-17: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

Param No.	Symbol	Characteristic	Min	Typ <sup>(1)</sup>	Мах	Units	Conditions
DO50	Cosco	OSCO/CLKO Pin	_		15	pF	In XT and HS modes when external clock is used to drive OSCI
DO56	Сю	All I/O Pins and OSCO	_	_	50	pF	EC mode
DO58	Св	SCLx, SDAx	—		400	pF	In I <sup>2</sup> C mode

**Note 1:** Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.



#### TABLE 32-18: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CH	ARACTE	RISTICS	Standard Op Operating ter	-		2.0V to 3.6V (unless otherwise stated) -40°C $\leq$ TA $\leq$ +85°C for Industrial		
Param No.	Symbol	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Conditions	
OS10	Fosc	External CLKI Frequency (External clocks allowed only in EC mode)	DC 4		32 48	MHz MHz	EC ECPLL (Note 2)	
		Oscillator Frequency	3.5 4 10 12 31		10 8 32 24 33	MHz MHz MHz MHz kHz	XT XTPLL HS HSPLL SOSC	
OS20	Tosc	Tosc = 1/Fosc	_			-	See Parameter OS10 for Fosc value	
OS25	Тсү	Instruction Cycle Time <sup>(3)</sup>	62.5	_	DC	ns		
OS30	TosL, TosH	External Clock in (OSCI) High or Low Time	0.45 x Tosc	—	—	ns	EC	
OS31	TosR, TosF	External Clock in (OSCI) Rise or Fall Time	—	—	20	ns	EC	
OS40	TckR	CLKO Rise Time <sup>(4)</sup>	—	15	30	ns		
OS41	TckF	CLKO Fall Time <sup>(4)</sup>	—	15	30	ns		

**Note 1:** Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Represents input to the system clock prescaler. PLL dividers and postscalers must still be configured so that the system clock frequency does not exceed the maximum frequency shown in Figure 32-1.

- 3: Instruction cycle period (TCY) equals two times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type, under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "Min." values with an external clock applied to the OSCI/CLKI pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.
- 4: Measurements are taken in EC mode. The CLKO signal is measured on the OSCO pin. CLKO is low for the Q1-Q2 period (1/2 TcY) and high for the Q3-Q4 period (1/2 TcY).

#### TABLE 32-19: AC SPECIFICATIONS FOR PHASE-LOCKED LOOP MODE

AC CH	ACCHARACTERISTICS		Standard Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial						
Sym	Characteristic	Min	Тур	Max	Units	Conditions			
Fin	Input Frequency Range	2	_	24	MHz				
FMIN	Minimum Output Frequency from the Frequency Multiplier	—	—	16	MHz	4 MHz FIN with 4x feedback ratio, 2 MHz FIN with 8x feedback ratio			
Fмах	Maximum Output Frequency from the Frequency Multiplier	96	—	—	MHz	4 MHz FIN with 24x net multiplication ratio, 24 MHz FIN with 4x net multiplication ratio			
FSLEW	Maximum Step Function of FIN at which the PLL will be Ensured to Maintain Lock	-4	—	+4	%	Full input range of FIN			
TLOCK	Lock Time for VCO	-	—	24	μs	With the specified minimum, TREF, and a lock timer count of one cycle, this is the maximum VCO lock time supported			
JFM8	Cumulative Jitter of Frequency Multiplier Over Voltage and Temperature during Any Eight Consecutive Cycles of the PLL Output	—	—	±0.12	%	4 MHz FIN with 4x feedback ratio			

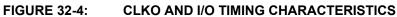
### TABLE 32-20: INTERNAL RC ACCURACY

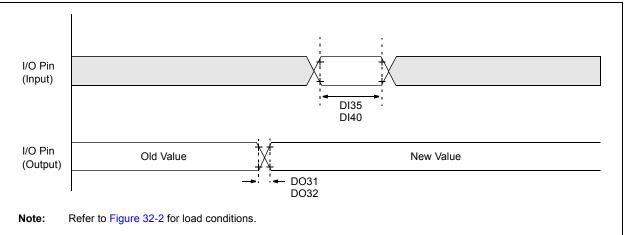
АС СНА	RACTERISTICS		$\begin{array}{llllllllllllllllllllllllllllllllllll$						
Param No.	Characteristic	Min	Тур	Max	C Units Conditions				
F20	FRC Accuracy @ 8 MHz	-1.5	+0.15	1.5	%	$2.0V \leq VDD \leq 3.6V, \ 0^{\circ}C \leq TA \leq +85^{\circ}C$ (Note 1)			
		-2	—	2	%	$2.0V \leq V\text{DD} \leq 3.6V, \ \text{-40}^\circ\text{C} \leq \text{Ta} \leq 0^\circ\text{C}$			
F21	LPRC @ 31 kHz	-20	_	20	%	VCAP Output Voltage = 1.8V			
F22	OSCTUN Step-Size		0.1	_	%/bit				

**Note 1:** To achieve this accuracy, physical stress applied to the microcontroller package (ex., by flexing the PCB) must be kept to a minimum.

#### TABLE 32-21: RC OSCILLATOR START-UP TIME

AC CH	ARACTEI	RISTICS		Standard Operating Conditions:2.0V to 3.6V (unless otherwise stOperating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial					
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions		
FR0	TFRC	FRC Oscillator Start-up Time	—	15	_	μS			
FR1	TLPRC	Low-Power RC Oscillator Start-up Time	—	50	—	μS			





#### TABLE 32-22: CLKO AND I/O TIMING REQUIREMENTS

AC CHA	AC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$						
Param No.	Symbol	Characteristic	Min	Typ <sup>(1)</sup>	Мах	Units	Conditions			
DO31	TIOR	Port Output Rise Time	—	10	25	ns				
DO32	TIOF	Port Output Fall Time	_	10	25	ns				
DI35	TINP	INTx Pin High or Low Time (input)	1	—	_	Тсү				
DI40	Trbp	CNx High or Low Time (input)	1	—	—	Тсү				

**Note 1:** Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated.

ас сн	AC CHARACTERISTICS			Standard Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial							
Param No.	Symbol	Characteristic	Characteristic Min Typ Max		Units	Conditions					
SY10	TMCL	MCLR Pulse Width (Low)	2	-	_	μS					
SY12	TPOR	Power-on Reset Delay	_	2	_	μS					
SY13	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	Lesser of: (3 Tcy + 2) or 700	—	(3 Tcy + 2)	μS					
SY25	TBOR	Brown-out Reset Pulse Width	1		—	μS	$V \text{DD} \leq V \text{BOR}$				
SY45	TRST	Internal State Reset Time	_	50		μS					
SY71	Трм	Program Memory Wake-up Time	—	20	—	μS	Sleep wake-up with VREGS = 1				
			_	1	—	μS	Sleep wake-up with VREGS = 0				
SY72	Tlvr	Low-Voltage Regulator Wake-up Time	—	90	—	μS	Sleep wake-up with VREGS = 1				
			—	70	—	μS	Sleep wake-up with VREGS = 0				

#### TABLE 32-23: RESET AND BROWN-OUT RESET REQUIREMENTS

AC CH	ARACTER	ISTICS	Standard O Operating te			: 2.0V to 3.6V (unless otherwise stated) -40°C $\leq$ TA $\leq$ +85°C for Industrial		
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions	
			Devid	e Supp	ly			
AD01	AVDD	Module VDD Supply	Greater of: VDD – 0.3 or 2.2	_	Lesser of: VDD + 0.3 or 3.6	V		
AD02	AVss	Module Vss Supply	Vss – 0.3		Vss + 0.3	V		
			Refere	nce Inp	uts			
AD05	VREFH	Reference Voltage High	AVss + 1.7		AVDD	V		
AD06	VREFL	Reference Voltage Low	AVss		AVDD - 1.7	V		
AD07	Vref	Absolute Reference Voltage	AVss – 0.3	—	AVDD + 0.3	V		
			Anal	og Input	ts			
AD10	VINH-VINL	Full-Scale Input Span	VREFL	_	VREFH	V	(Note 2)	
AD11	VIN	Absolute Input Voltage	AVss - 0.3	_	AVDD + 0.3	V		
AD12	Vinl	Absolute VINL Input Voltage	AVss – 0.3	_	AVDD/3	V		
AD13		Leakage Current	—	±1.0	±610	nA	VINL = AVSS = VREFL = 0V, AVDD = VREFH = $3V$ , Source Impedance = $2.5 \text{ k}\Omega$	
AD17	RIN	Recommended Impedance of Analog Voltage Source	—	_	2.5k	Ω	10-bit	
		•	A/D	Accurac	y			
AD20B	Nr	Resolution		12	—	bits		
AD21B	INL	Integral Nonlinearity	—	±1	< ±2	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V	
AD22B	DNL	Differential Nonlinearity	—	_	< ±1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V	
AD23B	Gerr	Gain Error	—	±1	±4	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V	
AD24B	EOFF	Offset Error	_	±1	±2	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V	
AD25B		Monotonicity <sup>(1)</sup>		—	_	_	Guaranteed	

# TABLE 32-24: A/D MODULE SPECIFICATIONS

Note 1: The A/D conversion result never decreases with an increase in the input voltage.

2: Measurements are taken with the external VREF+ and VREF- used as the A/D voltage reference.

АС СН	ARACTE	RISTICS		d <b>Operati</b> i g temper	-		V to 3.6V (unless otherwise stated) $^{\circ}C \leq TA \leq +85^{\circ}C$ for Industrial					
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions					
	Clock Parameters											
AD50	Tad	A/D Clock Period	278	—		ns						
AD51	tRC	A/D Internal RC Oscillator Period		250	—	ns						
	Conversion Rate											
AD55	tCONV	SAR Conversion Time, 12-Bit Mode	_	14	—	Tad						
AD55A		SAR Conversion Time, 10-Bit Mode is Typical 12 Tad	_	12	—	Tad						
AD56	FCNV	Throughput Rate		_	200	ksps	AVDD > 2.7V <sup>(2)</sup>					
AD57	tSAMP	Sample Time		1		Tad						
	Clock Synchronization											
AD61	tpss	Sample Start Delay from Setting Sample bit (SAMP)	1.5		2.5	Tad						

# TABLE 32-25: A/D CONVERSION TIMING REQUIREMENTS<sup>(1)</sup>

**Note 1:** Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

2: Throughput rate is based on AD55 + AD57 + AD61 and the period of TAD.

# 33.0 PACKAGING INFORMATION

#### 33.1 **Package Marking Information**

28-Lead QFN (6x6 mm) Example 24FJ256 XXXXXXXXX GA702 XXXXXXXXX YYWWNNN 1810017 28-Lead UQFN (4x4x0.6 mm) Example Ο Ο XXXXX PIC24 XXXXXX FJ256 XXXXXX GA702 YYWWNNN 1810017 28-Lead SOIC (7.50 mm) Example **1810017 M**YYWWNNN 28-Lead SSOP (5.30 mm) Example XXXXXXXXXXXXX PIC24FJ256 XXXXXXXXXXXXX GA702 **M** YYWWNNN **1810017** Legend: XX...X Customer-specific information Year code (last digit of calendar year) Y YΥ Year code (last 2 digits of calendar year)

NNN Alphanumeric traceability code In the event the full Microchip part number cannot be marked on one line, it will Note: be carried over to the next line, thus limiting the number of available characters for customer-specific information.

Week code (week of January 1 is week '01')





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# 33.1 Package Marking Information (Continued)

28-Lead SPDIP (300 mil)

44-Lead TQFP (10x10x1 mm)

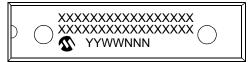
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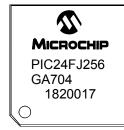
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# Example



#### Example



#### 48-Lead UQFN (6x6 mm)



Example



48-Lead TQFP (7x7x1.0 mm)



Example

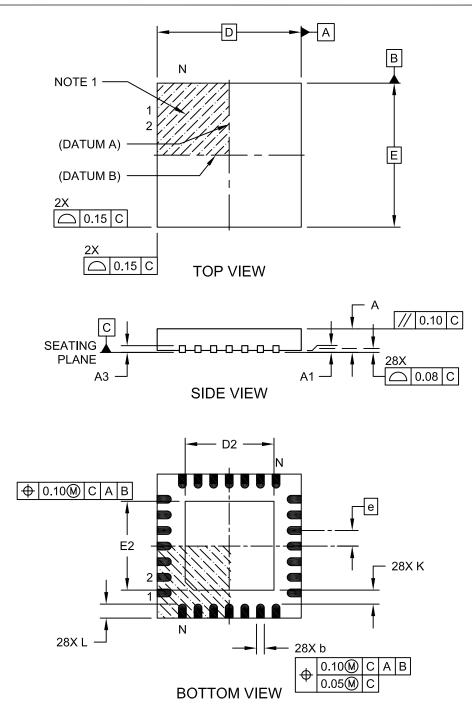


# 33.2 Package Details

The following sections give the technical details of the packages.

### 28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

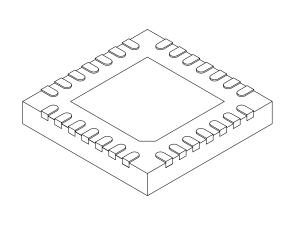
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-105C Sheet 1 of 2

### 28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	М	LLIMETERS	
Dimensior	Limits	MIN	NOM	MAX
Number of Pins	Ν		28	
Pitch	е		0.65 BSC	
Overall Height	Α	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.20 REF		
Overall Width	Е		6.00 BSC	
Exposed Pad Width	E2	3.65	3.70	4.20
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	3.65	3.70	4.20
Terminal Width	b	0.23	0.30	0.35
Terminal Length	L	0.50	0.55	0.70
Terminal-to-Exposed Pad	K	0.20	-	-

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

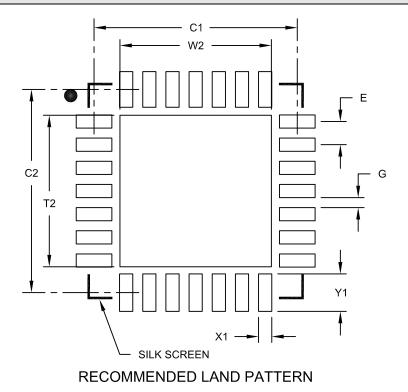
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105C Sheet 2 of 2

# 28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	•
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

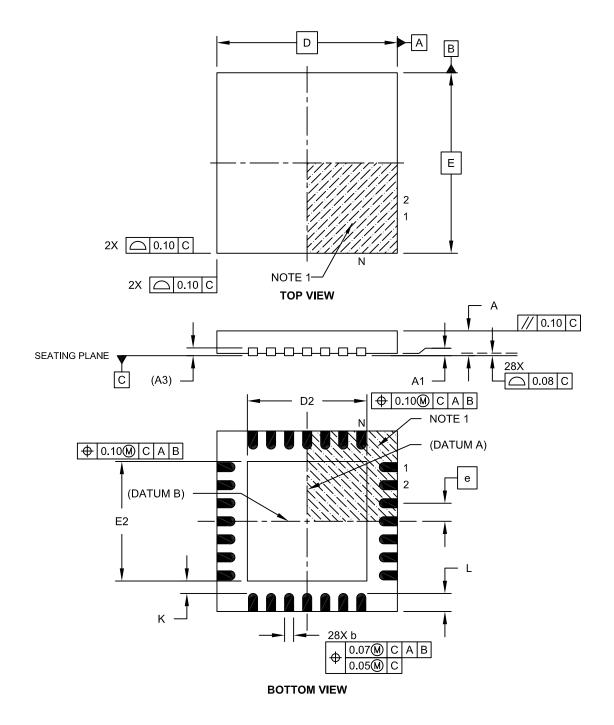
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A

# 28-Lead Plastic Ultra Thin Quad Flat, No Lead Package (MV) – 4x4x0.5 mm Body [UQFN]

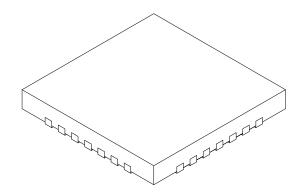
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-152A Sheet 1 of 2

#### 28-Lead Plastic Ultra Thin Quad Flat, No Lead Package (MV) – 4x4x0.5 mm Body [UQFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension	Dimension Limits		NOM	MAX
Number of Pins	N		28	
Pitch	е		0.40 BSC	
Overall Height	А	0.45	0.55	
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.127 REF		
Overall Width	E	4.00 BSC		
Exposed Pad Width	E2	2.55	2.65	2.75
Overall Length	D		4.00 BSC	
Exposed Pad Length	D2	2.55	2.65	2.75
Contact Width	b	0.15	0.20	0.25
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

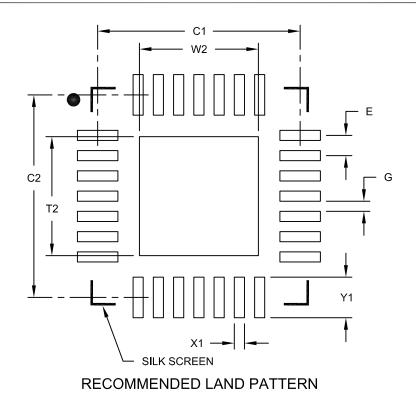
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-152A Sheet 2 of 2

28-Lead Ultra Thin Plastic Quad Flat, No Lead Package (MV) - 4x4 mm Body [UQFN] With 0.40 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Contact Pitch	E		0.40 BSC		
Optional Center Pad Width	W2			2.35	
Optional Center Pad Length	T2			2.35	
Contact Pad Spacing	C1		4.00		
Contact Pad Spacing	C2		4.00		
Contact Pad Width (X28)	X1			0.20	
Contact Pad Length (X28)	Y1			0.80	
Distance Between Pads	G	0.20			

#### Notes:

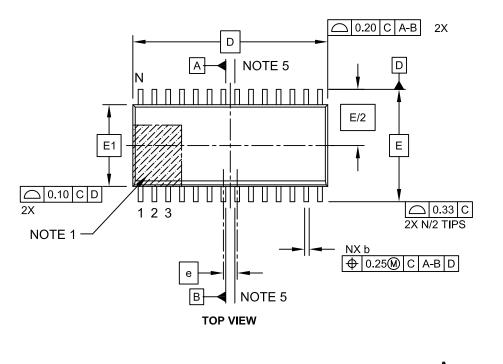
1. Dimensioning and tolerancing per ASME Y14.5M

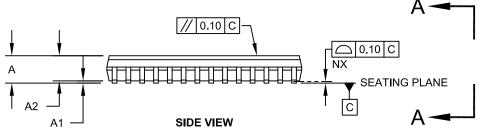
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

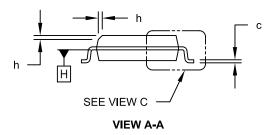
Microchip Technology Drawing No. C04-2152A

# 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



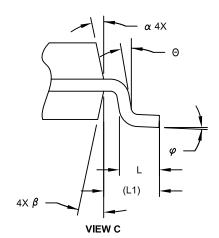


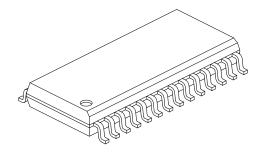


Microchip Technology Drawing C04-052C Sheet 1 of 2

## 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





	Units	Ν	MILLIMETERS		
Dimensio	n Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		1.27 BSC		
Overall Height	Α	-	-	2.65	
Molded Package Thickness	A2	2.05	-	-	
Standoff §	A1	0.10	-	0.30	
Overall Width	E	10.30 BSC			
Molded Package Width	E1	7.50 BSC			
Overall Length	D	17.90 BSC			
Chamfer (Optional)	h	0.25	-	0.75	
Foot Length	L	0.40	-	1.27	
Footprint	L1		1.40 REF		
Lead Angle	Θ	0°	-	-	
Foot Angle	φ	0°	-	8°	
Lead Thickness	С	0.18	-	0.33	
Lead Width	b	0.31	-	0.51	
Mold Draft Angle Top	α	5°	-	15°	
Mold Draft Angle Bottom	β	5°	-	15°	

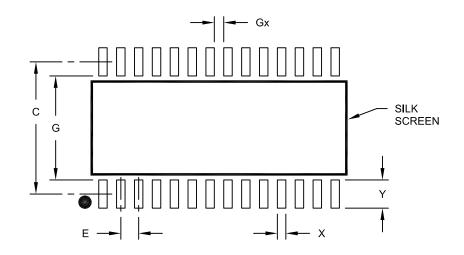
#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.
- 5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



# RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	С		9.40	
Contact Pad Width (X28)	X			0.60
Contact Pad Length (X28)	Y			2.00
Distance Between Pads	Gx	0.67		
Distance Between Pads	G	7.40		

Notes:

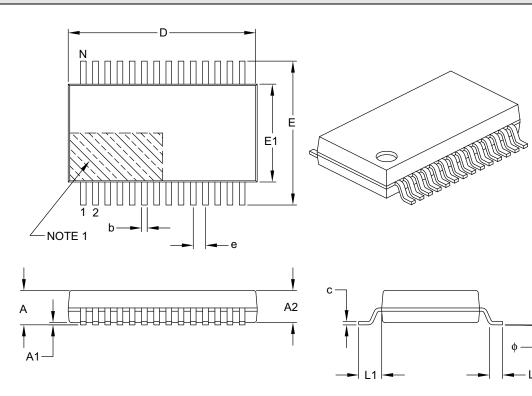
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

# 28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS		
Dimensio	on Limits	MIN	NOM	MAX	
Number of Pins	Ν		28		
Pitch	е		0.65 BSC		
Overall Height	Α	-	-	2.00	
Molded Package Thickness	A2	1.65	1.75	1.85	
Standoff	A1	0.05	-	-	
Overall Width	Е	7.40	7.80	8.20	
Molded Package Width	E1	5.00	5.30	5.60	
Overall Length	D	9.90	10.20	10.50	
Foot Length	L	0.55	0.75	0.95	
Footprint	L1	1.25 REF			
Lead Thickness	С	0.09	-	0.25	
Foot Angle	φ	0°	4°	8°	
Lead Width	b	0.22	-	0.38	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
 Dimensioning and tolerancing per ASME Y14.5M.

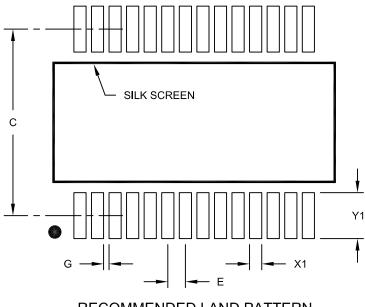
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units		MILLIMETERS			
Dimension	Dimension Limits		NOM	MAX		
Contact Pitch	E	0.65 BSC				
Contact Pad Spacing	С		7.20			
Contact Pad Width (X28)	X1			0.45		
Contact Pad Length (X28)	Y1			1.75		
Distance Between Pads	G	0.20				

Notes:

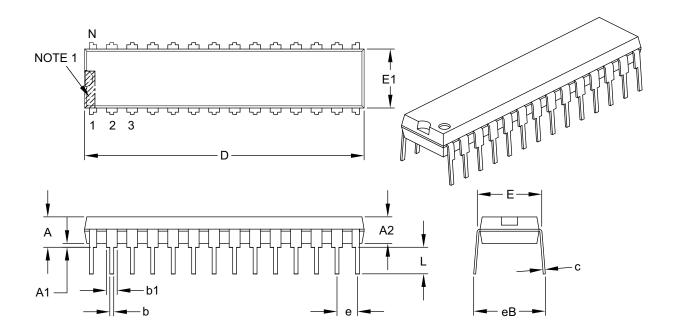
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A

## 28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES		
Dimensi	Dimension Limits		MIN NOM MAX		
Number of Pins	Ν		28		
Pitch	е		.100 BSC		
Top to Seating Plane	А	-	-	.200	
Molded Package Thickness	A2	.120	.135	.150	
Base to Seating Plane	A1	.015	-	-	
Shoulder to Shoulder Width	E	.290	.310	.335	
Molded Package Width	E1	.240	.285	.295	
Overall Length	D	1.345	1.365	1.400	
Tip to Seating Plane	L	.110	.130	.150	
Lead Thickness	С	.008	.010	.015	
Upper Lead Width	b1	.040	.050	.070	
Lower Lead Width	b	.014	.018	.022	
Overall Row Spacing §	eB	-	-	.430	

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

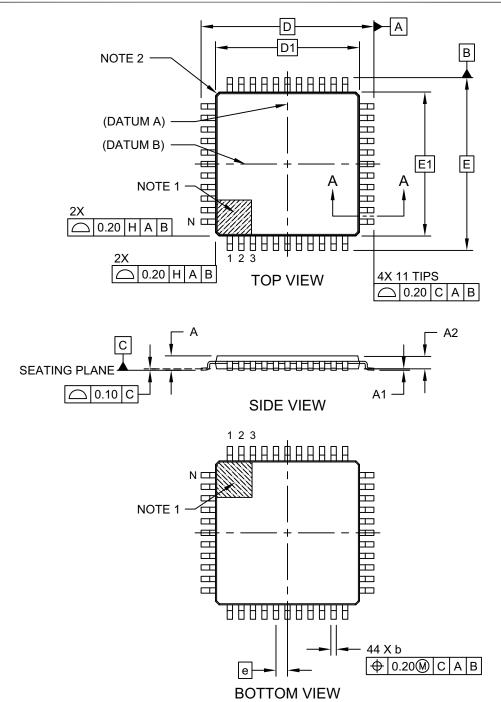
2. § Significant Characteristic.

3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.

4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B



# 44-Lead Plastic Thin Quad Flatpack (PT) - 10x10x1.0 mm Body [TQFP]

http://www.microchip.com/packaging

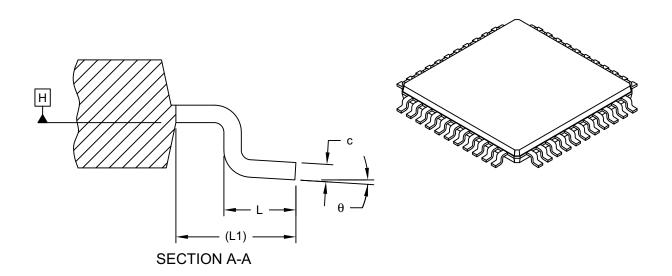
Note:

For the most current package drawings, please see the Microchip Packaging Specification located at

Microchip Technology Drawing C04-076C Sheet 1 of 2

# 44-Lead Plastic Thin Quad Flatpack (PT) - 10x10x1.0 mm Body [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	N	MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX	
Number of Leads	Ν		44		
Lead Pitch	е		0.80 BSC		
Overall Height	Α	1.2			
Standoff	A1	0.05	0.15		
Molded Package Thickness	A2	0.95	1.00	1.05	
Overall Width	E	12.00 BSC			
Molded Package Width	E1	10.00 BSC			
Overall Length	D		12.00 BSC		
Molded Package Length	D1		10.00 BSC		
Lead Width	b	0.30	0.37	0.45	
Lead Thickness	С	0.09	-	0.20	
Lead Length	L	0.45	0.60	0.75	
Footprint	L1	1.00 REF			
Foot Angle	θ	0°	3.5°	7°	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Exact shape of each corner is optional.

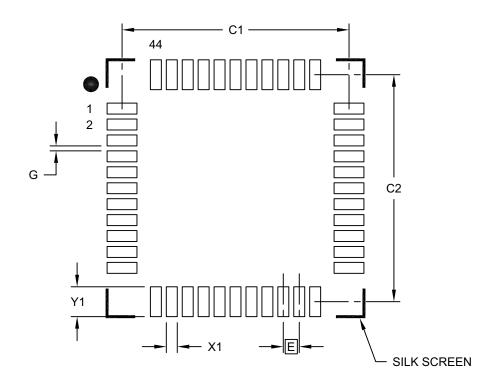
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076C Sheet 2 of 2

# 44-Lead Plastic Thin Quad Flatpack (PT) - 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



# RECOMMENDED LAND PATTERN

	11.1			
	Units		<b>IILLIMETER</b>	S
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.80 BSC		
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X44)	X1			0.55
Contact Pad Length (X44)	Y1			1.50
Distance Between Pads	G	0.25		

Notes:

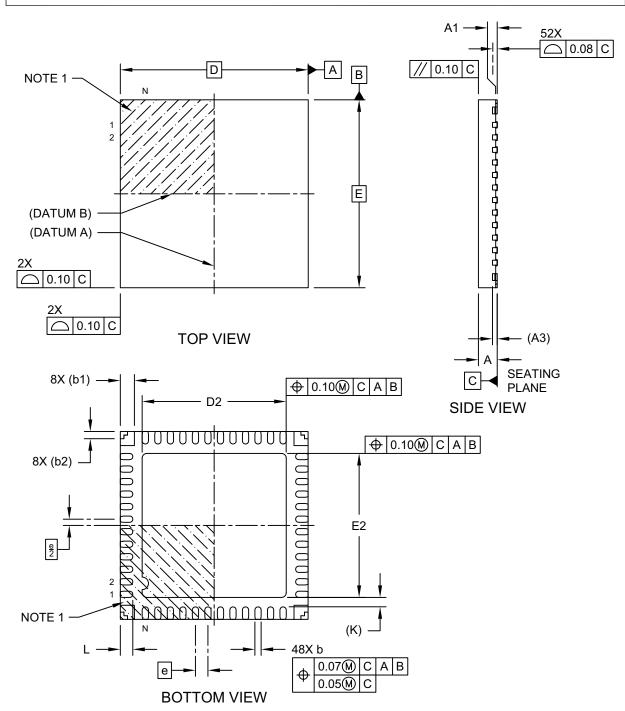
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B

# 48-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M4) - 6x6 mm Body [UQFN] With Corner Anchors and 4.6x4.6 mm Exposed Pad

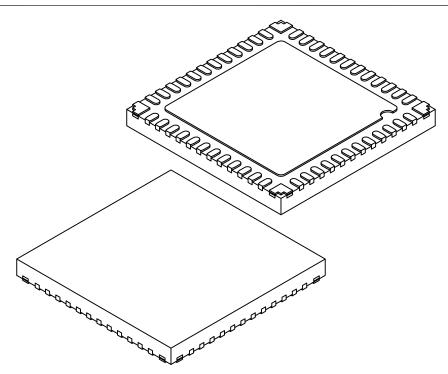
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-442A-M4 Sheet 1 of 2

# 48-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M4) - 6x6 mm Body [UQFN] With Corner Anchors and 4.6x4.6 mm Exposed Pad

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX
Number of Terminals	Ν	48		
Pitch	е		0.40 BSC	
Overall Height	А	0.50	0.55	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.15 REF		
Overall Length	D	6.00 BSC		
Exposed Pad Length	D2	4.50	4.60	4.70
Overall Width	Е		6.00 BSC	
Exposed Pad Width	E2	4.50	4.60	4.70
Terminal Width	b	0.15	0.20	0.25
Corner Anchor Pad	b1	0.45 REF		
Corner Anchor Pad, Metal-free Zone	b2	0.23 REF		
Terminal Length	L	0.35	0.40	0.45
Terminal-to-Exposed-Pad	K		0.30 REF	

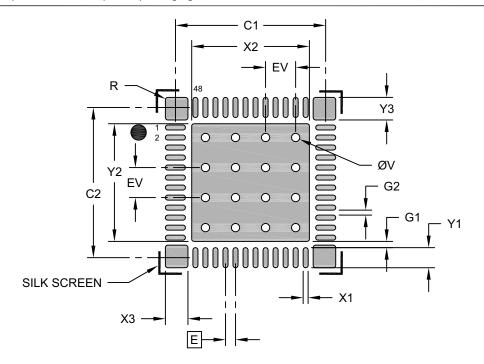
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-442A-M4 Sheet 2 of 2

# 48-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M4) - 6x6 mm Body [UQFN] With Corner Anchors and 4.6x4.6 mm Exposed Pad

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



### RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension	Dimension Limits		NOM	MAX
Contact Pitch	E		0.40 BSC	
Center Pad Width	X2			4.70
Center Pad Length	Y2			4.70
Contact Pad Spacing	C1		6.00	
Contact Pad Spacing	C2		6.00	
Contact Pad Width (X48)	X1			0.20
Contact Pad Length (X48)	Y1			0.80
Corner Anchor Pad Width (X4)	X3			0.90
Corner Anchor Pad Length (X4)	Y3			0.90
Pad Corner Radius (X 20)	R			0.10
Contact Pad to Center Pad (X48)	G1	0.25		
Contact Pad to Contact Pad	G2	0.20		
Thermal Via Diameter	V		0.33	
Thermal Via Pitch	EV		1.20	

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

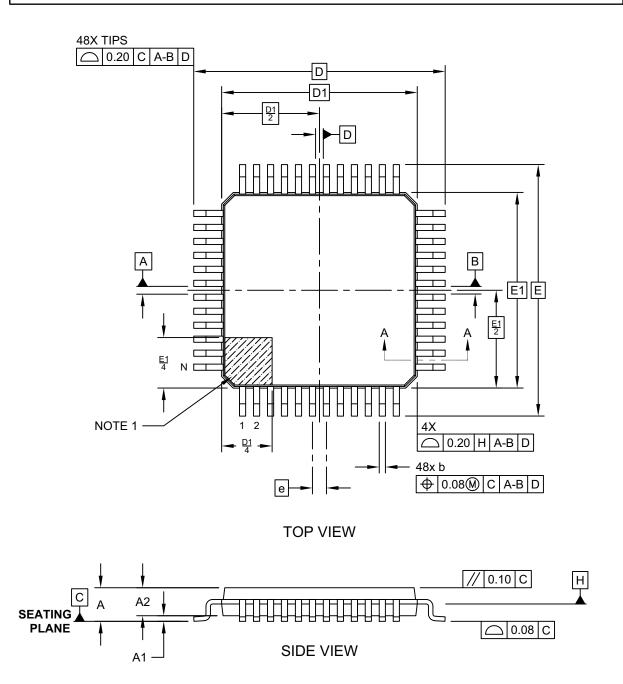
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2442A-M4

# 48-Lead Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

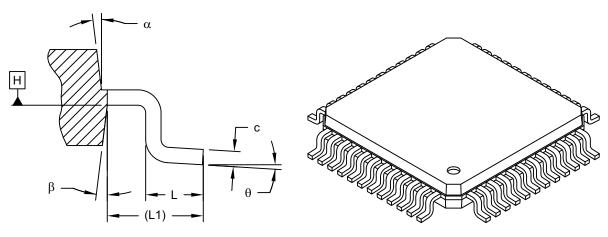
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-300-PT Rev A Sheet 1 of 2

# 48-Lead Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



SECTION A-A

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N	48		
Lead Pitch	е	0.50 BSC		
Overall Height	Α	-	-	1.20
Standoff	A1	0.05	-	0.15
Molded Package Thickness	A2	0.95	1.00	1.05
Foot Length	L	0.45	0.60	0.75
Footprint	L1	1.00 REF		
Foot Angle	¢	0°	3.5°	7°
Overall Width	E	9.00 BSC		
Overall Length	D	9.00 BSC		
Molded Package Width	E1	7.00 BSC		
Molded Package Length	D1	7.00 BSC		
Lead Thickness	С	0.09	-	0.16
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

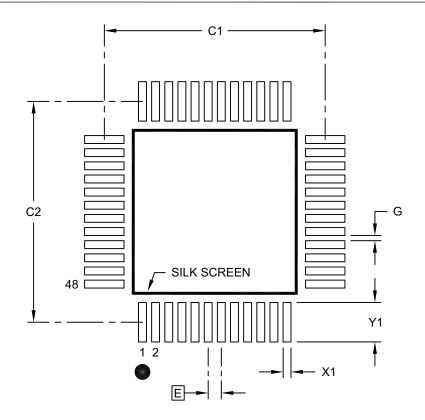
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Chamfers at corners are optional; size may vary.
- 3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25mm per side.
- Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.
- 5. Datums A-B and D to be determined at center line between leads where leads exit plastic body at datum plane H

Microchip Technology Drawing C04-300-PT Rev A Sheet 2 of 2

#### 48-Lead Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



#### RECOMMENDED LAND PATTERN

	Units	MILLIMETERS		S
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Contact Pad Spacing	C1		8.40	
Contact Pad Spacing	C2		8.40	
Contact Pad Width (X48)	X1			0.30
Contact Pad Length (X48)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2300-PT Rev A

#### APPENDIX A: REVISION HISTORY

#### **Revision A (March 2016)**

Original data sheet for the PIC24FJ256GA705 family of devices.

#### **Revision B (October 2016)**

This revision incorporates the following updates:

- Sections:
  - Removes Section 9.5 "FRC Active Clock Tuning".
  - Updates the Absolute Maximum Ratings in Section 32.0 "Electrical Characteristics".
  - Changes the 48-Lead QFN (7x7 mm) to 48-Lead UQFN (6x6 mm) in Section 33.0 "Packaging Information".
- Registers:
  - Updates Register 9-1, Register 9-3, Register 9-6, Register 16-5 and Register 16-6
- Tables:
  - Adds Table 11-3, Table 11-4 and Table 11-5.
  - Updates the GPIO column in the Peripheral Features table on Page 2.
  - Updates Table 2, Table 3, Table 4, Table 5, Table 6, Table 32-4, Table 32-5, Table 32-6, Table 32-7 and Table 32-25.
- Figures
  - Updates Figure 9-1.
- Changes to text and formatting were incorporated throughout the document.

#### **Revision C (March 2018)**

This revision incorporates the following updates which also includes "**Data Sheet Clarifications**" listed in *PIC24FJ256GA705 Family Silicon Errata and Data Sheet Clarification* (DS80000718):

- Sections:
  - Updates "Referenced Sources", Section 5.0 "Direct Memory Access Controller (DMA)", Section 5.4 "DMA Registers", Section 9.7.2 "Crystal Selection", Section 10.2.4 "Low-Voltage Retention Regulator", Section 21.0 "Real-Time Clock and Calendar (RTCC) with Timestamp", Section 29.2 "Unique Device Identifier (UDID)" and Section 29.8 "Customer OTP Memory".
  - Replaces the 28-Pin UQFN M6 drawings with 28-Pin UQFN MV drawings in Section 33.0 "Packaging Information"; therefore, "Product Identification System" is also updated.
- Tables:
  - Updates Table 1, Table 1-3, Table 8-2, Table 10-1, Table 16-2, Table 29-5, Table 31-1, Table 32-12 and Table 32-24.
- · Registers:
  - Updates Register 8-6, Register 10-2, Register 14-1, Register 16-1, Register 17-1, Register 17-5, Register 19-2, Register 22-3, Register 22-4, Register 26-1, Register 27-3 and Register 28-1
- Figures:
  - Updates Figure 17-1, Figure 18-1, Figure 26-1 and Figure 28-1.
- · Example:
  - Updates Example 19-1.

## INDEX

Α

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Flash Memory F		b)	PIC24FJ256GA702-I/ML:
Program Memor	y Size (Kbytes)		PIC24F General Purpose Device, 28-Pin, Industrial Temp., QFN Package
•			
Pin Count —	lag (if applicable)		
•	nge		
Package			
Pattern			
Architecture	24 = 16-Bit Modified Harvard without DSP		
Flash Memory Family	FJ = Flash Program Memory		
Pin Count	02 = 28-pin (QFN, UQFN, SOIC, SSOP, SPDIP) 04 = 44-pin (TQFP) 05 = 48-pin (UQFN, TQFP)		
Temperature Range	I = $-40^{\circ}$ C to $+85^{\circ}$ C (Industrial)		
Package	ML= 28-Lead (6x6 mm) QFN (Plastic Quad Flat)MV= 28-Lead (4x4x0.6 mm) UQFN (Ultra Thin Quad Flatpack)SO= 28-Lead (7.50 mm) SOIC (Plastic Small Outline)SS= 28-Lead (300 mil) SOPO (Plastic Shrink Small Outline)PP= 28-Lead (300 mil) SPDIP (Skinny Plastic Dual In-Line)PT= 44-lead (10x10x1 mm) TQFP (Thin Quad Flatpack)M4= 48-Lead (6X6 mm) UQFN (Plastic Quad Flat)PT= 48-Lead (7x7x1 mm) TQFP (Thin Quad Flatpack)		
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